

Wolfson AudioPlus™ Stereo CODEC with Power Management

DESCRIPTION

The WM8350 is an integrated audio and power management subsystem which provides a cost effective, single-chip solution for portable audio and multimedia systems.

The integrated audio CODEC provides all the necessary functions for high-quality stereo recording and playback. Programmable on-chip amplifiers allow for the direct connection of headphones and microphones with a minimum of external components. A programmable low-noise bias voltage is available to feed one or more electret microphones. Additional audio features include programmable high-pass filter in the ADC input path.

The WM8350 includes six programmable DC-DC converters, four low-dropout (LDO) regulators and a current limit switch to generate suitable supply voltages for each part of the system, including the integrated audio CODEC as well as off-chip components such as a digital core and I/O supplies, and LED lighting. An additional on-chip regulator maintains the backup power for always-on functions. The WM8350 can be powered by a lithium battery, by a wall adaptor or USB.

An on-chip battery charger supports both trickle charging and fast (constant current, constant voltage) charging of single-cell lithium batteries. The charge current, termination voltage, and charger time-out are programmable to suit different types of batteries.

Internal power management circuitry controls the start-up and shutdown sequencing of clocks and supply voltages. It also detects and handles conditions such as under-voltage, extreme temperatures, and deeply discharged or defective batteries, with a minimum of software involvement.

Two programmable constant-current sinks are available for driving LED strings, e.g. for display backlights or photo-flash applications, in a highly power-efficient way. Additional RGB LEDs can be driven through GPIO pins.

The WM8350 includes a 32.768kHz crystal oscillator, an internal RC oscillator, a real-time clock (RTC) and an alarm function capable of waking up the system. Internal circuitry can generate all clock signals required to start up the device.

The master clock for the audio CODEC can be input directly, or may be generated internally using an integrated, low power Frequency Locked Loop (FLL).

To extend battery life, fine-grained power management enables each function in the WM8350 to be independently powered down through the control interface. The WM8350 forms part of the Wolfson AudioPlusTM series of audio and power management solutions.

FEATURES

Stereo Hi-Fi CODEC

- DAC SNR 95dB ('A' weighted @ 48kHz), THD –81dB
- ADC SNR 95dB ('A' weighted @ 48kHz), THD –83dB
- 40mW on-chip headphone driver with 'capless' option
- 16Ω headphone load: THD -72dB, Po = 20mW
- 2 differential microphone inputs with low-noise bias voltage and programmable preamps
- · Programmable high-pass filter for ADC
- Microphone and Headphone detection
- Auxiliary inputs for analogue signals
- Sample rates: 8, 11.025, 16, 22.05, 24, 32, 44.1 or 48kHz

System Control

- Support for 2-wire or 3-/4-wire Control Interface
- Handles power sequencing, reset signals and fault conditions
- Autonomous power source selection (battery, wall adaptor or USB bus)
- Total current drawn from USB bus is limited to comply with USB 2.0 standard and USB OTG supplement

Supply Generation

- 2 x DC-DC Buck Converters (0.85V 3.4V, Up to 1A)
- 2 x DC-DC Buck Converters (0.85V 3.4V, Up to 500mA)
- 2 x DC-DC Boost Converters (5V 20V, 40 to 200mA)
- 4 x LDO voltage regulators (0.9V 3.3V, 150mA)

I FD Drivers

- 2 programmable constant-current sinks, suitable for screen backlight or white LED photo flash
- 3 open-drain outputs for RGB LEDs

Battery Charger

- Single-cell Li-Ion / Li-Pol battery charger
- Thermal protection for charge control; temperature monitoring available for thermal regulation
- LED outputs to indicate charge status and fault conditions

Additional Features

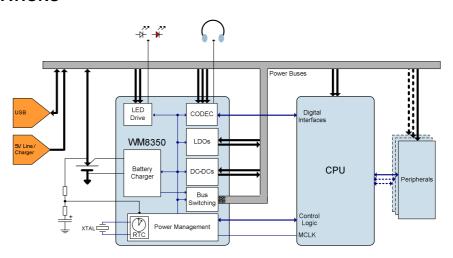
- "Always on" RTC with wake-up alarm
- Watchdog timer
- Up to 13 configurable GPIO pins
- On-chip crystal oscillator and internal RC oscillator
- Low power FLL supporting wide range of input clocks
- 7x7mm, 129 BGA package, 0.5mm ball pitch

APPLICATIONS

- · Portable Audio and Media players
- Portable Navigation Devices
- Portable systems powered by single-cell lithium batteries

WM8350

TYPICAL APPLICATIONS



The WM8350 is a complete audio and power management solution for portable media devices. The device incorporates four programmable step-down switching regulators, two step-up switching regulators, a full-featured battery charger, four Low Drop-Out (LDO) voltage regulators which can also serve as hot-swap outputs, a backup supply regulator, two programmable white LED drivers, a Real-Time Clock (RTC) alongside a 32.768kHz (32kHz) oscillator capable of operating from a backup battery, a 12-bit auxiliary ADC for precise measurements, a ROM-programmable power management state machine and numerous protection features all in a single 7x7mm BGA package. When only battery power is available, a battery switch provides power to all switching regulators (and some other internal modules). When external power is applied (eg. from USB or Wall adapter), the WM8350 seamlessly transitions from battery power (a single-cell Lithium battery) to the applicable external supply. The battery charger is then activated, all internal power for the device is drawn from the appropriate external power source and the battery is disconnected from the load. Maximum battery charge current and charge time are programmable. The USB power manager provides accurate current limiting for the USB pin under all conditions. The hot-swap outputs (LDOs in currentlimited 'Switch Mode' operation) are ideal for powering memory cards and other devices that can be inserted while the system is fully powered.

The integrated Hi-Fi stereo CODEC incorporates preamps and a low-noise bias voltage for differential microphones, and flexible pseudo-differential drivers for headphone and differential/single-ended line outputs. External component requirements are reduced as no separate microphone or headphone amplifiers are required. Digital filter options are available in the ADC and DAC paths, to cater for application filtering. The WM8350 is capable of operating without any external clock, as it can derive all required clocks from its internal crystal oscillator, RC clock, and Frequency Locked Loop. An external low jitter clock may be required in some applications for high performance audio.



BLOCK DIAGRAM

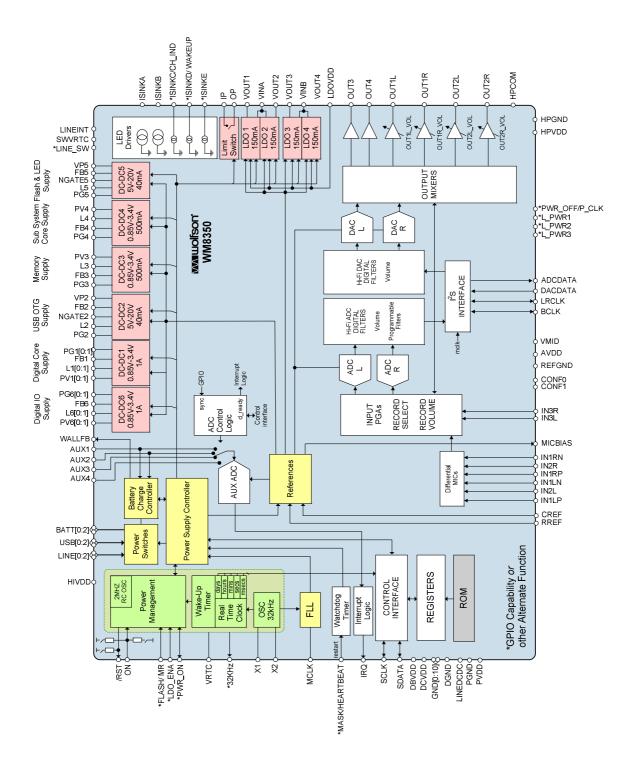


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1 PIN CONFIGURATION

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A	VP5	PG5	OP	PV1	L1	PG1	PG6	L6	PV6	FB6	GPIO12	FB2	PG2
В	L5	NGATE5	IP	PV1	L1	PG1	PG6	L6	PV6	PVDD	GPIO10	NGATE2	VP2
С	L4	PG4	FB4	FB5	LINEDCD C	FB1	GND	GND	AUX4	GPIO11	PGND	PG3	L2
D	PV4	BATT	HIVDD	N/A	N/A	N/A	N/A	N/A	N/A	N/A	FB3	PV3	L3
E	BATT	BATT	WALLFB	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ISINKA	ISINKB	SINKGND
F	LINE	LINE	LINE	N/A	N/A	GND	GND	GND	N/A	N/A	VOUT4	LDOVDD	VINB
G	USB	USB	USB	N/A	N/A	GND	GND	GND	N/A	N/A	VOUT2	VOUT3	VINA
н	VRTC	LINEINT	CREF	N/A	N/A	GND	GND	GND	N/A	N/A	AUX1	VOUT1	AUX3
J	CONF0	X1	RREF	N/A	N/A	N/A	N/A	N/A	N/A	N/A	OUT1R	НРСОМ	AUX2
к	CONF1	ON	X2	N/A	N/A	N/A	N/A	N/A	N/A	N/A	OUT1L	OUT4	HPVDD
L	GPIO0	/RST	SWVRTC	IRQ	GPIO5	GPIO8	GPIO9	BCLK	LRCLK	IN3L	IN1LN	OUT3	HPGND
м	GPIO2	GPIO1	SDA	GPIO6	DGND	MCLK	ADCDATA	AVDD	IN3R	INL2	MICBIAS	OUT2R	OUT2L
N	GPIO3	SCL	GPIO4	GPIO7	DCVDD	DBVDD	DACDATA	REFGND	VMID	IN1LP	INR2	IN1RP	IN1RN
	Notes: Pin names beginning with a lower-case "n" indicate that the pin is active low. Colour coding indicates function of pins in typical usage: DC-DC converters LDO voltage regulators Power management functions Analogue pins for audio codec Digital pins for audio codec Quiet ground Others												

2 ORDERING INFORMATION

ORDER CODE	TEMPERATURE RANGE	PACKAGE	MOISTURE SENSITIVITY LEVEL	PEAK SOLDERING TEMPERATURE
WM8350GEB/V	-25°C to +85°C	129-ball BGA (7 x 7 mm) (Pb-free)	MSL3	260°C
WM8350GEB/RV	-25°C to +85°C	129-ball BGA (7 x 7 mm) (Pb-free, tape and reel)	MSL3	260°C

Note:

Reel quantity = 2,200



WM8350

Production Data PIN DESCRIPTION

Notes:

Pins are listed in alphabetical order by name.

NAME	LOCATION(S)	TYPE	POWER DOMAIN	DESCRIPTION	
ADCDATA	M7	Digital Output	DBVDD	Digital audio output (typically from on-chip audio ADC to external IC)	
AUX1	H11	Analogue Input	LINE	Auxiliary ADC input AUX1	
				(Special function for connection to temperature-sensir NTC resistor in battery pack)	
AUX2	J13	Analogue Input	LINE	Auxiliary ADC input AUX2	
AUX3	H13	Analogue Input	LINE	Auxiliary ADC input AUX3	
AUX4	C9	Analogue Input	LINE	Auxiliary ADC input AUX4	
AVDD	M8	Supply		Analogue supply for audio CODEC	
BATT	E1, E2, D2	Analogue I/O		Main battery power connection (can draw power or charge battery)	
BCLK	L8	Digital I/O	DBVDD	Bit clock signal for digital audio interface	
CREF	H3	Analogue Output	VRTC	Decoupling for VREF reference voltage (connect capacitor here)	
CONF0	J1	Digital Input	VRTC	Start-up configuration pin 0	
CONF1	K1	Digital Input	VRTC	Start-up configuration pin 1	
DACDATA	N7	Digital Input	DBVDD	Digital audio input (typically from external IC to on-chip audio DAC)	
DCVDD	N5	Supply		Digital core supply; powers digital core of audio CODEO	
DBVDD	N6	Supply		Digital I/O buffer supply; powers digital audio interface, control interface and pins GPIO4 to GPIO9	
DGND	M5	Supply		Digital ground; return path for DCVDD and DBVDD supplies	
FB1	C6	Analogue Input	PV1	DC-DC1 feedback pin	
FB2	A12	Analogue Input	VP2	DC-DC2 feedback pin	
FB3	D11	Analogue Input	PV3	DC-DC3 feedback pin	
FB4	C3	Analogue Input	PV4	DC-DC4 feedback pin	
FB5	C4	Analogue Input	VP5	DC-DC5 feedback pin	
FB6	A10	Analogue Input	PV6	DC-DC6 feedback pin	
GND	F6, F7, F8, G6,G7, G8, H6, H7, H8, C7, C8	Supply		Quiet ground connection for audio CODEC. Note that DC-DC Converters use a separate ground connection.	
GPIO0	L1	Digital I/O	VRTC	General Purpose Input/Output pin 0	
GPIO1	M2	Digital I/O	VRTC	General Purpose Input/Output pin 1	
GPIO2	M1	Digital I/O	VRTC	General Purpose Input/Output pin 2	
GPIO3	N1	Digital I/O	VRTC	General Purpose Input/Output pin 3	
GPIO4	N3	Digital I/O	DBVDD	General Purpose Input/Output pin 4	
GPIO5	L5	Digital I/O	DBVDD	General Purpose Input/Output pin 5	
GPIO6	M4	Digital I/O	DBVDD	General Purpose Input/Output pin 6	
GPIO7	N4	Digital I/O	DBVDD	General Purpose Input/Output pin 7	
GPIO8	L6	Digital I/O	DBVDD	General Purpose Input/Output pin 8	
GPIO9	L7	Digital I/O	DBVDD	General Purpose Input/Output pin 9	
GPIO10	B11	Digital I/O	LINE	General Purpose Input/Output pin 10	
GPIO11	C10	Digital I/O	LINE	General Purpose Input/Output pin 11	
GPIO12	A11	Digital I/O	LINE	General Purpose Input/ Output pin 12	
HIVDD	D3	Analogue Output		Analogue output from power management unit which determines highest supply from Line, Battery or USB.	
HPCOM	J12	Analogue Input	HPVDD	Headphone output amplifier noise compensation input	
HPGND	L13	Supply	HPVDD	Headphone ground; return path for HPVDD supply	



NAME	LOCATION(S)	TYPE	POWER DOMAIN	DESCRIPTION
HPVDD	K13	Supply		Headphone supply – powers the analogue outputs OUT1L, OUT1R, OUT2L, OUT2R, OUT3 and OUT4
IN1LN	L11	Analogue Input	AVDD	Inverting input for left microphone channel
IN1LP	N10	Analogue Input	AVDD	Non-inverting input 1 for left microphone channel
IN1RN	N13	Analogue Input	AVDD	Inverting input for right microphone channel
IN1RP	N12	Analogue Input	AVDD	Non-inverting input 1 for right microphone channel
IN2L	M10	Analogue Input	AVDD	Non-inverting input 2 for left microphone channel
IN2R	N11	Analogue Input	AVDD	Non-inverting input 2 for right microphone channel
IN3L	L10	Analogue Input	AVDD	Auxiliary input for analogue audio signals (left channel)
IN3R	M9	Analogue Input	AVDD	Auxiliary input for analogue audio signals (right channel)
IP	B3	Analogue Input		Power input to current limit switch
ISINKA	E11	Analogue Output	LDOVDD	Constant-current LED driver A
ISINKB	E12	Analogue Output	LDOVDD	Constant-current LED driver B
L1	A5, B5	Analogue I/O	PV1	DC-DC1 inductor connection
L2	C13	Analogue I/O	VP2	DC-DC2 inductor connection
L3	D13	Analogue I/O	PV3	DC-DC3 inductor connection
L4	C1	Analogue I/O	PV4	DC-DC4 inductor connection
L5	B1	Analogue I/O	VP5	DC-DC5 inductor connection
L6	A8, B8	Analogue I/O	PV6	DC-DC6 inductor connection
LDOVDD	F12	Supply		LDO amplifier supply voltage
LINEDCDC	C5	Supply		Supply connection for DC-DC 1, 4 and 5 control circuits
LINEINT	H2	Supply		Supply connection for Internal Reference circuits
LINE	F1, F2, F3	Supply		LINE supply connection
LRCLK	L9	Digital I/O	DBVDD	Word clock (left/right clock) signal for digital audio interface
MCLK	M6	Digital I/O	DBVDD	Master Clock (may be generated internally or externally)
MICBIAS	M11	Analogue Output	AVDD	Low-noise bias voltage for condenser microphones (connect decoupling capacitor here)
NGATE2	B12	Analogue Output	VP2	DC-DC2 connection to gate of external power FET
NGATE5	B2	Analogue Output	VP5	DC-DC5 connection to gate of external power FET
IRQ	L4	Digital Output open-drain	DBVDD	Interrupt signal from WM8350 to host processor
ON	K2	Digital Input	VRTC	Connection for power-on switch
/RST	L2	Digital Output open-drain	DBVDD	System Reset Signal (active low)
OP	A3	Analogue Output		Power output from current limit switch
OUT1L	K11	Analogue Output	AVDD	Left channel analogue audio output 1
OUT2L	M13	Analogue Output	AVDD	Left channel analogue audio output 2
OUT1R	J11	Analogue Output	AVDD	Right channel analogue audio output 1
OUT2R	M12	Analogue Output	AVDD	Right channel analogue audio output 2
OUT3	L12	Analogue Output	AVDD	Analogue audio output 3 (or pseudo-ground output for capacitor-less headphone outputs)
OUT4	K12	Analogue Output	AVDD	Analogue audio output 4
PG1	A6, B6	Supply		DC-DC1 power ground
PG2	A13	Supply		DC-DC2 power ground
PG3	C12	Supply		DC-DC3 power ground
PG4	C2	Supply		DC-DC4 power ground
PG5	A2	Supply		DC-DC5 power ground
PG6	A7, B7	Supply		DC-DC6 power ground
PGND	C11	Supply		Ground connection
PV1	A4, B4,	Supply		DC-DC1 line or battery power input
PV3	D12	Supply		DC-DC3 line or battery power input
PV4	D1	Supply		DC-DC4 line or battery power input



NAME	LOCATION(S)	TYPE	POWER DOMAIN	DESCRIPTION	
PV6	A9, B9	Supply		DC-DC6 power input	
PVDD	B10	Supply		Supply connection for DC-DC 2, 3 and 6 control circuits	
REFGND	N8	Supply		Reference ground for audio ADC and DAC	
RREF	J3	Analogue Output		Connection for external 100kΩ current reference resistor	
SCLK	N2	Digital Input	DBVDD	Clock signal for 2-wire serial control interface (5V Tolerant)	
SDATA	M3	Digital I/O	DBVDD	Data line for 2-wire serial control interface (5V Tolerant)	
SINKGND	E13	Supply		Ground connection for ISINKA and ISINKB	
SWVRTC	L3	Analogue Output	VRTC	Switchable VRTC output. Typically used for battery temperature monitoring	
USB	G1, G2, G3	Supply		Connection to USB power rail	
VINA	G13	Supply		Input to voltage regulators LDO1 and LDO2	
VINB	F13	Supply		Input to voltage regulators LDO3 and LDO4	
VMID	N9	Analogue I/O	AVDD	Reference voltage (normally AVDD/2) for audio CODEC (connect capacitor here)	
VOUT1	H12	Analogue Output	VINA	Output of voltage regulator LDO1	
VOUT2	G11	Analogue Output	VINA	Output of voltage regulator LDO2	
VOUT3	G12	Analogue Output	VINB	Output of voltage regulator LDO3	
VOUT4	F11	Analogue Output	VINB	Output of voltage regulator LDO4	
VP2	B13	Supply		DC-DC2 power input	
VP5	A1	Supply		DC-DC5 power input	
VRTC	H1	Supply		Backup power connection (WM8350 can draw power from this pin or re-charge the backup power source)	
WALLFB	E3	Analogue Input	LINE	Connection to Wall feedback	
X1	J2	Analogue Input	VRTC	Connection for 32.768kHz crystal (input to oscillator from crystal) or 32.768kHz external clock input (when not using crystal)	
X2	K3	Analogue Output	VRTC	Connection for 32.768kHz crystal (output from oscillator to crystal)	

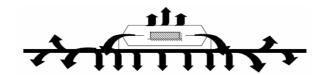


4 THERMAL CHARACTERISTICS

Thermal analysis must be performed in the intended application to prevent the WM8350 from exceeding maximum junction temperature. Several contributing factors affect thermal performance most notably the physical properties of the mechanical enclosure, location of the device on the PCB in relation to surrounding components and the number of PCB layers. Connecting the nine central GND balls through thermal vias and into a large ground plane will aid heat extraction.

Three main heat transfer paths exist to surrounding air:

- Package top to air (radiation).
- Package bottom to PCB (radiation).
- Package leads to PCB (conduction).



The temperature rise T_R is given by $T_R = P_D * \Theta_{JA}$

- P_D is the power dissipated by the device.
- Θ_{JA} is the thermal resistance from the junction of the die to the ambient temperature and is therefore a measure of heat transfer from the die to surrounding air.
- For WM8350, ⊖_{JA} = 32°C/W

The junction temperature T_J is given by $T_J = T_A + T_R$

- T_A, is the ambient temperature.

The worst case conditions are when the WM8350 is operating in a high ambient temperature, with low supply voltage, high duty cycle and high output current. Under such conditions, it is possible that the heat dissipated could exceed the maximum junction temperature of the device. Care must be taken to avoid this situation. An example calculation of the junction temperature is given below.

- P_D = 1W (example figure)
- ⊖_{JA} = 32°C/W
- T_R = P_D * Θ_{JA} = 32°C
- T_A = 85°C (example figure)
- $T_J = T_A + T_R = 117$ °C

The minimum and maximum operating junction temperatures for the WM8350 are quoted in Section 5. The maximum junction temperature is 125°C. Therefore, the junction temperature in the above example is within the operating limits of the WM8350.

5 ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings are stress ratings only. Permanent damage to the device may be caused by continuously operating at or beyond these limits. Device functional operating limits and guaranteed performance specifications are given under Electrical Characteristics at the test conditions specified.



ESD Sensitive Device. This device is manufactured on a CMOS process. It is therefore generically susceptible to damage from excessive static voltages. Proper ESD precautions must be taken during handling and storage of this device.

Wolfson tests its package types according to IPC/JEDEC J-STD-020B for Moisture Sensitivity to determine acceptable storage conditions prior to surface mount assembly. These levels are:

MSL1 = unlimited floor life at <30°C / 85% Relative Humidity. Not normally stored in moisture barrier bag.

MSL2 = out of bag storage for 1 year at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

MSL3 = out of bag storage for 168 hours at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

The WM8350 has been classified as MSL3.

CONDITION	MIN	MAX
BATT, LINE and USB voltage	-0.3V	+7V
Input voltage for LDO regulators (pins VINA, VINB)	-0.3V	+7V
Analogue supply voltages (AVDD, HPVDD)	-0.3V	+4.5V
Digital supply voltages (DCVDD, DBVDD)	-0.3V	+4.5V
Voltage range for CODEC analogue inputs	-0.3V	AVDD + 0.3V
Voltage range for digital inputs	-0.3V	DBVDD + 0.3V
Master Clock Frequency		37MHz
(When MCLK_DIV set to divide by 2)		
Operating Temperature Range, T _A	-25°C	+85°C
Junction Temperature, T _J	-20°C	+125°C
Thermal Impedance Junction to Ambient, θ_{JA}		32°C/W
Storage temperature prior to soldering	30°C max	/ 60% RH max
Storage temperature after soldering	-65°C	+150°C
Soldering temperature (10 seconds)		+260°C
Note: These ratings assume that all ground pins are at 0V.		•



6 RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
Digital Supply Range (Core)	DCVDD	1.71		3.6	V
Digital Supply Range (Buffer)	DBVDD	1.71		3.6	V
Headphone Supply Range	HPVDD	2.5		3.6	V
Analogue Supply Range	AVDD	2.5		3.6	V
Line Input Source	LINE	2.95		5.5	V
Battery Input Source	BATT	2.95		4.2	V
USB Input Source	USB	4.75		5.25	V
LDO Input Source	VINA, VINB	0		5.5	V
Ground	GND, PGND, DGND, HPGND, REFGND, PG1, PG2, PG3, PG4, PG5, PG6		0		V



7 ELECTRICAL CHARACTERISTICS

7.1 HI-FI AUDIO CODEC

Test Conditions

DCVDD = 1.8V, AVDD = HPVDD = 3.3V, T_A = +25°C, 1kHz signal, fs = 48kHz, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Microphone Preamp Inputs (IN1	LP, IN1LN, IN	1RP, IN1RN)	I	I I		I
Full-scale Input Signal Level	V _{INFS}	'		1		V rms
(0dB) – note this changes with AVDD				0		dBV
Mic preamp equivalent input	At			150		μV
noise	35.25dB					
	gain	0: (1.05.05.10				1.0
Input resistance	R _{MICIN}	Gain set to 35.25dB		2.3		kΩ
Input resistance	R _{MICIN}	Gain set to 0dB		64		kΩ
Input resistance	R _{MICIN}	Gain set to -12dB		101		kΩ
Input Capacitance	C _{MICIN}			2		pF
Recommended decoupling cap	C _{DECOUP}			0.33		μF
MIC Programmable Gain Amplif	ier (PGA)	1	Г	, , , , , , , , , , , , , , , , , , , 		T
Programmable Gain			-12		35.25	dB
Programmable Gain Step Size		Monotonic		0.75		dB
Mute Attenuation				-90		dB
Selectable Input Gain Boost (0/-	-20dB)	1				,
Gain Boost			0		20	dB
Auxiliary Analogue Inputs (IN3L	, IN3R)	1				,
Full-scale Input Signal Level	V_{INFS}			1.0		V rms
(0dB) – note this changes with AVDD				0		dBV
PGA gain range to summer			-12		+6	dB
PGA step size to summer				3		dB
Input Resistance	R _{AUXIN}			32		kΩ
Input Capacitance	C _{AUXIN}			10		pF
Analogue to Digital Converter (A	ADC)					
Signal to Noise Ratio (Note 1, 2)		A-weighted, 0dB gain	86	95		dB
Total Harmonic Distortion		-2dBV Input	-75	-83		dB
(Note 4)						
Digital to Analogue Converter (D	OAC) to Line-0	Out (OUT1L, OUT1R wit	th 10kΩ / 50p	F load)		
Full-scale output		PGA gains set to 0dB		HPVDD/3.3		V rms
Signal to Noise Ratio (Note 1, 2)	SNR	A-weighted	90	95		dB
Total Harmonic Distortion	THD+N	$R_L = 10k\Omega$	-75	-81		dB
(Note 3)		full-scale signal				
Channel Separation (Note 4)		1kHz signal		89		dB
Output Mixers						
PGA gain range into mixer			-15	0	+6	dB
PGA gain step into mixer				3		dB
Analogue Output PGAs (OUT1L,	OUT1R, OUT	C2L, OUT2R)				
Programmable Gain range			-57	0	+6	dB
Programmable Gain step size		Monotonic		1		dB
Mute attenuation		1KHz, full scale signal		78		dB



Test Conditions

DCVDD = 1.8V, AVDD = HPVDD = 3.3V, T_A = +25°C, 1kHz signal, fs = 48kHz, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Headphone Output (OUT1L, OUT	1R, OUT2L, (OUT2R)				
0dB full scale output voltage				HPVDD/3.3		Vrms
Signal to Noise Ratio	SNR	A-weighted	87	96		dB
Total Harmonic Distortion (Note 3)	THD+N	$R_L = 16\Omega$, Po=20mW	-65	-72		dB
		HPVDD=3.3V $R_L = 32\Omega,$ Po=20mW		-71		dB
OUT3/OUT4 outputs (with 10kΩ)	(EODE lood)	HPVDD=3.3V				
Full-scale output	Supr Idau)		1	HPVDD/3.3		V rms
Signal to Noise Ratio (Note 1, 2)	SNR	A-weighted	90	97		dB
Total Harmonic Distortion	THD	$R_L = 10k\Omega$	-77	-83		dВ
(Note 3)	טחו	full-scale signal	-//	-03		uБ
Channel Separation (Note 4)		5KHz signal		80		dB
Microphone Bias		Sixi iz sigilal		00		ub_
Bias Voltage	V _{MICBIAS}	MBVSEL=0		0.9*AVDD		V
2.ac tonage	· WIODIAG	MBVSEL=1		0.75*AVDD		V
Bias Current Source	I _{MICBIAS}	-		3		mA
Output Noise Voltage	Vn	1kHz to 20kHz		24		nV/√Hz
Digital Input / Output						
Input HIGH Level	V _{IH}		0.7×DBVDD			V
Input LOW Level	V _{IL}				0.3×DBVDD	V
Output HIGH Level	V _{OH}	I _{OL} =1mA	0.9×DBVDD			V
Output LOW Level	V _{OL}	I _{OH} -1mA			0.1xDBVDD	V
Frequency Locked Loop (FLL)						
Reference clock frequency	F _{REF}		0.032		22	MHz
Jack Detect						
Detection switch threshold	V _{IH}		0.7xAVDD			V
	V _{IL}				0.3xAVDD	V
НРСОМ					 	
Ground noise rejection	V _{IH}			40		dB
	V _{IL}			40		dB

TERMINOLOGY

- 1. Signal-to-noise ratio (dB) = SNR is a measure of the difference in level between the full scale output and the output with no signal applied. (No Auto-zero or Automute function is employed in achieving these results).
- 2. Dynamic range (dB) = DR is a measure of the difference between the highest and lowest portions of a signal. Normally a THD+N measurement at 60dB below full scale. The measured signal is then corrected by adding the 60dB to it. (E.g. THD+N @ -60dB= -32dB, DR= 92dB).
- 3. THD+N (dB) = THD+N is a ratio, of the rms values, of (Noise + Distortion)/Signal.
- 4. Channel Separation (dB) = Also known as Cross-Talk. This is a measure of the amount one channel is isolated from the other. Normally measured by sending a full scale signal down one channel and measuring the other.

7.2 DC-DC STEP UP CONVERTER ELECTRICAL CHARACTERISTICS

Test Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
DC-DC2 and DC-D	C5		"	II.	•		
Input voltage	V	when used as converter	2.7	3.7	5.5	V	
range	V _{IN}	when used as switch	1.2	3.7	5.5	V	
Output voltage	V _{OUT}	by default	V _{IN}		20	V	
range	¥001	(needs external component configuration)	VIIN		(30)	v	
USB OTG output voltage	$V_{\text{OUT,USB}}$	V _{IN} <4.5V; I _{OUT} <100mA; DCn_FBSRC [1:0]=11		5.0		V	
		V _{OUT} =30V			25		
Output current	Іоит	V _{OUT} =20V (DCn_ILIM_=1)	0		40 (18)	mA	
		V _{OUT} =5.0V (DCn_ILIM_=1)			170 (100)		
		V _{IN} =3.3V; V _{OUT} =3.2V; +25°C		0.26	(,		
Switch resistance	R _{ON}	V _{IN} =1.8V; V _{OUT} =1.7V; +25°C		0.41		Ω	
		V _{IN} =1.2V; V _{OUT} =1.1V; +25°C		0.84			
Maximum switch current	I _{SW,MAX}				700	mA	
Switching frequency	f _{CLK}			1.0		MHz	
Maximum duty cycle	D _{MAX}	V _{IN} =3V; f _{CLK} =1.0MHz		90		%	
Efficiency	Н	V _{IN} =3.8V; V _{OUT} =20V; I _{OUT} =20mA		75		%	
Efficiency		V _{IN} =3.8V; V _{OUT} =5.0V; I _{OUT} =100mA		88		%	
		Shutdown or switch configuration		0.1			
Quiescent current	I_{DD}	active; no switching		260		uA	
		active; pulse skipping		260		<u> </u>	
Regulated	V_{FB}	DCn_FBSRC [1:0] = 00		0.5		V	
feedback voltage	V_{CURR}	DCn_FBSRC [1:0] = 01 or 10		0.5			
Undervoltage	$V_{FB,UV}$	below feedback voltage		12		%	
detect	V _{USB,UV}	DCn_FBSRC [1:0] = 11		4.6		V	
Overvoltage	$V_{FB,OV}$	above feedback voltage		8		%	
detect	V _{USB,OV}	DCn_FBSRC [1:0] = 11		5.4		V	
Peak inductor	I _{PK}	V _{IN} =3V; V _{OUT} =90%;		700		mA	
current limit		DCn_ILIM_=1		450			
On resistance of NGATE driver	R _{NGATE}	P-Channel FET (I _{PFET} =100mA)		4.6	-	Ω	
	0	N-Channel FET (I _{NFET} =100mA)	4.0	4.9		_	
Input capacitor	C _{IN}	X5R/X7R dielectric	1.0	2.2	.000/	μF	
Inductor	L _F		-30%	10	+30%	μН	
Inductor current rating	I _{SAT,Lf}	DCn II IM =4	500			mA	
raung		DCn_ILIM_=1	320	10	22		
		DCn_FBSRC [1:0]= 00 or 11; V _{OUT} =5V DCn_FBSRC [1:0]= 00; V _{OUT} =10V	0.84	2.2	4.7	-	
		DCn_FBSRC [1:0]= 00; V _{OUT} = 10V DCn_FBSRC [1:0]= 00; V _{OUT} =20V				-	
Output capacitor	C_{OUT}	DCn_FBSRC [1:0]= 00, V _{OUT} =20V DCn_FBSRC [1:0]= 01 or 10; V _{OUT} =10V	0.18	0.47 4.7	1.0	μF	
		DCn_FBSRC [1:0]= 01 or 10; V _{OUT} =10V	2.0 1.5	2.2	10 10		
		DCn_FBSRC [1:0]= 01 or 10; V _{OUT} =20V	0.9	1.5	4.7]	



7.3 DC-DC STEP DOWN CONVERTER ELECTRICAL CHARACTERISTICS

Test Conditions

 V_{IN} = 3.7, V_{OUT} = 1.8V, T_{A} = +25°C unless otherwise noted.

PARAMETER	SYMBOL	c	OND	TIONS		MIN	TYP	MAX	UNITS	
DC-DC1 and DC-D	C6						1	I.	ı	
Input Voltage	V _{IN}					2.7	3.7	5.5	V	
Output Voltage	V _{OUT}					0.85		3.4	V	
VOUT Accuracy	V _{OUT}	V _{IN} = 3.7V V _{OUT} = 0.85V / 1.	8V	I _{OUT} = 0.5A	Active		+/- 3.0		%	
		/ 3.4V I _{OUT} = 0.005A		Sleep		-1.5 +4.5				
Line Regulation		V _{IN} = 2.7V to	I _{OU} -	_r = 0.5A	Active		+/- 0.5			
	V	5.5V V _{OUT} = 1.8V	I _{OU} -	_r = 0.1A	Standby		+/- 0.25		%	
			lou	r = 0.005A	Sleep		+/- 0.4	+/- 0.5		
Load Regulation		$I_{OUT} = 0.001A$ to			Active		+/- 0.2			
	Vout LOAD	I _{OUT} = 0A to 0.1A Standby				+/- 0.2		%		
		I _{OUT} = 0A to 0.01	Ą		Sleep		+/- 0.3	+/- 0.5		
Quiescent Current	IQ ACTIVE	Active (excluding	switch	ning losses)			265			
	I _{Q STANDBY}	Standby (excludin	g swit	ching losses	s)		115		μΑ	
	I _{QSLEEP}	Sleep					25			
Shutdown current	I _{SD}						0.01		μA	
P-channel On Resistance	R_{DSP}	$V_{IN} = 3.7V, I_{L(n)} =$	100m	Α			0.09		Ω	
N-channel On Resistance	R _{DSN}	V _{IN} = 3.7V, I _{L(n)} =	100m	ıA			0.167		Ω	
P-channel leakage current	I _{LXP}	V _{IN} = 3.7V, L(n) = GND				0.01		μA		
N-channel leakage current	I _{LXN}	V _{IN} = 3.7V, L(n) =	3.7V				2.8		μA	
Switching Frequency	f _{SW}						2.0		MHz	



Test Conditions

 V_{IN} = 3.7, V_{OUT} = 1.8V, T_{A} = +25°C unless otherwise noted.

PARAMETER	SYMBOL	C	ONDIT	IONS		MIN	TYP	MAX	UNITS
DC-DC3 and DC-D	C4						1	I.	
Input Voltage	V _{IN}					2.7	3.7	5.5	V
Output Voltage	V _{OUT}					0.85		3.4	V
VOUT Accuracy	V _{OUT}	$V_{IN} = 3.7V$ $V_{OUT} = 0.85V / 1.8$	8V	I _{OUT} = 0.5A	Active		+/- 3.0		%
		/ 3.4V		I _{OUT} = 0.005	Sleep		-1.5 +4.5		
Line Regulation		V _{IN} = 2.7V to	I _{OUT} = 0.25A Active			+/- 0.4			
V _{OUT} LINE	5.5V V _{OUT} = 1.8V	5.5V I _{OUT} =		Standby		+/- 0.18		%	
	I _{OUT} = 0.005			Sleep		+/- 0.4	+/- 0.5		
Load Regulation		I _{OUT} = 1mA to 500	I _{OUT} = 1mA to 500mA		Active		+/- 0.5		
	V _{OUT LOAD}	I _{OUT} = 0A to 0.05	4		Standby		+/- 0.2		%
		I _{OUT} = 0A to 0.010)A		Sleep		+/- 0.3	+/- 0.5	
Quiescent Current	I _{Q ACTIVE}	Active (excluding	switch	ning losses	s)		318		
	I _{Q STANDBY}	Standby (excluding	ng swite	ching loss	es)		120		μΑ
	I _{Q SLEEP}	Sleep	Sleep				25		
Shutdown current	I _{SD}						0.01		μΑ
P-channel On Resistance	R _{DSP}	$V_{IN} = 3.7V, I_{L(n)} =$	100m <i>A</i>	٨			0.29		Ω
N-channel On Resistance	R _{DSN}	$V_{IN} = 3.7V, I_{L(n)} =$	100mA	١			0.2		Ω
P-channel leakage current	I_{LXP}	V _{IN} = 3.7V, L(n) =	V _{IN} = 3.7V, L(n) = GND				0.02		μΑ
N-channel leakage current	I _{LXN}	V _{IN} = 3.7V, L(n) =	3.7V				1.4		μΑ
Switching Frequency	f _{SW}						2.0		MHz



7.4 LDO REGULATOR ELECTRICAL CHARACTERISTICS

Test Conditions

 V_{IN} = 3.7, V_{OUT} = 1.8V, T_A = +25°C unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
LDO1 to LDO4 (WM8350 in ACT	IVE State)			·		
Input Voltage	VIN	After start-up	1.6	3.7	5.5	V
Output voltage	VOUTn		0.9		3.3	V
Regulation Accuracy				+/-3.3		%
Dropout Voltage		100mA, V _{IN} < 1.8V		200		mV
		100mA, V _{IN} < 2.7V		700		
Load current				100	150	mA
Quiescent Current			27		1% of load	μΑ
Leakage Current				<2.5		μΑ
Power Supply Rejection Ratio	PSRR	1kHz, V _{OUT} =1.8V, 25mA load		-50		dB
		100Hz				
ON Resistance in switch mode	R _{ON}	LDOn_SWI = 1		2	3.5	Ω
LDO1 (WM8350 in OFF State)	•			•		
Output Voltage	VOUT1			0.95 × VOUT1 in ACTIVE		V



7.5 BATTERY CHARGER

Test Conditions

 $T_A = +25$ °C unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
General	•					
Wall adaptor voltage	LINE	When charging from wall adaptor	4.0		5.5	V
USB voltage	USB	When charging from USB power rail	4.0		5.5	V
Target voltage		CHG_VSEL=00	4.0	4.05	4.1	V
		CHG_VSEL=01	4.05	4.1	4.15	
		CHG_VSEL=10	4.1	4.15	4.2	
		CHG_VSEL=11	4.15	4.2	4.25	
Defective battery threshold				2.85		V
End of Charge Current	EOC	Programmable in register R168 CHG_EOC_SEL bits		20 to 90		mA
Trickle Charging						
Trickle charge initiation threshold (WM8350 starts trickle charging when battery is below this threshold)				CHG_VSEL - 100mV		V
50mA trickle charge current		CHG_TRICKLE_SEL = 0 (default)		36.6		mA
100mA trickle charge current		CHG_TRICKLE_SEL = 1		79.5		mA
Fast Charging						
Fast charge threshold (WM8350 can only fast-charge if battery is above this threshold)				3.1		V
Maximum fast-charge current	I _{MAX}			750		mA
Backup Battery (VRTC)						
Backup battery charger output. (Note that this backup charger voltage also determines the						
UVLO threshold.)			2.5	2.7	2.9	V

7.6 CURRENT LIMIT SWITCH

Test Conditions

PARAMETER	CONDITION	MIN	TYP	MAX	UNITS
Maximum input voltage		2.7		LINE	V
On resistance (at 3.3V)			2.0		Ω
Current limit flag threshold			180		mA
Current limit			215		mA
Quiescent current (EN but not ON)			7		μΑ
Quiescent current (EN and ON)					μΑ



7.7 LED DRIVERS

Test Conditions

 $T_A = +25$ °C unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ISINKA, ISINKB						
Sink Current		duty cycle = 20%			200	mA
		continuous			40	
ISINKC, ISINKD, ISINKE						
Sink Current					20	mA
Output voltage drop		10mA load		0.8		V

7.8 GENERAL PURPOSE INPUTS / OUTPUTS (GPIO)

Test Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
GPIO0 to GPIO3						
Input HIGH Level	V _{IH}		0.7×VRTC			V
Input LOW Level	V _{IL}				0.3×VRTC	V
Output HIGH Level	V _{OH}	sinking 2 mA	0.9×VRTC			V
Output LOW Level	V _{OL}	sourcing 2 mA			0.1×VRTC	V
Sink / source current						mA
Pull-up resistance to VRTC	R _{PU}	GPn_PU = 1		310		kΩ
Pull-down resistance	R _{PD}	GPn_PD = 1		225		kΩ
GPIO4 to GPIO9						
Logic levels			See Section 7.	9		
Sink / source current						mA
Pull-up resistance to DBVDD	R _{PU}	GPn_PU= 1		220		kΩ
Pull-down resistance	R _{PD}	GPn_PD = 1		144		kΩ
GPIO10 to GPIO12						
Input HIGH Level	V _{IH}		2.0			V
Input LOW Level	V _{IL}				0.9	V
Output HIGH Level	V_{OH}	sinking 2 mA	0.9×			V
			LINE			
Output LOW Level	V_{OL}	sourcing 2 mA			0.1×	V
					GPIO_VD	
					D	
Sink / source current					1	mA
Pull-up resistance to LINE	R _{PU}	GPn_PU = 1		250	1	kΩ
Pull-down resistance	R_{PD}	GPn_PD = 1		135		kΩ

7.9 DIGITAL INTERFACES

Test Conditions

 $T_A = +25$ °C unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SDA, SCLK, MCLK, BCLK, LRC	CLK, ADCDAT	A, DACDATA, GPIO4 to	GPIO9			
Input HIGH Level	V _{IH}		0.7×DBVDD			V
Input LOW Level	V _{IL}				0.3×DBVDD	V
Output HIGH Level	V _{OH}	sinking 1mA	0.9×DBVDD			V
Output LOW Level	V _{OL}	sourcing 1mA			0.1xDBVDD	V

7.10 AUXILIARY ADC

Test Conditions

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS
Input resistance	AUXADC_SCALEn [1:0] = 00		∞	∞	8	Ω
(AUX1,2,3,4, USB, LINE, BATT	AUXADC_SCALEn [1:0] = 01			2.2		kΩ
and CHIPTEMP)	AUXADC_SCALEn [1:0]= 10		330		660	kΩ
	AUXADC_SCALEn [1:0] = 11		330		440	kΩ
Input Voltage range. AUX1,2,3,4,USB,LINE,BATT and	AUXADC_SCALEn [1:0] = 01 AUXADC_REF = 0				V_{BG}	V
CHIPTEMP ($V_{RTC} = 2.7V \& V_{LINE}$ (max)= 5.5V,	AUXADC_SCALEn [1:0] = 01 AUXADC_REF = 1				V _{RTC}	V
V _{BG} =1.25V)	AUXADC_SCALEn [1:0] = 10 AUXADC_REF = 0				2 x V _{BG}	V
	AUXADC_SCALEn [1:0] = 10 AUXADC_REF = 1				2 x V _{RTC}	V
	AUXADC_SCALEn [1:0] = 11 AUXADC_REF = 0				V _{LINE}	V
	AUXADC_SCALEn [1:0] = 11 AUXADC_REF = 1				4 x V _{BG}	V
Input capacitance (AUX1,2,3,4, USB, LINE, BATT and CHIPTEMP)	Input is selected (INPUT_SELECT) and AUXADC_SCALEn [1:0] not = 00			2.08		pF
VRTC quiescent current	AUX_RBMODE = 0, AUXADC_ENA = 1			140		μА
VRTC quiescent current	AUX_RBMODE = 1 AUXADC ENA = 1			151		μΑ
LINE_INT quiescent current					<<1	mA
ADCCLK frequency		f _{AUXCLK}	400	470/512	800	kHz
ADC Resolution				12		bits
ADC Conversion Time				13		CLK periods
Aux ADC accuracy	Non-calibrated (calibration possible using the VBG input on AUX3). 1% of this variation due to BG variation over temperature.			2.2		%



8 TYPICAL POWER CONSUMPTION

ADC Master Mode

48kHz

AVDD	HPVDD	DBVDD	DCVDD	IAVDD	IHPVDD	IDB	IDC	Power Consumption
(V)	(V)	(V)	(V)	(mA)	(mA)	(mA)	(mA)	(mW)
2.5	2.5	1.71	1.71	3.6	0.000014	0.55	2.3	13.87
3.3	3.3	3.3	1.8	4.46	0.00003	1.085	2.4	22.62
3.6	3.6	3.6	3.6	4.79	0.000028	1.18	5.67	41.90

ADC Master Mode

1kHz Tone 100mVpk-pk

	p., p.	•						
AVDD	HPVDD	DBVDD	DCVDD	IAVDD	IHPVDD	IDB	IDC	Power Consumption
(V)	(V)	(V)	(V)	(mA)	(mA)	(mA)	(mA)	(mW)
2.5	2.5	1.71	1.71	3.6	0.00009	0.5	2.14	13.51
3.3	3.3	3.3	1.8	4.4	0.00016	1.02	2.3	22.03
3.6	5.5	3.6	3.6	4.8	0.00008	1.12	5.3	40.39

ADC Master Mode

Pink Noise

AVDD	HPVDD	DBVDD	DCVDD	IAVDD	IHPVDD	IDB	IDC	Power Consumption
(V)	(V)	(V)	(V)	(mA)	(mA)	(mA)	(mA)	(mW)
2.5	2.5	1.71	1.71	3.58	0.000004	0.51	2.1	13.41
3.3	3.3	3.3	1.8	4.43	0.00026	1	2.2	21.88
3.6	5.5	3.6	3.6	4.8	0.000085	1.1	5.2	39.96

ADC Slave Mode

44.1kHz

77.11(112								
AVDD	HPVDD	DBVDD	DCVDD	IAVDD	IHPVDD	IDB	IDC	Power Consumption
(V)	(V)	(V)	(V)	(mA)	(mA)	(mA)	(mA)	(mW)
2.5	2.5	1.71	1.71	3.4	0.00002	0.02	2.2	12.30
3.3	3.3	3.3	1.8	4.2	0.00041	0.05	2.3	18.17
3.6	3.6	3.6	3.6	4.4	0.0004	0.05	5.33	35.21

DAC OUT1 Master Mode

44.1kHz, 10kΩ Load

AVDD (V)	HPVDD (V)	DBVDD (V)	DCVDD (V)	IAVDD (mA)	IHPVDD (mA)	IDB (mA)	IDC (mA)	Power Consumption (mW)
2.5	2.5	1.71	1.71	2.97	0.299	0.193	1.69	11.39
3.3	3.3	3.3	1.8	4.14	0.432	0.39	1.78	19.58
3.6	3.6	3.6	3.6	4.54	0.486	0.461	4.28	35.16

48kHz,10kΩ Load

AVDD (V)	HPVDD (V)	DBVDD (V)	DCVDD (V)	IAVDD (mA)	IHPVDD (mA)	IDB (mA)	IDC (mA)	Power Consumption (mW)
2.5	2.5	1.71	1.71	2.82	0.3	0.2	2	11.56
3.3	3.3	3.3	1.8	3.94	0.45	0.42	2.12	19.69
3.6	3.6	3.6	3.6	4.33	0.51	0.46	4.9	36.72



DAC OUT1 Master Mode

Pink Noise

AVDD (V)	HPVDD (V)	DBVDD (V)	DCVDD (V)	IAVDD (mA)	IHPVDD (mA)	IDB (mA)	IDC (mA)	Power Consumption (mW)
2.5	2.5	1.71	1.71	2.97	2	0.192	2.2	16.52
3.3	3.3	3.3	1.8	4.13	2.6	0.39	2.3	27.64
3.6	5.5	3.6	3.6	4.5	2.9	0.45	5.5	53.57

DAC OUT1 Master Mode

1kHz Tone, 16Ω Load

AVDD (V)	HPVDD (V)	DBVDD (V)	DCVDD (V)	IAVDD (mA)	IHPVDD (mA)	IDB (mA)	IDC (mA)	Power Consumption (mW)
2.5	2.5	1.71	1.71	2.9	2.97	0.19	2.2	18.76
3.3	3.3	3.3	1.8	4.1	3.8	0.4	2.3	31.53
3.6	5.5	3.6	3.6	4.5	4.1	0.44	5.4	59.77

1kHz Tone, 10kΩ Load

AVDD (V)	HPVDD (V)	DBVDD (V)	DCVDD (V)	IAVDD (mA)	IHPVDD (mA)	IDB (mA)	IDC (mA)	Power Consumption (mW)
2.5	2.5	1.71	1.71	2.97	0.3	0.2	2.17	12.23
3.3	3.3	3.3	1.8	4.14	0.43	0.4	2.3	20.54
3.6	3.6	3.6	3.6	4.5	0.5	0.46	5.4	39.10

DAC OUT1 Slave Mode

44.1 kHz, 10kΩ Load

77.1 KHZ, 1	UK12 LUAU							
AVDD	HPVDD	DBVDD	DCVDD	IAVDD	IHPVDD	IDB	IDC	Power Consumption
(V)	(V)	(V)	(V)	(mA)	(mA)	(mA)	(mA)	(mW)
2.5	2.5	1.71	1.71	2.8	0.27	0.009	2.1	11.28
3.3	3.3	3.3	1.8	3.6	0.38	0.02	2.3	17.34
3.6	3.6	3.6	3.6	41	0.43	0.02	5.2	35 10

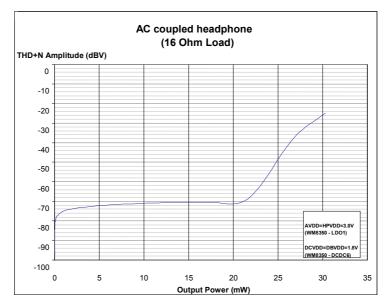


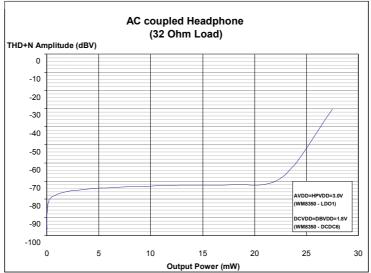
9 TYPICAL PERFORMANCE DATA

9.1 AUDIO CODEC

Typical THD+N performance of the Headphone Drivers is shown below for 16Ω and 32Ω headphone loads. These graphs are derived whilst using the WM8350 Power Management to generate the power supply rails for the audio CODEC. The supply conditions are as follows:

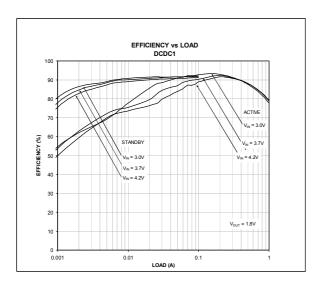
- AVDD = HPVDD = 3.0V, generated by WM8350 LDO1
- DCVDD = DBVDD = 1.8V, generated by WM8350 DC-DC6





9.2 DC-DC CONVERTERS

9.2.1 POWER EFFICIENCY



EFFICIENCY vs LOAD DCDC1

100

80

80

70

STANDBY

V_m = 3.0V

V_m = 3.7V

V_m = 4.2V

10

0.001

LOAD (A)

EFFICIENCY vs LOAD

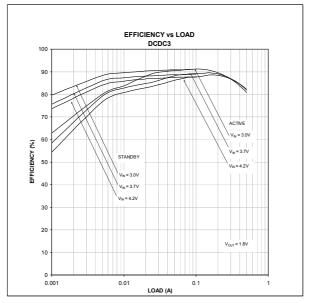
AGTME

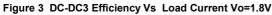
V_m = 3.0V

V_m = 1.2V

Figure 1 DC-DC1 Efficiency Vs Load Current Vo=1.8V

Figure 2 DC-DC1 Efficiency Vs Load Current Vo=1.2V





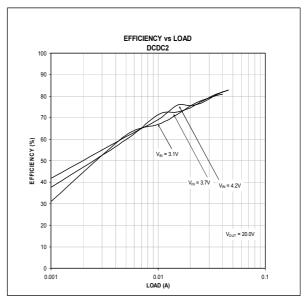


Figure 4 DC-DC2 Efficiency Vs Load Current Vo=20V

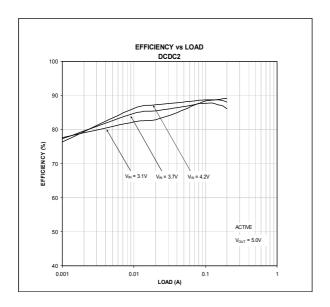


Figure 5 DC-DC2 Efficiency Vs Load Current Vo=5V

9.2.2 OUTPUT VOLTAGE REGULATION

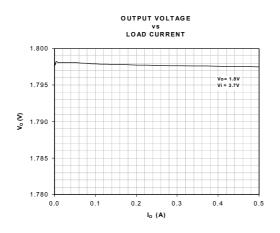


Figure 6 DC-DC1 Output Voltage Vs Output Current

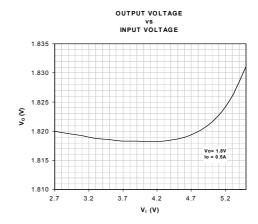


Figure 7 DC-DC1 Output Voltage Vs Input Voltage

9.2.3 DYNAMIC OUTPUT VOLTAGE

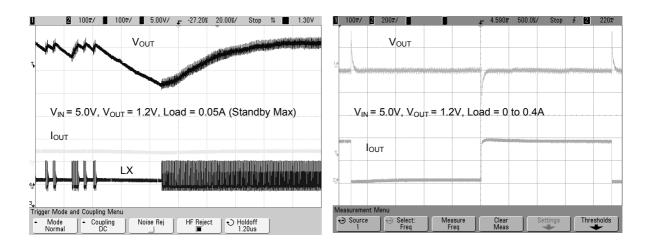


Figure 8 DC-DC1 STANDBY to ACTIVE Handover at Maximum Standby Current

Figure 9 DC-DC1 Transient Load

9.3 LDO REGULATORS



Figure 10 LDO1 Output Voltage Versus Output Current

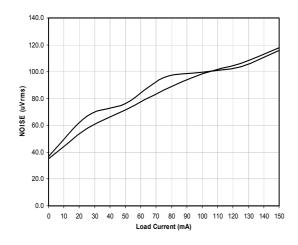


Figure 12 LDO1 Output Noise versus Output Current

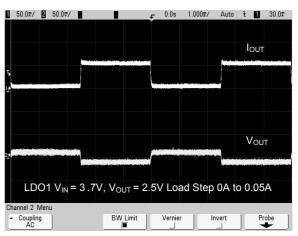


Figure 11 LDO1 Load Transient Response

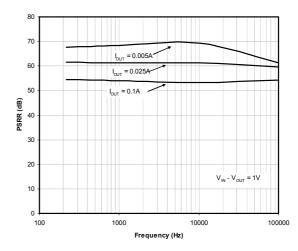


Figure 13 Power Supply Ripple Rejection versus Frequency 217Hz GSM to 100kHz

10 SIGNAL TIMING REQUIREMENTS

10.1 SYSTEM CLOCK TIMING

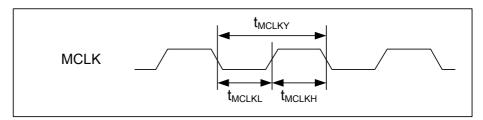


Figure 14 Master Clock Timing

Master Clock Timing										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT				
MCLK cycle time	T _{MCLKY}		40			ns				
MCLK duty cycle		= high time / low time	60:40		40:60					

10.2 AUDIO INTERFACE TIMING - MASTER MODE

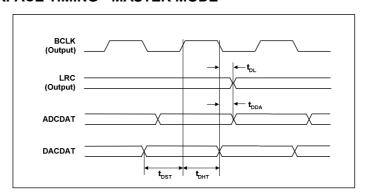


Figure 15 Digital Audio Data Timing - Master Mode

Test Conditions

DCVDD = 1.8V, DBVDD = 3.3V, DGND = 0V, $T_A = +25^{\circ}C$, Master Mode, fs = 48kHz, 24-bit data, unless otherwise stated.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
BCLK rise time (10pF load)	t _{BCLKR}			3	ns
BCLK fall time (10pF load)	t _{BCLKF}			3	ns
BCLK duty cycle	t _{BCLKDS}	60:40		40:60	
LRC propagation delay from BCLK falling edge	t _{DL}			10	ns
ADCDAT propagation delay from BCLK falling edge	t _{DDA}			10	ns
DACDAT setup time to BCLK rising edge	t _{DST}	10			ns
DACDAT hold time from BCLK rising edge	t _{DHT}	10			ns



10.3 AUDIO INTERFACE TIMING - SLAVE MODE

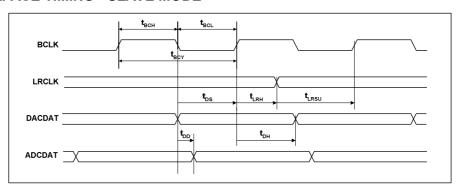


Figure 16 Digital Audio Data Timing - Slave Mode

Test Conditions

DCVDD = 1.8V, DBVDD = 3.3V, DGND = 0V, T_A = +25°C, Slave Mode, fs = 48kHz, 24-bit data, unless otherwise stated.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
BCLK cycle time	t _{BCY}	50			ns
BCLK pulse width high	t _{BCH}	20			ns
BCLK pulse width low	t _{BCL}	20			ns
LRCLK set-up time to BCLK rising edge	t _{LRSU}	10			ns
LRCLK hold time from BCLK rising edge	t _{LRH}	10			ns
DACDAT hold time from BCLK rising edge	t _{DH}	10			ns
DACDAT set-up time to BCLK rising edge	t _{DS}	10			ns
ADCDAT propagation delay from BCLK falling edge	t _{DD}			10	ns

10.4 AUDIO INTERFACE TIMING - TDM MODE

In TDM mode, it is important that two ADC devices to not attempt to drive the ADCDAT pin simultaneously. The timing of the WM8350 ADCDAT tri-stating at the start and end of the data transmission is described in Figure 17 and the table below.

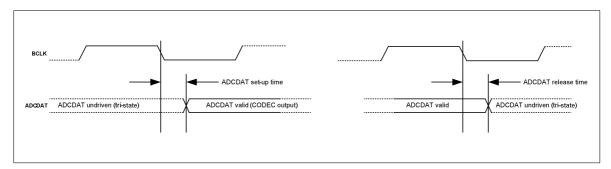


Figure 17 Digital Audio Data Timing - TDM Mode

Test Conditions

DBVDD = 3.3V, DGND = 0V, T_A =+25°C, Master Mode, fs=48kHz, 24-bit data, unless otherwise stated.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Audio Data Timing Information					
ADCDAT setup time from BCLK falling edge	DCVDD = 3.6V		5		ns
	DCVDD = 1.8V		15		ns
ADCDAT release time from BCLK falling edge	DCVDD = 3.6V		5		ns
	DCVDD = 1.8V		15		ns



10.5 CONTROL INTERFACE TIMING

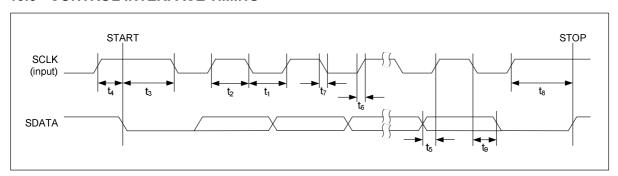


Figure 18 Control Interface Timing - 2-wire Control Mode

Test Conditions

DCVDD = 1.8V, DBVDD = 3.3V, DGND = 0V, T_A = +25 $^{\circ}$ C, unless otherwise stated.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
SCLK Frequency		0		526	kHz
SCLK Low Pulse-Width	t ₁	1.3			us
SCLK High Pulse-Width	t ₂	600			ns
Hold Time (Start Condition)	t ₃	600			ns
Setup Time (Start Condition)	t ₄	600			ns
Data Setup Time	t ₅	100			ns
SDATA, SCLK Rise Time	t ₆			300	ns
SDATA, SCLK Fall Time	t ₇			300	ns
Setup Time (Stop Condition)	t ₈	600			ns
Data Hold Time	t ₉			900	ns
Pulse width of spikes that will be suppressed	t _{ps}	0		5	ns



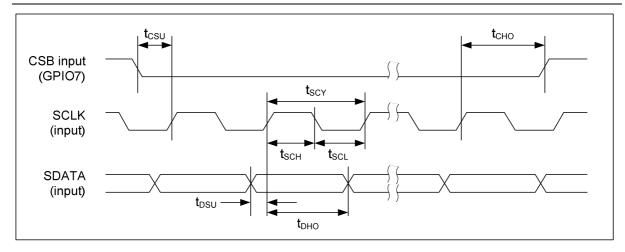


Figure 19 Control Interface Timing - 3-wire Control Mode (Write Cycle)

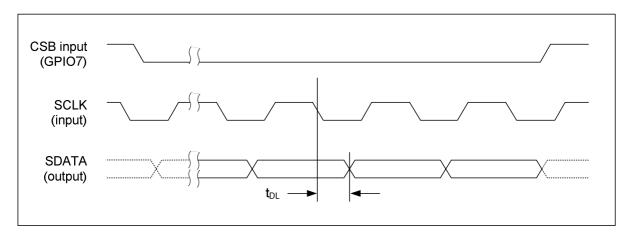


Figure 20 Control Interface Timing - 3-wire Control Mode (Read Cycle)

Test Conditions

DBVDD = 3.3V, DGND = 0V, T_A = +25°C, unless otherwise stated.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
CSB falling edge to SCLK rising edge	t _{csu}	40			ns
SCLK rising edge to CSB rising edge	t _{CHO}	10			ns
SCLK pulse cycle time	t _{SCY}	200			ns
SCLK pulse width low	t _{SCL}	80			ns
SCLK pulse width high	tscн	80			ns
SDATA to SCLK set-up time	t _{DSU}	40			ns
SDATA to SCLK hold time	t _{DHO}	10			ns
Pulse width of spikes that will be suppressed	t _{ps}	0		5	ns
SCLK falling edge to SDATA output transition	t _{DL}			40	ns

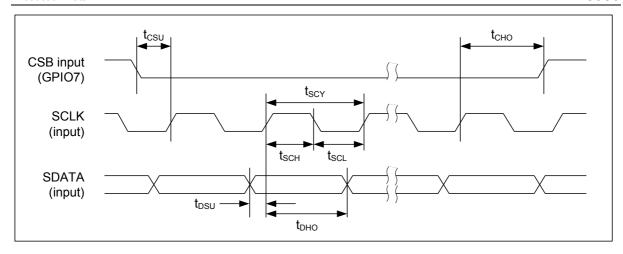


Figure 21 Control Interface Timing - 4-wire Control Mode (Write Cycle)

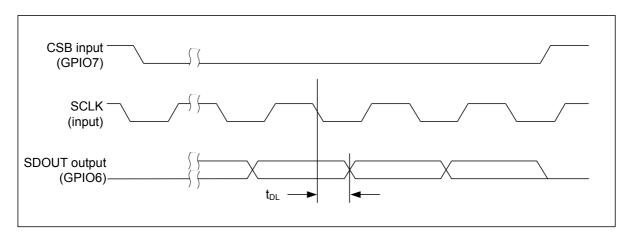


Figure 22 Control Interface Timing - 4-wire Control Mode (Read Cycle)

Test Conditions

DBVDD = 3.3V, DGND = 0V, T_A = +25°C, unless otherwise stated.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
CSB falling edge to SCLK rising edge	t _{CSU}	40			ns
SCLK rising edge to CSB rising edge	tcно	10			ns
SCLK pulse cycle time	tscy	200			ns
SCLK pulse width low	t _{SCL}	80			ns
SCLK pulse width high	t _{scн}	80			ns
SDATA to SCLK set-up time	t _{DSU}	40			ns
SDATA to SCLK hold time	t _{DHO}	10			ns
Pulse width of spikes that will be suppressed	t _{ps}	0		5	ns
SCLK falling edge to SDOUT transition	t _{DL}			40	ns

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11 CONTROL INTERFACE

11.1 GENERAL DESCRIPTION

The WM8350 is controlled by writing to its control registers. Readback is available for most registers. Most aspects of the WM8350 operation can be controlled via this interface. The control interface can operate as either a 2-, 3- or 4-wire control interface:

- 2-wire mode uses pins SCLK and SDATA.
- 3-wire mode uses pins CSB, SCLK and SDATA.
- 4-wire mode uses pins CSB, SCLK, SDATA and SDOUT.

GPIO7 is automatically enabled as CSB in 3-wire and 4-wire control modes. GPIO6 is automatically enabled as SDOUT in 4-wire control mode. Register readback is provided on the bi-directional pin SDATA in 2-/3-wire modes and on SDOUT (GPIO6) in 4-wire mode.

In 2-wire mode, the control interface supports single register access as well as multiple access with or without address auto-increment.

In Development Mode (see Section 14.4), the WM8350 initially selects the secondary 2-wire control interface, using pins GPIO10 and GPIO11. This enables configuration of the WM8350 via a separate interface prior to selecting the normal system operation. Note that, in Custom modes, the secondary interface is not supported.

11.2 CONTROL INTERFACE MODES

The WM8350 control interface can be configured for 2-, 3- or 4-wire operation using the following register bits:

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R6 (06h)	3	SPI_CFG	0	Controls the SDOUT (GPIO6) pin operation in
Interface				4 wire mode
Control				0 = SDOUT output is CMOS
				1 = SDOUT output is open drain
				Note: SPI_4WIRE must be set for this to take effect.
	2	SPI_4WIRE	0	Selects 3-wire or 4-wire SPI mode
				0 = 3 wire mode using bi-directional SDATA pin
				1 = 4 wire mode using SDOUT (GPIO6)
				Note: SPI_3WIRE must be set for this to take effect.
	1	SPI_3WIRE	0	Selects 2- or 3-/4-wire mode.
				0 = 2-wire mode
				1 = 3-/4-wire mode

Table 1 Control Interface Modes



11.3 2-WIRE SERIAL CONTROL MODE

The 2-wire control interface normally uses the SCLK and SDATA pins, which are referenced to the digital buffer supply, DBVDD. (In Development mode, the interface is initially redirected, with GPIO10 and GPIO11 effectively replacing SCLK and SDATA - see Section 14.4.1).

2-wire control mode is selected by setting SPI_3WIRE = 0. This is the default setting for this field.

In 2-wire mode, the WM8350 is a slave device on the control interface; SCLK (or GPIO10) is a clock input, while SDATA (or GPIO11) is a bi-directional data pin. To allow arbitration of multiple slaves (and/or multiple masters) on the same interface, the WM8350 transmits logic 1 by tri-stating the SDATA pin, rather than pulling it high. An external pull-up resistor is required to pull the SDATA line high so that the logic 1 can be recognised by the master.

Many devices can be controlled by the same bus, and each device has a unique 7-bit device ID (this is not the same as the 8-bit address of each register in the WM8350). The default device ID is 0011 0100 (0x34h). The LSB of the device ID is the Read/Write bit; this bit is set to logic 1 for "Read" and logic 0 for "Write". In Development Mode, the device ID may be changed to other values.

The controller indicates the start of data transfer with a high to low transition on SDATA while SCLK remains high. This indicates that a device ID, register address and data will follow. All devices on the 2-wire bus respond to the start condition and shift in the next eight bits on SDATA (7-bit device ID + Read/Write bit, MSB first). If the device ID received matches the device ID of the WM8350, then the WM8350 responds by pulling SDATA low on the next clock pulse (ACK). If the device ID is not recognised or the R/W bit is '1' when operating in write only mode, the WM8350 returns to the idle condition and waits for a new start condition and valid address.

If the device ID matches the device ID of the WM8350, the data transfer continues as described below. The controller indicates the end of data transfer with a low to high transition on SDATA while SCKL remains high. After receiving a complete address and data sequence the WM8350 returns to the idle state and waits for another start condition. If a start or stop condition is detected out of sequence at any point during data transfer (i.e. SDATA changes while SCLK is high), the device returns to the idle condition.

The WM8350 supports the following read and write operations:

- Single write
- Single read
- Multiple write using auto-increment
- Multiple read using auto-increment



WM8350 Production Data

The sequence of signals associated with a single register write operation is illustrated in Figure 23.

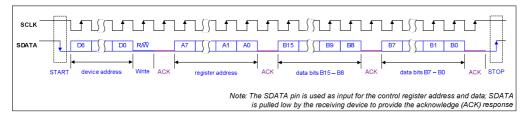


Figure 23 Control Interface 2-wire Register Write

The sequence of signals associated with a single register read operation is illustrated in Figure 24.

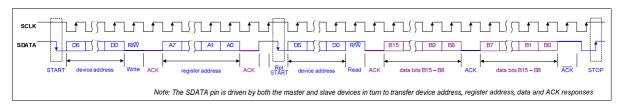


Figure 24 Control Interface 2-wire Register Read

The Control Interface also supports other register operations, as listed above. The interface protocol for these operations is summarised below. The terminology used in the following figures is detailed in Table 2

TERMINOLOGY	DESCRIPTION			
S	Start C	ondition		
Sr	Repeat	ed start		
А	Acknowledge			
Р	Stop C	Stop Condition		
R/W	ReadNotWrite	0 = Write		
	1 = Read			
[White field]	Data flow from bus master to WM8350			
[Grey field]	Data flow from WM	8350 to bus master		

Table 2 Control Interface Terminology



Figure 25 Single Register Write to Specified Address



Figure 26 Single Register Read from Specified Address



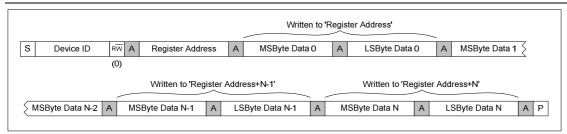


Figure 27 Multiple Register Write to Specified Address using Auto-increment

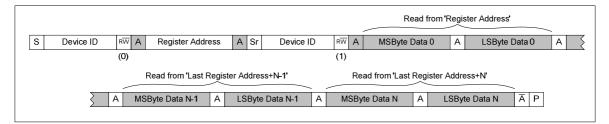


Figure 28 Multiple Register Read from Specified Address using Auto-increment

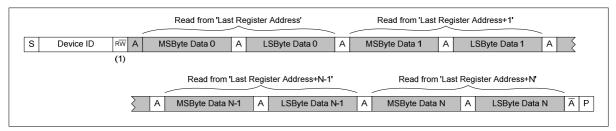


Figure 29 Multiple Register Read from Last Address using Auto-increment

Multiple Write and Multiple Read operations enable the host processor to access sequential blocks of the data in the WM8350 register map faster than is possible with single register operations. The Auto-Increment function is enabled by default; this is controlled by the AUTOINC register bit as described in Table 3.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R6 (06h)	9	AUTOINC	1	Enables address auto-increment
Interface Control				0 = disabled
				1 = enabled

Table 3 Enabling Address Auto-Increment

WM8350 Production Data

11.4 3-WIRE SERIAL CONTROL MODE

The 3-wire control interface uses the CSB, SCLK and SDATA pins, which are referenced to the digital buffer supply, DBVDD. (In 3-wire mode, CSB is provided on GPIO7.)

3-wire control mode is selected by setting SPI_3WIRE = 1 and SPI_4WIRE = 0.

In 3-wire control mode, a control word consists of 24 bits. The first bit is the read/write bit (R/W), which is followed by 7 address bits (A6 to A0) that determine which control register is accessed. The remaining 16 bits (B15 to B0) are data bits, corresponding to the 16 bits in each control register.

In 3-wire mode, every rising edge of SCLK clocks in one data bit from the SDATA pin. A rising edge on CSB latches in a complete control word consisting of the last 24 bits.

In Write operations (R/W=0), all SDATA bits are driven by the controlling device.

In Read operations (R/W=1), the SDATA pin is driven by the controlling device to clock in the register address, after which the WM8350 drives the SDATA pin to output the applicable data bits.

Similarly to 2-wire control mode, the WM8350 transmits logic 1 by tri-stating the SDATA pin, rather than pulling it high. An external pull-up resistor is required to pull the SDATA line high so that the logic 1 can be recognised by the master.

The 3-wire control mode timing is illustrated in Figure 30.

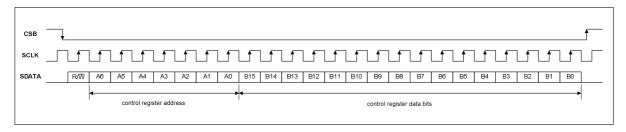


Figure 30 3-Wire Serial Control Interface



11.5 4-WIRE SERIAL CONTROL MODE

The 4-wire control interface uses the CSB, SCLK, SDATA and SDOUT pins, which are referenced to the digital buffer supply, DBVDD. (In 4-wire mode, SDOUT is provided on GPIO6; CSB is provided on GPIO7.)

4-wire control mode is selected by setting SPI_3WIRE = 1 and SPI_4WIRE = 1.

The Data Output pin, SDOUT, can be configured as CMOS or Open Drain, as described in Table 1. In CMOS mode, SDOUT is driven low when not outputting register data bits. In Open Drain mode, SDOUT is undriven when not outputting register data bits.

In Write operations (R/W=0), this mode is the same as 3-wire mode described above.

In Read operations (R/W=1), the SDATA pin is ignored following receipt of the valid register address. SDOUT is driven by the WM8350.

The 4-wire control mode timing is illustrated in Figure 31 and Figure 32.

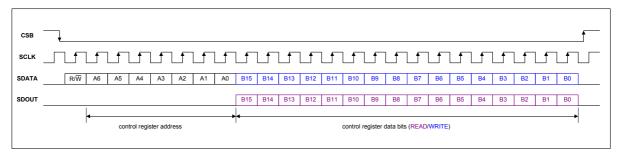


Figure 31 4-Wire Readback (CMOS)

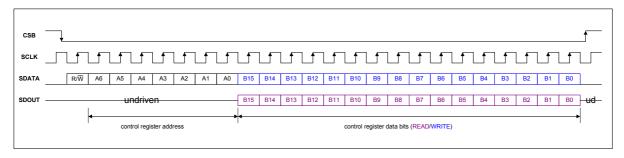


Figure 32 4-Wire Readback (Open Drain)

WM8350 Production Data

11.6 REGISTER LOCKING

Certain control fields are protected against accidental overwriting. This includes:

 Watchdog timer and system control settings in Registers R3, R4, R6 and R12 (03h, 04h, 06h and 0Ch).

Battery charger control fields in Registers R168, R169 and R170 (A8h, A9h and AAh).

By default, these registers are locked, i.e. writing to them has no effect. However, they can be unlocked by writing a value of 0013h to Register R219.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R219 (DBh) Security	15: 0	SECURITY [15:0]	0000h	The value 0013h needs to be set in this register to allow write access to the security locked registers.

Table 4 Locking and Unlocking Protected Registers

It is recommended to re-lock the protected registers immediately after writing to them. This helps protect the system against accidental overwriting of register values.

It is recommended to contact Wolfson Applications support for guidance on features that are affected by Register Locking.

11.7 SPECIAL REGISTERS

11.7.1 CHIP ID

A read instruction from register R0 can be used to confirm that the chip is a WM8350.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R0 (00h)	15:0	SW_RESET/C	6143h	Reading this register returns 6143h.
Reset/ID		HIP_ID [15:0]		

Table 5 Chip ID

11.7.2 DEVICE INFORMATION

The read-only register R1 provides additional information about the WM8350 device.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1 (01h) ID	15:1 2	CHIP_REV [3:0]		The functional silicon revision - this tracks changes in functionality which are separate from ROM mask settings
	11:1 0	CONF_STS [1:0]		The state of the configuration pins. This selects what register defaults should be.
	7:0	CUST_ID [7:0]		The Chip Revision Number
R2 (02h) Revision	7:0	MASK_REV [7:0]		The ROM mask ID

Table 6 Reading Device Information



12 CLOCKING, TIMING AND SAMPLE RATES

12.1 GENERAL DESCRIPTION

The WM8350 includes clocking circuitry for the on-chip audio CODEC, the DC-DC converters and the auxiliary ADC. It provides the following capabilities:

The WM8350 has two internal clock generators: a 2MHz RC oscillator and a 32kHz crystal oscillator. Clocks are required for system start-up and also for the DC-DC converter clocks; these are derived from the internal 2MHz RC oscillator. The 32kHz crystal oscillator (or external 32kHz source) is used to drive the internal Real Time Clock (RTC), and may also be used as a reference source for the CODEC clock generators.

The CODEC clocks may be derived either directly from MCLK, or else via an on-chip Frequency Locked Loop (FLL) to generate the required clocking from a wide range of reference inputs. The FLL can take as input the external MCLK, or ADCLRCLK / DACLRCLK (in Slave modes), or the 32kHz crystal oscillator (or external 32kHz source), and generates (typically) a 12.288MHz clock for the CODEC.

The flexible clocking arrangements are illustrated in Figure 33.

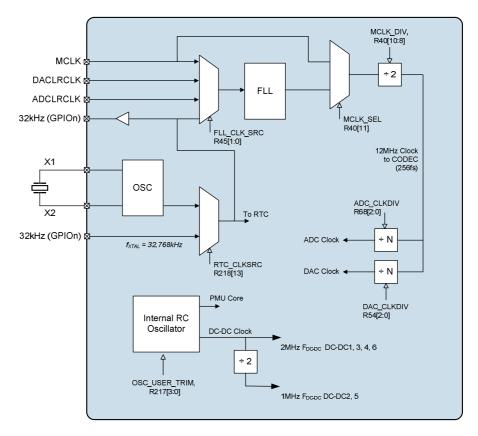


Figure 33 Clock Generation and Distribution Scheme

12.1.1 CLOCKING THE AUDIO CODEC

The WM8350 audio CODEC core requires an accurate, low-jitter clock. Clocks for the ADCs, DACs, DSP core functions, and the digital audio interface are all derived from a common internal clock source, SYSCLK. This clock may be derived directly from MCLK, or may be generated from an FLL using MCLK or alternate sources as an external reference. The SYSCLK source is selected by MCLK_SEL. Many commonly-used audio sample rates can be derived directly from typical MCLK frequencies.

The ADC and DAC sample rates are independently selectable, relative to SYSCLK, using ADC CLKDIV and DAC CLKDIV. Refer to Section 12.3 for more details

12.1.2 CLOCKING THE DC-DC CONVERTERS

During a system start-up, no external clock signals are available. The WM8350 therefore generates all internal clocks required for the DC-DC converters, system control and housekeeping functions. These clocks are derived from the on-chip RC oscillator. The DC-DC converters' nominal switching rate is 2.0MHz and 1.0MHz.

12.1.3 INTERNAL RC OSCILLATOR

The internal RC Oscillator generates the system clock 2.0MHz as well as the clock for the DCDC converters. The period of the generated clock is defined by the time needed for a fixed value capacitor to be charged up to the reference voltage by a constant current source.

12.2 CRYSTAL OSCILLATOR

The on-chip crystal oscillator generates a 32.768kHz reference clock, which can be used to provide reference clock for the Real Time Clock (RTC) in the WM8350. It may also be used as a reference input to the FLL, for the purpose of generating the CODEC clocks. The oscillator is powered from VRTC, so that it can keep running when no other power source is available. It requires an external crystal on the X1 and X2 pins, as well as two capacitors and a resistor, connected as shown in Figure 34.

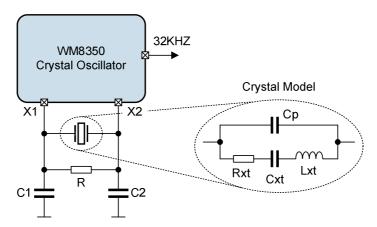


Figure 34 WM8350 Crystal Oscillator

The oscillator is enabled by the OSC32K_ENA field, as described in Table 7. It is enabled by default and remains enabled when the WM8350 is in the OFF or BACKUP state.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12 (0Ch)	10	OSC32K_ENA	1	32kHz crystal oscillator control
Power				0 = 32kHz OSC is disabled
Mgmt (5)				1 = 32kHz OSC is enabled
R218 (DAh)	12			. 02.11.12.000.10.01.10.000
RTC Tick				
Control				

Note: OSC32K_ENA can be accessed through R12 or through R218. Reading from or writing to either register location has the same effect.

Table 7 Enabling the 32kHz Oscillator

If a suitable 32.768kHz clock is already present elsewhere in the system, then it is possible for the WM8350 to use this clock instead. An external clock can be provided to the WM8350 on pin X1 (with pin X2 left floating) or else on a GPIO pin configured as a 32kHz input (see Section 20).

In addition to driving the RTC, the 32kHz oscillator signal can be output to a GPIO pin configured as a 32kHz output; this is possible on GPIO pins 2, 3, 5 and 12 (see Section 20.2).

12.3 CLOCKING AND SAMPLE RATES

Clocks for the ADCs, DACs, DSP core functions, and the digital audio interface are all derived from a common internal clock source, SYSCLK.

SYSCLK can either be derived directly from MCLK (with a selectable divide by two option, controlled by MCLK_DIV), or may be generated by the FLL using MCLK or alternate sources as an external reference. The SYSCLK source is selected by MCLK_SEL. Many commonly-used audio sample rates can be derived directly from typical MCLK frequencies.

The ADC and DAC sample rates are independently selectable, relative to SYSCLK, using ADC_CLKDIV and DAC_CLKDIV. These fields must be set according to the required sampling frequency and depending upon the selected clocking mode. Two clocking modes are provided as follows. Normal mode allows selection of the commonly used sample rates from typical audio system clocking frequencies (eg. 12.288MHz); USB mode allows many of these sample rates to be generated from a 12MHz USB clock. Depending on the available clock sources, USB mode may be used to save power by supporting 44.1kHz operation.

In Normal mode.

- ADC_SYSCLK = 256 x ADC Sampling Frequency
- DAC_SYSCLK = 256 x DAC Sampling Frequency

In USB mode,

- ADC_SYSCLK = 272 x ADC Sampling Frequency
- DAC_SYSCLK = 272 x DAC Sampling Frequency

The above equations determine the required values for ADC_CLKDIV and DAC_CLKDIV. The clocking mode is selected via the AIF_LRCLKRATE field.

In master mode, BCLK is also derived from SYSCLK via a programmable division set by BCLK_DIV. In the case where the ADCs and DACs are operating at different sample rates, BCLK must be set according to whichever is the faster rate. In Master Mode, internal clock divide and phase control mechanisms ensure that the BCLK, ADCLRCLK and DACLRCLK edges will occur in a predictable and repeatable position relative to each other and to the data for a given combination of ADC/DAC sample rates and BCLK settings. In Slave Mode, the host processor must ensure that BCLK, ADCLRCLK and DACLRCLK are fully synchronised; if these inputs are not synchronised, unpredictable pops and noise may result.

When the GPIO5 pin is configured as CODEC_OPCLK, a clock derived from SYSCLK may be output on this pin to provide clocking for other parts of the system. The frequency of this signal is set by OPCLK DIV.

Alternate GPIO pins can be used to provide ADCLRCLK and ADCBCLK as described in Section 20. An inverted L/R clock signal ADCLRCLKB can also be generated. When this feature is used, the LRCLK and BCLK pins support the DAC only, and the alternate GPIO pins support the ADC only. Limited capability can be provided to support mixed sample rates by this method. (The selection of USB mode and the supported values of the various SYSCLK dividers impose restrictions on what combinations of clocking and sample rates may be configured.)

A slow clock derived from SYSCLK may be used to provide de-bouncing of the headphone detect function, and to set the timeout period for volume updates when zero-cross functions are used. This clock is enabled by TOCLK_ENA and its frequency is set by TOCLK_RATE.

The overall CODEC clocking scheme is illustrated in Figure 35.

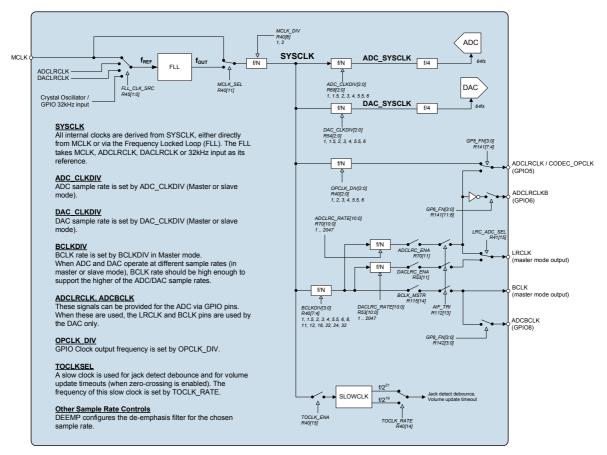


Figure 35 Audio CODEC Clocking

12.3.1 SYSCLK CONTROL

The MCLK_SEL bit is used to select the source for SYSCLK. The source may be either directly from the MCLK input or may be from the output of the FLL. If required, the selected source may be divided by two, as determined by MCLK_DIV, as described in Table 8. For further details of the FLL, see Section 12.4.

When the internal clock source is switched from one value to another using MCLK_SEL, the change of source will only occur following a falling edge of the source signal that was originally selected. In the case where the clock source is switched from FLL to MCLK, a suitable falling edge can be ensured by disabling the FLL after selection of MCLK as the source.

The recommended sequence of actions to switch from FLL to MCLK source is as follows:

- Select MCLK as source (MCLK_SEL = 0)
- Disable FLL (FLL_ENA = 0)
- Disable FLL oscillator (FLL_OSC_ENA = 0)

Note that, as an alternative to the above sequence, a software reset may be used to re-select MCLK as the default SYSCLK source.

The recommended sequence of actions to switch from MCLK to FLL source is as follows:

- Enable FLL oscillator (FLL_OSC_ENA = 1)
- Enable FLL (FLL_ENA = 1)
- Select FLL as source (MCLK_SEL = 1)

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R40 (28h) Clock Control 1	11	MCLK_SEL	0	Selects source for SYSCLK to CODEC 0 = MCLK pin 1 = FLL
	8	MCLK_DIV	0	Selects MCLK division in slave (MCLK input) mode: 0 = divide MCLK by 1 1 = divide MCLK by 2

Table 8 SYSCLK Control

12.3.2 ADC / DAC SAMPLE RATES

The ADC and DAC sample rates are independently selectable, relative to SYSCLK, by setting the register fields ADC_CLKDIV and DAC_CLKDIV. These fields must be set according to the SYSCLK frequency, and according to the selected mode of operation (Normal or USB). The applicable fields are described in Table 9.

Selection of USB mode enables a 12MHz USB clock to be used to generate the required internal clock signals. Table 10 describes the available sample rates using four different common MCLK frequencies. The AIF_LRCLKRATE field must be set as described in Table 9.

In Normal mode, the programmable division set by ADC_CLKDIV must ensure that ADC_SYSCLK is 256 * ADC Sampling Frequency. DAC_CLKDIV must ensure that DAC_SYSCLK is 256 * DAC Sampling Frequency.

In USB mode, ADC_CLKDIV must ensure that ADC_SYSCLK is 272 * ADC Sampling Frequency. DAC_CLKDIV must ensure that DAC_SYSCLK is 272 * DAC Sampling Frequency.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R48 (30h)	12	AIF_LRCLKRATE	0	Mode Select
DAC				1 = USB mode (272 * Fs)
Control				0 = Normal mode (256 * Fs)
R68 (44h)	2:0	ADC_CLKDIV [2:0]	000	ADC Sample rate divider
ADC Clock				000 = SYSCLK / 1.0
Control				001 = SYSCLK / 1.5
				010 = SYSCLK / 2
				011 = SYSCLK / 3
				100 = SYSCLK / 4
				101 = SYSCLK / 5.5
				110 = SYSCLK / 6
				111 = Reserved
R54 (36h)	2:0	DAC_CLKDIV [2:0]	000	DAC Sample rate divider
DAC Clock				000 = SYSCLK / 1.0
Control				001 = SYSCLK / 1.5
				010 = SYSCLK / 2
				011 = SYSCLK / 3
				100 = SYSCLK / 4
				101 = SYSCLK / 5.5
				110 = SYSCLK / 6
				111 = Reserved

Table 9 ADC / DAC Sample Rate Control



SYSCLK	ADC / DAC SAMPLE RATE DIVIDER	CLOCKING MODE	ADC / DAC SAMPLE RATE
	000 = SYSCLK / 1		48 kHz
	001 = SYSCLK / 1.5		32 kHz
	010 = SYSCLK / 2	N	24 kHz
12 2000 MU-	011 = SYSCLK / 3	Normal	16 kHz
12.2880 MHz	100 = SYSCLK / 4	(256 * Fs)	12 kHz
	101 = SYSCLK / 5.5	(250 FS)	Not used
	110 = SYSCLK / 6		8 kHz
	111 = Reserved		Reserved
	000 = SYSCLK / 1		44.1 kHz
	001 = SYSCLK / 1.5		Not used
	010 = SYSCLK / 2	N	22.05 kHz
11 2006 MH-	011 = SYSCLK / 3	Normal	Not used
11.2896 MHz	100 = SYSCLK / 4	(256 * Fs)	11.025 kHz
	101 = SYSCLK / 5.5	(230 FS)	8.018 kHz
	110 = SYSCLK / 6		Not used
	111 = Reserved		Reserved
	000 = SYSCLK / 1		44.118 kHz
	001 = SYSCLK / 1.5		Not used
	010 = SYSCLK / 2	LICD	22.059 kHz
12 0000 MH I=	011 = SYSCLK / 3	USB	Not used
12.0000 MHz	100 = SYSCLK / 4	(272 * Fs)	11.029 kHz
	101 = SYSCLK / 5.5	(272 F5)	8.021 kHz
	110 = SYSCLK / 6		Not used
	111 = Reserved		Reserved
	000 = SYSCLK / 1		8 kHz
	001 = SYSCLK / 1.5		Not used
	010 = SYSCLK / 2	N	Not used
2.0480 MHz	011 = SYSCLK / 3	Normal	Not used
2.040U IVITIZ	100 = SYSCLK / 4	(256 * Fs)	Not used
	101 = SYSCLK / 5.5	(200 F8)	Not used
	110 = SYSCLK / 6		Not used
	111 = Reserved		Reserved

Table 10 Derivation of Sample Rates in Normal / USB Modes

Note that, in USB mode, the ADC / DAC sample rates do not match exactly with the commonly used sample rates (eg. 44.118 kHz instead of 44.100 kHz). At most, the difference is less than 0.5%, which is within normal accepted tolerances. Data recorded at 44.100 kHz sample rate and replayed at 44.118 kHz will experience a slight (sub 0.5%) pitch shift as a result of this difference.

Note: USB mode cannot be used to generate a 48kHz samples rate from a 12MHz MCLK; the FLL should be used in this case.

The user must ensure correct synchronisation of data across the digital interfaces. This is particularly important when different sample rates are used, as described above.

12.3.3 BCLK CONTROL

In Master Mode, BCLK is derived from SYSCLK via a programmable division set by BCLK_DIV, as described in Table 11. BCLK_DIV must be set to an appropriate value to ensure that there are sufficient BCLK cycles to transfer the complete data words from the ADCs and to the DACs. When the GPIO8 pin is used to provide ADCBCLK in Master mode, the clock rate on this pin is also controlled by BCLK_DIV.

In Slave Mode, BCLK is generated externally and appears as an input to the CODEC. The host device must provide sufficient BCLK cycles to transfer complete data words to the ADCs and DACs.

Note that, although the ADC and DAC can run at different sample rates, they share the same bit clock BCLK in Master Mode. In the case where different ADC / DAC sample rates are used, the BCLK frequency should be set according to the higher of the ADC / DAC bit rates. When the GPIO8 pin is used to provide ADCBCLK, and either the ADC or DAC is in Slave mode, then this restriction does not apply.

Master/Slave operation for BCLK is controlled by the BCLK_MSTR register field.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R40 (28h)	7:4	BCLK_DIV [3:0]	0000	Sets BCLK rate for Master mode
Clock Control				0000 = SYSCLK
1				0001 = SYSCLK / 1.5
				0010 = SYSCLK / 2
				0011 = SYSCLK / 3
				0100 = SYSCLK / 4
				0101 = SYSCLK / 5.5
				0101 = SYSCLK / 6
				0111 = SYSCLK / 8
				1000 = SYSCLK / 11
				1001 = SYSCLK / 12
				1010 = SYSCLK / 16
				1011 = SYSCLK / 22
				1100 = SYSCLK / 24
				1101 = SYSCLK / 32
				1110 = SYSCLK / 32
				1111 = SYSCLK / 32
R115 (73h) Audio I/F DAC Control	14	BCLK_MSTR	0	Enables the Audio Interface BCLK generation and enables the BCLK pin for Master mode
				0 = BCLK Slave Mode
				1 = BCLK Master Mode

Table 11 BCLK Control



Table 12 shows the maximum word lengths supported for a given SYSCLK and BCLK_DIV, assuming that one or both the ADCs and DACs are running at maximum rate.

SYSCLK	BCLK DIVIDER	BCLK RATE (MASTER	MAXIMUM WORD
	BCLK_DIV	MODE) (MHZ)	LENGTH
	0000 = SYSCLK / 1	12.288	32
	0001 = SYSCLK / 1.5	8.192	32
	0010 = SYSCLK / 2	6.144	32
	0011 = SYSCLK / 3	4.096	32
	0100 = SYSCLK / 4	3.072	32
	0101 = SYSCLK / 5.5	2.2341818	20
	0110 = SYSCLK / 6	2.048	20
40.000 MILE	0111 = SYSCLK / 8	1.536	16
12.288 MHz	1000 = SYSCLK / 11	1.117091	8
	1001 = SYSCLK / 12	1.024	8
	1010 = SYSCLK / 16	0.768	8
	1011 = SYSCLK / 22	0.558545	N/A
	1100 = SYSCLK / 24	0.512	N/A
	1101 = SYSCLK / 32	0.384	N/A
	1110 = SYSCLK / 32	0.384	N/A
	1111 = SYSCLK / 32	0.384	N/A
	0000 = SYSCLK / 1	11.2896	32
	0001 = SYSCLK / 1.5	7.5264	32
	0010 = SYSCLK / 2	5.6448	32
	0011 = SYSCLK / 3	3.7632	32
	0100 = SYSCLK / 4	2.8224	32
	0101 = SYSCLK / 5.5	2.052655	20
	0110 = SYSCLK / 6	1.8816	20
11.2896 MHz	0111 = SYSCLK / 8	1.4112	16
11.2090 WITZ	1000 = SYSCLK / 11	1.026327	8
	1001 = SYSCLK / 12	0.9408	8
	1010 = SYSCLK / 16	0.7056	8
	1011 = SYSCLK / 22	0.513164	N/A
	1100 = SYSCLK / 24	0.4704	N/A
	1101 = SYSCLK / 32	0.3528	N/A
	1110 = SYSCLK / 32	0.3528	N/A
	1111 = SYSCLK / 32	0.3528	N/A

Table 12 BCLK Divider in Master Mode

12.3.4 ADCLRCLK / DACLRCLK CONTROL

In Master Mode, ADCLRCLK and DACLRCLK are derived from BCLK via programmable dividers set by ADCLRC_RATE and DACLRC_RATE. The BCLK frequency is derived from SYSCLK according to BCLK DIV, as described earlier in Table 11.

In Slave Mode, ADCLRCLK and DACLRCLK are generated externally and are input to the CODEC.

By default, the LRCLK pin provides the L/R Clock signal for the ADC and the DAC. If a separate L/R Clock is required for the ADC and the DAC, then a GPIO pin must be configured as ADCLRCLK (or ADCLRCB) as described in Section 20. The LRCLK pin can be driven by either ADCLRCLK or by DACLRCLK in Master Mode; this is selected by the LRC_ADC_SEL bit as described in Table 13.

Master/Slave operation for ADCLRCLK is controlled by the ADCLRC_ENA register field.

Master/Slave operation for DACLRCLK is controlled by the DACLRC_ENA register field.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R70 (46h) ADC LRC	11	ADCLRC_ENA	0	Enables the LRC generation for the ADC
Rate				0 = disabled
				1 = enabled
	10:0	ADCLRC_RATE [10:0]	040h (64 BCLK	Determines the number of bit clocks per LRC phase (when enabled)
		[10.0]	/ LRC)	00000000000 = invalid
				0000000111 = invalid
				00000001000 = 8 BCPS
				 11111111111 = 2047 BCPS
DE2 (25h)	11	DACIDO ENA	0	
R53 (35h) DAC LRC	11	DACLRC_ENA	U	Enables DAC LRC generation in Master mode
Rate				0 = disabled
				1 = enabled
	10:0	DACLRC_RATE	040h	Determines the number of bit clocks
		[10:0]	(64 BCLK / LRC)	per LRC phase (when enabled) 000000000000 = invalid
			/ LINO)	
				00000000111 = invalid
				00000001000 = 8 BCPS
				11111111111 = 2047 BCPS
R41 (29h) Clock	15	LRC_ADC_SEL	0	Selects either ADCLRCLK or DACLRCLK to drive LRCLK pin in
Control 2				Master Mode
				0 = DACLRCLK
				1 = ADCLRCLK

Table 13 ADCLRCLK / DACLRCLK Control



12.3.5 OPCLK CONTROL

When the GPIO5 pin is configured as CODEC_OPCLK, a clock derived from SYSCLK may be output on this pin to provide clocking for other parts of the system. The frequency of this signal is derived from SYSCLK and determined by OPCLK DIV, as described in Table 14.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R40 (28h)	2:0	OPCLK_DIV	000	OPCLK Frequency (GPIO function)
Clock Control		[2:0]		000 = SYSCLK
1				001 = SYSCLK / 2
				010 = SYSCLK / 3
				011 = SYSCLK / 4
				100 = SYSCLK / 5.5
				101 = SYSCLK / 6
				110 = Reserved
				111 = Reserved

Table 14 OPCLK Control

12.3.6 SLOWCLK CONTROL

A slow clock derived from SYSCLK may be generated for de-bouncing of the Headphone Jack Detect function or to set the timeout period for volume updates when zero-cross functions are used. This clock is enabled by TOCLK_ENA and its frequency is set by TOCLK_RATE, as described in Table 15

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R11 (0Bh) Power Mgmt 4	8	TOCLK_ENA	0	Slow clock enable. Used for both the jack insert detect debounce circuit and the zero cross timeout.
R40 (28h)	15			0 = slow clock disabled
Clock Control				1 = slow clock enabled
1	14	TOCLK_RATE	0	Slow Clock Selection (Used for volume update timeouts and for jack detect debounce)
				0 = SYSCLK / 2^21 (Slower Response)
				1 = SYSCLK / 2^19 (Faster Response)

Note: TOCLK_ENA can be accessed through R11 or through R40. Reading from or writing to either register location has the same effect.

Table 15 SLOWCLK Control

12.4 FLL

The integrated FLL can be used to generate SYSCLK from a wide variety of different reference sources and frequencies. The FLL can accept a wide range of reference frequencies, which may be high frequency (eg. 12.288MHz) or low frequency (eg. 32.768kHz). The FLL is tolerant of jitter and may be used to generate a stable SYSCLK from a less stable input signal.

The FLL can take as input the external MCLK, or ADCLRCLK / DACLRCLK (in Slave modes), or the 32kHz crystal oscillator (or external 32kHz source). The FLL input reference source is selected using the FLL_CLK_SRC, as described in Table 17. Choosing the 32kHz source as an input selects either the 32kHz GPIO input or the internal 32kHz oscillator, as illustrated in Figure 33. For best audio performance, it is recommended that a high frequency input clock (above 1MHz) is used.

The analogue and digital portions of the FLL may be enabled independently via FLL_OSC_ENA and FLL_ENA. When initialising the FLL, the analogue circuit must be enabled first by setting FLL_OSC_ENA. The digital circuit may then be enabled on the next register write or later. When changing FLL settings, it is recommended that the digital circuit be disabled via FLL_ENA and then re-enabled after the other register settings have been updated. When changing the input reference frequency FREF, it is recommended that the FLL be reset by setting FLL_ENA to 0.



The field FLL_RATE controls internal functions within the FLL; it is recommended that only the default setting be used for this parameter. FLL_RSP_RATE controls the internal loop gain and should be set to the recommended value.

The FLL output frequency is directly determined from FLL_RATIO, FLL_OUTDIV and the real number represented by FLL_N and FLL_K. The field FLL_N is an integer (LSB = 1); FLL_K is the fractional portion of the number (MSB = 0.5). The fractional portion is only valid when enabled by the field FLL_FRAC. It is recommended that FLL_FRAC is enabled at all times.

The FLL frequency is determined according to the following equation:

$$F_{OUT} = (F_{VCO} / FLL_OUTDIV)$$

$$F_{VCO} = (F_{REF} x N.K x FLL_RATIO)$$

 F_{VCO} must be in the range 90-100 MHz. The value of FLL_OUTDIV should be selected as follows according to the desired output F_{OUT} .

OUTPUT FREQUENCY FOUT	FLL_OUTDIV
2.8125 MHz - 3.125 MHz	4h (divide by 32)
5.625 MHz - 6.25 MHz	3h (divide by 16)
11.25 MHz - 12.5 MHz	2h (divide by 8)
22.5 MHz - 25 MHz	1h (divide by 4)

Table 16 Choice of FLL OUTDIV

Note that the output frequencies that do not lie within the ranges quoted above cannot be guaranteed across the full range of device operating temperatures.

Once F_{VCO} has been determined, the value of FLL_RATIO should be selected in accordance with the recommendations in Table 17. The value of N.K can then be determined using the equation above. FLL_REF_FREQ should be set as described in Table 17.

For best performance, FLL Fractional Mode should always be used. Therefore, if the calculations yield an integer value of N.K, then it is recommended to adjust FLL_RATIO in order to obtain a non-integer value of N.K.

The register fields that control the FLL are described in Table 17. Example settings for a variety of reference frequencies and output frequencies are shown in Table 18.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R42 (2Ah)	15	FLL_ENA	0	Digital Enable for FLL
FLL Control 1				0 = disabled
				1 = enabled
				Note that FLL_OSC_ENA must be enabled before enabling FLL_ENA.
	14	FLL_OSC_EN	0	Analogue Enable for FLL
		Α		0 = FLL disabled
				1 = FLL enabled
				Note that FLL_OSC_ENA must be enabled before enabling FLL_ENA.
	10:8	FLL_OUTDIV	010	F _{OUT} clock divider
		[2:0]		000 = F _{VCO} / 2
				001 = F _{VCO} / 4
				010 = F _{VCO} / 8
				011 = F _{VCO} / 16
				100 = F _{VCO} / 32
				101 = Reserved
				110 = Reserved



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
				111 = Reserved
	7:4	FLL_RSP_RAT	0000	FLL Loop Gain
		-		0000 = x 1 (Recommended value)
				0001 = x 2
				0010 = x 4
				0011 = x 8
				0100 = x 16
				0101 = x 32
				0110 = x 64 0111 = x 128
				1000 = x 256
				1000 - X 230
				Recommended that these are not changed from default.
	2:0	FLL_RATE	000	Frequency of the FLL control block
		[2:0]		000 = F _{VCO} / 1 (Recommended value)
				001 = F _{VCO} / 2
				010 = F _{VCO} / 4
				011 = F _{VCO} / 8
				100 = F _{VCO} / 16
				101 = F _{VCO} / 32
				Recommended that these are not changed from default.
R43 (2Bh)	15:11	FLL_RATIO	14	CLK_VCO is divided by this integer, valid
FLL Control	13.11	[4:0]	(0Eh)	from 1 31.
2		,	(OLII)	1 recommended for high freq reference
				8 recommended for low freq reference
	9:0	FLL_N [9:0]	086h	FLL integer multiplier N for CLK_REF
R44 (2Ch) FLL Control 3	15:0	FLL_K [15:0]	C226h	FLL fractional multiplier K for CLK_REF. This is only used if FLL_FRAC is set.
R45 (2Dh)	7	FLL_REF_FRE	0	Low frequency reference locking
FLL Control		Q		0 = High frequency reference locking
4				(recommended for reference clock > 48kHz)
				1 = Lock frequency reference locking
				(recommended for reference clock <= 48kHz)
	5	FLL_FRAC	0	Fractional enable
				0 = Integer Mode
				1 = Fractional Mode
				1 recommended in all cases
	1:0	FLL_CLK_SRC	00	Select FLL input clock Source
		[1:0]		00 = MCLK
				01 = DACLRCLK
				10 = ADCLRCLK
				11 = CLK_32K_REF

Table 17 FLL Control Registers



12.4.1 EXAMPLE FLL CALCULATION

To generate 12.288 MHz output (F_{OUT}) from a 12.000 MHz reference clock (F_{REF}):

- Determine FLL_OUTDIV for the required output frequency as given by Table 16:
 For F_{OUT} = 12.288 MHz, FLL_OUTDIV = 2h (divide by 8)
- Calculate F_{VCO} for the given FLL_OUTDIV:
 F_{VCO} = F_{OUT} * FLL_OUTDIV = 12.288 MHz * 8 = 98.304 MHz
- Calculate the required N.K x FLL_RATIO for the given F_{REF} and F_{VCO}.: N.K x FLL_RATIO = F_{VCO} / F_{REF} = 8.192
- Determine FLL_REF_FREQ for the given F_{REF} as given by Table 17: For F_{REF} = 12MHz, FLL_REF_FREQ = 0
- Determine FLL_RATIO as given by Table 17:
 For High Frequency Reference, FLL_RATIO = 1
- Calculate N.K for the given FLL_RATIO: N.K = 8.192 / 1 = 8.192
- Determine FLL_N and FLL_K from the integer and fractional portions of N.K: FLL_N is 8. FLL_K is 0.192
- Set FLL_FRAC according to whether fractional mode is required: FLL_K is 0.192, so fractional mode is required; FLL_FRAC = 1

Note that, for best performance, FLL Fractional Mode should always be used. If the calculations yield an integer value of N.K, then it is recommended to adjust FLL_RATIO in order to obtain a non-integer value of N.K.



12.4.2 EXAMPLE FLL SETTINGS

Table 18 provides example FLL settings for generating common SYSCLK frequencies from a variety of low and high frequency reference inputs.

F _{REF}	Fout	F _{vco}	FLL_N	FLL_K	FLL_ RATIO	FLL_ OUTDIV	FLL_FRAC	FLL_REF_ FREQ
32.000 kHz	12.288 MHz	98.304 MHz	438 (1B6h)	0.857143 (DB6Eh)	7	2h (divide by 8)	1	1
32.000 kHz	11.2896 MHz	90.3168 MHz	352 (160h)	0.8 (CCCCh)	8	2h (divide by 8)	1	1
32.768 kHz	12.288 MHz	98.304 MHz	428 (1ACh)	0.571429 (9249 h)	7	2h (divide by 8)	1	1
32.768 kHz	11.288576 MHz	90.308608 MHz	344 (158h)	0.500000 (8000 h)	8	2h (divide by 8)	1	1
32.768 kHz	11.2896 MHz	90.3168 MHz	344 (158h)	0.53125 (8800h)	8	2h (divide by 8)	1	1
48 kHz	12.288 MHz	98.304 MHz	292 (124h)	0.571429 (9249 h)	7	2h (divide by 8)	1	1
11.3636 MHz	12.368544 MHz	98.948354 MHz	8 (008h)	0.707483 (B51Dh)	1	2h (divide by 8)	1	0
12.000 MHz	12.288 MHz	98.3040 MHz	8 (008h)	0.192 (3127h)	1	2h (divide by 8)	1	0
12.000 MHz	11.289597 MHz	90.3168 MHz	7 (007h)	0.526398 (86C2h)	1	2h (divide by 8)	1	0
12.288 MHz	12.288 MHz	98.304 MHz	2 (002h)	0.666667 (AAABh)	3	2h (divide by 8)	1	0
12.288 MHz	11.2896 MHz	90.3168 MHz	7 (007h)	0.35 (599Ah)	1	2h (divide by 8)	1	0
13.000 MHz	12.287990 MHz	98.3040 MHz	7 (007h)	0.56184 (8FD5h)	1	2h (divide by 8)	1	0
13.000 MHz	11.289606 MHz	90.3168 MHz	6 (006h)	0.94745 (F28Ch)	1	2h (divide by 8)	1	0
19.200 MHz	12.287988 MHz	98.3040 MHz	5 (005h)	0.119995 (1EB8h)	1	2h (divide by 8)	1	0
19.200 MHz	11.289588 MHz	90.3168 MHz	4 (004h)	0.703995 (B439h)	1	2h (divide by 8)	1	0

Table 18 Example FLL Settings

WM8350 Production Data

13 AUDIO CODEC SUBSYSTEM

13.1 GENERAL DESCRIPTION

The WM8350 includes a high-performance stereo CODEC. Analogue output buffers and input amplifiers are integrated on-chip, enabling the WM8350 to connect directly to headphones and microphones as well as line-in and line-out sockets.

The CODEC handles analogue-to-digital and digital-to-analogue conversion for audio signals, and integrates programmable filtering. Analogue mixing capabilities are also provided.

Digital audio data is transferred to and from the audio CODEC through a dedicated audio interface that supports a number of industry-standard data formats.

Electrical power is provided to the CODEC through the following pins:

- DBVDD and DGND for the CODEC's audio interface
- DCVDD and DGND for the CODEC's digital core
- HPVDD and HPGND for the analogue outputs
- AVDD and REF_GND for ADC and DAC references
- AVDD and GND for all other analogue functions (including input amplifiers and buffers, ADC, DAC, and analogue mixers)



13.2 AUDIO PATHS

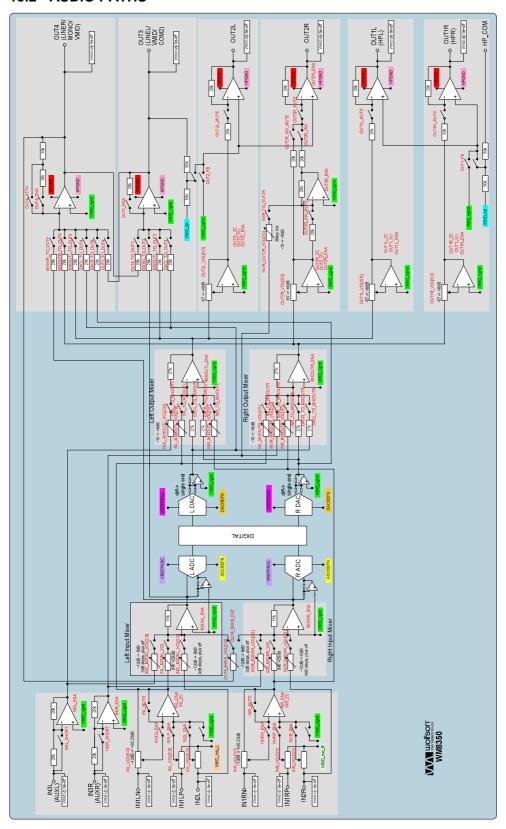


Figure 36 WM8350 Audio Path Diagram



WM8350

13.3 ENABLING THE AUDIO CODEC

Before the audio CODEC can be used, it must be enabled by writing to the CODEC_ENA, SYSCLK_ENA and BIAS_ENA register bits.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12 (0Ch)	12	CODEC_EN	0	Master codec enable bit. Until this bit is set, all
Power		Α		codec registers are held in reset.
Mgmt 5				0 = All codec registers held in reset
				1 = Codec registers operate normally.
R11 (0Bh)	14	SYSCLK_ENA	0	CODEC SYSCLK enable
Power				0 = disabled
Mgmt 4				1 = enabled
R8 (08h)	5	BIAS_ENA	0	Enables bias to analogue audio CODEC
Power				circuitry
Mgmt 1				0 = disabled
				1 = enabled

Table 19 Enabling the Audio CODEC

Each individual part of the audio CODEC (e.g. left/right ADC, left/right DAC, each analogue output pin, mic bias etc.) also has its own enable bit, which must be set before that part of the CODEC can be used. These enable bits are described in the sections that follow.

In order to minimize output pop and click noise, it is recommended that the WM8350 device is powered up and down under control using the following sequences:

Power Up:

- Ensure the CODEC power supplies are available before the CODEC is enabled (CODEC_ENA = 1). The order in which this is done should be DCVDD, DBVDD then HPVDD And/Or AVDD
- 2. Mute all outputs
- 3. Enable the anti-pop circuits by setting ANTI_POP. There are three Anti-pop setting options. Recommended value is ANTI_POP = 01.
- 4. Ensure external capacitors are fully discharged on all outputs that are used by delaying 250ms
- 5. Set the mixers and DAC volume to required settings
- 6. Enable VMID by setting VMID_ENA = 1. VMID should raise in a controlled fashion and charge the output capacitors
- 7. Wait approx 500ms to allow VMID to charge.
- 8. Disable the anti-pop circuits by setting ANTI POP = 00.
- 9. Un-mute all outputs



Power Down:

- 1. Mute all outputs
- 2. Enable anti-pop circuits by setting ANTI_POP = 01.
- 3. Disable circuits down-stream on outputs
- 4. Disable VMID by setting VMID_ENA = 0.
- 5. Wait for VMID to discharge (typically 500ms)
- Disable the anti-pop circuits by setting ANTI_POP = 00.
- 7. Disable all outputs

13.4 INPUT SIGNAL PATH

The WM8350 has multiple analogue inputs. There are two input channels, Left and Right, each of which consists of an input PGA stage followed by a boost/mix stage switch into the hi-fi ADC. Each input PGA path has three input pins which can be configured in a variety of ways to accommodate single-ended, differential or dual differential microphones. There are two auxiliary input pins which can be fed into to the input boost/mix stage as well as driving into the output path. A bypass path exists from the output of the boost/mix stage into the output left/right mixers.

13.4.1 MICROPHONE INPUTS

The microphone inputs of the WM8350 are designed to accommodate electret condenser microphones or analogue line-in signals. They comprise the following pins:

- IN1LP: first non-inverting input, left channel
- IN2L: second non-inverting input, left channel
- IN1LN: inverting input, left channel
- IN1RP: first non-inverting input, right channel
- IN2R: second non-inverting input, right channel
- IN1RN: inverting input, right channel

The non-inverting inputs have constant input impedance to VMID, whereas the inverting input's impedance varies with the pre-amplifier's gain. (Note: the terms "inverting" and "non-inverting" refer to the microphone pre-amplifiers only. For overall behaviour, the inverting record mixer and the ADC, whose output can optionally be inverted in the digital domain, must also be taken into account.)

Each channel has a programmable pre-amplifier, which supports single-ended or pseudo-differentially connected microphones. The amplified signal for each channel can be digitised in the audio ADC and/or mixed into the output signal path.



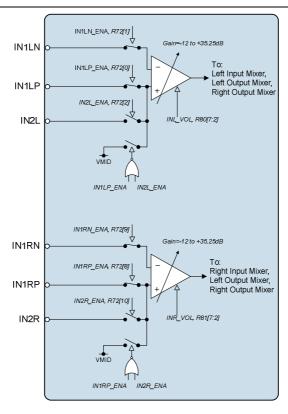


Figure 37 Microphone Inputs and Pre-amplifiers

13.4.2 ENABLING THE PRE-AMPLIFIERS

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R9 (09h)	9	INR_ENA	0	Right input PGA enable
Power Mgmt				0 = disabled
2				1 = enabled
	8	INL_ENA	0	Left input PGA enable
				0 = disabled
				1 = enabled
R80 (50h)	15	INL_ENA	0	Left input PGA enable
Left Input				0 = disabled
Volume				1 = enabled
R81 (51h)	15	INR_ENA	0	Right input PGA enable
Right Input				0 = disabled
Volume				1 = enabled

Note: These bits can be accessed through R9 or through R80/R81. Reading from or writing to either register location has the same effect.

Table 20 Enabling the Microphone Pre-amplifiers

13.4.3 SELECTING INPUT SIGNALS

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R72 (48h) Mic Input	0	IN1LP_ENA	1	Connect IN1LP pin to left channel input PGA amplifier positive terminal.
Control				0 = IN1LP not connected to input PGA
				1 = input PGA amplifier positive terminal connected to IN1LP (constant input impedance)
	1	IN1LN_ENA	1	Connect IN1LN pin to left channel input PGA negative terminal.
				0 = IN1LN not connected to input PGA
				1 = IN1LN connected to input PGA amplifier negative terminal.
	2	IN2L_ENA	0	Connect IN2L pin to left channel input PGA amplifier
				0 = IN2L not connected to input PGA amplifier
				1 = IN2L connected to input PGA amplifier
	8	IN1RP_ENA	1	Connect IN1RP pin to right channel input PGA amplifier positive terminal.
				0 = IN1RP not connected to input PGA
				1 = right channel input PGA amplifier positive terminal connected to IN1RP (constant input impedance)
	9	IN1RN_ENA	1	Connect IN1RN pin to right channel input PGA negative terminal.
				0 = IN1RN not connected to input PGA
				1 = IN1RN connected to right channel input PGA amplifier negative terminal.
	10	IN2R_ENA	0	Connect IN2R pin to right channel input PGA
				0 = IN2R not connected to input PGA amplifier
				1 = IN2R connected to input PGA amplifier

Table 21 Selecting Input Pins for the Microphone Pre-amplifiers



13.4.4 CONTROLLING THE PRE-AMPLIFIER GAINS

The gain of each microphone pre-amplifier is controlled by writing to the appropriate control registers. The gain of each pre-amplifier applies to all three inputs associated with that pre-amplifier, whether inverting or non-inverting. Although the gain settings for each pre-amplifier are in two separate registers, both gains can be changed simultaneously using the IN_VU bit (see Table 22). Additionally, it is also possible to control the gain updates to only occur when the respective signal crosses through zero. This feature reduces clicking noise caused by gain changes.

BIT	LABEL	DEFAULT	DESCRIPTION
14	INL_MUTE	0	Mute control for left channel input PGA:
			0 = Input PGA not muted, normal operation
			1 = Input PGA muted (and disconnected from the following input record mixer).
13	INL_ZC	0	Left channel input PGA zero cross enable:
			0 = Update gain when gain register changes
			1 = Update gain on 1st zero cross after gain register write.
8	IN_VU	0	Input left PGA and input right PGA volume do not update until a 1 is written to either IN_VU register bit.
7:2	INL_VOL	01_0000	Left channel input PGA volume
	[5:0]		000000 = -12dB
			000001 = -11.25dB
			010000 = 0dB
			111111 = 35.25dB
14	INR_MUTE	0	Mute control for right channel input PGA:
			0 = Input PGA not muted, normal operation
			1 = Input PGA muted (and disconnected from the following input record mixer).
13	INR_ZC	0	Right channel input PGA zero cross enable:
			0 = Update gain when gain register changes
			1 = Update gain on 1st zero cross after gain register write.
8	IN_VU	0	Input left PGA and input right PGA volume do not update until a 1 is written to either IN_VU register bit.
7:2	INR_VOL	01_0000	Right channel input PGA volume
	[5:0]		000000 = -12dB
			000001 = -11.25dB
			010000 = 0dB
			111111 = 35.25dB
	14 13 8 7:2	14 INL_MUTE 13 INL_ZC 8 IN_VU 7:2 INL_VOL [5:0] 14 INR_MUTE 13 INR_ZC 8 IN_VU 7:2 INR_VOL	14 INL_MUTE 0 13 INL_ZC 0 8 IN_VU 0 7:2 INL_VOL [5:0] 01_0000 14 INR_MUTE 0 13 INR_ZC 0 8 IN_VU 0 7:2 INR_VOL 01_0000

Table 22 Controlling the Microphone Pre-amplifier Gain



13.4.5 MICROPHONE BIASING

The WM8350 provides a programmable, low-noise bias voltage for condenser electret microphones on the MICBIAS pin.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R8 (08h)	4	MICB_ENA	0	Microphone bias enable
Power Mgmt 1				0 = OFF (high impedance output)
R74 (4Ah)	15	MICB_ENA		1 = ON
Mic Bias	14	MICB_SEL	0	Microphone bias voltage control:
Control				0 = 0.9 * AVDD
				1 = 0.75 * AVDD

Note: MICB_ENA can be accessed through R8 or through R74. Reading from or writing to either register location has the same effect.

Table 23 Controlling the Microphone Bias Voltage

13.4.6 AUXILIARY INPUTS (IN3L AND IN3R)

The WM8350 provides two additional analogue input pins, IN3L and IN3R, for line-level audio or "beep" signals. Each pin has a simple input buffer whose output signal can be digitised in the audio ADC and/or mixed into the output signal path. The Right input IN3R may also be connected to the Output Beep Mixer, for output on OUT2R (see Table 43). The input buffers have a nominal default gain of -1 (0dB).

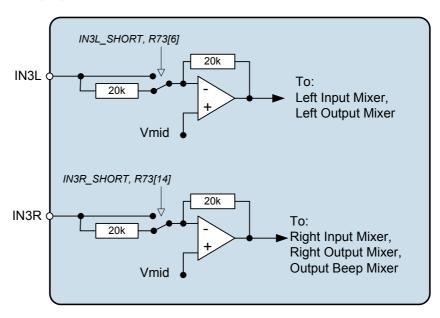


Figure 38 Auxiliary Input Buffers

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R9 (09h)	10	IN3L_ENA	0	IN3L Amplifier enable
Power				0 = disabled
Mgmt 2				1 = enabled
	11	IN3R_ENA	0	IN3R Amplifier enable
				0 = disabled
				1 = enabled
R73 (49h)	7	IN3L_ENA	0	IN3L Amplifier enable
IN3 Input				0 = disabled
Control				1 = enabled
	15	IN3R_ENA	0	IN3R Amplifier enable
				0 = disabled
				1 = enabled
	6	IN3L_SHORT	0	Short circuit internal input resistor for IN3L amplifier.
				0 = Internal resistor in circuit
				1 = Internal resistor shorted
	14	IN3R_SHORT	0	Short circuit internal input resistor for IN3R amplifier.
				0 = Internal resistor in circuit
				1 = Internal resistor shorted
Note: IN2L ENA and IN2D ENA can be accessed through D0 or through D72. Deading from or				

Note: IN3L_ENA and IN3R_ENA can be accessed through R9 or through R73. Reading from or writing to either register location has the same effect.

Table 24 Controlling the Auxiliary Input Buffers



13.4.7 INPUT MIXERS

The WM8350 has mixers in the input signal paths. This allows each ADC to record either a single input signal or a mix of several signals, as desired. The gain for the different input signals can also be adjusted. Each input mixer has four inputs:

- the output of the respective (left/right) microphone pre-amplifier
- the IN2L and IN2R pins (used as a line input, bypassing the microphone pre-amplifiers)
- the output of the respective (left/right) auxiliary input buffer (ie. inputs IN3L or IN3R)
- the output of the OUT4 amplifier (only one input mixer at a time can take this signal)

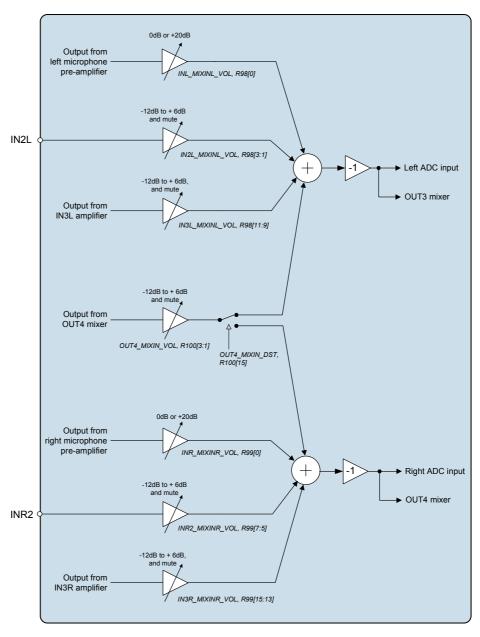


Figure 39 Input Mixers

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R9 (09h)	7	MIXINR ENA	0	Right input mixer enable
Power Mgmt		_		0 = disabled
2				1 = enabled
	6	MIXINL_ENA	0	Left input mixer enable
		_		0 = disabled
				1 = enabled
R98 (62h)	0	INL_MIXINL_V	0	Boost enable for left channel input PGA:
Input mixer		OL		0 = PGA output has +0dB gain through
volume for left				input record mixer.
channel				1 = PGA output has +20dB gain through
				input record mixer.
	3:1	IN2L_MIXINL_	000	IN2L amplifier volume control to right input
		VOL [2:0]		mixer.
				000 = Path disabled (disconnected) 001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				1 010 – -905 gain through mixer
				111 = +6dB gain through mixer
	11:9	IN3L_MIXINL_	000	IN3L amplifier volume control to right input
	11.0	VOL	000	mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
R99 (63h)	0	INR_MIXINR_	1	Boost enable for right channel input PGA:
Input mixer		VOL		0 = PGA output has +0dB gain through
volume for				input record mixer.
right channel				1 = PGA output has +20dB gain through input record mixer.
-	7:5	IN2R_MIXINR_	000	IN2R amplifier volume control to right
	7.0	VOL [2:0]	000	input mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
	15:13	IN3R_MIXINR_	000	IN3R amplifier volume control to right
		VOL [2:0]		input mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				 111 = +6dB gain through mixer
R100 (64h)	15	OUT4_MIXIN_	0	Select routing of OUT4 to input mixers.
OUT4 Mixer	.0	DST		0 = OUT4 to left input mixer.
Control				1 = OUT4 to right input mixer.
	3:1	OUT4_MIXIN_ VOL [2:0]	000	Controls the gain of OUT4 to left and right
		V OL [2.0]		input mixers: 000 = Path disabled (left and right mute)
				001 = -12dB gain through boost stages
		1	l	1
				010 = -9dB gain through boost stages
				010 = -9dB gain through boost stages

Table 25 Input Mixer Control



13.5 ANALOGUE TO DIGITAL CONVERTER (ADC)

The high-performance stereo ADC within the WM8350 converts analogue input signals to the digital domain. It uses a multi-bit, over-sampled sigma-delta architecture. The ADC's over-sampling rate is selectable to control the trade-off between best audio performance and lowest power consumption. A variety of digital filtering stages process the ADC's digital output signal before it is sent to the WM8350 audio interface. These include:

- digital decimation and filtering needed for the ADC
- digital volume control
- A programmable high-pass filter

The audio ADC supports all commonly used audio sampling rates between 8kHz and 48kHz (see Figure 40).

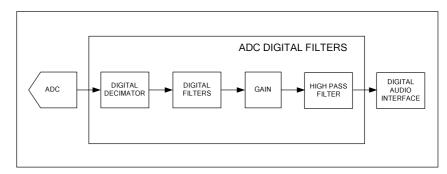


Figure 40 ADC Digital Filter Path

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R11 (0Bh)	2	ADCL_ENA	0	Left ADC enable
Power Mgmt 4				0 = disabled
R66 (42h)	15			1 = enabled
ADC Digital Volume L				When ADCR and ADCL are used together as a stereo pair, then both ADCs must be enabled together using a single register write to Register R11 (0Bh).
R11 (0Bh)	3	ADCR_ENA	0	Right ADC enable
Power Mgmt 4				0 = disabled
R67 (43h)	15			1 = enabled
ADC Digital Volume R				When ADCR and ADCL are used together as a stereo pair, then both ADCs must be enabled together using a single register write to Register R11 (0Bh).
R64 (40h)	1	ADCL_DATINV	0	ADC Left channel polarity:
ADC Control				0 = Normal
				1 = Inverted
	0	ADCR_DATINV	0	ADC Right Channel Polarity
				0 = Normal
				1 = Inverted

Note: ADCL_ENA and ADCR_ENA can be accessed through R11 or through R66/R67. Reading from or writing to either register location has the same effect.

Table 26 Enabling the ADC Left and Right Channels

When ADCR and ADCL are used together as a stereo pair, then it is important that ADCR_ENA and ADCL_ENA are enabled at the same time using a single register write. This must be implemented by writing to the bits in Register R11 (0Bh). This ensures that the system starts up both channels in a synchronous manner.



13.5.1 ADC VOLUME CONTROL

Programmable digital volume control is provided to attenuate the ADC's output signal.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R66 (42h) ADC Digital Volume L	8	ADC_VU	0	ADC left and ADC right volume do not update until a 1 is written to either ADC_VU register bit.
	7:0	ADCL_VO L [7:0]	1100_000 0	Left ADC Digital Volume Control 0000 0000 = Digital Mute 0000 0001 = -71.625dB 0000 0010 = -71.25dB 0.375dB steps up to 1110 1111 = +17.625dB
R67 (43h) ADC Digital Volume R	8	ADC_VU	0	ADC left and ADC right volume do not update until a 1 is written to either ADC_VU register bit.
	7:0	ADCR_VO L [7:0]	1100_000 0	Right ADC Digital Volume Control 0000 0000 = Digital Mute 0000 0001 = -71.625dB 0000 0010 = -71.25dB 0.375dB steps up to 1110 1111 = +17.625dB

Table 27 ADC Volume Control

13.5.2 ADC HIGH-PASS FILTER

A digital high-pass filter is provided to remove DC offsets from the ADC signal.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R11 (0Bh)	13	ADC_HPF_EN	0	High Pass Filter enable
Power		Α		0 = disabled
Mgmt 4				1 = enabled
R64 (40h)	15			
ADC	9:8	ADC_HPF_CU	00	Select cut-off frequency for high-pass filter
Control		T [1:0]		00 = 2^-11 (first order) = 3.7Hz @ fs=44.1kHz
				01 = 2^-5 (2nd order) = ~250Hz @ fs=8kHz
				10 = 2^-4 (2nd order) = ~250Hz @ fs=16kHz
				11 = 2^-3 (2nd order) = ~250Hz @ fs=32kHz

Note: ADC_HPF_ENA can be accessed through R11 or through R64. Reading from or writing to either register location has the same effect.

Table 28 Controlling the ADC High-pass Filter



13.6 DIGITAL MIXING

13.6.1 DIGITAL SIDETONE

A digital sidetone is available when ADCs and DACs are operating at the same sample rate. Digital data from either left or right ADC can be mixed with the audio interface data on the left and right DAC channels. Sidetone data is taken from the ADC high pass filter output, to reduce low frequency noise in the sidetone (e.g. wind noise or mechanical vibration).

The digital sidetone will not function when ADCs and DACs are operating at different sample rates.

When using the digital sidetone, it is recommended that the ADCs are enabled before un-muting the DACs to prevent pop noise. The DAC volumes and sidetone volumes should be set to an appropriate level to avoid clipping at the DAC input.

The digital sidetone is controlled as shown Table 29.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R68 (44h)	11:8	ADCL_DAC_SVOL	0000	Controls left digital side tone volume
ADC		[3:0]		from -36dB to 0dB in 3dB steps.
Divider				0000 = -36dB
				0001 = -33dB
				(3dB steps)
				1011 = -3dB
				1100 = 0dB
				11XX = 0dB
	7:4	ADCR_DAC_SVOL	0000	Controls right digital side tone
		[3:0]		volume from -36dB to 0dB in 3dB steps.
				steps.
				0000 = -36dB
				0001 = -33dB
				(3dB steps)
				1011 = -3dB
				1100 = 0dB
				11XX = 0dB
R60 (3Ch)	13:12	ADC_TO_DACL	00	DAC Left Side-tone Control
Digital Side		[1:0]		11 = Unused
Tone				10 = Mix ADCR into DACL
Control				01 = Mix ADCL into DACL
				00 = No Side-tone mix into DACL
	11:10	ADC_TO_DACR	00	DAC Right Side-tone Control
		[1:0]		11 = Unused
				10 = Mix ADCR into DACR
				01 = Mix ADCL into DACR
				00 = No Side-tone mix into DACR

Table 29 Digital Side Tone Control

The coding of ADCL_DAC_SVOL and ADCR_DAC_SVOL is described in Table 30.

ADCL_DAC_SVOL or ADCR_DAC_SVOL	SIDETONE VOLUME
0000	-36
0001	-33
0010	-30
0011	-27
0100	-24
0101	-21
0110	-18
0111	-15
1000	-12
1001	-9
1010	-6
1011	-3
1100	0
1101	0
1110	0
1111	0

Table 30 Digital Side Tone Control

13.7 DIGITAL TO ANALOGUE CONVERTER (DAC)

The WM8350 contains a high-performance stereo DAC to convert digital audio signals to the analogue domain. Audio data is passed to the WM8350 via the audio interface, and passes through a variety of digital filtering stages before reaching the DAC. These include:

- Digital volume control
- Digital filtering, interpolation and sigma-delta modulation functions needed for the DAC

The audio DAC supports all commonly used audio sampling rates between 8kHz and 48kHz.

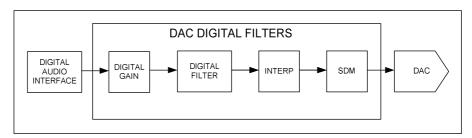


Figure 41 DAC Overview

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R11 (0Bh)	4	DACL_EN	0	Left DAC enable
Power Mgmt		Α		0 = disabled
4				1 = enabled
R50 (32h)	15			
DAC Digital				
Volume Left				
R11 (0Bh)	5	DACR_EN	0	Right DAC enable
Power Mgmt		Α		0 = disabled
R51 (33h)	15			1 = enabled
DAC Digital				
Volume Right				

Note: These bits can be accessed through R11 or through R50/R51. Reading from or writing to either register location has the same effect.

Table 31 DAC Enable

13.7.1 DAC PLAYBACK VOLUME CONTROL

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R50 (32h) DAC Digital Volume Left	8	DAC_VU	0	DAC left and DAC right volume do not update until a 1 is written to either DAC_VU register bit.
	7:0	DACL_VOL [7:0]	1100_0000	Left DAC digital volume control: 0000_0000 = Digital mute 0000_0001 = -71.625dB 0000_0010 = -71.25dB (0.375dB steps) 1100_000 = 0dB
R51 (33h) DAC Digital Volume Right	8	DAC_VU	0	DAC left and DAC right volume do not update until a 1 is written to either DAC_VU register bit.
, and the second	7:0	DACR_VOL [7:0]	1100_0000	Right DAC digital volume control: 0000_0000 = Digital mute 0000_0001 = -71.625dB 0000_0010 = -71.25dB (0.375dB steps) 1100_000 = 0dB

Table 32 DAC Volume Control

13.7.2 DAC SOFT MUTE AND SOFT UN-MUTE

The WM8350 has a soft mute function which, when enabled, gradually attenuates the volume of the DAC output. When soft mute is disabled, the gain will either gradually ramp back up to the digital gain setting, or return instantly to the digital gain setting, depending on the DAC_MUTEMODE register bit.

The DAC is soft-muted by default (DAC_MUTE = 1). To play back an audio signal, this function must first be disabled by setting DAC_MUTE to 0.

Soft Mute Mode would typically be enabled (DAC_MUTEMODE = 1) when using DAC_MUTE during playback of audio data so that when DAC_MUTE is subsequently disabled, the sudden volume increase will not create pop noise by jumping immediately to the previous volume level (e.g. resuming playback after pausing during a track).

Soft Mute Mode would typically be disabled (DAC_MUTEMODE = 0) when un-muting at the start of a music file, in order that the first part of the track is not attenuated (e.g. when starting playback of a new track, or resuming playback after pausing between tracks).

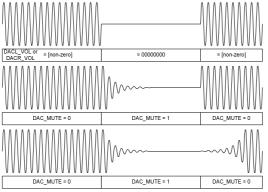


Figure 42 DAC Mute Control

DAC muting and un-muting using volume control bits DACL_VOL and DACR_VOL.

DAC muting and un-muting using soft mute bit DAC_MUTE. Soft un-mute not enabled (DAC_MUTEMODE = 0).

DAC muting and un-muting using soft mute bit DAC_MUTE. Soft un-mute enabled (DAC_MUTEMODE = 1).



The volume ramp rate during soft mute and un-mute is controlled by the DAC_MUTERATE bit. Ramp rates of fs/32 and fs/2 are selectable as shown

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R58 (3Ah)	14	DAC_MUTE	1	DAC Mute
DAC Mute				0 = disabled
				1 = enabled
R59 (3Bh)	14	DAC_MUTEM	0	DAC Soft Mute Mode
DAC Mute Volume		ODE		0 = Disabling soft-mute (DAC_MUTE=0) will cause the volume to change immediately to the DACL_VOL / DACR_VOL settings 1 = Disabling soft-mute (DAC_MUTE=0) will cause the volume to ramp up gradually to the DACL_VOL / DACR_VOL settings
	13	DAC_MUTER	0	DAC Soft Mute Ramp Rate
		ATE		0 = Fast ramp (24kHz at fs=48k, providing maximum delay of 10.7ms)
				1 = Slow ramp (1.5kHz at fs=48k, providing maximum delay of 171ms)

Table 33 DAC Soft-Mute Control

13.7.3 DAC DE-EMPHASIS

Digital de-emphasis can be applied to the DAC playback data (e.g. when the data comes from a CD with pre-emphasis used in the recording). De-emphasis filtering is available for sample rates of 48kHz, 44.1kHz and 32kHz.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R48 (30h)	5:4	DEEMP [1:0]	00	De-Emphasis Control
DAC Control				11 = 48kHz sample rate
				10 = 44.1kHz sample rate
				01 = 32kHz sample rate
				00 = No de-emphasis

Table 34 DAC De-Emphasis Control

13.7.4 DAC OUTPUT PHASE AND MONO MIXING

The digital audio data is converted to oversampled bit streams in the on-chip 24-bit digital interpolation filters. The bitstream data enters two multi-bit, sigma-delta DACs, which convert them to high quality analogue audio signals. The multi-bit DAC architecture reduces high frequency noise and sensitivity to clock jitter. It also uses a Dynamic Element Matching technique for high linearity and low distortion.

In normal operation, the left and right channel digital audio data is converted to analogue in two separate DACs. It is also possible for the DACs to output a mono mix of left and right channels, using DAC_MONO. Both DACs must be enabled for this mono mix to function.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R48 (30h) DAC Control	13	DAC_MONO	0	Adds left and right channel and halves the resulting output to create a mono output
	1	DACL_DATINV	0	DAC data left channel polarity 0 = Normal 1 = Inverted
	0	DACR_DATINV	0	DAC data right channel polarity 0 = Normal 1 = Inverted

Table 35 DAC Mono Mix and Phase Invert Select

13.7.5 DAC STOPBAND ATTENUATION

The DAC digital filter type is selected by the DAC_SB_FILT register bit as shown in Table 36.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R59 (3Bh)	12	DAC_SB_FILT	0	Selects DAC filter characteristics
DAC Digital				0 = Normal mode
Control				1 = Sloping stopband mode

Table 36 DAC Filter Selection



13.8 OUTPUT SIGNAL PATH

The analogue output pins produce audio signals to drive headphones, line-out connections and/or external loudspeaker amplifiers. These pins include:

- OUT1L and OUT1R
- OUT2L and OUT2R
- OUT3 and OUT4

OUT1L, OUT1R, OUT2L and OUT2R have individual analogue volume PGAs with -57dB to +6dB ranges. AC-coupled and Capless headphone drive modes are available. Common mode noise rejection is possible using the HPCOM connection.

OUT3 and OUT4 can be configured as a stereo line out (OUT3 is left output and OUT4 is right output). OUT3 and OUT4 can also be used as a Vmid buffer to provide a "ground" reference for headphone outputs, eliminating the need for DC blocking capacitors.

Alternatively, OUT4 can be used to provide a mono mix of left and right channels.

All analogue output pins are powered through the HPVDD and HPGND pins.

Each output can drive a headphone load down to 16 $\!\Omega.$

There are four output mixers in the output signal path: the left and right channel mixers which control the signals to headphone (and optionally the line outputs) and also dedicated OUT3 and OUT4 mixers.

13.8.1 ENABLING THE ANALOGUE OUTPUTS

Each output can be individually enabled or disabled via dedicated control bits.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R10 (0Ah)	0	OUT1L_ENA	0	OUT1L enable
R104 (68h)	15			0 = disabled
				1 = enabled
R10 (0Ah)	1	OUT1R_ENA	0	OUT1R enable
R105 (69h)	15			0 = disabled
				1 = enabled
R10 (0Ah)	2	OUT2L_ENA	0	OUT2L enable
R106 (70h)	15			0 = disabled
				1 = enabled
R10 (0Ah)	3	OUT2R_ENA	0	OUT2R enable
R107 (71h)	15			0 = disabled
				1 = enabled
R9 (09h)	4	OUT3_ENA	0	OUT3 enable
R92 (5Ch)	15			0 = disabled
				1 = enabled
R9 (09h)	5	OUT4_ENA	0	OUT4 enable
R93 (5Dh)	15			0 = disabled
				1 = enabled

Note: Each bit can be accessed through two separate control registers. Reading from or writing to either register location has the same effect.

Table 37 Enabling the Analogue Outputs



13.8.2 OUTPUT MIXERS

The left and right output channel mixers are shown in Figure 43. These mixers allow the AUX inputs, the ADC bypass and the DAC left and right channels to be combined as desired. This allows a mono mix of the DAC channels to be done as well as mixing in external line-in from the IN3.

The IN3L/IN3R and PGA inputs have individual volume control from -15dB to +6dB. The DAC channel volumes can be adjusted in the digital domain if required. The outputs of these mixers are routed to OUT1L/OUT1R or OUT2L/OUT2R. They can also optionally be routed to the OUT3 and OUT4 mixers.

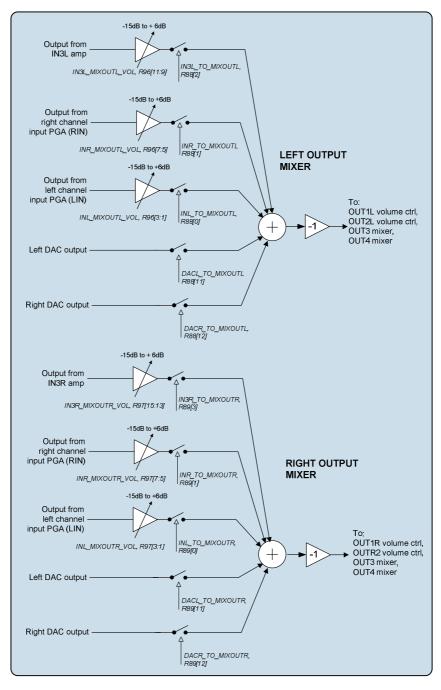


Figure 43 Output Mixers



Each output mixer can be enabled or disabled by writing either to the power management control register or to the respective mixer's own control register. Each analogue signal going into the output mixers can be independently enabled or muted for each mixer.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R88 (58h)	0	INL_TO_MIXOU	0	Left input PGA output to left output
Left Mixer		TL		mixer
Control				0 = not selected
				1 = selected
	1	INR_TO_MIXOU	0	Right input PGA output to left output
		TL		mixer
				0 = not selected
				1 = selected
	2	IN3L_TO_MIXO	0	IN3L amplifier output to left output
		UTL		mixer:
				0 = not selected
				1 = selected
	11	DACL_TO_MIX	0	Left DAC output to left output mixer
		OUTL		0 = not selected
				1 = selected
	12	DACR_TO_MIX	0	Right DAC output to left output mixer
		OUTL		0 = not selected
				1 = selected
	15	MIXOUTL_ENA	0	Left output mixer enable
R9 (09h)	0			0 = disabled
Power Mgmt 2				1= enabled
R89 (59h)	0	INL_TO_MIXOU	0	Left input PGA output to right output
Right Mixer		TR		mixer
Control				0 = not selected
				1 = selected
	1	INR_TO_MIXOU	0	Right input PGA output to right
		TR		output mixer
				0 = not selected
				1 = selected
	3	IN3L_TO_MIXO UTR	0	IN3L amplifier output to right output mixer:
				0 = not selected
				1 = selected
	11	DACL_TO_MIX	0	Left DAC output to right output mixer
		OUTR		0 = not selected
				1 = selected
	12	DACR_TO_MIX OUTR	0	Right DAC output to right output mixer
		OUIK		0 = not selected
				1 = selected
	15	MIXOLITO ENIA	0	
D0 (00h)	15	MIXOUTR_ENA	0	Right output mixer enable
R9 (09h)	1			0 = disabled
Power Mgmt 2	<u></u>			1 = enabled ed through two separate control

Note: MIXOUTL_ENA and MIXOUTR_ENA can be accessed through two separate control registers. Reading from or writing to either register location has the same effect.

Table 38 Selecting Signals into the Output Mixers

The gain for microphone pre-amp and auxiliary input (IN3L/IN3R) signals can be independently adjusted for each output mixer. This does not affect the volume of the same signals going into the separate record mixer. The level of the DAC output signals can be adjusted using the DAC's digital volume control function (see Table 32).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R96 (60h)	3:1	INL_MIXOUTL_VOL	000	Left input PGA volume control to left
Output Left		[2:0]		output mixer.
Mixer				000 = Path disabled (disconnected)
Volume				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
	7:5	INR_MIXOUTL_VO L [2:0]	000	Right input PGA volume control to left output mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
	11:9	IN3L_MIXOUTL_VO L [2:0]	000	IN3L amplifier volume control to left output mixer
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
R97 (61h) Output Right	3:1	INL_MIXOUTR_VO L [2:0]	000	Left input PGA volume control to right output mixer.
Mixer				000 = Path disabled (disconnected)
Volume				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
	7:5	INR_MIXOUTR_VO L [2:0]	000	Right input PGA volume control to right output mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer
	15:1 3	IN3R_MIXOUTR_V OL [2:0]	000	IN3R amplifier volume control to right output mixer.
				000 = Path disabled (disconnected)
				001 = -12dB gain through mixer
				010 = -9dB gain through mixer
				111 = +6dB gain through mixer

Table 39 Controlling the Gain of Signals Going into the Output Mixers



13.9 ANALOGUE OUTPUTS

13.9.1 OUT1L AND OUT1R

The headphone outputs, OUT1L and OUT1R can drive a 16Ω or 32Ω headphone load, either through DC blocking capacitors, or DC coupled without any capacitor. Each output has an analogue volume control PGA with a gain range of -57dB to +6dB as shown in Figure 44.

Common mode noise rejection is also possible on the OUT1L and OUT1R outputs, using HPCOM as the return path. The HPCOM feature must be enabled via the OUT1_FB register field and the HPCOM connection must be AC coupled to the headphone output. A 4.7uF coupling capacitor is required between the noisy ground connection the HPCOM pin.

The control register fields for the OUT1L and OUT1R outputs are described in Table 40. The available output configurations are shown in Section 13.9.3.

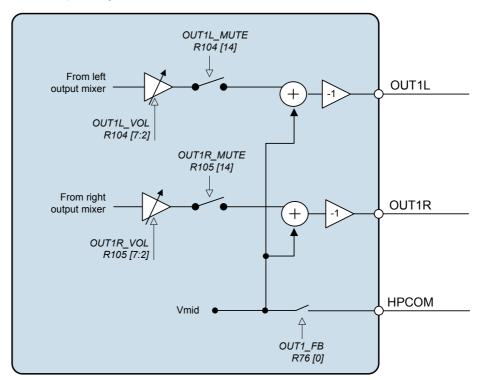


Figure 44 Headphone Outputs OUT1L and OUT1R

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R104 (68h)	14	OUT1L_MUTE	0	OUT1L mute:
OUT1L				0 = normal operation
Volume				1 = mute
	13	OUT1L_ZC	0	OUT1L volume zero cross enable
				0 = Change gain immediately
				1 = Change gain on zero cross only
	8	OUT1_VU	0	OUT1L and OUT1R volumes do not update until a 1 is written to either OUT1_VU.
	7:2	OUT1L_VOL	11_1001	OUT1L volume:
		[5:0]		000000 = -57dB
				111001 = 0dB
				111111 = +6dB
R105 (69h)	14	OUT1R_MUTE	0	OUT1R mute:
OUT1R				0 = normal operation
Volume				1 = mute
	13	OUT1R_ZC	0	OUT1R volume zero cross enable
				0 = Change gain immediately
				1 = Change gain on zero cross only
	8	OUT1_VU	0	OUT1L and OUT1R volumes do not update until a 1 is written to either OUT1_VU.
	7:2	OUT1R_VOL	11_1001	OUT1R volume:
		[5:0]		000000 = -57dB
				111001 = 0dB
				111111 = +6dB
R76 (4Ch) Output	0	OUT1_FB	0	Enable Headphone common mode ground feedback for OUT1
Control				0 = disabled (HPCOM unused)
				1 = enabled (common mode feedback through HPCOM)

Table 40 Controlling OUT1L and OUT1R



13.9.2 OUT2L AND OUT2R

OUT2L and OUT2R are designed as a stereo pair and can drive a headphone, a line load or a loudspeaker amplifier. Each output has an analogue volume control PGA with a gain range of -57dB to +6dB as shown in Figure 45.

Common mode noise rejection is also possible on the OUT2L and OUT2R outputs, using HPCOM as the return path. The HPCOM feature must be enabled via the OUT2_FB register field and the HPCOM connection must be AC coupled to the headphone output. A 4.7uF coupling capacitor is required between the noisy ground connection the HPCOM pin.

The signal path from the right output mixer to OUT2R can be inverted, using the OUT2R_INV and OUT2R_INV_MUTE register bits. Table 41 describes the required settings of these register bits for inverted and non-inverted configurations. Note that the OUT2R_MUTE mutes the OUT2R signal path in both cases.

OUT2R_INV	OUT2R_INV_MUTE	DESCRIPTION
0	1	Non-inverting path from MIXOUTR to OUT2R
1	0	Inverting path from MIXOUTR to OUT2R

Table 41 OUT2R Signal Path Polarity

The control register fields for the OUT2L and OUT2R outputs are described in Table 42. The available output configurations are shown in Section 13.9.3.

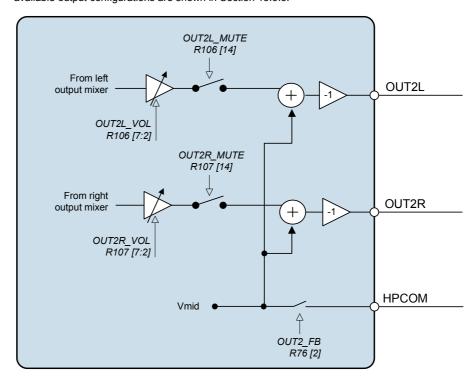


Figure 45 Headphone Outputs OUT2L and OUT2R

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R106 (6Ah)	14	OUT2L_MU	0	OUT2L mute:
for OUT2L		TE		0 = normal operation
Volume				1 = mute
	13	OUT2L_ZC	0	OUT2L volume zero cross enable
				0 = Change gain immediately
				1 = Change gain on zero cross only
	8	OUT2_VU	0	OUT2L and OUT2R volumes do not update until a 1 is written to either OUT2_VU register bits.
	7:2	OUT2L_VO L [5:0]	11_1001	OUT2L volume: 000000 = -57dB
				111001 = 0dB
				111111 = +6dB
R107 (6Bh)	14	OUT2R_M	0	OUT2R mute:
for OUT2R		UTE		0 = normal operation
				1 = mute
	13	OUT2R_ZC	0	OUT2R volume zero cross enable
				0 = Change gain immediately
	40	OUTOD IN	0	1 = Change gain on zero cross only
	10	OUT2R_IN V	0	Enable OUT2R inverting amplifier 0 = disabled
				1 = enabled
				This register must be set to 0 when using the non-inverting MIXOUT2R to OUT2R path.
				This register must be set to 1 when using the inverting MIXOUT2R to OUT2R path.
	9	OUT2R IN	1	Mute output of PGA to inverting amplifier.
		V_MUTE		0 = PGA output goes to inverting amplifier
				1 = PGA output goes to output driver
				This register must be set to 0 when using the inverting MIXOUT2R to OUT2R path.
				This register must be set to 1 when using the non-inverting MIXOUT2R to OUT2R path.
	8	OUT2_VU	0	OUT2L and OUT2R volumes do not update until a 1 is written to either OUT2_VU register bits.
	7:2	OUT2R_VO	11_1001	OUT2R volume:
		L [5:0]		000000 = -57dB
				111001 = 0dB
D=0 ((C))		0.170		111111 = +6dB
R76 (4Ch) Output	2	OUT2_FB	0	Enable Headphone common mode ground feedback for OUT2
Control				0 = disabled (HPCOM unused)
				1 = enabled (common mode feedback through HPCOM)

Table 42 Controlling OUT2L and OUT2R



A beep signal on the IN3R pin (see Table 43) can be mixed into OUT2R independently of the right output mixer (i.e. without mixing the same beep signal into OUT1R).

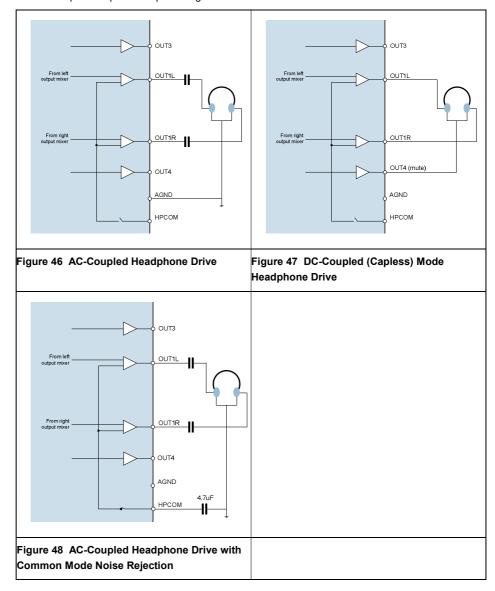
Note that this feature is only possible when the inverting path configuration (MIXOUTR to OUT2R) is selected. See Table 41 for the required register settings.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R111 (6Fh)	15	IN3R_TO_O	0	Beep mixer enable
Веер		UT2R		0 = disabled
Volume				1 = enabled
	7:5 IN3R_OL		R 000	Beep mixer volume:
		_VOL [2:0]		000 = -15dB
				in +3dB steps
				111 = +6dB

Table 43 Controlling the "Beep" Path (IN3R to OUT2R)

13.9.3 HEADPHONE OUTPUTS EXTERNAL CONNECTIONS

Some example headphone output configurations are shown below.



Notes:

The above figures illustrate the headphone connections to outputs OUT1L and OUT1R. The equivalent configurations apply equally to OUT2L and OUT2R.

The DC-coupled configuration illustrated in Figure 47 shows OUT4 (muted) being used as the Ground Return connection. The same capability may alternatively be provided using OUT3.

Twin headphone output (OUT1L, OUT1R, OUT2L and OUT2R) is possible, using a shared Ground Return connection via any of OUT3, OUT4, HPCOM or AGND.

Capless operation is not possible when using the HPCOM feature.

When DC blocking capacitors are used their capacitance and the load resistance together determine the lower cut-off frequency, f_{c} . Increasing the capacitance lowers f_{c} , improving the bass response. Smaller capacitance values will diminish the bass response. For a 16Ω load and a capacitance of $220\mu\text{F}$, the following derivation of cut-off frequency applies:

$$f_c = 1 / 2\pi R_L C_1 = 1 / (2\pi \times 16\Omega \times 220\mu F) = 45 Hz$$

In the DC coupled configuration, the headphone "ground" is connected to VMID. The OUT3 or OUT4 pins can be configured as DC output drivers by de-selecting all inputs to the OUT3 or OUT4 mixers. The DC voltage on VMID in this configuration is equal to the DC offset on the OUT1L and OUT2L pins therefore no DC blocking capacitors are required. This saves space and material cost in portable applications.

It is recommended to only use the DC coupled configuration to drive headphones, and not to use this configuration to drive the line input of another device.



13.9.4 OUT3 AND OUT4

The additional analogue outputs OUT3 and OUT4 have independent mixers and can be used in a number of different ways:

- OUT3 and OUT4 as a stereo pair (OUT3 = left, OUT4 = right) to drive a headphone or line load
- OUT3 or OUT4 as pseudo-ground outputs for headphones connected directly (without DC blocking capacitors) to OUT1L/OUT1R or OUT2L/OUT2R
- OUT4 as a mono mix of left and right signals

The OUT3 and OUT4 output stages are powered from HPVDD and HPGND.

If OUT4 is providing a mono mix, it is recommended to reduce the level of OUT4 by 6dB to avoid clipping in the event of 2 full-scale signals being combined. This is implemented via the OUT4_ATT register field. When OUT4_ATT is asserted, then OUT4 = (L+R) / 2.

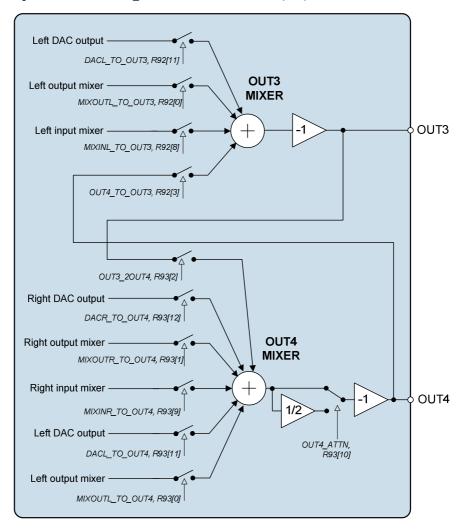


Figure 49 OUT 3 and OUT4 Mixers

OUT3 can provide a buffered midrail headphone pseudo-ground, or a left line output. It can also be a common mode input for OUT2L/OUT2R. OUT4 can provide a buffered midrail headphone pseudo-ground, a right line output, or a mono mix output. It can also be mixed into the input boost mixer for recording.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R92 (5Ch)	11	DACL_TO_OUT3	0	Left DAC output to OUT3
OUT3 Mixer				0 = disabled
				1 = enabled
	8	MIXINL_TO_OUT3	0	Left input mixer to OUT3
				0 = disabled
				1 = enabled
	3	OUT4_TO_OUT3	0	OUT4 mixer to OUT3
				0 = disabled
				1 = enabled
	0	MIXOUTL_TO_OUT	0	Left output mixer to OUT3
		3		0 = disabled
				1 = enabled
R92 (5Ch)	15	OUT3_ENA	0	OUT3 enable
OUT3 Mixer				0 = disabled
R9 (09h)	4			1 = enabled
Power Mgmt 2				

Note: OUT3_ENA can be accessed through R92 or R9. Reading from or writing to either register location has the same effect.

Table 44 Controlling the OUT3 Mixer

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R93 (5Dh)	12	DACR_TO_OUT4	0	Right DAC output to OUT4
OUT4 Mixer				0 = disabled
				1 = enabled
	11	DACL_TO_OUT4	0	Left DAC output to OUT4
				0 = Disabled
				1 = Enabled
	10	OUT4_ATT	0	Reduce OUT4 output by 6dB
				0 = Output at normal level
				1 = Output reduced by 6dB
	9	MIXINR_TO_OUT4	0	Right input mixer to OUT4
				0 = disabled
				1 = enabled
	2	OUT3_TO_OUT4	0	OUT3 mixer to OUT4
				This function is not supported
	1	MIXOUTR_TO OUT4	0	Right output mixer to OUT4
				0 = disabled
				1 = enabled
	0	MIXOUTL_TO_OUT4	0	Left output mixer to OUT4
				0 = disabled
				1 = enabled
R93 (5Dh)	15	OUT4_ENA	0	OUT4 enable
OUT4 Mixer				0 = disabled
R9 (09h)	5			1 = enabled
Power Mgmt 2				

Note: OUT4_ENA can be accessed through R93 or R9. Reading from or writing to either register location has the same effect.

Table 45 Controlling the OUT4 Mixer



13.10 DIGITAL AUDIO INTERFACE

The audio interface enables the WM8350 to exchange audio data with other system components. It is separate from the control interface and has four dedicated pins:

- ADCDAT: Output pin for data coming from the audio ADC
- DACDAT: Input pin for audio data going to the audio DAC
- LRCLK: Data Left/Right alignment clock (also known as "word clock")
- BCLK: Bit clock, for synchronisation

The LRCLK and BCLK pins are outputs when the WM8350 operates as a master device and are inputs when it is a slave device.

In order to allow the ADC and DAC to run at different sampling rates, separate ADCLRCLK and ADCBCLK signals are both available through GPIO pins: GPIO5 (ADCLRCLK) and GPIO6 or GPIO8 (ADCBCLK). This feature also allows mixed Master/Slave operation between the ADC and DAC.

13.10.1 AUDIO DATA FORMATS

The audio interface supports six different audio data formats:

- Left justified
- Right justified
- I²S
- DSP mode A
- DSP mode B
- TDM Mode

In all of these formats, the MSB (most significant bit) of each data sample is transferred first and the LSB (least significant bit) last.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R112 (70h)	15	AIF_BCLK_INV	0	BCLK polarity
Audio				0 = normal
Interface				1 = inverted
	13	AIF_TRI	0	Sets Output enables for LRCLK and
				BCLK and ADCDAT to inactive state
				0 = normal
				1 = forces pins to Hi-Z
	12	AIF_LRCLK_IN	0	LRCLK clock polarity
		V		0 = normal
				1 = inverted
				DSP Mode – mode A/B select
				0 = MSB is available on 2 nd BCLK rising
				edge after LRCLK rising edge (mode A)
				1 = MSB is available on 1 st BCLK rising
				edge after LRCLK rising edge (mode B)
	11:10	AIF_WL [1:0]	10	Data word length
			(24 bits)	11 = 32 bits
				10 = 24 bits
				01 = 20 bits
				00 = 16 bits
				Note: When using the Right-Justified
				data format (AIF_FMT=00), the maximum word length is 24 bits.
				maximum word length is 24 bits.



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	8:9	AIF_FMT [1:0]	10	Data format
			(I^2S)	00 = Right Justified
				01 = Left Justified
				$10 = I^2S$
				11 = DSP / PCM mode
				Note - see Section 13.11 for the selection of 8-bit mode.
R114 (72h)	7	AIFADC_PD	0	Enables a pull down on ADC data pin
Audio				0 = disabled
Interface				1 = enabled
ADC Control	6	AIFADCL_SRC	0	Selects Left channel ADC output.
Control				0 = ADC Left channel
				1 = ADC Right channel
	5	AIFADCR_SRC	1	Selects Right channel ADC output.
				0 = ADC Left channel
				1 = ADC Right channel
	4	AIFADC_TDM_	0	ADCDAT TDM Channel Select
		CHAN		0 = ADCDAT outputs data on slot 0
				1 = ADCDAT outputs data on slot 1
	3	AIFADC_TDM	0	ADC TDM Enable
				0 = Normal ADCDAT operation
				1 = TDM enabled on ADCDAT
R115 (73h)	7	AIFDAC_PD	0	Enables a pull down on DAC data pin
Audio				0 = disabled
Interface				1 = enabled
DAC Control	6	DACL_SRC	0	Selects Left channel DAC input.
Control				0 = DAC Left channel
				1 = DAC Right channel
	5	DACR_SRC	1	Selects Right channel DAC input.
				0 = DAC Left channel
				1 = DAC Right channel
	4	AIFDAC_TDM_	0	DACDAT TDM Channel Select
		CHAN		0 = DACDAT outputs data on slot 0
				1 = DACDAT outputs data on slot 1
	3	AIFDAC_TDM	0	DAC TDM Enable
				0 = Normal DACDAT operation
				1 = TDM enabled on DACDAT

Table 46 Selecting the Audio Data Format

In Left Justified mode, the MSB is available on the first rising edge of BCLK following an LRCLK transition. The other bits up to the LSB are then transmitted in order. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles before each LRCLK transition.

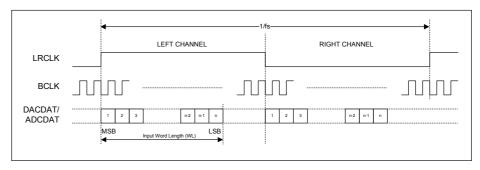


Figure 50 Left Justified Audio Interface (assuming n-bit word length)



In Right Justified mode, the LSB is available on the last rising edge of BCLK before a LRCLK transition. All other bits are transmitted before (MSB first). Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles after each LRCLK transition.

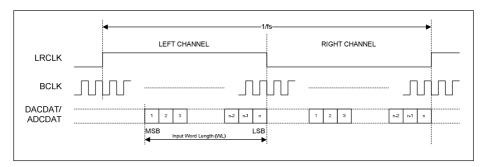


Figure 51 Right Justified Audio Interface (assuming n-bit word length)

In I2S mode, the MSB is available on the second rising edge of BCLK following a LRCLK transition. The other bits up to the LSB are then transmitted in order. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles between the LSB of one sample and the MSB of the next.

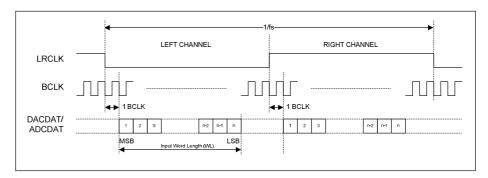


Figure 52 I2S Audio Interface (assuming n-bit word length)

In DSP/PCM mode, the left channel MSB is available on either the 1st (mode B) or 2nd (mode A) rising edge of BCLK (selectable by AIF_LRCLK_INV) following a rising edge of LRCLK. Right channel data immediately follows left channel data. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles between the LSB of the right channel data and the next sample.

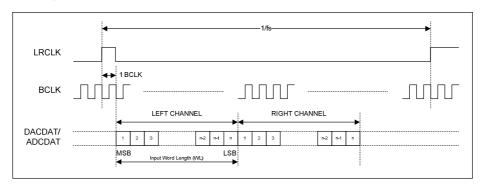


Figure 53 DSP/PCM Mode Audio Interface (mode A, AIF_LRCLK_INV=0)



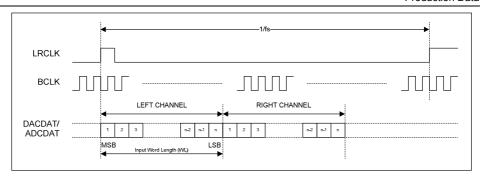


Figure 54 DSP/PCM Mode Audio Interface (mode B, AIF_LRCLK_INV=1)

13.10.2 AUDIO INTERFACE TDM MODE

The digital audio interface on WM8350 has the facility of tri-stating the ADCDAT pin to allow multiple data sources to operate on the same bus. Time division multiplexing (TDM) is also supported, allowing audio output data to be transferred simultaneously from two different sources.

TDM mode is enabled for the ADC and DAC by register bits AIFADC_TDM and AIFDAC_TDM respectively. TDM slot selection for the WM8350 is set for the ADC and DAC by register bits AIFADC_TDM_CHAN and AIFDAC_TDM_CHAN respectively, as defined in Table 46. When not actively transmitting data, the ADCDAT pin will be tristated in TDM mode, to allow other devices to transmit data

13.10.3 TDM DATA FORMATS

All selectable data formats support TDM. The allocation of time slots is controlled by register bits AIFADC_TDM_CHAN and AIFDAC_TDM_CHAN. Two possible slots (SLOT0 and SLOT1) are available for the ADC and for the DAC.

Timing signals for the various interface formats in TDM mode are shown below for the ADC. Similar slot allocation will exist for the DAC.

Left Justified Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 to the start of SLOT1 is determined by the selected word length of the interface of the WM8350.

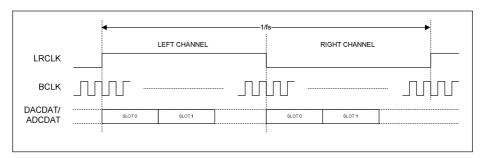


Figure 55 Left Justified Mode with TDM

Right Justified Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the end of SLOT1 to the end of SLOT0 is determined by the selected word length of the interface of the WM8350.



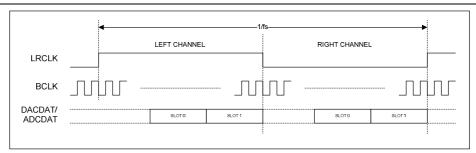


Figure 56 Right Justified Mode with TDM

I2S Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 to the start of SLOT1 is determined by the selected word length of the interface of the WM8350.

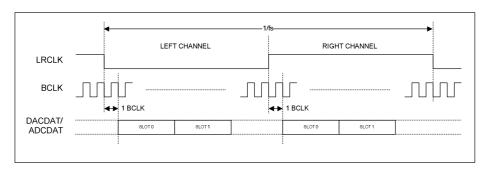


Figure 57 I2S Mode with TDM

DSP/PCM Mode A, Master Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 (left) to the start of SLOT1 (left) is determined by the selected word length of the interface of the WM8350.

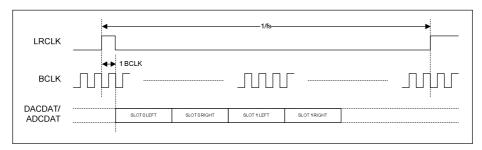


Figure 58 DSP/PCM Mode A, Master Mode with TDM

DSP/PCM Mode B, Master Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 (left) to the start of SLOT1 (left) is determined by the selected word length of the interface of the WM8350.

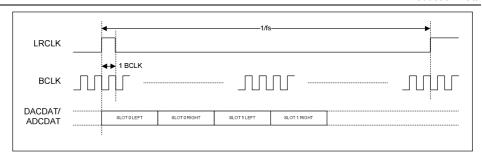


Figure 59 DSP/PCM Mode B, Master Mode, with TDM

DSP/PCM Mode A, Slave Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 (left) to the start of SLOT1 (left) is determined by the selected word length of the interface of the WM8350.

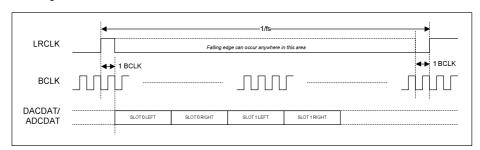


Figure 60 DSP/PCM Mode A, Slave Mode with TDM

DSP/PCM Mode B, Slave Mode: SLOT0 and SLOT1 are defined as shown below. The number of BCLK cycles from the start of SLOT0 (left) to the start of SLOT1 (left) is determined by the selected word length of the interface of the WM8350.

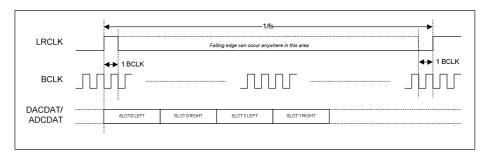


Figure 61 DSP/PCM Mode B, Slave Mode, with TDM

13.10.4 LOOPBACK

When the loopback feature is enabled, the audio ADC's digital output data is looped back to the audio DAC and converted back into an analogue signal. This is often useful for test and evaluation purposes.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R113 (71h)	0	LOOPBACK	0	Digital Loopback Function
ADC Control				0 = No loopback.
				1 = Loopback enabled, ADC data output is fed directly into DAC data input.

Table 47 Enabling loopback



WM8350 **Production Data**

13.11 COMPANDING

The WM8350 supports A-law and μ-law companding on both transmit (ADC) and receive (DAC) sides. Companding can be enabled on the DAC or ADC audio interfaces by writing the appropriate value to the DAC_COMP or ADC_COMP register bits respectively.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R113 (71h)	4	ADC_COMPM	0	ADC Companding mode select:
Companding		ODE		0 = μ-law
Control				1 = A-law
				(Note: Setting ADC_COMPMODE=1 selects 8-bit mode when DAC_COMP=0 and ADC_COMP=0)
	5	ADC_COMP	0	ADC Companding enable
				0 = disabled
				1 = enabled
	6	DAC_COMPM	0	DAC Companding mode select:
		ODE		0 = μ-law
				1 = A-law
				(Note: Setting DAC_COMPMODE=1 selects 8-bit mode when DAC_COMP=0 and ADC_COMP=0)
	7	DAC_COMP	0	DAC Companding enable
				0 = disabled
				1 = enabled

Table 49 Companding Control

Companding involves using a piecewise linear approximation of the following equations (as set out by ITU-T G.711 standard) for data compression:

 μ -law (where μ =255 for the U.S. and Japan):

$$F(x) = \ln(1 + \mu |x|) / \ln(1 + \mu)$$
 $-1 \le x \le 1$

law (where A=87.6 for Europe):

$$F(x) = A|x| / (1 + InA)$$
 } for $x \le 1/A$
 $F(x) = (1 + InA|x|) / (1 + InA)$ } for $1/A \le x :$

The companded data is also inverted as recommended by the G.711 standard (all 8 bits are inverted for μ -law, all even data bits are inverted for A-law). The data will be transmitted as the first 8 MSBs of data.

 $for 1/A \le x \le 1$

Companding converts 13 bits (µ-law) or 12 bits (A-law) to 8 bits using non-linear quantization. This provides greater precision for low amplitude signals than for high amplitude signals, resulting in a greater usable dynamic range than 8 bit linear quantization. The companded signal is an 8-bit word comprising sign (1 bit), exponent (3 bits) and mantissa (4-bits).

8-bit mode is selected whenever DAC_COMP=1 or ADC_COMP=1. The use of 8-bit data allows samples to be passed using as few as 8 BCLK cycles per LRCLK frame. When using DSP mode B, 8-bit data words may be transferred consecutively every 8 BCLK cycles.

8-bit mode (without Companding) may be enabled by setting DAC_COMPMODE=1 or ADC_COMPMODE=1 when DAC_COMP=0 and ADC_COMP=0.

BIT7	BIT[6:4]	BIT[3:0]
SIG	EXPONENT	MANTISSA
N		

Table 50 8-bit Companded Word Composition



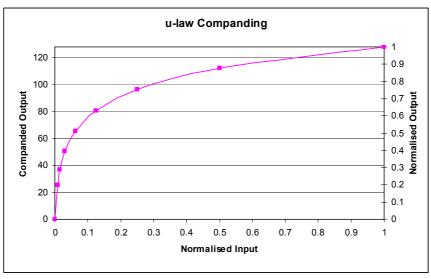


Figure 39 µ-Law Companding

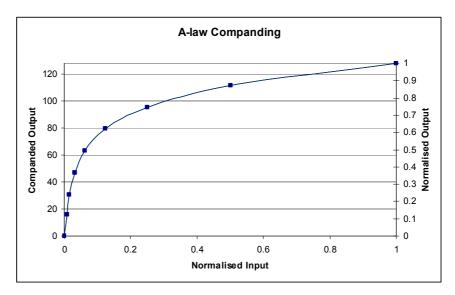


Figure 40 A-Law Companding

13.12 ADDITIONAL CODEC FUNCTIONS

13.12.1 HEADPHONE JACK DETECT

The IN2L and IN2R pins can be selected as headphone jack detect inputs, to enable automatic control of the analogue outputs when a headphone is plugged into a jack socket.

Jack Detection on the IN2L or IN2R pins is enabled by register bits JDL_ENA or JDR_ENA respectively. When Jack Detection is enabled, the associated second level interrupts CODEC_JCK_DET_L_EINT and CODEC_JCK_DET_R_EINT indicate the status of the jack socket. See Section 13.12.7 for further details.

The Headphone Jack Detect function requires the internal slow clock to be enabled - see Section 12.3.6.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R77 (4Dh) Jack Detect	15	JDL_ENA	0	Jack Detect Enable for inputs connected to IN2L 0 = disabled 1 = enabled
	14	JDR_ENA	0	Jack Detect Enable for input connected to IN2R 0 = disabled 1 = enabled

Table 48 Headphone Jack Detect



13.12.2 MICROPHONE DETECTION

The WM8350 can detect when a microphone has been plugged in, and/or when the microphone is short-circuited. It detects these events by comparing the current drawn from the MICBIAS pin against two thresholds. The thresholds for plug-in detection and short-circuit detection are programmable.

A MICBIAS current above the MCDTHR threshold level is used to indicate that a microphone is plugged in, and is associated with the CODEC_MICD_EINT interrupt. If the bias current exceeds the MCDSCTHR limit, this indicates a microphone short-circuit condition, and the WM8350 raises a CODEC_MICSCD_EINT interrupt. See Section 13.12.7 for further details. Note that the MICBIAS current thresholds are subject to a wide tolerance - up to +/-50% of the specified value.

Microphone detection requires the internal slow clock to be enabled - see Section 12.3.6.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R8 (08h)	8	MIC_DET_ENA	0	Enable MIC detect:
Power Mgmt 1				0 = disabled
R74 (4Ah)	7	MIC_DET_ENA	0	1 = enabled
Mic Bias	4:2	MCDTHR [2:0]	000	Threshold for bias current detection
Control				000 = 160μA
				001 = 330μA
				010 = 500μA
				011 = 680μA
				100 = 850μA
				101 = 1000μA
				110 = 1200μA
				111 = 1400μA
				These threshold currents scale
				proportionally with AVDD. The values
				given are for AVDD=3.3V.
	1:0	MCDSCTHR [1:0]	00	Threshold for microphone short-circuit detection
				00 = 400μA
				01 = 900μA
				10 = 1350μA
				11 = 1800μA
				These threshold currents scale
				proportionally with AVDD. The values
				given are for AVDD=3.3V.

Note: MIC_DET_ENA can be accessed through R8 or through R74. Reading from or writing to either register location has the same effect.

Table 49 Controlling Microphone Bias Current Detection



13.12.3 MID-RAIL REFERENCE (VMID)

VMID provides a potential mid-way between AVDD and GND, used in many parts of the audio CODEC. It is generated from AVDD using on-chip potential dividers. Different resistor values can be selected for this purpose. A medium resistance should be used when the CODEC is active. A high resistance option provides a more power-efficient way to maintain the VMID voltage when the CODEC is in "Standby" (i.e. inactive but ready to start immediately, without needing to wait for the VMID capacitor to be charged). For startup and shutdown the VMID generator provides soft VMID ramping to reduce pops and clicks. The speed of this ramp is selectable using the anti-pop controls and can be tuned to the application.

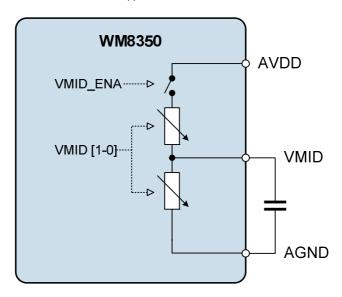


Figure 62 Generating the Mid-rail Reference

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R8 (08h)	2	VMID_EN	0	Enables VMID resistor string
Power		Α		0 = disabled
Management 1				1 = enabled
	1:0	VMID [1:0]	00	Resistor selection for VMID potential divider
			(off)	00 = off
				01 = Vmid comes from 300kΩ R-string
				10 = Vmid comes from 50kΩ R-string
				11 = Vmid comes from 5kΩ R-string

Table 50 Controlling the Mid-rail Reference

13.12.4 ANTI-POP CONTROL

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R78 (4Eh) Anti pop	9:8	ANTI_POP [1:0]	00	Reduces pop when VMID is enabled by setting the speed of the S-ramp for VMID.
control				00 = no S-ramp (will pop)
				01 = fastest S-curve
				10 = medium S-curve
				11 = slowest S-curve
	7:6	DIS_OP_LN4 [1:0]	00	Sets the Discharge rate for OUT4
				00 = discharge path OFF
				01 = fastest discharge
				10 = medium discharge
				11 = slowest discharge
	5:4	DIS_OP_LN3 [1:0]	00	Sets the Discharge rate for OUT3
				00 = discharge path OFF
				01 = fastest discharge
				10 = medium discharge
				11 = slowest discharge
	3:2	DIS_OP_OUT2 [1:0]	00	Sets the discharge rate for OUT2L and OUT2R
				00 = discharge path OFF
				01 = fastest discharge
				10 = medium discharge
				11 = slowest discharge
	1:0	DIS_OP_OUT1 [1:0]	00	Sets the discharge rate for OUT1L and OUT1R
				00 = discharge path OFF
				01 = fastest discharge
				10 = medium discharge
				11 = slowest discharge

Table 51 Control Registers for Anti-pop



13.12.5 UNUSED ANALOGUE INPUTS/OUTPUTS

Whenever an analogue input/output is disabled, it remains connected to AVDD/2 through a resistor. This helps to prevent pop noise when the output is re-enabled. The resistance between the voltage buffer and the output pins can be controlled using the VROI control bits. The default impedance is low, so that any capacitors on the outputs can charge up quickly at start-up. If high impedance is desired for disabled outputs, VROI can then be set to 1, increasing the resistance to about $30 \mathrm{k}\Omega$.

There are individual VROI bits for each output or output pair. This allows matching of the rise times of the outputs if they are driving different capacitors. Using the small resistance with a capacitor for headphone outputs (typically 220uF) and the larger resistance with a line load capacitance (10uF for example); will allow both sets of outputs to power up in around the same time, around 200ms.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R8 (08h)	13	VBUF_ENA	0	Forces ON the tie-off amplifiers
Power Mgmt				0 = disabled
1				1 = enabled
R76 (4Ch)	8	OUT1_VROI	0	VREF (AVDD/2) to OUT1L/OUT1R
Output				resistance
Control				$0 = \operatorname{approx} 500\Omega$
				1 = approx 30 kΩ
	9	OUT2_VROI	0	VREF (AVDD/2) to OUT2L/OUT2R
				resistance
				$0 = \operatorname{approx} 500\Omega$
				1 = approx 30 kΩ
	10	OUT3_VROI	0	VREF (AVDD/2) to OUT3 resistance
				0 = approx 500Ω
				1 = approx 30 kΩ
	11	OUT4_VROI	0	VREF (AVDD/2) to OUT4 resistance
				0 = approx 500Ω
				1 = approx 30 kΩ

Table 52 Disabled Outputs to VREF Resistance

A dedicated buffer is available for tying off unused analogue I/O pins as shown below. This buffer can be enabled using the VBUF_ENA register bit.

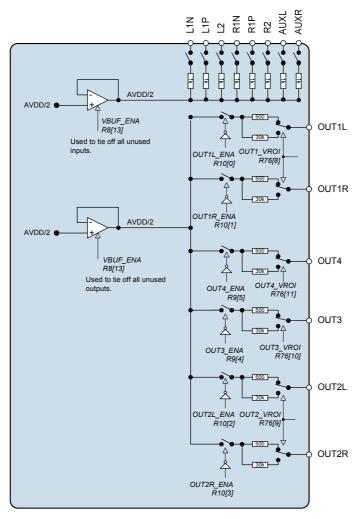


Figure 63 Unused Input/Output Pin Tie-off Buffers

OUT1R/L_ENA/ OUT2R/L_ENA OUT3/4_ENA	VROI	OUTPUT CONFIGURATION
0	0	500Ω tie-off to AVDD/2
0	1	30kΩ tie-off to AVDD/2
1	Х	Output enabled (DC level = AVDD/2)
1	Х	Output enabled (DC level = 1.5 x AVDD/2)

Table 53 Unused Output Pin Tie-off Options

13.12.6 ZERO CROSS TIMEOUT

A zero-cross timeout function is also provided so that if zero cross is enabled on the input or output PGAs the gain will automatically update after a timeout period if a zero cross has not occurred.

The zero-cross timeout function requires the internal slow clock to be enabled - see Section 12.3.6.

13.12.7 INTERRUPTS AND FAULT PROTECTION

The CODEC has its own first-level interrupt, CODEC_INT (see Section 24). This comprises four second-level interrupts which indicate Jack detect and Microphone current conditions. These interrupts can be individually masked by setting the applicable mask bit(s) as described in Table 54.

ADDRESS	BIT	LABEL	DESCRIPTION
R31 (1Fh)	11	CODEC_JCK_DET_L_EINT	Left channel Jack detection interrupt.
Comparator			(Rising and Falling Edge triggered)
Interrupt			Note: This bit is cleared once read.
Status	10	CODEC_JCK_DET_R_EINT	Right channel Jack detection interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	9	CODEC_MICSCD_EINT	Mic short-circuit detect interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	8	CODEC_MICD_EINT	Mic detect interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
R39 (27h)	11:8	"IM_" + name of respective	Interrupt mask.
Comparator		bit in R31	0 = Do not mask interrupt.
Interrupt			1 = Mask interrupt.
Status Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default value for these bits is 0 (unmasked).

Table 54 CODEC Interrupts

WM8350 Production Data

14 POWER MANAGEMENT SUBSYSTEM

14.1 GENERAL DESCRIPTION

The WM8350 provides 6 DC-DC Converters and 4 LDO Regulators which each deliver high efficiency across a wide range of line and load conditions. These power management components are designed to support application processors and associated peripherals. They are also suitable for providing power to the analogue and digital functions of the on-board CODEC and GPIO features. The output voltage of each of the converters and regulators is programmable in software through control registers.

The WM8350 has a number of operating states which are either selected by software control or are selected autonomously according to the available power supply conditions. A low power active 'Hibernate' state is provided, with programmable characteristics. The 'Backup' and 'Zero' states are selected autonomously when the available supply voltages do not permit full operation of the WM8350

Four configuration modes are provided, selected by hardware control. Development Mode gives complete control over the configuration and start-up behaviour of the WM8350. Three different Custom Modes each have a defined set of configuration parameters, which determine the start-up timing and output voltage of each of the DC-DC Converters and LDO Regulators. The configuration of each of the GPIO pins is also contained with the configuration modes definitions.

14.2 POWER MANAGEMENT OPERATING STATES

The WM8350 autonomously controls the power-up and power-down sequencing for itself and for other connected devices. It also selects the most appropriate power source available at any given time (see Section 17). The stable states of the WM8350 are:

ACTIVE - All WM8350 functions can be used. The WM8350 enters the ACTIVE state after a valid start-up event (see Section 14.3.1), provided that no fault condition occurred during start-up.

HIBERNATE - This is an alternative active state with programmable characteristics, allowing an optional low power system condition. The internally generated supply voltages can be individually enabled or disabled as desired. The WM8350 enters the HIBERNATE state from ACTIVE by setting the HIBERNATE register bit or when commanded via a GPIO pin configured as a HIBERNATE alternate function.

OFF - All DC-DC converters and regulators LDO2, LDO3 and LDO4 are disabled. LDO1 may remain active (See Section 14.7.4). The VRTC regulator remains active and powers the always-on functions (such as crystal oscillator and RTC.) Register settings are restored to default settings. Trickle charging for the main battery is enabled by default. The WM8350 enters the OFF state from ACTIVE if a shutdown event occurs (see Section 14.3.3), or if the power source falls below the shutdown threshold (see Section 18). The WM8350 enters the OFF state from BACKUP if a power source greater than the UVLO threshold becomes available.

BACKUP - The crystal oscillator and RTC are enabled, powered from the backup power (VRTC) supply. All other functions are disabled. The WM8350 enters the BACKUP state from OFF if the power source falls below the UVLO threshold (see Section 18), and provided that backup power (VRTC) is available (i.e. LINE falls below the UVLO level but VRTC remains above the Power-On Reset threshold).

ZERO - All functions are disabled and all data in registers is lost. The WM8350 goes into this state when no power source is available and VRTC falls below the Power-On Reset threshold.

The Active state can only be entered via the **PRE-ACTIVE** state. In Development Mode, the Pre-Active state is the state in which the WM8350 start-up parameters may be defined, prior to the start-up sequence being triggered. The **ACTIVE** state is only entered on completion of the start-up sequence.

The WM8350 operating states and valid transitions are illustrated in Figure 64.



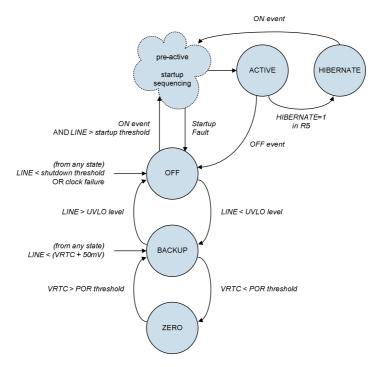


Figure 64 WM8350 Operating State Diagram

14.2.1 HIBERNATE STATE SELECTION

The WM8350 moves from the ACTIVE to the HIBERNATE state when the HIBERNATE register bit is set. It can also move to hibernate using the Hibernate Edge or the Hibernate Level function from the GPIOs.

It returns to the ACTIVE state when the Hibernate Level GPIO function is reset and the HIBERNATE bit is set to 0. It can also return to ACTIVE via the Hibernate Edge function or when a wake-up event (see Section 14.3.1) occurs.

If a fault condition occurs in the HIBERNATE state, the WM8350 moves to the OFF state.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R5 (05h) System Hibernate	15	HIBERNATE	0	Determines what state the chip should operate in. 0 = Active state 1 = Hibernate state The register bit defaults to 0 when a reset happens

Table 55 Invoking HIBERNATE State

The behaviour of the WM8350 in the HIBERNATE state is programmable in terms of supply voltage generation, interrupts and resets. Fast battery charging is disabled in the HIBERNATE state, but trickle charging is possible.

WM8350 Production Data

14.3 POWER SEQUENCING AND CONTROL

14.3.1 STARTUP

The WM8350 moves from OFF or HIBERNATE states to the ACTIVE state when a startup event occurs. Startup events include:

- A trigger signal on the ON pin lasting more than 40ms. The active polarity of this input is set by the register field ON_POL.
- A trigger signal on a GPIO pin configured as /WAKEUP lasting more than 40ms. The
 active polarity of this input is set by GPn_CFG for the applicable GPIO pin (see
 Section 20).
- A trigger signal on a GPIO pin configured as PWR_ON input lasting more than 40ms. The
 active polarity of this input is set by GPn_CFG for the applicable GPIO pin (see
 Section 20).
- Programmed ALARM from RTC module, if enabled (see Section 22).
- Wall adaptor plug-in (WALL_FB rises above 4.0V).
- USB plug-in (USB pin rises above 4.0V).

The start-up events are only valid provided also that the available supply voltage, sensed on the LINE pin, is greater than the start-up threshold set by PCCMP_ON_THR, as defined in Section 18.

Start-Up by Wall adaptor plug-in occurs when the Wall Adapter feedback pin detects a voltage greater than 4.0V. See Section 17.1 for a description of the WALL FB pin function.

Start-Up by USB plug-in occurs when the USB voltage rises above the LINE voltage. If USB Suspend mode is invoked, then USB plug-in starts the WM8350 on battery power, if available. When USB Suspend Mode is not invoked, this start-up event will lead to starting the WM8350 on USB power, and USB 100mA trickle charging of the battery is enabled.

Note that applying a battery voltage is not a start-up event, i.e. connecting a battery pack does not start the WM8350. The WM8350 starts up on battery power if a startup event occurs and battery power is the only power source available, provided the battery voltage is above the startup threshold. (The start-up threshold is set by PCCMP_ON_THR, as defined in Section 18.

In the ACTIVE state, the host processor can read the Interrupt status fields in Register R31 in order to determine what action initiated the start-up. These fields indicate, for example, if the start-up was due to a reset caused by an error condition, or if the start-up was caused by a PWR_ON input, or if the start-up was caused by an RTC alarm. The first-level interrupt WKUP_INT is triggered whenever any of the second-level interrupt events described in Table 56 is set. See Section 24 for further details of Interrupt.



ADDRESS	BIT	LABEL	DESCRIPTION
R31 (1Fh) Comparator	6	WKUP_OFF_STATE_EINT	Indicates that the chip started from the OFF state.
Interrupt			(Rising Edge triggered)
Status			Note: This bit is cleared once read.
	5	WKUP_HIB_STATE_EINT	Indicated the chip started up from the hibernate state.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	4	WKUP_CONV_FAULT_EINT	Indicates the wakeup was caused by a converter fault leading to the chip being reset.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	3	WKUP_WDOG_RST_EINT	Indicates the wakeup was caused by a watchdog heartbeat being missed, and hence the chip being reset.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	2 WKUP_GP_PWR_ON_EINT		PWR_ON (Alternate GPIO function) pin has been pressed for longer than specified time.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	WKUP_ONKEY_EINT	ON key has been pressed for longer than specified time.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	0	WKUP_GP_WAKEUP_EINT	WAKEUP (Alternate GPIO function) pin has been pressed for longer than specified time.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R39 (27h)	6:0	"IM_" + name of respective	Interrupt mask.
Comparator		bit in R31	0 = Do not mask interrupt.
Interrupt			1 = Mask interrupt.
Status Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default value for these bits is 0 (unmasked).

Table 56 Wake-Up Interrupts

14.3.2 POWER-UP SEQUENCING

The WM8350 power supply blocks can be commanded to start up according to a defined sequence when the WM8350 is commanded into the ACTIVE state. This sequence comprises fourteen timeslots, where the enabling of each DC-DC converter, LDO voltage regulator and the current limit switch is associated with one timeslot. In order to minimise supply in-rush current at power-up time, the start-up of these power supply blocks should be staggered in time by the use of this feature.

The WM8350 proceeds from one time slot to the next after a delay of approximately 1.28ms, provided that all power supply blocks started up in the current time slot (if any) have reached 90% of their programmed output voltage. See Section 14.3.4 for details of the WM8350 behaviour if any power supply block fails to achieve 90% of its programmed output voltage.



14.3.3 SHUTDOWN

The WM8350 goes from ACTIVE or HIBERNATE to the OFF state when a shutdown event occurs. Shutdown events include:

- Software shutdown (setting CHIP_ON = 0)
- A trigger signal on a GPIO pin configured as PWR_OFF lasting more than 5ms. The active polarity of this input is set by GPn_CFG for the applicable GPIO pin (see Section 20).
- A trigger signal on the ON pin lasting more than 10 seconds. The active polarity of this
 input is set by the register field ON_POL. If required, the de-bounce time can be set to 5
 seconds using the ON_DEB_T register bit.
- Watchdog time-out (see Section 23) after 7 previous faults.
- Fault conditions programmed to trigger a shutdown (see Section 18).
- Thermal shutdown (see Section 25)

As part of the start-up sequence, the CHIP_ON bit is set to 1. The software shutdown is commanded by writing 0 to the CHIP_ON register field as described in Table 57.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h) System Control 1	15	CHIP_ON	0	Indicates whether the system is on or off. Writing 0 to this bit powers down the whole chip. Registers which are affected by state machine reset will get reset.
				Once the system is turned OFF it can be restarted by any of the valid ON event.
	3	ON_DEB_T	0	ON pin Shutdown function debounce time
				0 = 10s
				1 = 5s
	1	ON_POL	1	ON pin polarity:
				0 = Active high (ON)
				1 = Active low (/ON)

Table 57 Software Shutdown

As part of the shutdown sequence, the WM8350 asserts the /RST and /MEMRST reset signals, resets its internal control registers, disables most of its functions, resets the CHIP_ON bit to 0 and moves to the OFF state. (Note that /MEMRST is an optional output available on GPIO pins only.)



14.3.4 POWER CYCLING

If an undervoltage fault or a limit switch overcurrent fault is detected (eg. during start-up, or when exiting the HIBERNATE state), the WM8350 will respond according to various configurable options. The Limit Switch and each of the DC Converters and LDO Regulators may be programmed to shutdown the system in the event of a fault condition. In these events (where a system shutdown is selected), the WM8350 will either shut down or will attempt to re-start, depending on the state of the POWERCYCLE register bit.

If POWERCYCLE = 0, then a fault condition will result in the shutdown of the WM8350, reverting to the OFF state. If POWERCYCLE = 1, then the WM8350 will make a maximum of 8 attempts to restart. Each attempt will be scheduled at 200ms intervals. After 8 consecutive failed attempts, the WM8350 reverts to the OFF state and resets the power cycling counter. Any subsequent start-up event again has a maximum of 8 attempts to start up (provided that POWERCYCLE = 1).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h)	13	POWERCYCL	0	Action to take on a fault (if fault response
System		E		is set to shutdown system):
Control				0 = Shut down
				1 = Shutdown everything then go through
				startup sequence. ie. Reboot the system.

Table 58 Controlling Power Cycling

14.3.5 REGISTER RESET

The control registers of the WM8350 are reset when it goes into the OFF state. Under default conditions, the control registers are also reset when exiting the HIBERNATE state; this behaviour is selectable using the REG_RESET_HIB_MODE control bit.

In Development mode, the register reset in OFF can be disabled using the RECONFIG_AT_ON register field. See Section 14.4 for a definition of this field.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R5 (05h)	5	REG_RESE	0	Action of the internal register reset signal
System		T_HIB_MOD		when going from Hibernate to Active.
Hibernate		E		0 = Do a register reset when leaving the
				hibernate state.
				1 = Do not do a register reset when leaving
				the hibernate state

Table 59 Register Reset Control

14.3.6 RESET SIGNALS

The WM8350 provides an active-low reset output signal to the host processor on the open-drain /RST pin. The /RST pin is asserted low in the OFF state. The status of the /RST pin in HIBERNATE state is configurable using the RST_HIB_MODE bit.

In start-up, after all enabled power supplies reach 90% of their programmed output voltage, the /RST output is held low for a programmable duration set by RSTB_TO. The /RST pin is then set high. The /RST output is set low during the shutdown sequence.

An additional GPIO output, /RST can be generated, with the same functionality as the /RST pin. A GPIO pin must be configured as /RST in order to output this signal (see Section 20).

The WM8350 can also generate a separate /MEMRST signal for other subsystems such as external memory. This allows resetting some subsystems in the HIBERNATE state, while not resetting others. The /MEMRST feature is provided via a GPIO pin (see Section 20). Note that /MEMRST is not a valid control signal during the start-up as the GPIO pins are not configured at this time. The MEM_VALID field provides an indication of whether the contents of the external memory (under control of /MEMRST) are valid.

The /RST and /MEMRST signals can also be asserted under control of a manual reset input. A GPIO pin (see Section 20) must be configured as /MR to enable this feature. Note that the /MR input has no effect on the WM8350 circuits other than asserting /RST and /MEMRST.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h) System Control 1	11:10	RSTB_TO [1:0]	11	Time that the /RST pin and /MEMRST output is held low after the chip reaches the active state. 00 = 15ms 01 = 30ms 10 = 60ms 11 = 120ms
	5	MEM_VALID	0	Indicates that the contents of external memory are still valid. This bit is cleared on startup and whenever /MEMRST is asserted from the main state machine. The system software should set this bit once the external memory has been set up. Controlled in hibernate mode by MEMRST_HIB_MODE 0 = External memory is not valid and needs restoring. 1 = External memory is valid.
R5 (05h) System Hibernate	4	RST_HIB_M ODE	0	/RST pin state in hibernate mode: 0 = Asserted (low)
Tilberilate	2	MEMRST_H IB_MODE	0	1 = Not asserted (high) /MEMRST (Alternative GPIO function) pin state in hibernate mode 0 = Asserted (low) 1 = Not asserted (high)

Table 60 Controlling Reset Signals



The WM8350 can be commanded to assert the /RST and /MEMRST signals by writing a logic '1' to the SYS_RST register bit. In this case, the /RST and /MEMRST outputs are asserted low for the duration specified by RSTB_TO.

Care must be taken if writing to this bit in 2-wire (I2C) Control Interface mode. The WM8350 will act upon the register write operation as soon as it has received the address and data fields; this may happen before the I2C Acknowledge has been clocked by the host processor. If the /RST signal causes the processor to reset before it has clocked the I2C Acknowledge, then the WM8350 will continue to assert the Acknowledge signal (ie. pull the SDA pin low) after the processor has completed its reset. On some processors, it may be necessary to toggle the SCLK pin in order to clear the Acknowledge signal and resume I2C communications.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h)	14	SYS_RST	0	Allows the processors to reboot itself
System		_		0 = Do nothing
Control 1			1 = Perform a processor reset by asserting the /RST and /MEMRST (GPIO) pins for the first control of the first con	
				programmed duration Protected by security key.

Table 61 Software Reset Command



WM8350 Production Data

14.4 DEVELOPMENT MODE

The WM8350 can start in different modes depending on the state of the CONF1 and CONF0 pins. Development mode is selected by tying CONF1 and CONF0 to logic 0.

Development mode gives complete control over the configuration and startup behaviour of the WM8350 and allows overriding the default values of selected registers (listed in Table 64). It enables configuration of the WM8350 before startup. This is especially useful for evaluation and debugging.

In low-volume production, an external 'genie' (low-cost, small-size microcontroller) may be used to configure the WM8350 in Development mode. The 'genie' is used to write the required register values to generate the desired supplies and to configure the GPIO pins as required. These register write operations can be achieved via a secondary control interface, which is provided by redirecting the control interface to two GPIO pins as described below.

The configuration mode pins CONF1 and CONF0 should be tied to fixed logic levels. The start-up sequence that they control is initiated on every transition from the OFF to the ACTIVE state.

14.4.1 CONTROL INTERFACE REDIRECTION

In Development mode, the 2-wire control interface is initially redirected from the primary control interface (dedicated SDATA and SCLK pins, which require a DBVDD supply) to the secondary control interface (the GPIO10 and GPIO11 pins, which can run on an externally generated supply provided through the LINE pin). When using GPIO pins for the Control Interface, GPIO11 provides the SDATA functionality, and GPIO10 provides the SCLK functionality.

Use of the secondary interface makes it possible to configure the WM8350 before the DBVDD supply voltage becomes available (e.g. in the OFF and PRE-ACTIVE states). The control interface can be switched back to the primary interface at any time by writing to the USE_DEV_PINS bit. In a typical application, the primary control interface would be selected after the WM8350 is fully configured.

The device address for the secondary control interface is 0x34h, and cannot be changed. In development mode only, the primary interface address can be selected by writing to the DEV_ADDR bits through the secondary interface. Note that this functionality is only available in Development mode.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R6 (06h) Interface	15	USE_DEV_P INS	1	Selects which pins to use for the 2-wire control:
Control				0 = Use 2-wire I/F pins as 2-wire interface
				1 = Use GPIO 10 and 11 as 2-wire interface, e.g. to download settings from PIC.
				Only applies when CONFIG pins[1:0] = 00.
	14:13	DEV_ADDR [1:0]	00	Selects device address (only valid when CONF_STS = 00)
				00 = 0x34
				01 = 0x36
				10 = 0x3C
				11 = 0x3E

Note: In custom modes (CONF[1:0]#00), the secondary control interface is never used and the control bits described here have no effect.

Table 62 Control Interface Switching in Development Mode



14.4.2 STARTING UP IN DEVELOPMENT MODE

In Development mode, the GPIO1 pin is configured as a DO_CONF output (see Section 20), which is asserted high to indicate that the WM8350 is about to start up. This may be used to trigger the 'genie' to configure the WM8350 via the secondary control interface.

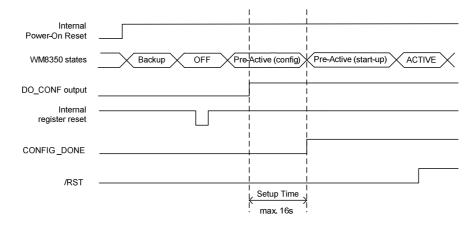


Figure 65 Configuration Timing in Development Mode

On completion of the register configuration, the power-up sequence is initiated by writing a logic 1 to the CONFIG_DONE bit. If the CONFIG_DONE bit is not set before the maximum set-up time has elapsed (see Figure 65), then the WM8350 will revert to the OFF state.

An alternative implementation is to start up the WM8350 by setting CONFIG_DONE to '1' without first programming the converter/LDO settings. By this method, the rising edge of the /RST signal may be used to trigger the WM8350 configuration process after the device has entered the ACTIVE state. In this case, the DC-DC converters and LDOs turn on immediately when they are enabled (time slots are no longer relevant because the WM8350 is already in the ACTIVE state). To reduce in-rush current, any configuration sequence triggered by /RST should therefore include supply staggering in software (i.e. time delays between powering up individual supply domains).

Note that, whether using DO_CONF or /RST to trigger configuration, the on-chip watchdog imposes a time-out for configuration; if the WM8350 watchdog is not serviced, it restarts the system. This can be prevented, if necessary, by disabling the watchdog.

By default, the DO_CONF output will be set low when the WM8350 enters the OFF state and set high on every transition from OFF to ACTIVE, re-triggering the external 'genie'. Also, by default, the internal control registers will be reset when the WM8350 enters the OFF state. This behaviour can be changed using the RECONFIG_AT_ON register bit. If RECONFIG_AT_ON is set to 0, then the control registers will not be reset when going into the OFF state, and the DO_CONF output will remain set high after the first powering up of the chip, regardless of subsequent state transitions.

De-selection of RECONFIG_AT_ON should be used with caution, as this can potentially lead to system failures in some applications. If RECONFIG_AT_ON is set to 0, and an OFF event occurs, then it is possible that control registers will not be set to the intended start-up values when the WM8350 subsequently returns to the ON state. The impact of this will depend upon the hardware and software of the particular target application, and is not necessarily a risk in every instance. Please contact Wolfson Applications support if further guidance is required on this topic.

Note that RECONFIG_AT_ON should never be set to 0 in Custom Modes 01, 10 or 11. Setting this bit to 0 may result in erroneous behaviour and deviation from the custom configuration settings. Under default settings, the control registers are always reset in the OFF state.

The register fields DO_CONF and RECONFIG_AT_ON are defined in Table 63.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R6 (06h) Interface	12	CONFIG_D ONE	0	Tells the system that the PIC micro has completed its programming.
Control				0 = Programming still to be done
				1 = Programming complete
				Only applies when CONFIG pins[1:0] = 00.
	11	RECONFIG _AT_ON	1	Selects whether to reset the registers in the OFF state and whether to reload the device configuration from the PIC when an ON event occurs.
				0 = Do not reset registers in the OFF state. Do not load configuration data when an ON event occurs.
				1 = Reset registers in the OFF state. Load configuration from the PIC when an ON event occurs.
				Note that, in development mode, the device configuration from the PIC is always loaded when first powering up the chip.
				This bit must always be set to default (1) in Custom Modes 01, 10 and 11.

Table 63 Start-Up Control in Development Mode

Note: if the WM8350 enters the BACKUP state as a result of an undervoltage condition (see Section 18), then the control registers will be reset, but DO_CONF will remain high. When the supply voltage rises and device comes out of BACKUP, the DO_CONF output will still be high. If the DO_CONF signal is used to trigger an external 'genie' device, then this may not work, as the DO_CONF has remained high through the BACKUP state transition, and the WM8350 device will become locked in the PRE-ACTIVE state when an ON event occurs.

This problem may be avoided by ensuring that the 'genie' monitors the LINE voltage in order to recognise the undervoltage condition, and that it verifies the I2C Acknowledge signal on the secondary interface (GPIO10 and GPIO11) to determine whether it can execute its programming function



14.4.3 CONFIGURING THE WM8350 IN DEVELOPMENT MODE

The WM8350 can be configured in Development mode by writing to control bits that determine its startup behaviour. The locations of these register bits are shown in Table 64 below. A typical configuration sequence would include writes to some or all of the registers listed. If none of the highlighted bits in any given register needs to be changed from its default, then no write to that register is recommended.

The configuration bits include:

- Duration control bits for the /RST reset signal (RSTB_TO)
- GPIO pull-up / pull-down settings and debounce times (GPn_PD, GPn_PU, GPn_DB and GP_DBTIME)
- Alternate function and input/output selection for GPIO pins (GPn_FN, GPn_DIR and GPn_CFG)
- Voltage settings for DC-DC converters and LDO regulators (DCn_VSEL and LDOn_VSEL)
- Time slots for automatic start of all DC-DC converters, all LDO regulators and the Current Limit Switch during startup (DCn_ENSLOT, LDOn_ENSLOT and LS_ENSLOT). Note that supplies can be programmed to not start up automatically by setting the respective _ENSLOT bits to 0000.

Typically, the final step in the sequence is a write to register R6, in order to:

- Select the WM8350 device address on the primary control interface, using the DEV_ADDR hits
- Allow the WM8350 to proceed to startup. This is achieved by setting the CONFIG_DONE bit (R6 bit 12) to 1.
- Switch the control interface back to the primary interface (if desired), so that a host processor can communicate with the WM8350. This is achieved by setting USE_DEV_PINS (R6 bit 15) to 0.

REGISTER	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Select /RST d	uration					•			•		•					
R3 (03h)					RST	В_ТО										
Unlock protect	Unlock protected registers															
R219 (DBh)								00)13h							
Alternate func	tion and	d input/	output	selectio	n for G	PIO pin	3									
R140 (8Ch)		GP3	_FN			GP2	_FN			GP	1_FN			GP0	_FN	
R141 (8Dh)		GP7	_FN			GP6	_FN			GP	5_FN			GP4	_FN	
R142 (8Eh)		GP1	1_FN			GP10	_FN			GP	9_FN			GP8	_FN	
R143 (8Fh)														GP12	_FN	
R128 (80h)				GPn_	DB (n	= 0 to 12	2)									
R129 (81h)				GPn_	PU (n	= 0 to 12	2)									
R130 (82h)				GPn_	PD (n	= 0 to 12	2)									
R134 (86h)				GPn_	DIR (n	= 0 to 1	2)									
R135 (87h)				GPn_	CFG (r	n = 0 to	12)									
Disable batter	y charg	er (only	if batte	ery type	is not	compati	ble wit	h WM8	350 ch	arger)						
R168 (A8h)	0															
Re-lock protec	ted reg	gisters														
R219 (DBh)								FF	FFFh							
Configure sup	ply gen	eration														
R180 (B4h)												DC1	_VSEL[6	3:0]		
R181(B5h)			D	C1_EN	SLOT[3	3:0]										
R183 (B7h)			D	C2_EN	SLOT[3	3:0]										
R186 (BAh)												DC3	S_VSEL[6	3:0]		
R187 (BBh)			D	C3_EN	SLOT 3	3:0]										
R189 (BDh)												DC4	VSEL[6	3:0]		
R190 (BEh)			D	C4_EN	SLOT[3	3:0]										
R193 (C1h)			D	C5_EN	SLOT[3	3:0]										
R195 (C3h)												DC6	S_VSEL[6	6:0]		
R196 (C4h)			D	C6_EN	SLOT[3	3:0]										
R199 (C7h)			L	S_ENS	LOT[3	:0]										
R200 (C8h)													LDO1	_VSEL	[4:0]	
R201 (C9h)			LD	01_EN	ISLOT[3:0]										
R203 (CAh)													LDO2	_VSEL	[4:0]	
R204 (CBh)			LD	02_EN	ISLOT[3:0]										
R206 (CEh)													LDO3	_VSEL	[4:0]	
R207 (CFh)			LD	O3_EN	ISLOT[3:0]										
R209 (D1h)													LDO4	_VSEL	[4:0]	
R210 (D2h)			LD	04_EN	ISLOT[3:0]										
Proceed to sta	rtup ar			host p	rocess	or			•	•						
R6 (06h)	0	DEV_	_	1												

Table 64 Suggested Sequence of Register Writes for WM8350 Configuration in Development Mode

Note that configuration only includes registers that are required for starting up correctly. All other register settings should be loaded after the WM8350 has started up.

Most of these control fields are described here within Section 14. See Section 11.6 for details of Register Locking. See Section 20 for details of the GPIO configuration fields. See Section 17.7 for details of the Battery Charger configuration.

When using the /RST signal to trigger configuration, writing to the _ENSLOT and RSTB_TO fields can be omitted (the reset and power-up sequence has already taken place, so the write would have no effect). However, additional writes to R13 or R176 should be added to enable the DC-DC converters and LDO regulators one by one.



14.5 CUSTOM MODES

The WM8350 provides three custom start-up modes. These are selected by setting the CONF1 and CONF0 pins = 01, 10 or 11. The custom mode start-up sequences define the following parameters:

- Polarity of the ON pin (Active low or high)
- Configuration of the USB power source
- Configuration of the Watchdog timer mode
- Configuration of the Control Interface mode
- Configuration of the 32kHz oscillator (enabled or disabled)
- Configuration of the real-time-clock (enabled or disabled)
- Configuration of LDO1
- Configuration of the voltage settings and start-up timeslots for DC-DC and LDO supplies
- Configuration of GPIO pins

In Development Mode, the RECONFIG_AT_ON register bit (see Section 14.4.2) may be used to control the device configuration behaviour. In Custom Modes 01, 10 or 11, the default setting (RECONFIG_AT_ON = 1) should always be used. Setting this bit to 0 may result in erroneous behaviour and deviation from the custom configuration settings.

The custom modes do not allow configuring the WM8350 in the OFF state. As a result, evaluation and debugging in custom modes is limited.

14.5.1 CONFIGURATION MODE 01

In Configuration Mode 01, the following general default settings apply:

PARAMETER	REGISTER SETTING	DESCRIPTION
ON polarity	ON_POL = 1	ON pin is Active Low
USB power source	USB_SLV_500MA = 1	Selects 500mA limit in USB slave
Watchdog timer	WDOG_MODE [1:0] = 00	Watchdog is disabled
Control Interface	SPI_3WIRE = 0	Control Interface is 2-wire mode
	SPI_4WIRE = 0	
	SPI_CFG = 0	
32kHz oscillator	OSC32K_ENA = 1	32kHz Oscillator is enabled
Real Time Clock	RTC_TICK_ENA = 1	Real Time Clock is enabled
	RTC_CLKSRC = 0	
LDO1	LDO1_PIN_MODE = 0	LDO1 controlled as normal via
	LDO1_PIN_EN = 0	register bits

The default voltages and the power-up sequence for all DC-DCs and LDOs in Configuration Mode 01 are shown below in Table 65 and Figure 66.

The time delay between each time slot is approximately 1.28ms.

Note that the Limit Switch is not enabled automatically in Configuration Mode 01; as a result, the Limit Switch remains open when the WM8350 enters the ACTIVE state.



SUPPLY	REGISTER SETTING	DESCRIPTION		
DCDC1	DC1_ENSLOT [3:0] = 0100	Fourth timeslot		
	DC1_VSEL [6:0] = 000_0110	1.0V		
DCDC2	DC2_ENSLOT [3:0] = 0000	Disabled		
DCDC3	DC3_ENSLOT [3:0] = 0001	First timeslot		
	DC3_VSEL [6:0] = 010_0110	1.8V		
DCDC4	DC4_ENSLOT [3:0] = 0001	First timeslot		
	DC4_VSEL [6:0] = 101_0110	3.0V		
DCDC5	DC5_ENSLOT [3:0] = 0000	Disabled		
DCDC6	DC6_ENSLOT [3:0] = 0100	Fourth timeslot		
	DC6_VSEL [6:0] = 000_1010	1.1V		
LDO1	LDO1_ENSLOT [3:0] = 0011	Third timeslot		
	LDO1_VSEL [4:0] = 0_0010	1.0V		
LDO2	LDO2_ENSLOT [3:0] = 0010	Second timeslot		
	LDO2_VSEL [4:0] = 1_1111	3.3V		
LDO3	LDO3_ENSLOT [3:0] = 0001	First timeslot		
	LDO3_VSEL [4:0] =1_1100	3.0V		
LDO4	LDO4_ENSLOT [3:0] = 0010	Second timeslot		
	LDO4_VSEL [4:0] = 0_0100	1.1V		

Table 65 Default Supply Voltages / Power-up Sequence for Configuration Mode 01

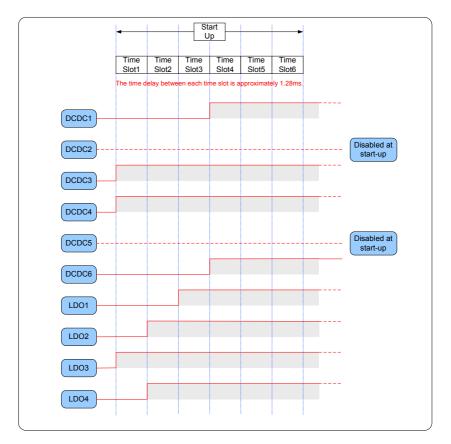


Figure 66 Power-up Sequence - Configuration Mode 01

The default GPIO settings for configuration mode 01 are shown below in Table 66.

GPIO PIN	POWER	DEFAULT GPIO	DEFAULT	DEFAULT PULL-UP /	DEFAULT
	DOMAIN	FUNCTION	DIRECTION	PULL-DOWN	DE-BOUNCE
GPIO0	VRTC	GP0_FN [3:0] = 0000	GP0_DIR = 1	GP0_PD=0	GP0_DB = 1
		GPIO	GP0_CFG =1	GP0_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO1	VRTC	GP1_FN [3:0] = 0000	GP1_DIR = 1	GP1_PD=0	GP1_DB = 1
		GPIO	GP1_CFG =1	GP1_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO2	VRTC	GP2_FN [3:0] = 0000	$GP2_DIR = 1$	GP2_PD=0	GP2_DB = 1
		GPIO	GP2_CFG =1	GP2_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO3	VRTC	GP3_FN [3:0] = 0000	GP3_DIR = 1	GP3_PD=0	GP3_DB = 1
		GPIO	GP3_CFG =1	GP3_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO4	DBVDD	GP4_FN [3:0] = 0000	GP4_DIR = 1	GP4_PD=0	GP4_DB = 1
		GPIO	GP4_CFG =1	GP4_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO5	DBVDD	GP5_FN [3:0] = 0001	GP5_DIR = 1	GP5_PD=0	GP5_DB = 1
		L_PWR1	GP5_CFG =0	GP5_PU=0	Debounce enabled
			Input, Active Low	Normal Mode	
GPIO6	DBVDD	GP6_FN [3:0] = 0001	GP6_DIR = 1	GP6_PD=0	GP6_DB = 1
		L_PWR2	GP6_CFG =0	GP6_PU=0	Debounce enabled
			Input, Active Low	Normal Mode	
GPI07	DBVDD	GP7_FN [3:0] = 0001	GP7_DIR = 1	GP7_PD=0	GP7_DB = 1
		L_PWR3	GP7_CFG =0	GP7_PU=0	Debounce enabled
			Input, Active Low	Normal Mode	
GPIO8	DBVDD	GP8_FN [3:0] = 0011	GP8_DIR = 0	GP8_PD=0	GP8_DB = 1
		/BATT_FAULT	GP8_CFG =0	GP8_PU=0	Debounce enabled
			Output, CMOS	Normal Mode	
GPIO9	DBVDD	GP9_FN [3:0] = 0001	GP9_DIR = 0	GP9_PD=0	GP9_DB = 1
		/VCC_FAULT	GP9_CFG =0	GP9_PU=0	Debounce enabled
			Output, CMOS	Normal Mode	
GPIO10	LINE	GP10_FN [3:0] = 0000	GP10_DIR = 1	GP10_PD=0	GP10_DB = 1
		GPIO	GP10_CFG =1	GP10_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO11	LINE	GP11_FN [3:0] = 0000	GP11_DIR = 1	GP11_PD=0	GP11_DB = 1
		GPIO	_ GP11_CFG =1	GP11_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO12	LINE	GP12_FN [3:0] = 0011	GP12_DIR = 0	GP12_PD=0	GP12_DB = 1
		LINE_SW	 GP12_CFG =0	GP12_PU=0	Debounce enabled
		_	Output, CMOS	Normal Mode	

Table 66 Default GPIO Settings for Configuration Mode 01

14.5.2 CONFIGURATION MODE 10

In Configuration Mode 10, the following general default settings apply:

PARAMETER	REGISTER SETTING	DESCRIPTION	
ON polarity	ON_POL = 1	ON pin is Active Low	
USB power source	USB_SLV_500MA = 1	Selects 500mA limit in USB slave	
Watchdog timer	WDOG_MODE [1:0] = 01	Watchdog set to Interrupt on Timeout	
Control Interface	SPI_3WIRE = 0	Control Interface is 2-wire mode	
	SPI_4WIRE = 0		
	SPI_CFG = 0		
32kHz oscillator	OSC32K_ENA = 1	32kHz Oscillator is enabled	
Real Time Clock	RTC_TICK_ENA = 1	Real Time Clock is enabled, driven	
	RTC_CLKSRC = 0	by the internal 32kHz oscillator	
LDO1	LDO1_PIN_MODE = 0	LDO1 controlled as normal via	
	LDO1_PIN_EN = 0	register bits	

The default voltages and the power-up sequence for all DC-DCs and LDOs in Configuration Mode 10 are shown below in Table 67 and Figure 67.

The time delay between each time slot is approximately 1.28ms.

Note that the Limit Switch is not enabled automatically in Configuration Mode 10; as a result, the Limit Switch remains open when the WM8350 enters the ACTIVE state.



SUPPLY	REGISTER SETTING	DESCRIPTION
DCDC1	DC1_ENSLOT [3:0] = 0001	First timeslot
	DC1_VSEL [6:0] = 001_0010	1.3V
DCDC2	DC2_ENSLOT [3:0] = 0000	Disabled
DCDC3	DC3_ENSLOT [3:0] = 0000	Disabled
	DC3_VSEL [6:0] = 010_1110	2.0V
DCDC4	DC4_ENSLOT [3:0] = 0000	Disabled
	DC4_VSEL [6:0] = 000_1110	1.2V
DCDC5	DC5_ENSLOT [3:0] = 0000	Disabled
DCDC6	DC6_ENSLOT [3:0] = 0011	Third timeslot
	DC6_VSEL [6:0] = 010_0110	1.8V
LDO1	LDO1_ENSLOT [3:0] = 0000	Disabled
	LDO1_VSEL [4:0] = 1_1100	3.0V
LDO2	LDO2_ENSLOT [3:0] = 0010	Second timeslot
	LDO2_VSEL [4:0] = 1_0000	1.8V
LDO3	LDO3_ENSLOT [3:0] = 0000	Disabled
	LDO3_VSEL [4:0] = 1_0101	2.3V
LDO4	LDO4_ENSLOT [3:0] = 0000	Disabled
	LDO4_VSEL [4:0] = 1_1010	2.8V

Table 67 Default Supply Voltages / Power-up Sequence for Configuration Mode 10

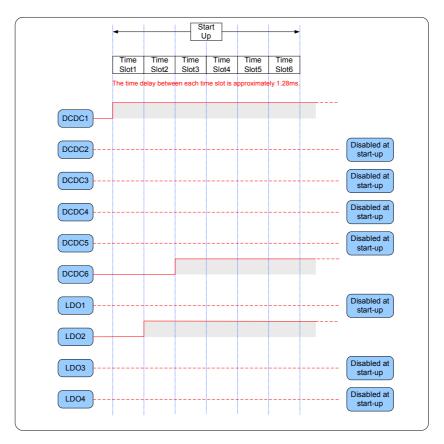


Figure 67 Power-up Sequence - Configuration Mode 10

The default GPIO settings for configuration mode 10 are shown below in Table 68.

GPIO PIN	POWER DOMAIN	DEFAULT GPIO FUNCTION	DEFAULT DIRECTION	DEFAULT PULL-UP / PULL-DOWN	DEFAULT DE-BOUNCE
GPIO0	VRTC	GP0_FN [3:0] = 0000	GP0_DIR = 0	GP0_PD=0	GP0_DB = 1
		GPIO	GP0_CFG =0	GP0_PU=0	Debounce enabled
			Output, CMOS	Normal Mode	
GPIO1	VRTC	GP1_FN [3:0] = 0001	GP1_DIR = 1	GP1_PD=0	GP1_DB = 1
		PWR_ON	GP1_CFG =1	GP1_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO2	VRTC	GP2_FN [3:0] = 0011	GP2_DIR = 0	GP2_PD=0	GP2_DB = 1
		32kHz	GP2_CFG =1	GP2_PU=0	Debounce enabled
			Output, Open Drain	Normal Mode	
GPIO3	VRTC	GP3_FN [3:0] = 0001	GP3_DIR = 1	GP3_PD=0	GP3_DB = 1
		PWR_ON	GP3_CFG =0	GP3_PU=0	Debounce enabled
			Input, Active Low	Normal Mode	
GPIO4	DBVDD	GP4_FN [3:0] = 0011	GP4_DIR = 1	GP4_PD=1	GP4_DB = 1
		HIBERNATE Level	GP4_CFG =1	GP4_PU=0	Debounce enabled
			Input, Active High	Pull-down	
GPIO5	DBVDD	GP5_FN [3:0] = 0000	GP5_DIR = 1	GP5_PD=0	GP5_DB = 1
		GPIO	GP5_CFG =1	GP5_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO6	DBVDD	GP6_FN [3:0] = 0000	GP6_DIR = 1	GP6_PD=0	GP6_DB = 1
		GPIO	GP6_CFG =1	GP6_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPI07	DBVDD	GP7_FN [3:0] = 0000	GP7_DIR = 1	GP7_PD=0	GP7_DB = 1
		GPIO	GP7_CFG =1	GP7_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO8	DBVDD	GP8_FN [3:0] = 0000	GP8_DIR = 1	GP8_PD=1	GP8_DB = 1
		GPIO	GP8_CFG =1	GP8_PU=0	Debounce enabled
			Input, Active High	Pull-down	
GPIO9	DBVDD	GP9_FN [3:0] = 0000	$GP9_DIR = 0$	GP9_PD=0	GP9_DB = 1
		GPIO	GP9_CFG =0	GP9_PU=0	Debounce enabled
			Output, CMOS	Normal Mode	
GPIO10	LINE	GP10_FN [3:0] = 0000	$GP10_DIR = 0$	GP10_PD=0	GP10_DB = 1
		GPIO	GP10_CFG =1	GP10_PU=0	Debounce enabled
			Output, Open Drain	Normal Mode	
GPIO11	LINE	GP11_FN [3:0] = 0010	GP11_DIR = 1	GP11_PD=0	GP11_DB = 1
		/WAKEUP	GP11_CFG =1	GP11_PU=0	Debounce enabled
			(see note)	Normal Mode	
GPIO12	LINE	GP12_FN [3:0] = 0000	GP12_DIR = 0	GP12_PD=0	GP12_DB = 1
		GPIO	GP12_CFG =0	GP12_PU=0	Debounce enabled
			Output, CMOS	Normal Mode	

Note: The alternate GPIO functions PWR_ON and /WAKEUP are system wakeup events. The debounce time of these functions are determined by GP_DBTIME[1:0] + 40ms

Table 68 Default GPIO Settings for Configuration Mode 10

Note that setting GP11_CFG = 1 results in Active Low function for /WAKEUP. In most cases, setting GPn_CFG = 1 results in Active High function, but /MR, /WAKEUP and /LDO_ENA are exceptions to this. See Section 20.)



14.5.3 CONFIGURATION MODE 11

In Configuration Mode 11, the following general default settings apply:

PARAMETER	REGISTER SETTING	DESCRIPTION
ON polarity	ON_POL = 1	ON pin is Active Low
USB power source	USB_SLV_500MA = 1	Selects 500mA limit in USB slave
Watchdog timer	WDOG_MODE [1:0] = 00	Watchdog is disabled
Control Interface	SPI_3WIRE = 0	Control Interface is 2-wire mode
	SPI_4WIRE = 0	
	SPI_CFG = 0	
32kHz oscillator	32kHz oscillator OSC32K_ENA = 1 32kHz Oscillator is enabled	
Real Time Clock	RTC_TICK_ENA = 1	Real Time Clock is enabled, driven
	RTC_CLKSRC = 0	by the internal 32kHz oscillator
LDO1	LDO1_PIN_MODE = 1	LDO1 enabled at all times
	LDO1_PIN_EN = 0	

The default voltages and the power-up sequence for all DC-DCs and LDOs in configuration mode 11 are shown below in Table 69 and Figure 68.

The time delay between each time slot is approximately 1.28ms.

Note that the Limit Switch is not enabled automatically in Configuration Mode 11; as a result, the Limit Switch remains open when the WM8350 enters the ACTIVE state.

SUPPLY	REGISTER SETTING	DESCRIPTION
DCDC1	DC1_ENSLOT [3:0] = 0010	Second timeslot
	DC1_VSEL [6:0] = 110_0010	3.3V
DCDC2	DC2_ENSLOT [3:0] = 0000	Disabled
DCDC3	DC3_ENSLOT [3:0] = 0000	Disabled
	DC3_VSEL [6:0] = 000_1110	1.2V
DCDC4	DC4_ENSLOT [3:0] = 0011	Third timeslot
	DC4_VSEL [6:0] = 000_0110	1.0V
DCDC5	DC5_ENSLOT [3:0] = 0000	Disabled
DCDC6	DC6_ENSLOT [3:0] = 0001	First timeslot
	DC6_VSEL [6:0] = 010_0110	1.8V
LDO1	LDO1_ENSLOT [3:0] = 0000	(See note below)
	LDO1_VSEL [4:0] = 0_0010	1.0V
LDO2	LDO2_ENSLOT [3:0] = 0000	Disabled
	LDO2_VSEL [4:0] = 1_1010	2.8V
LDO3	LDO3_ENSLOT [3:0] = 0000	Disabled
	LDO3_VSEL [4:0] = 1_1111	3.3V
LDO4	LDO4_ENSLOT [3:0] = 0000	Disabled
	LDO4_VSEL [4:0] = 1_1111	3.3V

Table 69 Default Supply Voltages / Power-up Sequence for Configuration Mode 11

Note: In this Configuration Mode, LDO1 is enabled at all times. Therefore, the setting of LDO1_ENSLOT has no effect.

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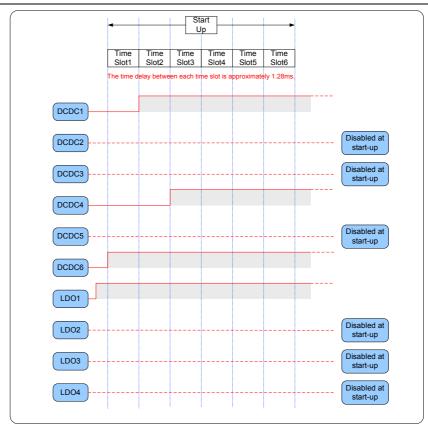


Figure 68 Power-up Sequence - Configuration Mode 11

The default GPIO settings for configuration mode 11 are shown below in Table 70.

GPIO PIN	POWER DOMAIN	DEFAULT GPIO FUNCTION	DEFAULT DIRECTION	DEFAULT PULL-UP / PULL-DOWN	DEFAULT DE-BOUNCE
GPI00	VRTC	GP0_FN [3:0] = 0000	GP0_DIR = 1	GP0_PD=0	GP0_DB = 1
		GPIO	GP0_CFG =1	GP0_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO1	VRTC	GP1_FN [3:0] = 0001	GP1_DIR = 1	GP1_PD=0	GP1_DB = 1
		PWR_ON	GP1_CFG =0	GP1_PU=0	Debounce enabled
			Input, Active Low	Normal Mode	
GPIO2	VRTC	GP2_FN [3:0] = 0011	GP2_DIR = 0	GP2_PD=0	GP2_DB = 1
		32kHz	GP2_CFG =1	GP2_PU=0	Debounce enabled
			Output, Open Drain	Normal Mode	
GPIO3	VRTC	GP3_FN [3:0] = 0000	GP3_DIR = 1	GP3_PD=0	GP3_DB = 1
		GPIO	GP3_CFG =1	GP3_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO4	DBVDD	GP4_FN [3:0] = 0001	GP4_DIR = 1	GP4_PD=0	GP4_DB = 1
		/MR	GP4_CFG =1	GP4_PU=1	Debounce enabled
			(see note)	Pull-up	
GPIO5	DBVDD	GP5_FN [3:0] = 0000	GP5_DIR = 1	GP5_PD=0	GP5_DB = 1
		GPIO	GP5_CFG =1	GP5_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO6	DBVDD	GP6_FN [3:0] = 0000	GP6_DIR = 1	GP6_PD=0	GP6_DB = 1
		GPIO	GP6_CFG =1	GP6_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPI07	DBVDD	GP7_FN [3:0] = 0000	GP7_DIR = 1	GP7_PD=0	GP7_DB = 1
		GPIO	GP7_CFG =1	GP7_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO8	DBVDD	GP8_FN [3:0] = 0000	GP8_DIR = 1	GP8_PD=0	GP8_DB = 1
		GPIO	GP8_CFG =1	GP8_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO9	DBVDD	GP9_FN [3:0] = 0000	GP9_DIR = 1	GP9_PD=0	GP9_DB = 1
		GPIO	GP9_CFG =1	GP9_PU=0	Debounce enabled
			Input, Active High	Normal Mode	
GPIO10	LINE	GP10_FN [3:0] = 0011	$GP10_DIR = 0$	GP10_PD=0	GP10_DB = 1
		CH_IND	GP10_CFG =1	GP10_PU=0	Debounce enabled
			Output, Open Drain	Normal Mode	
GPIO11	LINE	GP11_FN [3:0] = 0010	GP11_DIR = 1	GP11_PD=0	GP11_DB = 1
		/WAKEUP	GP11_CFG =1	GP11_PU=0	Debounce enabled
			(see note)	Normal Mode	
GPIO12	LINE	GP12_FN [3:0] = 0011	$GP12_DIR = 0$	GP12_PD=0	GP12_DB = 1
		LINE_SW	GP12_CFG =0	GP12_PU=0	Debounce enabled
		IO formations DIMP, ON a	Output, CMOS	Normal Mode	

Note: The alternate GPIO functions PWR_ON and /WAKEUP are system wakeup events. The debounce time of these functions are determined by GP_DBTIME[1:0] + 40ms

Table 70 Default GPIO Settings for Configuration Mode 11

Note that setting GP4_CFG = 1 results in Active Low function for /MR. Also, setting GP11_CFG = 1 results in Active Low function for /WAKEUP. In most cases, setting GPn_CFG = 1 results in Active High function, but /MR, /WAKEUP and /LDO_ENA are exceptions to this. See Section 20.)

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14.6 CONFIGURING THE DC-DC CONVERTERS

The configuration of the DC-DC converters is described in the following sections. Some of the control fields form part of the Custom Mode configuration settings and therefore will not require to be set in software in some applications.

14.6.1 DC-DC CONVERTER ENABLE

The DC-DC Converters can be enabled in software using the register fields defined in Table 71. All DC-DC converters include a soft-start feature that helps to reduce the inductor current at start up. In order to further reduce supply in-rush current, individual converters should be programmed to start in different time slots within the start-up sequence.

In the WM8350 ACTIVE state, the DC-DC Converters can be enabled in software using the DCn_ENA bits. Setting these bits whilst in the Pre-Active state (see Figure 65) will not immediately enable the corresponding DC-DC converter; these bits will only become effective once the WM8350 has reached the ACTIVE state.

Each Converter may be programmed to switch on in a selected timeslot within the start-up sequence. The WM8350 will set the DC*n_*ENA field for any DC-DC converter that is enabled during the start-up sequence. Note that setting the DC*n_*ENSLOT fields in software is only relevant to the Development Mode, as these fields are assigned preset values in each of the Custom Modes.

Each Converter may be programmed to switch off in a selected timeslot within the shutdown sequence. If a Converter is not allocated to one of the 14 shutdown timeslots, it will be disabled when the WM8350 enters the OFF state.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION		
R13 (0Dh) or	0,1,2,3	DCn_ENA	Dependant	DCDCn converter enable		
	,4,5		on CONFIG	0 = disabled		
R176 (B0h)			settings	1 = enabled		
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.		
Note: These bits or register location has		•	13 or through R	176. Reading from or writing to either		
	13:10		Danandant	Time slet for DC DCs start up		
R181 (B5h) for DC-DC1	13.10	DC <i>n</i> _ENSLO T [3:0]	Dependant on CONFIG	Time slot for DC-DC <i>n</i> start-up		
DC-DC1		1 [0.0]	settings	0000 = Disabled (do not start up)		
D404 (D0b) for			3.	0001 = Start-up in time slot 1		
R184 (B8h) for				(total 14 slots available)		
DC-DC2				1110 = Start-up in time slot 14		
				1111 = Start up on entering ACTIVE		
R187 (BBh) for	9:6	DCn_SDSLO	0000	Time slot for DC-DCn shutdown.		
DC-DC3		T [3:0]		0000 = Shut down on entering OFF		
				0001 = Shutdown in time slot 1		
R190 (BEh) for				(total 14 slots available)		
DC-DC4				1110 = Shutdown in time slot 14		
				1111 = Shut down on entering OFF		
R193 (C1h) for						
DC-DC5						
R196 (C4h) for DC-DC6						
Note: n is number	Note : <i>n</i> is number between 1 and 6 that identifies the individual DC-DC converter					

Table 71 Enabling and Disabling the DC-DC Converters



14.6.2 CLOCKING

The DC-DC converters are controlled by an internally generated clock signal from the RC Oscillator with a constant frequency of around 2.0MHz for DC-DC 1, 3, 4 and 6, and a constant frequency of around 1.0MHz for DC-DC 2 and 5.

14.6.3 DC-DC BUCK (STEP-DOWN) CONVERTER CONTROL

DC-DC Converters 1, 3, 4 and 6 are buck converters which can be configured to operate in different operating modes using the register bits described in Table 72.

In Active mode, the DC-DC Converters operate to their highest level of performance. The DC-DC Converters will automatically select PWM or Pulse-Skipping operation according to the load condition. This enables the power efficiency to be maximised across a wide range of load conditions. It is possible to force the Converters to use the higher performance PWM mode; in this mode, pulse-skipping is disabled and the output voltage is regulated by switching at a constant frequency which improves the transient response at light loads.

In Standby/Hysteretic Mode, the DC-DC Converters disable some of the internal control circuitry in order to reduce power consumption. The load regulation may be degraded in this mode of operation. The efficiency data in Section 9.2.1 shows the conditions under which Standby Mode can offer better efficiency than Active Mode.

In LDO Mode, the DC-DC Converters are reconfigured as low power LDOs.

When $DCn_SLEEP = 0$, the corresponding DCn_ACTIVE register bit selects between Active and Standby/Hysteretic modes for the associated DC-DC converter.

The DCn_SLEEP register bits control the selection of LDO Mode. Setting DCn_SLEEP = 1 selects LDO Mode. This bit takes precedence over the corresponding DCn_ACTIVE bit.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R177 (B1h)	0	DC1_ACTIVE	1	DC-DCn Active mode
DC-DC Active	2	DC3_ACTIVE	1	0 = Select Standby mode
Options	3	DC4_ACTIVE	1	1 = Select Active mode
	5	DC6_ACTIVE	1	
R178 (B2h)	0	DC1_SLEEP	0	DC-DCn Sleep Mode
DC-DC Sleep	2	DC3_SLEEP	0	0 = Normal DC-DC operation
Options	3	DC4_SLEEP	0	1 = Select LDO mode
	5	DC6_SLEEP	0	
Note: n is either 1,	, 3, 4 or 6	and identifies the	individual DC-	DC converter
R248 (F8h)	4	DC1_FORCE_	0	Force DC-DC1 PWM mode
DCDC1 Test		PWM		0 = Normal DC-DC operation
Controls				1 = Force DC-DC PWM mode
R250 (FAh)	4	DC3_FORCE_	0	Force DC-DC3 PWM mode
DCDC3 Test		PWM		0 = Normal DC-DC operation
Controls				1 = Force DC-DC PWM mode
R251 (FBh)	4	DC4_FORCE_	0	Force DC-DC4 PWM mode
DCDC4 Test		PWM		0 = Normal DC-DC operation
Controls				1 = Force DC-DC PWM mode
R253 (FDh)	4	DC6_FORCE_	0	Force DC-DC6 PWM mode
DCDC4 Test		PWM		0 = Normal DC-DC operation
Controls				1 = Force DC-DC PWM mode

Table 72 Operating Mode Control for DC-DC Converters 1, 3, 4 and 6



DC-DC Converters 1, 3, 4 and 6 can also be controlled by the device HIBERNATE bit, or by hardware input signals L_PWR1, L_PWR2 and L_PWR3. Several GPIO pins can be assigned as L_PWR pins. Each converter can be assigned to one of these three signals, or else to the device HIBERNATE bit. The signals are active high and each converter's response to the selected signal is programmable as defined in Table 73.

Note that, when a GPIO pin is configured as a Hibernate input pin, and this input is asserted, then all DC-DC Converters will be placed in Hibernate mode.

In order to use GPIO pins as L_PWR pins, they must be configured by setting the respective GPn_FN , and GPn_DIR bits to the appropriate value (see Section 20).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R182 (B6h) for	14:12	DCn_HIB_M	001	DC-DCn Hibernate behaviour:
DC-DC1		ODE [2:0]		000 = Use current settings (no change)
				001 = Select voltage image settings
R188 (BCh) for				010 = Force standby mode
DC-DC3				011 = Force standby mode and voltage image settings
R191 (BFh) for				100 = Force LDO mode
DC-DC4				101 = Force LDO mode and voltage
				image settings
R197 (C5h) for				110 = Reserved
DC-DC6				111 = Disable output
	9:8	DCn_HIB_T	00	DC-DC <i>n</i> Hibernate signal select
		RIG [1:0]		00 = HIBERNATE register bit
				01 = L_PWR1
				10 = L_PWR2
				11 = L_PWR3
				Note that Hibernate is also selected when a GPIO Hibernate input is
				asserted.
Note: n is either 1	, 3, 4 or 6 a	ind identifies the	individual DC-D	OC converter

Table 73 Low-Power Mode Control for DC-DC Converters 1, 3, 4 and 6



The default output voltage for DC-DC Converters 1, 3, 4 and 6 is set by writing to the DCn_VSEL register bits. The 'image' voltage settings DCn_VIMG are alternate values that may be invoked when the HIBERNATE software or hardware control is asserted as described above.

The DC-DC Converters 1, 3, 4 and 6 are dynamically programmable - the output voltage may be adjusted in software at any time. These Converters are buck (step-down) converters; their output voltage can therefore be lower than the input voltage, but cannot be higher.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R180 (B4h) for	6:0	DCn_VSEL	Dependant	DC-DCn Converter output voltage
DC-DC1		[6:0]	on CONFIG	settings in 25mV steps.
			settings	Maximum output = 3.4V.
R186 (BAh) for				
DC-DC3				110 0110 = 3.4V
				110 0010 = 3.3V
R189 (BDh) for				101 0110 = 3.0V
DC-DC4				100 1110 = 2.8V
R195 (C3h) for				010 0110 = 1.8V
DC-DC6				000 1110 = 1.2V
DO-DO0				000 0110 = 1.0V
				000 0000 = 0.85V
				0.000
R182 (B6h) for	6:0	DCn VIMG	000 0110	DC-DCn Converter output image voltage
DC-DC1		[6:0]		settings in 25mv steps.
2020.				Maximum output = 3.4V.
R188 (BCh) for				·
DC-DC3				110 0110 = 3.4V
DO-DO3				110 0010 = 3.3V
R191 (BFh) for				101 0110 = 3.0V
DC-DC4				100 1110 = 2.8V
DC-DC4				100 1110 2.00
D407 (OFI) (010 0110 = 1.8V
R197 (C5h) for				000 1110 = 1.2V
DC-DC6				000 1110 = 1.2V 000 0110 = 1.0V
				000 0000 = 0.85V
Note: n is either 1.		1.1 (.6		<u> </u>

Note: *n* is either 1, 3, 4 or 6 and identifies the individual DC-DC converter

Table 74 Output Voltage Control for DC-DC Converters 1, 3, 4 and 6

register bits described in Table 75.

When the DC-DC Converters 1, 3, 4 and 6 are disabled, the output can be set to float or else the outputs can be actively discharged through internal resistors. This feature is controlled using the

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R180 (B4h) for DC-DC1	10	DCn_OPFLT	0	Enable discharge of DC-DC <i>n</i> outputs when DC-DC <i>n</i> is disabled
				0 = Enabled - Output to be discharged
R186 (BAh) for DC-DC3				1 = Disabled - Output is left floating
R189 (BDh) for DC-DC4				
R195 (C3h) for DC-DC6				
Note: n is either 1	, 3, 4 or 6	and identifies the	individual DC-	DC converter

Table 75 Output Float Control for DC-DC Converters 1, 3, 4 and 6



A summary of the Mode Control and Voltage Control for DC-DC Converter 1 is provided in Table 76. Note that "Hibernate" in Table 76 refers to a GPIO Hibernate input or to the applicable Hibernate signal selected by the DC1_HIB_TRIG field.

The equivalent logic applies for DC-DC 3, 4 and 6. Note that the DC-DC Converters must also be enabled as described in Table 71.

HIBERNATE	DC1_HIB_MODE	DC1_SLEEP	DC1_ACTIVE	OPERATING MODE	OUTPUT VOLTAGE
0	Х	0	0	Standby/Hysteretic	DC1_VSEL
0	Х	0	1	Active	DC1_VSEL
0	Х	1	Х	LDO Mode	DC1_VSEL
1	000	0	0	Standby/Hysteretic	DC1_VSEL
		0	1	Active	DC1_VSEL
		1	X	LDO Mode	DC1_VSEL
	001	0	0	Standby/Hysteretic	DC1_VIMG
		0	1	Active	DC1_VIMG
		1	Х	LDO Mode	DC1_VIMG
	010	Х	Х	Standby/Hysteretic	DC1_VSEL
	011	Х	Х	Standby/Hysteretic	DC1_VIMG
	100	Х	Х	LDO Mode	DC1_VSEL
	101	Х	Х	LDO Mode	DC1_VIMG
	110	Х	Х	Disabled	N/A
	111	Х	Х	Disabled	N/A

Table 76 DC1 Converter Operating Mode Selection

14.6.4 DC-DC BOOST (STEP-UP) CONVERTER CONTROL

DC-DC Converters 2 and 5 are boost converters which can be configured to operate in different operating modes, using the register bits described in Table 77.

In Switch mode, the DC-DC Converter acts as a switch between VP2 and L2 or between VP5 and L5 for Converter 2 and 5 respectively. The switch is enabled (closed) by setting DCn_ENA = 1. The switch is disabled (opened) by setting DCn_ENA = 0. Note that the switch voltage source on VP2 or VP5 must be >1.2V to ensure reliable operation.

In Boost mode, the DC-DC Converters operate as step-up converters, employing current-mode architecture, capable of powering LED lights. The output voltage can be higher than the input voltage, but cannot be lower. Different configurations of voltage feedback are available in boost mode, to control the output voltage in different ways. The voltage feedback mode is selected by the DCn_FBSRC register field.

When $DCn_FBSRC = 00$, the converter's output voltage is set by two external resistors connected to FB2 or FB5. See Section 29 for Applications Information covering the selection of suitable components.

When DCn_FBSRC = 01, the converter uses the ISINKA pin as feedback and adjusts its output voltage in order to achieve the required ISINKA current.

When DCn_FBSRC = 10, the converter uses the ISINKB pin as feedback and adjusts its output voltage in order to achieve the required ISINKB current.

When $DCn_FBSRC = 11$, the converter's output voltage is set by two internal resistors, resulting in a fixed 5V output, suitable for USB interfaces.

The current-controlled configurations using ISINKA or ISINKB are intended for controlling a string of serially-connected LEDs driven by one of the DC-DC boost converters. See Table 97 for a definition of the CSn_ISEL register field which determines the required ISINKA or ISINKB current. In these modes, external resistors connected on the FB2 or FB5 pin determine the maximum output voltage. See Section 29 for Applications Information covering the selection of suitable components.



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> In all configurations, the input pins VP2 and VP5 must be externally wired to one of the supply rails, BATT or LINE. Using LINE has the advantage that the converters can operate when the battery is flat, defective or absent. Note that VP2 and VP5 should not be connected to the USB supply rail.

> The DCn RMPH and DCn RMPL bits defined in Table 77 should be set according to the desired output voltage in order to optimise the transient response of the converter. Selecting a different value could result in sub-harmonic oscillation of the converter.

The DCn_ILIM bits defined in Table 77 should be set according to the intended output load conditions.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R183 (B7h)	14	DCn_MODE	0	DC-DCn Converter Mode
for DC-DC2				0 = boost mode
				1 = switch mode
R192 (C0h)	6	DCn_ILIM	0	DC-DCn peak current limit select
for DC-DC5				0 = Higher peak current
				1 = Lower peak current
	4:3	DCn_RMPH	01	DC-DCn compensation ramp
		DCn_RMPL		{DCn_RMPH, DCn_RMPL}
				00 = 20V < VOUT ≤ 30V
				01 = 10V < VOUT ≤ 20V
				10 = 5V < VOUT ≤ 10V
				11 = VOUT ≤ 5V (will be chosen automatically if DCn_FBSRC=11)
	1:0	DCn_FBSRC	00	DC-DCn voltage feedback selection
		[1:0]		00 = voltage feedback (using external resistor divider on pin FBn)
				01 = current sink ISINKA used as feedback
				10 = current sink ISINKB used as feedback
				11 = voltage feedback (using internal resistor divider on pin USB)
Note: n is either	2 or 5 and	d identifies the indiv	idual DC-DC	converter

Table 77 Operating Mode Control for DC-DC Converters 2 and 5

DC-DC Converters 2 and 5 can also be controlled by the device HIBERNATE bit, or by hardware input signals L_PWR1, L_PWR2 and L_PWR3. Several GPIO pins can be assigned as L_PWR pins. Each converter can be assigned to one of these three signals, or else to the device HIBERNATE bit. The signals are active high and each converter's response to the selected signal is programmable as defined in Table 78.

Note that, when a GPIO pin is configured as a Hibernate input pin, and this input is asserted, then all DC-DC Converters will be placed in Hibernate mode.

In order to use GPIO pins as L_PWR pins, they must be configured by setting the respective GPn_FN, and GPn_DIR bits to the appropriate value (see Section 20).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION			
R183 (B7h) for	12	DCn_HIB_MO	0	DC-DCn Hibernate behaviour:			
DC-DC2		DE		0 = Continue as in Active state			
				1 = Disable converter output			
R192 (C0h) for	9:8	DCn_HIB_TRI	00	DC-DCn Hibernate signal select			
DC-DC5		G [1:0]		00 = HIBERNATE register bit			
				01 = L_PWR1			
				10 = L_PWR2			
				11 = L_PWR3			
				Note that Hibernate is also selected when a GPIO Hibernate input is asserted.			
Note: n is either	2 or 5 and i	dentifies the indivi	Note: <i>n</i> is either 2 or 5 and identifies the individual DC-DC converter				

Table 78 Hibernate Mode Control for DC-DC Converters 2 and 5

14.6.5 INTERRUPTS AND FAULT PROTECTION

Each DC-DC Converter is monitored for voltage accuracy and fault conditions. An undervoltage condition is set if the voltage falls below 95% of the required level. The action taken in response to a fault condition can be set independently for each DC-DC Converter, as described in Table 79.

The DCn_ERRACT fields configure the fault response to disable the respective converter or to shut down the entire system if desired. In addition, DC-DC Converter fault conditions also generate a second-level interrupt (see Section 24).

To prevent false alarms during short current surges, faults are only signalled if the fault condition persists. When a DC-DC Converter is started up, any initial fault condition is ignored until the Converter has been allowed time to settle. The time for which any fault condition is ignored is set by the PUTO register field, as described in Table 79.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R181 (B5h) for	15:14	DCn_ERRAC	00	Action to take on DC-DCn fault (as well
DC-DC1		T [1:0]		as generating an interrupt):
				00 = ignore
R184 (B8h) for				01 = shut down converter
DC-DC2				10 = shut down system
				11 = reserved (shut down system)
R187 (BBh) for				
DC-DC3				
D400 (DEL) (
R190 (BEh) for				
DC-DC4				
D103 (C1h) for				
R193 (C1h) for DC-DC5				
DC-DC3				
R196 (C4h) for				
DC-DC6				
20 200				
R177 (B1h)	13:12	PUTO [1:0]	00	Power up time out value for all
DCDC Active				converters
options				00 = 0.5ms
				01 = 2ms
				10 = 32ms
				11 = 256ms
Note: n is a numb	er betwee	n 1 and 6 that ider	ntifies the indiv	vidual DC-DC converter

Table 79 Fault Responses for DC-DC Converters



The DC-DC Converters and the LDO Regulators have a first-level interrupt, UV_INT (see Section 24). This comprises second-level interrupts from each of the DC-DC Converters and the LDO Regulators.

Each DC-DC Converter has a dedicated second-level interrupt which indicates an under-voltage condition. These can be masked by setting the applicable mask bit as defined in Table 80.

ADDRESS	BIT	LABEL	DESCRIPTION
R28 (1Ch)	5	UV_DC6_EINT	DCDC6 Under-voltage interrupt.
Under Voltage			(Rising Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
	4	UV_DC5_EINT	DCDC5 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	3	UV_DC4_EINT	DCDC4 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	2	UV_DC3_EINT	DCDC3 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	UV_DC2_EINT	DCDC2 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	0	UV_DC1_EINT	DCDC1 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R36 (24h)	as in	"IM_" + name of respective	Mask bits for DC-DC converter under-
Under Voltage	R28	bit in R28	voltage interrupts
Interrupt Mask			Each of these bits masks the respective
			bit in R28 when it is set to 1 (e.g. UV DC1 EINT in R28 does not trigger a
			UV_INT interrupt when
			IM_UV_DC1_EINT in R36 is set).
Note: there is no	over-curre	ent fault condition for converters	

Table 80 DC-DC Converter Interrupts



The status of the DC-DC Converters can be indicated and monitored externally via a GPIO pin configured as /VCC_FAULT (see Section 20). When a GPIO pin is configured as /VCC_FAULT output, a logic low level on this pin indicates that there is a fault condition on one of the LDO Regulators, DC-DC Converters, or the Current Limit switch.

The /VCC_FAULT output is configurable by the control fields in Register R215. The fields described in Table 81 determine which of the DC-DCs contribute to the /VCC_FAULT indication. An undervoltage or overvoltage condition on any unmasked DC-DC Converter will cause the /VCC_FAULT output to be set to logic low.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R215 (D7h)	5	DC6_FAULT	0	DCDC6 fault mask for the
VCC_FAULT				/VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault
	4	DC5_FAULT	0	DCDC5 fault mask for the /VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault
	3	DC4_FAULT	0	DCDC4 fault mask for the /VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault
	2	DC3_FAULT	0	DCDC3 fault mask for the /VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault
	1	DC2_FAULT		DCDC2 fault mask for the //CC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault
	0	DC1_FAULT		DCDC1 fault mask for the /VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault

Table 81 DC Converter /VCCFAULT Mask Bits



14.7 CONFIGURING THE LDO REGULATORS

The configuration of the LDO Regulators is described in the following sections. Some of the control fields form part of the Custom Mode configuration settings and therefore will not require to be set in software in some applications.

14.7.1 LDO REGULATOR ENABLE

The LDO Regulators can be enabled in software using the register fields defined in Table 82. To reduce supply in-rush current, individual regulators should be programmed to start in different time slots within the start-up sequence.

In the WM8350 ACTIVE state, the LDO Regulators can be enabled in software using the LDO*n_*ENA bits. Setting these bits whilst in the Pre-Active state (see Figure 65) will not immediately enable the corresponding LDO Regulators; these bits will only become effective once the WM8350 has reached the ACTIVE state.

Each Regulator may be programmed to switch on in a selected timeslot within the start-up sequence. The WM8350 will set the LDO*n_*ENA field for any LDO Regulator that is enabled during the start-up sequence. Note that setting the LDO*n_*ENSLOT fields in software is only relevant to the Development Mode, as these fields are assigned preset values in each of the Custom Modes.

Each Regulator may be programmed to switch off in a selected timeslot within the shutdown sequence. If a Regulator is not allocated to one of the 14 shutdown timeslots, it will be disabled when the WM8350 enters the OFF state.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R13 (0Dh) or	8	LDO1_ENA	0	LDO1 enable
				0 = disabled
R176 (B0h)				1 = enabled
DC-DC / LDO requested				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.
	9	LDO2_ENA	0	LDO2 enable
				0 = disabled
				1 = enabled
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.
	10	LDO3_ENA	0	LDO3 enable
				0 = disabled
				1 = enabled
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.
	11	LDO4_ENA	0	LDO4 enable
				0 = disabled
				1 = enabled
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.

Note: These bits can be accessed through R13 or through R176. Reading from or writing to either register location has the same effect.



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R201 (C9h)	13:10	LDOn_ENSL	Dependant	Time slot for LDOn start-up
for LDO1		OT [3:0]	on	0000 = Disabled (do not start up)
			CONFIG	0001 = Start-up in time slot 1
R204 (CCh)			settings	(total 14 slots available)
for LDO2				1110 = Start-up in time slot 14
				1111 = Start up on entering ACTIVE
R207 (CFh)	9:6	LDOn_SDSL	0000	Time slot for LDO <i>n</i> shutdown.
for LDO3		OT [3:0]		0000 = Shut down on entering OFF
				0001 = Shutdown in time slot 1
R210 (D2h)				(total 14 slots available)
for LDO4				1110 = Shutdown in time slot 14
				1111 = Shut down on entering OFF
Note: n is a number	er betwee	n 1 and 4 that ider	ntifies the indiv	ridual DC-DC converter

Table 82 Enabling and Disabling the LDO Regulators

14.7.2 LDO REGULATOR CONTROL

The LDO Regulators can be configured to operate in different modes using the register bits described in Table 83.

In Switch mode, the Regulators operate as current-limited switches with no voltage regulation.

In LDO Regulator mode, the Regulators generate an output voltage determined by the LDOn_VSEL fields. The LDO Regulators are dynamically programmable - the output voltage may be adjusted in software at any time. The Regulators are critically damped to ensure there is no voltage overshoot or undershoot when adjusting the output voltage.

The default output voltage for the LDO Regulators is set by writing to the LDOn_VSEL register bits. The 'image' voltage settings LDOn_VIMG are alternate values that may be invoked when the HIBERNATE software or hardware control is asserted.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R200 (C8h)	14	LDOn_SWI	0	LDOn Regulator mode
for LDO1				0 = LDO voltage regulator
R203 (CBh)				1 = Current-limited switch (no voltage regulation, LDO <i>n_</i> VSEL has no effect)
for LDO2	4:0	LDOn_VSEL [4:0]	Dependant on CONFIG	LDO <i>n</i> Regulator output voltage (when LDO <i>n_</i> SWI=0)
R206 (CEh)			settings	
for LDO3				1 1111 = 3.3V
				(100mV steps)
R209 (D1h)				1 0000 = 1.8V
for LDO4				0 1111 = 1.65V
				(50mV steps)
				0 0000 = 0.9V
R202 (CAh)	4:0	LDOn_VIMG	1 1100	LDOn Regulator output image voltage
for LDO1		[4:0]		
				1 1111 = 3.3V
R205 (CDh)				(100mV steps)
for LDO2				1 0000 = 1.8V
				0 1111 = 1.65V
R208 (D0h)				(50mV steps)
for LDO3				0 0000 = 0.9V
R211 (D3h)				
for LDO4				
Note: n is a nu	ımber b	etween 1 and 4 tl	hat identifies the	e individual LDO regulator

Table 83 Controlling Regulator Voltage and Switch Mode



The LDO Regulators can also be controlled by the device HIBERNATE bit, or by hardware input signals L_PWR1, L_PWR2 and L_PWR3. Several GPIO pins can be assigned as L_PWR pins. Each Regulator can be assigned to one of these three signals, or else to the device HIBERNATE bit. The signals are active high and each Regulator's response to the selected signal is programmable as defined in Table 84.

Note that, when a GPIO pin is configured as a Hibernate input pin, and this input is asserted, then all LDO Regulators will be placed in Hibernate mode.

In order to use GPIO pins as L_PWR pins, they must be configured by setting the respective GPn_FN , and GPn_DIR bits to the appropriate value (see Section 20).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R202 (CAh)	13:12	LDOn_HIB_M	00	LDOn Hibernate behaviour:	
for LDO1		ODE [1:0]		00 = Select voltage image settings	
				01 = disable output	
R205 (CDh)				10 = reserved	
for LDO2				11 = reserved	
	9:8	LDOn_HIB_T	00	LDOn Hibernate signal select	
R208 (D0h)		RIG [1:0]		00 = Hibernate register bit	
for LDO3				01 = L_PWR1	
				10 = L_PWR2	
R211 (D3h)				11 = L_PWR3	
for LDO4					
Note: n is a numb	Note : <i>n</i> is a number between 1 and 4 that identifies the individual LDO regulator				

Table 84 Configuring Hardware Control for LDO Regulators

When the LDO Regulators are disabled, the output can be set to float or else the outputs can be actively discharged through internal resistors. This feature is controlled using the register bits described in Table 85.

Note that the "float" option is only supported when at least one other LDO Regulator remains enabled. If LDO Regulators 1, 2, 3 and 4 are all disabled, then the LDO Regulator outputs will be discharged, regardless of the $LDOn_OPFLT$ registers.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R200 (C8h)	10	LDOn_OPFLT	0	Enable discharge of LDOn outputs
for LDO1				when LDOn is disabled
				0 = Enabled - Output to be discharged
R203 (CBh)				1 = Disabled - Output is left floating
for LDO2				Note - if LDO Regulators 1, 2, 3 and 4
				are all disabled, then the outputs will all be discharged, regardless of the
R206 (CEh)				LDOn OPFLT bit.
for LDO3				EBOII_OITET bit.
R209 (D1h)				
for LDO4				
Note: n is a num	ber betwe	en 1 and 4 that ider	ntifies the indiv	ridual LDO regulator

Table 85 Output Float Control for LDO Regulators

14.7.3 INTERRUPTS AND FAULT PROTECTION

Each LDO Regulator is monitored for voltage accuracy and fault conditions. An undervoltage condition is set if the voltage falls below 95% of the required level. The action taken in response to a fault condition can be set independently for each LDO Regulator, as described in Table 86. The LDOn_ERRACT fields configure the fault response to disable the respective regulator or to shut down the entire system if desired. In addition, LDO Regulator fault conditions also generate a second-level interrupt (see Section 24).

To prevent false alarms during short current surges, faults are only signalled if the fault condition persists.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R201 (C9h)	15:14	LDOn_ERRACT	00	Action to take on LDOn fault (as
for LDO1		[1:0]		well as generating an interrupt):
				00 = ignore
R204 (CCh)				01 = shut down regulator
for LDO2				10 = shut down system
				11 = reserved (shut down system)
R207 (CFh)				
for LDO3				
R210 (D2h)				
for LDO4				
Note: n is a numb	er betwee	n 1 and 4 that ident	ifies the individu	ual LDO regulator

Table 86 Fault Responses for LDO Regulators

The DC-DC Converters and the LDO Regulators have a first-level interrupt, UV_INT (see Section 24). This comprises second-level interrupts from each of the DC-DC Converters and the LDO Regulators.

Each LDO Regulator has a dedicated second-level interrupt which indicates an under-voltage condition. These can be masked by setting the applicable mask bit as defined in Table 87.

ADDRESS	BIT	LABEL	DESCRIPTION
R28 (1Ch)	11	UV_LDO4_EINT	LDO4 Under-voltage interrupt.
Under Voltage			(Rising Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
	10	UV_LDO3_EINT	LDO3 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	9	UV_LDO2_EINT	LDO2 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	8	UV_LDO1_EINT	LDO1 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R36 (24h)	as in	"IM_" + name of respective	Mask bits for LDO regulator under-voltage
Under Voltage	R28	bit in R28	interrupts
Interrupt Mask			Each of these bits masks the respective
			bit in R28 when it is set to 1 (e.g. UV LDO1 EINT in R28 does not trigger a
			UV INT interrupt when
			IM_UV_LDO1_EINT in R36 is set).

Table 87 LDO Regulator Interrupts



The status of the LDO Regulators can be indicated and monitored externally via a GPIO pin configured as \(\text{VCC_FAULT} \) (see Section 20). When a GPIO pin is configured as \(\text{VCC_FAULT} \) output, a logic low level on this pin indicates that there is a fault condition on one of the LDO Regulators, DC-DC Converters, or the Current Limit switch.

The /VCC_FAULT output is configurable by the control fields in Register R215. The fields described in Table 88 determine which of the LDOs contribute to the /VCC_FAULT indication. An undervoltage or overvoltage condition on any unmasked LDO will cause the /VCC_FAULT output to be set to logic low

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R215 (D7h)	11	LDO4_FAULT	0	LDO4 fault mask for the /VCC_FAULT	
VCC_FAULT				0 = don't mask converter fault	
				1 = mask converter fault	
	10	LDO3_FAULT	0	LDO3 fault mask for the /VCC_FAULT	
				0 = don't mask converter fault	
				1 = mask converter fault LDO2 fault mask for the /VCC_FAULT 0 = don't mask converter fault	
	9	LDO2_FAULT	0		
				1 = mask converter fault	
	8	LDO1_FAULT	0	LDO1 fault mask for the /VCC_FAULT	
				0 = don't mask converter fault	
				1 = mask converter fault	

Table 88 LDO Regulator /VCCFAULT mask bits

14.7.4 ADDITIONAL CONTROL FOR LDO1

By default, all DC Converters and LDOs are disabled in the OFF state. Additional control is provided to enable LDO1 to be configured differently, allowing it to be enabled in the OFF state, or else to be controlled by a GPIO pin configured as /LDO_ENA (see Section 20.2.2). These options are selected by setting the register fields described in Table 89. In practical applications, however, these options are set by the Config Mode settings and are not set by users.

Operation of LDO1 in the OFF state is subject to the restriction that VOUT1 must be set to at least 1.8V.

CONDITION	DESCRIPTION		
LDO1_PIN_MODE = 0	LDO1 controlled as normal via register bits		
LDO1_PIN_MODE = 1 LDO1_PIN_EN = 0	LDO1 enabled at all times		
LDO1_FIN_EN = 0 LDO1_PIN_MODE = 1 LDO1_PIN_EN = 1	LDO1 controlled by /LDO_ENA only		

Table 89 LDO1 Additional Control

Note that LDO1 is always disabled in BACKUP and ZERO states.

Note that, when LDO1_PIN_MODE = 1, then LDO1 only operates as determined by the LDO1_VSEL field. The Hibernate settings are ignored under this configuration.

WM8350 Production Data

14.8 DC-DC CONVERTER OPERATION

14.8.1 OVERVIEW

The WM8350 provides six DC-DC switching converters. Four of these are Buck (Step-down) converters and two are Boost (Step-up) converters. The principal characteristics and typical usage for each DC-DC converter are shown below.

	DC-DC 1 / 6	DC-DC 2 / 5	DC-DC 3 / 4		
Typical Application	Other system components	Constant-current LED drivers or I/O supply	Digital supply for WM8350 and other components		
Converter Type	Step-down	Step-up, using external NFET	Step-down		
Input Voltage Range	2.7V to 5.5V				
Output Voltage Range	0.85V to 3.4V	5V to 20V	0.85V to 3.4V		
Load Current Rating	Up to 1A (may be limited by application)	170mA @ 5V 40mA @ 20V	Up to 500mA (may be limited by application)		
Switching Frequency	2.0MHz	1.0MHz	2.0MHz		

Table 90 DC-DC Converter Characteristics



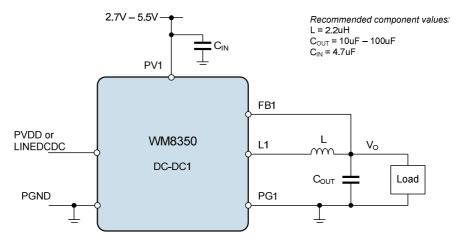
14.8.2 DC-DC STEP DOWN CONVERTERS

DC-DC Converters 1, 3, 4 and 6 are versatile step-down, pulse-width-modulated (PWM) DC-DC converters designed to deliver high power efficiency across full load conditions. The converters offer Active and Standby/Hysteretic operating modes in order to maximise efficiency for different loads. A low-power LDO sleep mode is also available to further reduce quiescent current at very lightly loaded conditions. The DC-DC Converters maintain output voltage regulation during the switch-over between operating modes.

The step-down regulators are designed with a fixed frequency current mode architecture. The current feedback loop is through the PMOS current path and is amplified and summed with an internal slope compensation network. The voltage feedback loop is through an internal feedback divider. The ON time is determined by comparing the summed current feedback and the output of the switcher error amplifier. The period is set by the internal RC oscillator, which provides a 2.0MHz clock.

A supply pin (PVDD) provides the core supply for DC-DC Converters 3 and 6. Another supply pin (LINEDCDC) provides the core supply for DC-DC Converters 1 and 4. The input voltage connection to DC-DC Converters 1, 3, 4 and 6 is provided on PV1, PV3, PV4 and PV6 respectively. These input voltages may be provided from the LINE voltage.

The connections to DC-DC Converter 1 are illustrated in Figure 69. The equivalent circuit applies to DC-DC Converters 3, 4 and 6 also.



Note: Equivalent circuit applies for DC-DC 3, 4 and 6.

Figure 69 Step-Down DC-DC Converter Connections

The external components at the converter output are required by the DC-DC Converter integral loop compensation circuit. Note that the recommended output capacitor Cout varies according to the required transient response on DC-DC1 and DC-DC6. A single recommended value is provided for Cout on DC-DC3 and DC-DC4.

See Section 29.2 for details of the recommended external components.

14.8.3 DC-DC STEP UP CONVERTERS

DC-DC Converters 2 and 5 are versatile step-up pulse-width-modulated (PWM) DC-DC converters designed to deliver high power efficiency across full load conditions. The converters can also be used as switches.

DC-DC Converters 2 and 5 are designed with a fixed frequency current mode architecture. The clock frequency is set by the internal RC oscillator, which provides a 1.0MHz clock.

The PVDD supply pin provides the core supply for DC-DC Converter 2. The LINEDCDC supply pin provides the core supply for DC-DC Converter 5.

The connections to DC-DC Converter 2 in Constant Voltage Mode are illustrated in Figure 70. The equivalent circuit applies to DC-DC Converter 5 also. See Section 29.4 for details of the connections for the Constant Current and USB operating modes of the DC-DC Step-Up Converters.

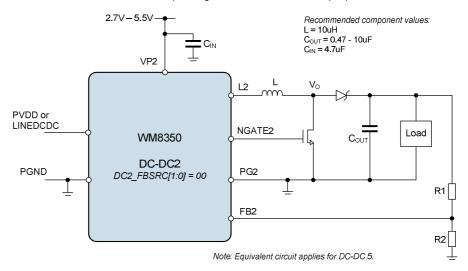


Figure 70 Step-Up DC-DC Converter Connections

The external components at the converter output are required by the DC-DC Converter integral loop compensation circuit. Note that the recommended output capacitor Cout varies according to the required output voltage.

See Section 29.4 for details of the recommended external components.

14.9 LDO REGULATOR OPERATION

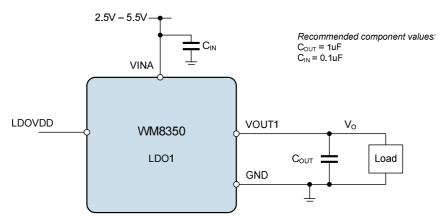
The WM8350 provides four identical LDO voltage regulators to generate accurate, low-noise supply voltages for various system components. The LDOs can also operate as current-limited switches, with no voltage regulation; this is useful for 'Hot Swap' outputs, i.e. supply rails for external devices that are plugged in when the system is already powered up - the current-limiting function prevents the in-rush current into the external device from disturbing other system power supplies.

The LDO regulators are dynamically programmable. Each regulator output is current-limited; the output voltage is automatically throttled back if the load current exceeds the limit.

A single supply pin (LDOVDD) provides the core supply for all four LDOs. The input voltage connection to LDO1 and LDO2 is provided on the VINA pin. The input voltage connection to LDO3 and LDO4 is provided on the VINB pin. These input voltages can be provided from one of the DC-DC Converters or from the LINE voltage.

Note that separate voltage regulators are provided to generate the backup supply VRTC and the microphone bias voltage MICBIAS.

The connections to LDO Regulator 1 are illustrated in Figure 71. The equivalent circuit applies to LDO2, LDO3 and LDO4.



Note: Equivalent circuit applies for LDO2, LDO3 and LDO4.
Input pin VINA supplies LDO1 and LDO2; Input pin VINB supplies LDO3 and LDO4.

Figure 71 LDO Regulator Connections

An input and output capacitor are recommended for each LDO Regulator, as illustrated above. See Section 29.5 for details of the recommended external components.

15 CURRENT LIMIT SWITCH

15.1 GENERAL DESCRIPTION

The WM8350 includes an on-chip Current Limit Switch to control external devices and to support hotplugging of accessories and power supplies.

When the switch is enabled, it normally has a low resistance, allowing current to pass through (from the IP pin to the OP pin). If the current limit threshold is reached, the WM8350 can raise an interrupt, disable the switch and/or shut down the whole device.

15.2 CONFIGURING THE CURRENT LIMIT SWITCH

15.2.1 CURRENT LIMIT SWITCH ENABLE

The Current Limit Switch can be enabled in software using the register fields defined in Table 91.

In Active mode, the Current Limit Switch can be enabled in software using the LS_ENA bit. Setting this bit whilst in the Pre-Active state (see Figure 65) will not immediately enable the Current Limit Switch; this bit will only become effective once the WM8350 has reached the Active state.

The Current Limit Switch may be programmed to become enabled in a selected timeslot within the start-up sequence. When this happens, the WM8350 will set the LS_ENA bit. Note that setting the LS_ENSLOT field in software is only relevant to the Development Mode, as this field is assigned a preset value in each of the Custom Modes.

The Current Limit Switch may be programmed to switch off in a selected timeslot within the shutdown sequence. If the Limit Switch is not allocated to one of the 14 shutdown timeslots, it will be disabled when the WM8350 enters the OFF state.

The Current Limit Switch behaviour in Hibernate mode is controlled by the LS_HIB_MODE bit.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R13 (0Dh)	15	LS_ENA	0	Limit Switch enable
R176 (B0h)	15			0 = disabled
DC-DC / LDO				1 = enabled
requested				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.
Note: LS_ENA can be accessed through R13 or through R176. Reading from or writing to either register location has the same effect.				n R176. Reading from or writing to either
R199 (C7h)	13:10	LS_ENSLOT	0000	Time slot for Limit Switch start-up
Limit switch		[3:0]		0000 = Disabled (do not start up)
control				0001 = Start-up in time slot 1
				(total 14 slots available)
				1110 = Start-up in time slot 14
				1111 = Start-up on entering ACTIVE
	9:6	LS_SDSLOT	0000	Time slot for Limit Switch shutdown.
		[3:0]		0000 = Shut down on entering OFF
				0001 = Shutdown in time slot 1
				(total 14 slots available)
				1110 = Shutdown in time slot 14
				1111 = Shut down on entering OFF
	4	LS_HIB_MO	0	Limit switch hibernate mode setting
		DE		0 = disabled
				1 = leave setting as in Active mode

Table 91 Enabling and Disabling the Current Limit Switch



15.2.2 CURRENT LIMIT SWITCH BULK DETECTION CONTROL

The Current Limit Switch can be connected to voltages which may be higher than the device LINE voltage. To support this capability, the switch is powered from the highest available voltage; this requires a bulk detection circuit in order to select the highest available voltage. The bulk detection circuit is always enabled whenever the Current Limit Switch is enabled.

It is possible to control whether the bulk detection circuit is enabled or not when the Current Limit Switch is disabled. This is controlled in Active mode by the LS_PROT bit, and in Hibernate mode by the LS_HIB_PROT bit.

Disabling the Bulk Detection circuit will reduce power consumption. It is important to note, however, that the Bulk Detection circuit should always be enabled if voltages greater than LINE could be present on IP or OP. This applies regardless of whether the Current Switch is open or closed.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R199 (C7h) Limit switch control	1	LS_HIB_PRO T	1	Controls the bulk detection circuit when Limit Switch is disabled in Hibernate mode.
				0 = bulk detection disabled 1 = bulk detection enabled
	0	LS_PROT	1	Controls the bulk detection circuit when Limit Switch is disabled in Active mode.
				0 = bulk detection disabled 1 = bulk detection enabled

Table 92 Current Limit Switch Bulk Detection Control

15.2.3 INTERRUPTS AND FAULT PROTECTION

The response to an over-current condition is selectable. To prevent false alarms during short current surges, faults are only signalled if the fault condition persists.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R199 (C7h)	15:14	LS_ERRACT	00	Current limit detection behaviour
Limit switch		[1:0]		00 = ignore
control				01 = disable switch
				10 = shut down system
				11 = shut down system

Table 93 Fault Response for the Current Limit Switch

The limit switch has its own first-level interrupt, OC_INT (see Section 24). This contains a single second-level interrupt, OC_LS_EINT, indicating an over-current condition. OC_LS_EINT can be masked by setting the IM OC LS EINT bit.

ADDRESS	BIT	LABEL	DESCRIPTION
R29 (1Dh)	15	OC_LS_EINT	Limit Switch Over-current interrupt.
Over Current			(Rising Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
R37 (25h) Over Current	15	IM_OC_LS_EINT	Mask bit for Limit switch over-current interrupt
Interrupt Mask			When set to 1, IM_OC_LS_EINT masks OC_LS_EINT in R29 and does not trigger an OC_INT interrupt when OC_LS_EINT is set).

Table 94 Current Limit Switch Interrupts



The status of the Current Limit Switch can be indicated and monitored externally via a GPIO pin configured as /VCC_FAULT (see Section 20). When a GPIO pin is configured as /VCC_FAULT output, a logic low level on this pin indicates that there is a fault condition on one of the LDO Regulators, DC-DC Converters, or the Current Limit switch.

The /VCC_FAULT output is configurable by the control fields in Register R215. The LS_FAULT bit described in Table 95 selects whether the Limit Switch contributes to the /VCC_FAULT indication. When LS_FAULT = 0, then an overcurrent condition on the Limit Switch will cause the /VCC_FAULT output to be set to logic low.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R215 (D7h)	15	LS_FAULT	0	Limit Switch fault mask for the
VCC_FAULT				/VCC_FAULT
				0 = don't mask converter fault
				1 = mask converter fault

Table 95 Limit Switch /VCCFAULT Mask



16 CURRENT SINKS (LED DRIVERS)

16.1 GENERAL DESCRIPTION

The WM8350 includes five pins for driving different types of LEDs.

The pins ISINKA and ISINKB provide programmable constant-current sinks designed to drive strings of serially connected LEDs, including white LEDs used in display backlights or in camera flash applications. Using ISINKA and ISINKB in conjunction with DC-DC Converters 2 or 5 provides a particularly power-efficient way to drive such LED strings. The ground connection associated with these two Current Sinks is the SINKGND pin.

ISINKC, ISINKD and ISINKE are regular open-drain outputs. They are alternate functions of the GPIO10, GPIO11 and GPIO12 pins respectively. These GPIOs are provided on the LINE power domain; the associated ground connection is the GND pin.

16.2 CONSTANT-CURRENT SINKS

ISINKA and ISINKB are dedicated LED driver pins equipped with programmable constant current sinks. They are designed to drive strings of serially connected white LEDs such as those used in display backlights or photo-flash applications. Powering LEDs in this way is particularly power efficient because no series resistor is required. DC-DC converters 2 or 5, operating as a current-controlled voltage source, are ideal power sources for LED strings. These converters can generate voltages higher than BATT or LINE, which can overcome the combined forward voltages of long LED strings (e.g. a string of 7 white LEDs with a forward voltage of 4V requires at least 28V).

16.2.1 ENABLING THE SINK CURRENT

In Active mode, ISINKA and ISINKB can be enabled in software using the register fields defined in Table 96. If required, the Current Sink functions may also be controlled by the Hibernate bit.

Note that these control bits do not exist for ISINKC, ISINKD or ISINKE.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R14 (0Eh)	0	CS1_ENA	0	Current Sink 1 enable (ISINKA pin)
Power mgmt				0 = disabled
(7)				1 = enabled
R172 (ACh)	15			
Current Sink Driver A	12	CS1_HIB_MO DE	0	Current Sink 1 behaviour in Hibernate mode
				0 = disable current sink in Hibernate
				1 = leave current sink as in Active
R14 (0Eh)	1	CS2_ENA	0	Current Sink 2 enable (ISINKB pin)
Power mgmt				0 = disabled
(7)				1 = enabled
R174 (AEh)	15			
Current Sink Driver B	12	CS2_HIB_MO DE	0	Current Sink 2 behaviour in Hibernate mode
				0 = disable current sink in Hibernate
				1 = leave current sink as in Active

Note: CS1_ENA and CS2_ENA can be accessed through R14 or through R172/R174. Reading from or writing to either register location has the same effect.

Table 96 Enabling ISINKA and ISINKB

When ISINKA or ISINKB is used in conjunction with DC-DC Converter 2 or 5, the ISINK should always be switched on before the DC-DC Converter is switched on. Conversely, the DC-DC Converter should always be switched off before the ISINK is switched off. If high voltages are used, additional external components may also be needed to protect the WM8350.



16.2.2 PROGRAMMING THE SINK CURRENT

The sink currents for ISINKA and ISINKB can be independently programmed by writing to the CS1_ISEL and CS2_ISEL register bits. The current steps are logarithmic to match the logarithmic light sensitivity characteristic of the human eye. The step size is 1.5dB (i.e. the current doubles every four steps).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R172 (ACh)	5:0	CS1_ISEL	00 0000	ISINKA current = 4.05µA × 2 ^{CSn_ISEL/4}
Current Sink Driver A				where CS1_ISEL is an unsigned binary number
				Minimum: $00\ 0000 = 4.05\mu\text{A}$,
				Maximum: 11 1111 = 220mA
				(from circuit simulation)
				or
				CS1_ISEL = 13.3 × log (desired current / 4.05μ A)
R174 (AEh)	5:0	CS2_ISEL	00 0000	ISINKB current = 4.05µA × 2 ^{CSn_ISEL/4}
Current Sink Driver B				where CS2_ISEL is an unsigned binary number
				Minimum: $00\ 0000 = 4.05\mu A$,
				Maximum: 11 1111 = 220mA
				(from circuit simulation)
				or
				CS2_ISEL = 13.3 × log (desired current / 4.05μA)

Table 97 Controlling the Sink Current for ISINKA and ISINKB

Note that currents above 40mA are not supported continuously; these settings are intended for flash mode only.

16.2.3 FLASH MODE

Each current sink can either sink current continuously (LED mode) or in short bursts (flash mode). The operating mode is selected by the CSn_FLASH_MODE bits, as described in Table 98.

In LED mode, the current sink is controlled by setting CSn_DRIVE. For as long as this bit is asserted, the LED is enabled continuously.

In Flash mode, the current sink may be set to automatically flash every 4 seconds by setting $CSn_FLASH_RATE = 1$, or may be triggered normally by setting $CSn_FLASH_RATE = 0$.

When normal triggering is selected in Flash mode, the trigger control can be either a GPIO Flash input (see Section 20) or a register control. Setting $CSn_TRIGSRC = 1$ selects GPIO as the trigger. The flash will be edge triggered by the selected GPIO input. Setting $CSn_TRIGSRC = 0$ selects the register field CSn_DRIVE as the trigger. In this case, writing a 1 to CSn_DRIVE will trigger a flash; this bit will be reset at the end of the flash.

In all flash modes, the duration of each flash is set by CSn_FLASH_DUR . The status of each current sink may be read from the CSn_DRIVE bits.

In all modes, the current sink must also be enabled via the applicable CSn_ENA bit (see Table 96).

Note that some photo-flash applications may require a reservoir capacitor to store sufficient charge for the flash.



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R173 (ADh) for ISINKA	15	CSn_FLASH_M ODE	0	Determines the function of the current sink
				0 = LED mode
R175 (AFh) for				1 = Flash mode
ISINKB	14	CSn_TRIGSRC	0	Selects the trigger in Flash mode.
				0 = Flash triggered by CSn_DRIVE bit
				1 = Flash triggered from GPIO pin configured as FLASH
				This bit has no effect when
				CSn_FLASH_MODE=0
	13	CSn_DRIVE	0	Enables the current sink ISINKn
				LED mode-
				0 = disable LED
				1 = enabled LED
				FLASH mode-
				Register bit used to trigger the flash, if
				CS1_TRIGSRC is set to 0. Flash is
				started when the bit goes high, it is then
				reset at the end of the flash duration.
				Duration is determined by
				CS1_FLASH_DUR. This bit has no effect
				if CS1_TRIGSRC is set to 1.
	12	CSn_FLASH_R	0	Determines the Flash rate
		ATE		0 = Normal Operation. Once per trigger (Either register bit or GPIO)
				1 = Flash will be internally triggered
				every 4 second
	9:8	CSn_FLASH_D	00	Sets duration of flash
		UR [1:0]		00 = 32ms
				01 = 64ms
				10 = 96ms
				11 = 1024ms
Note: n is either	1' for ISIN	KA or '2' for ISINKI	В	

Table 98 Configuring Flash Mode for ISINKA and ISINKB

Note that the CSn_DRIVE bits are always reset when exiting the hibernate state, regardless of the REG_RESET_HIB_MODE bit. If the CSn_DRIVE is enabled in the hibernate state, then it must be re-enabled by writing to the applicable control register after exiting the hibernate state. This may result in a short interruption to the Current Sink output.

16.2.4 ON/OFF RAMP TIMING

The sink currents for ISINKA and ISINKB can be programmed to switch on and off gradually in LED and in Flash modes. The current ramp durations are set as described in Table 99.

ADDRESS	BIT	LABEL	DEFAULT	DESCR	RIPTION
R173 (ADh) for	5:4	CSn_OFF_RA	00	Switch-off ramp dur	ation
ISINKA		MP [1:0]		LED Mode	Flash Mode
R175 (AFh) for				00 = instant (no ramp)	00 = instant (no ramp)
ISINKB				01 = 0.25s	01 = 1.95ms
				10 = 0.5s	10 = 3.91ms
				11 = 1s	11 = 7.8ms
	1:0	CSn_ON_RAM	00	Switch-on ramp dur	ation
		P [1:0]		Similar to CSn_OFF	RAMP
Note: n is either	Note: n is either '1' for ISINKA or '2' for ISINKB				

Table 99 Configuring On/Off Ramp Timing for ISINKA and ISINKB

16.2.5 INTERRUPTS AND FAULT PROTECTION

The Current Sinks have a first-level interrupt, CS_INT (see Section 24). This comprises two second-level interrupts which indicate if the Current Sinks are unable to sink the amount of current that has been programmed. CS1_EINT and CS2_EINT can be masked by setting the applicable mask bit as defined in Table 100.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah) Interrupt Status 2	13	CS1_EINT	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	12	CS2_EINT	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h) Interrupt Status 2 Mask	13:12	"IM_" + name of respective bit in R26	Each bit in R34 enables or masks the corresponding bit in R26. The default value for these bits is 0 (unmasked).

Table 100 Current Sink Interrupts



16.3 OPEN-DRAIN LED OUTPUTS

The three open-drain outputs ISINKC, ISINKD and ISINKE are alternate functions of the GPIO10, GPIO11 and GPIO12 pins, respectively (see Section 20). They can drive LEDs connected to LINE, with a series resistor. Note that the GPIO pins have other alternate functions, which will not be available that pin is configured as ISINKC, ISINKD or ISINKE.

16.4 LED DRIVER CONNECTIONS

The recommended connections for LEDs on ISINKA and ISINKB are illustrated in Figure 72.

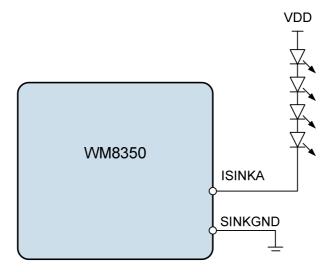


Figure 72 LED Connections to ISINKA and ISINKB

The recommended connections for LEDs on ISINKC, ISINKD and ISINKE are illustrated in Figure 73.

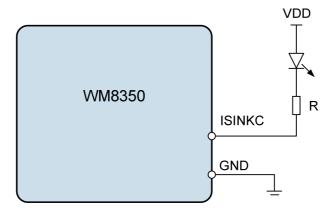


Figure 73 LED Connections to ISINKC, ISINKD and ISINKE

17 POWER SUPPLY CONTROL

17.1 GENERAL DESCRIPTION

The WM8350 can take its power supply from a Wall adaptor, a USB interface or from a single-cell lithium battery. The WM8350 autonomously chooses the most appropriate power source available, and supports hot-swapping between sources (ie. the system can remain in operation while different sources are connected and disconnected).

Comparators within the WM8350 identify which power supplies are available and select the power source in the following order of preference:

- Wall adaptor (LINE pins)
- USB power rail (USB pins)
- Battery (BATT pins)

Note that the Wall supply is always the first choice of supply, (providing that it is within required limits), even if the Wall supply voltage is lower than the USB voltage.

When Wall or USB is selected as the power source, this may be used to charge the Battery, using the integrated battery charger circuit. For battery charging to occur, the USB or LINE supply voltage must be no less than 4.0V.

Figure 74 illustrates the WM8350 connections associated with the WALL, USB and Battery supplies.

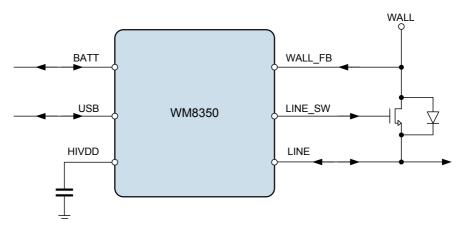


Figure 74 WM8350 Power Supply Connections

The Wall Adaptor supply connects to LINE via a FET switch as illustrated in Figure 74. The FET switch is necessary in order to provide isolation between the Wall supply and the Battery/USB supplies; this is vital in the event of the USB voltage being greater than the Wall supply voltage.

The Wall Adapter voltage is sensed directly on the WALL_FB pin; this allows the WM8350 to determine the preferred supply, including when the FET is switched off.

The gate connection to the external FET is controlled by LINE_SW, which is an alternate function that can be enabled on GPIO12 (see Section 20). Note that, if the USB connection is not used, then the FET may not be required and the Wall supply may be connected directly to LINE.

LINE is primarily an output from the WM8350; this output is the preferred supply, where the WM8350 has arbitrated between the Wall, Battery and USB connections. This output is suitable for supplying power to the other blocks of the WM8350, including the DC-DC Converters and LDO Regulators. LINE is also an input under some conditions, such as battery charging from Wall or providing power at the USB connection.



HIVDD is an external connection which exists for the purposes of decoupling only. It represents the highest available power supply connected to the WM8350. It should be noted that the preferred supply (on the LINE pin) is not necessarily the same voltage as HIVDD - the Wall supply will always be the preferred voltage when it is within the intended limits, even if it is not also the highest available source.

The main battery connects directly to the BATT pin. When the battery is the preferred supply source, this pin is an input. When battery charging is in operation, this pin is an output. (Note that the backup VRTC battery is connected separately - see Section 17.6.)

The USB interface connects directly to the USB pin. In USB Master Mode (USB is less than LINE), the WM8350 can supply power to external devices on this pin. In USB Slave Mode (USB is greater than LINE), the WM8350 can use this pin as an input to power the device and/or to charge a battery connected to the BATT pin. Note that, when USB is the preferred power supply, the Battery may also be used if necessary to supplement the current drawn from the USB pin (ie. to source current into LINE when required).

All loads connected to the WM8350 should normally be connected to the LINE pin. The inputs to the DC-DC Converters and LDOs should be connected to the LINE pin. It is not recommended to connect any load directly to the battery (BATT).

Note that the inputs to the LDOs may be connected to the outputs of the DC-DCs if desired.

17.2 BATTERY POWERED OPERATION

The WM8350 selects battery power when the Battery voltage is higher than the Wall (LINE) and USB supplies. In practical usage, this means the Battery is used when Wall (LINE) and USB are both disconnected.

The battery can also be used to supplement the USB supply when required (ie. to source current into LINE).

If the Wall (LINE) or USB supply becomes available during battery operation, then the selected power source is adjusted accordingly.

Battery pack temperature sensing is enabled by default. The battery's NTC resistor is monitored via the AUX1 pin on the WM8350, as described in Section 17.7. Note that the absence of this NTC connection will lead to a temperature failure condition being detected and battery charging will not be possible.

Safe operation of the battery charger outside the designed operating temperatures is not guaranteed when a battery NTC resistor is not used. The designed operating temperatures are noted in Section 17.7.7

17.3 WALL ADAPTOR (LINE) POWERED OPERATION

The WM8350 selects Wall Adaptor power via the LINE pins whenever the Wall Adaptor supply is within the normal operating limits of 4.0V to 5.5V. The Wall Adaptor is also selected as the power source below 4.0V in the case where it is the highest available power source. The minimum LINE voltage is a programmable threshold in the range 2.9V to 3.6V (see Section 18). The maximum recommended operating voltage for LINE is 5.5V.

Note that USB power is not used when a suitable LINE supply is available, even if the USB supply is higher than the Wall (LINE) supply.

If the Wall (LINE) supply becomes unsuitable and a USB is available, then the USB supply will be selected as the preferred power source. Note that, when hot-swapping from Wall (LINE) to USB supply, a usable Battery must be present on the BATT pin.

When the Wall (LINE) supply is selected and a Battery is connected, then trickle charging is enabled by default, including when the WM8350 is in the OFF or HIBERNATE states. When the WM8350 is in the ACTIVE state, then fast charging may be selected under software control.



17.4 USB POWERED OPERATION

The WM8350 selects USB Slave mode by default. In USB Slave Mode, the USB pin can be used as one of the sources of power for the WM8350. In USB Master Mode (selected using the USB_MSTR register bit) the WM8350 can provide power to an external USB device.

In USB Slave mode, the WM8350 selects USB power if the Wall (LINE) supply is outside its normal operating limits and the USB supply is the highest supply source available. For a transition from OFF to ACTIVE state to occur under USB power, the USB supply must be no less than 4.0V.

The maximum current drawn from the USB supply can be set to 100mA (USB low power mode) or 500mA (USB high power mode). The default is set according to the selected Config Mode (see Section 14).

When the WM8350 is in the ACTIVE state, USB high power mode can be selected using the register bits USB_MSTR_500MA (in USB Master Mode) or USB_SLV_500MA (in USB Slave Mode) as defined in Table 101. If a USB current higher than the applicable threshold is demanded, then internal protection circuits will limit the USB current, and the USB_LIMIT_EINT interrupt will be asserted.

Short term currents higher than 500mA can also be supported. This may be necessary for supporting transient demands (eg. for a hard drive starting up). When the USB_NOLIM register field is set, the internal protection circuits are disabled, and the current limit interrupt threshold is raised to double the normal value. In 500mA mode, the current limit interrupt threshold is raised to approximately 1A. This feature must be used with caution, as the internal protection circuits are disabled when USB_NOLIM is set. The maximum steady-state current supported is 500mA; higher currents can only be supported for short term transients.

USB power may be supplemented by battery power if available and if necessary to maintain the USB current within the applicable limit. If a suitable Wall (LINE) supply becomes available during USB operation, then the Wall (LINE) supply will be selected as the preferred power source. Note that, when hot-swapping from USB to Wall supply, a usable Battery must be present on the BATT pin.

In USB low power mode, trickle charging is enabled by default. Trickle charging is suspended if necessary to keep within the 100mA USB limit.

In USB high power mode, fast charging is possible (subject to other conditions - see Section 17.7.4). The fast charge current is controlled dynamically as necessary to keep the overall USB current within the 500mA limit.

Note that Battery Charging from the USB source is only possible in USB Slave Mode.

USB power may be suspended by writing to the USB_SUSPEND register bit. Setting this bit to '1' disconnects the WM8350 from the USB supply, resulting in the selection of Battery as the power source. USB Suspend mode is invoked under software control, by writing to the USB_SUSPEND bit. Suspend mode should be invoked whenever the USB connection is not used.

To comply with the USB 2.0 specification, the host processor should initially invoke USB Suspend mode after the WM8350 has successfully started up, and whenever the USB connection is not in use. If the USB connection is active and USB enumeration has been completed, the host processor may (but is not required to) switch the WM8350 into USB low-power mode or USB high-power mode. However, if wall adaptor power is available, it is recommended to remain in USB Suspend mode.



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R4 (04h)	14	USB_SUSPEND	0	Opens the USB switch
System				0 = USB enabled
Control 2				1 = USB suspended
				The register bit defaults to 0, when a reset happens or LINE < UVLO or the system fail on boot due to the upper limit of the Hysteresis Comp not being met.
	13	USB_MSTR	0	Set the chip to be a USB master 0 = Slave
				1 = Master
				The register bit defaults to 0, when a reset happens or the USB state machine moves from MASTER mode to SLAVE mode.
	11	USB_MSTR_500MA	0	Set 500mA or 100mA mode when the USB switch is in master mode
				0 = 100mA
				1 = 500mA
	9	USB_SLV_500MA	Dependant on CONFIG	Set 500mA or 100mA mode when the USB switch is in slave mode
			settings	0 = 100mA
				1 = 500mA
				The register bit defaults to 0, when a reset happens or LINE <uvlo been="" boot="" comp="" due="" fail="" hysteresis="" limit="" met.<="" not="" of="" on="" or="" system="" td="" the="" to="" upper=""></uvlo>

Table 101 Selecting USB Power Modes

The USB connection has its own first-level interrupt, USB_INT (see Section 24). This contains a single second-level interrupt, USB_LIMIT_EINT, which indicates an over-current condition. USB_LIMIT_EINT can be masked by setting the IM_USB_LIMIT_EINT bit.

USB Current monitoring is effective in USB Master and USB Slave Modes. The current limit threshold is determined by USB_MSTR_500MA (in USB Master Mode) or USB_SLV_500MA (in USB Slave Mode).

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	10	USB_LIMIT_EINT	USB Limit Switch interrupt.
Interrupt			(Rising Edge triggered)
Status 2			Note: This bit is cleared once read.
R34 (22h)	10	IM_USB_LIMIT_EINT	Interrupt mask.
Interrupt			0 = Do not mask interrupt.
Status 2 Mask			1 = Mask interrupt.
			When IM_USB_LIMIT_EINT is set to 1,
			then USB_LIMIT_EINT in R26 does not
			trigger an USB_INT interrupt when set.
			The default value is 0 (unmasked).

Table 102 USB Interrupt

17.5 EXTERNAL INTERRUPTS

The power supply control circuit has a first-level interrupt, EXT_INT (see Section 24). This comprises three second-level interrupts which indicate if the USB, Wall or Battery supplies have been connected or disconnected. Internal feedback signals USB_FB, WALL_FB and BATT_FB are used to indicate when the associated supplies are present. Note that these interrupt events occur on both the rising and falling edges of the trigger events. They can be masked by setting the applicable mask bits as defined in Table 103.

ADDRESS	BIT	LABEL	DESCRIPTION
R31 (1Fh)	15	EXT_USB_FB_EINT	USB_FB changed interrupt.
Comparator			(Rising and Falling Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
	14	EXT_WALL_FB_EINT	WALL_FB changed interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	13	EXT_BATT_FB_EINT	BATT_FB changed interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
R39 (27h)	15:13	"IM_" + name of respective bit	Interrupt mask.
Comparator		in R31	0 = Do not mask interrupt.
Interrupt Status			1 = Mask interrupt.
Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default value for these bits is 0 (unmasked).

Table 103 External Interrupts

17.6 BACKUP POWER

A backup power source should be provided for the WM8350 on the VRTC pin. This can be a small rechargeable battery or a high-capacitance capacitor (supercap). The purpose of this component is to power the always-on functions such as the on-chip crystal oscillator, RTC and ALARM control registers and UVLO comparator. As these circuit blocks store settings required for start-up, it is desirable that they continue to operate even when no other power source is available.

The VRTC battery (or capacitor) maintains its charge from the Wall (LINE), USB or BATT sources. The connection is illustrated in Figure 75. The series resistor limits the VRTC charge current. The $1\mu F$ capacitor is recommended also for stability; if this capacitor is too small or is not present, the VRTC output may oscillate and cause a system reset.

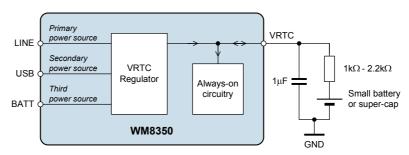


Figure 75 Backup Power

Note that, if the main battery is not present or is heavily discharged, and the WM8350 enters BACKUP mode from Wall or USB power, then leakage may occur between VRTC and LINE. This will cause the Backup Power source to be drained more quickly, and reduce the time for which the WM8350 can maintain the RTC.



The leakage occurs via the switched-VRTC connection (SWVRTC) and the AUX1 pin; a resistor is normally connected between these pins as part of the battery temperature detection circuit, as illustrated in Section 17.7.1. The leakage does not occur if the WM8350 enters BACKUP mode from Battery power, because the switched-VRTC output is not enabled in this case.

If no main battery is present in the system, then the SWVRTC pin should be left floating; this will prevent any leakage in BACKUP mode.

If the application supports the connection of a main battery, then it is important to select a battery pack where the NTC resistance is around $100k\Omega$ at 25°C. This will limit the leakage current to a maximum of $23\mu A$ in BACKUP mode. Battery packs with lower NTC resistance are not recommended as the leakage current in BACKUP will be higher.

If no backup battery is present in the system, then the leakage current is of no importance, as the BACKUP state is not supported.

17.7 BATTERY CHARGER

17.7.1 GENERAL DESCRIPTION

The WM8350 incorporates a battery charger which is designed for single-cell lithium batteries. The battery charger can operate from either the Wall (LINE) or USB power sources. Trickle charging at 50mA is enabled by default. The battery charger configuration and termination can run without any intervention required by the host processor.

The battery charger voltage and currents are programmable. Trickle charging at either 50mA or 100mA is supported; fast charging from 50mA up to 750mA is possible under certain conditions. Note that charging from the USB power is subject to the 100mA or 500mA overall limit on the USB source (see Section 17.4).

Battery pack temperature sensing is enabled by default. The connection to the battery's NTC resistor is made using the SWVRTC pin and the AUX1 pin, as illustrated in Figure 76. The SWVRTC pin is a reference source controlled by the WM8350. The AUX1 pin (also an input to the AUXADC) is used as the input to the temperature sensing circuit. Note that the absence of the NTC connection will lead to a temperature failure condition being detected and battery charging will not be possible.

Typical connections for the WM8350 battery charger are illustrated in Figure 76. The resistor value between SWVRTC and AUX1 should be selected to match the NTC. A typical value is $100k\Omega$.

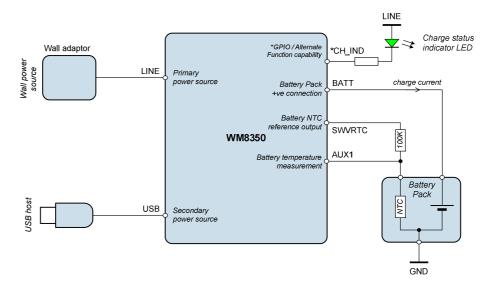


Figure 76 Typical Connections for WM8350 Battery Charger



The WM8350 monitors the battery status via the AUX1 pin and by voltage/current sensing on other pins. See Section 17.7.7 for details of the battery fault conditions and reporting.

If the application is intended to run without a battery present, then it is recommended that a $3.3\mu F$ capacitor be placed on the BATT pin to ensure correct charger behaviour. Also, the SWRTC pin should be left floating, to avoid leakage in BACKUP mode as described in Section 17.6. The Battery Charger interrupts should also be masked, as these will be invalid - see Section 17.7.8 for details of the Battery Charger Interrupts. It is recommended that the Battery Charger also be disabled in this case - note that the Battery Charger is enabled by default, including on entry to the OFF power state.

A typical battery charge cycle is illustrated in Figure 77. This shows both the trickle charge and fast charge processes.

The trickle charge mode is a constant current mode. Trickle charging is enabled when the battery voltage falls below a charging threshold voltage; it is disabled when the charge current falls to a programmable 'End of Charge' threshold level.

Fast charging consists of two phases:

In the constant current phase, the WM8350 drives a programmable constant current into the battery through the BATT pin. During this phase, the battery voltage rises monotonically until the battery reaches the target voltage.

When the battery reaches the target voltage, the charger enters the constant voltage phase, in which the WM8350 regulates BATT to the target voltage. To achieve this, the WM8350 adjusts the charge current adaptively. The charge current decreases monotonically over time. Fast charging is disabled when the current falls to a programmable 'End of Charge' threshold level.

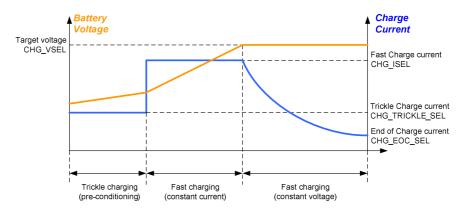


Figure 77 A Typical Charge Cycle

17.7.2 BATTERY CHARGER ENABLE

The battery charger is enabled by default when the WM8350 is in the ACTIVE, HIBERNATE or OFF states. Note that battery charging is only possible when the selected power source is within normal operating limits (see Section 7.5) and is more than 100mV higher than the battery voltage.

The battery charger can be disabled by setting the CHG_ENA register bit to '0'. When the battery charger is enabled, it autonomously checks if the conditions for charging are fulfilled and controls the charging processes accordingly. The status of the battery charger can be read from the CHG_ACTIVE register bit. (Note this bit is read-only.)

The battery charger can be paused by writing to the CHG_PAUSE register bit. This provides a simple option to halt the battery charger and to subsequently restart it without affecting the charge timer or other settings.



The battery charger target voltage is set by the CHG_VSEL field, as defined in Table 104.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12 (0Ch) Power Mgmt	9	CHG_ENA	1	CHG_ENA bit selects battery charger current control
(5)				0 = Set battery charger current to zero
R168 (A8h)	15			1 = Enable battery charge control
Battery charger control 1				Protected by security key.
R169 (A9h)	15	CHG_ACTIVE	0	Charger Status.
Battery charger				0 = Battery Charging is inactive
control 2				1 = Battery Charging is active
				(Note CHG_ENA is just a request; the WM8350 determines if the conditions are satisfied for Battery Charging).
	14	CHG_PAUSE	0	Charger pause:
				0 = Don't pause the charger
				1 = Pause charging
	5:4	CHG_VSEL	00	Battery charge voltage:
		[1:0]		00 = 4.05V
				01 = 4.1V
				10 = 4.15V
				11 = 4.2V

Note: CHG_ENA can be accessed through R9 or through R168. Reading from or writing to either register location has the same effect.

Table 104 Battery Charger Control

17.7.3 TRICKLE CHARGING

Trickle charging is enabled by default when the Wall (LINE) or USB pins are selected as the power source. It is autonomously initiated, supervised and terminated by the WM8350, without requiring any intervention by the host processor.

By default, trickle charging is initiated when the battery voltage is below the battery charge voltage CHG_VSEL by more than 100mV. Setting the CHG_FRC bit allows trickle charging to be initiated at higher battery voltages.

The trickle charge current is set by the CHG_TRICKLE_SEL field, as described in Table 105.

A choke circuit is provided to enhance the trickle charge current control. This allows the charge current to be modified according to temperature conditions or according to the USB current limit restrictions.

If the WM8350 temperature is above 115°C and trickle charge temperature choking is enabled, then charging is interrupted for at least 8 seconds and until the temperature has fallen below the threshold. If trickle charge temperature choking is not enabled, then charging continues. (Note that the device shutdown temperature is set at 140° C - this threshold cannot be disabled.) Trickle charge temperature choking is controlled by the CHG_TRICKLE_TEMP_CHOKE register bit.

If the USB current limit cannot support the charge current demanded by CHG_TRICKLE_SEL and USB current choking is enabled, then the charge current will be modified, where possible, in order to continue charging. The trickle charge current cannot be controlled dynamically - the only possible charge currents are 50mA or 100mA. Therefore, the only form of USB choking in trickle charge mode is for a demanded current of 100mA to be reduced to 50mA. Trickle charge USB current choking is controlled by the CHG_TRICKLE_USB_CHOKE register bit. The time constant for the charger's attempts to increase the current after USB choking can be controlled by CHG_RECOVERY_T.

The register control fields for Trickle Charging are described in Table 105. See Section 17.7.5 for details of battery charger termination.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R168 (A8h) Battery charger control 1	9	CHG_TRICKLE _TEMP_CHOK E	0	Enable trickle charge temperature choking 0 = disable
CONTROL 1				1 = enable
				Protected by security key.
	8	CHG_TRICKLE _USB_CHOKE	0	Enable USB current choking in trickle charge
				0 = disable
				1 = enable
				Protected by security key.
	7	CHG_RECOVE R_T	0	Time constant adjust for charger choke recovery (step-up):
				0 = Step-up time constant is 180us (allows faster recovery between processor wakeups)
				1 = Step-up time constant is >20ms (outside audio band)
				Protected by security key.
R169 (A9h)	6	CHG_TRICKLE	0	Selects the trickle charge current.
Battery charger control 2		_SEL		0 = Set the trickle charge current to 50mA.
				1 = Set the trickle charge current to 100mA.
				Protected by security key.
R170 (AAh) Battery charger control 3	7	CHG_FRC	0	Allows trickle-charging to be forced even if the battery voltage is above the default threshold
				0 = only trickle-charge if the battery voltage is below CHG_VSEL - 100mV
				1 = always trickle-charge
				Protected by security key.

Table 105 Trickle Charging Control



17.7.4 FAST CHARGING

Fast charging provides a faster way to charge the battery. This is only possible under certain conditions. Fast charging must be initiated by the system controller, and can never start autonomously.

Fast charging is normally possible in the ACTIVE state when the selected power source is Wall (LINE) or when USB high power mode is selected. The battery charger determines whether the conditions for fast charging are satisfied; these conditions include a suitable selected power source voltage (see Section 17.7.2) and a suitable battery voltage (greater than 3.1V).

If the conditions for fast charging are satisfied, this is indicated by the WM8350 setting the CHG_FAST_RDY_EINT register bit, as described in Table 106. Providing that the conditions for fast charging are satisfied, then fast charging is enabled by setting the CHG_FAST bit. If the conditions are not satisfied, then CHG_FAST will be held at 0.

The maximum fast charge current is set by the CHG_ISEL register field, as described in Table 106. During fast charging, the current may be dynamically controlled by the WM8350 in order to achieve optimum battery charging. It is recommended that the charge current limit should not be set higher than 400mA when charging from a USB power rail.

A throttle circuit is provided to enhance the fast charge current control. This allows the charge current to be modified according to temperature conditions or according to the USB current limit restrictions.

If the WM8350 temperature is above 115°C, then charging is interrupted for at least 8 seconds and until the temperature has fallen below the threshold. Temperature control of the battery charger is always enabled during Fast Charging.

If the USB current limit is reached during Fast Charging, then the charge current must be reduced. If USB current throttling is enabled, then the charge current will be controlled dynamically in order to continue charging. If USB current throttling is not enabled, then the charging will be terminated. (Note that this may give rise to an erroneous indication of 'End of Charge' as the charging may have terminated prematurely.) If USB current throttling is enabled, then 'End of Charge' will not be indicated, even if the throttle circuit causes the charger current to fall below the End of Charge current threshold. Fast charge USB current throttling is controlled by the CHG_FAST_USB_THROTTLE register bit. The time constant for the charger's attempts to increase the current after USB throttling can be controlled by CHG_THROTTLE_T.

The WM8350 will revert to Trickle charging if the conditions for fast charging are no longer satisfied. This includes selection of the OFF or HIBERNATE states, or selection of USB low power mode. The WM8350 will also revert to Trickle charging if it detects a low battery voltage condition (see Section 17.7.8).



The register control fields for Fast Charging are described in Table 106. See Section 17.7.5 for details of battery charger termination.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R25 (15h)	9	CHG_FAST_R	0	Indicates that the charger is ready to go
Interrupt Status		DY_EINT		into fast charge.
1				(Rising Edge triggered)
				Note: This bit is cleared once read.
R168 (A8h)	5	CHG_FAST	0	Enable fast charging.
Battery charger				0 = Fast charging cannot take place.
control 1				1 = Enable fast charging (will not start until valid charging conditions are met).
				Note: This register is held low and can only be written to once the fast charge ready signal has gone high.
				Protected by security key.
	4	CHG_FAST_U SB_THROTTL	0	Enable USB current throttling in fast charge:
		E		0 = Don't do any current throttling when
				fast charging.
				1 = Do current throttle while fast
				charging.
				Protected by security key.
R169 (A9h)	3:0	CHG_ISEL	0110	Fast charge current limit setting.
Battery charger		[3:0]		0000 = off
control 2				0001 = 50mA
				0010 = 100mA
				(50mA steps)
				1111 = 750mA
				Note: Do not set the charger to be more than 400mA when USB powered.
				Protected by security key.
R170 (AAh)	6:5	CHG THROTT	00	Time between steps when the charger
Battery		LE_T [1:0]		throttles back due to USB current limit.
Charger				00 = 8us
Control 3				01 = 16us
				10 = 32us
				11 = 128us
				Protected by security key.

Table 106 Fast Charging Control



17.7.5 BATTERY CHARGER TIMEOUT AND TERMINATION

Fast charging and Trickle charging is terminated under any of the following conditions:

- Charge current falls below a programmable threshold
- Charger timeout
- Charger fault condition (see Section 17.7.7)

The End of Charge Current threshold can be set between 20mA and 90mA, using the CHG_EOC_SEL register field, as defined in Table 107. Care should be taken to ensure that the End of Charge Threshold is lower than the selected Charge Current Limit (CHG_ISEL and/or CHG_TRICKLE_SEL).

When the End of Charge Current threshold is reached, the CHG_END_EINT interrupt field is set (see Section 17.7.8). The action taken when the End of Charge Current threshold occurs is set by CHG_END_ACT. The battery charging will either be terminated or will continue until timeout.

When Trickle charge choking or Fast charge throttling is enabled, it is possible that these circuits may cause the charge current to be reduced below the CHG_EOC_SEL threshold even though the battery is not fully charged. When choke or throttle control is enabled, the End of Charge detection described above is disabled, and charging always continues until timeout. It is recommended that Trickle charge choking and Fast charge throttling is enabled.

The WM8350 battery charger has a programmable timer. The timer is initiated when either fast charging or trickle charging commences. The initial value of the timer may be set by writing to the CHG_TIME register field. This field can also be read back as an indicator of the charge time remaining. Note that the readback value of this field is coded differently to the write value. Due to the limited resolution provided by the 4-bit field, the readback value is approximate only, to an accuracy of around 30 minutes.

If charging is paused by setting CHG_PAUSE (see Table 104), or is paused due to temperature or maximum current conditions, the charge timer is halted so that the time limit is extended accordingly.

If the charging mode is changed by asserting or de-asserting CHG_FAST, then the timer is reset to its initial value.

If the charging mode reverts to Trickle charge mode as a result of a change in power source or a change in USB power mode, then the timer is not reset, but continues to count down from its earlier value. (Note that the charger will never autonomously switch from Trickle charge mode to Fast charge mode.)

When the Charger Timer completes, the CHG_TO_EINT interrupt field is set (see Section 17.7.8) and charging is terminated.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R168 (A8h)	12:10	CHG_EOC_SE	000	Selects what the end of charge current
Battery charger		L [1:0]		should be set to
control 1				000 = 20mA
				001 = 30mA
				(10mA steps)
				111 = 90mA
				Protected by security key.
	6	CHG_END_AC	0	Action to take when charging ends:
		Т		0 = Set charge current to 0
				1 = Do nothing (leave charger on till timeout)
				Protected by security key



	DESCRIPTION
Battery charger control 2 [3:0] duration	g to his field set the charge timeout

Table 107 Battery Charger Termination

17.7.6 BATTERY CHARGER STATUS

The status of the Battery Charger can be read from the CHG_STS register field, as described in Table 108. This field indicates whether the charger is active in trickle or fast charge modes.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R169 (A9h)	13:12	CHG_STS [1:0]	00	Charger status:
Battery charger				00 = Charger off, current set to 0.
control 2				01 = In trickle charge mode.
				10 = In fast charge mode.
				11 - Reserved

Table 108 Battery Charger Status

In addition to the CHG_STS register readback, the charger status can be indicated on an LED connected to a GPIO pin configured as CH_IND (see Section 20). The CH_IND function is an opendrain LED output that provides a visible indication of the charger status.

CHARGER STATUS	CH_IND ACTION
Charger current set to zero	LED off
Trickle charging	LED blinks slowly (0.5Hz)
Fast charging	LED blink s quickly (1Hz)

Table 109 Battery Charger Status via CH_IND



17.7.7 BATTERY FAULT CONDITIONS

The WM8350 continuously monitors battery temperature, chip temperature and battery voltage. In case of a fault condition, it autonomously takes appropriate action, and alerts the host processor via the applicable interrupt flags.

Battery Temperature Monitoring

The WM8350 can monitor the battery temperature via the NTC (negative temperature coefficient) resistor which is incorporated into suitable battery packs. The NTC resistor must be connected to the AUX1 pin as shown in Section 17.7.1. Typical NTC resistor values vary over a range of temperature (source of information is Vishay Dale's "R-T Curve 2").

The NTC monitoring circuit is designed to detect temperature conditions outside the typical 0°C and 45°C safe battery charging conditions. The WM8350 indicates a cold battery temperature condition is indicated by setting the CHG_BATT_COLD_EINT interrupt. A hot battery temperature is indicated by setting the CHG_BATT_HOT_EINT interrupt. Battery charging is suspended when either of these conditions is set. (Note that trickle charging will resume once the battery temperature has returned to within normal levels.)

It is possible to disable the NTC detection circuit and associated flags. This option is protected by a security key. The associated register bits are described in Table 110.

Safety warning - The battery temperature sensor is a safety mechanism and it is strongly recommended that it be used, as directed, in all applications requiring charger functionality. Disabling this feature by any means, intentional or otherwise, could result in incorrect behaviour of the battery charger function.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION		
R168 (A8h) Battery Charger	3	CHG_NTC_M ON	1	Enable charger battery NTC detection (some batteries may not need this - turn off with caution)		
Control 1				0 = Charger ignores NO_NTC detection.		
				1 = Charger monitors NO_NTC detection.		
				Protected by user key, read-only in ROM configs.		
	2	CHG_BATT_H OT_MON	1	Enable charger battery temperature high detection (some batteries may not need this - turn off with caution)		
				0 = Charger ignores battery temperature too high.		
				1 = Charger monitors battery temperature too high.		
				Protected by user key, read-only in ROM configs.		
	1	CHG_BATT_C OLD_MON	1	Enable charger battery temperature low detection (some batteries may not need this - turn off with caution)		
				0 = Charger ignores battery temperature low.		
				1 = Charger monitors battery temperature low.		
				Protected by user key, read-only in ROM configs.		
Note: Some batte	Note: Some batteries may not require battery temperature monitoring. Disable with caution.					

Table 110 Battery Temperature Monitoring



Chip Temperature Monitoring

The WM8350 has a built-in temperature sensor to monitor the silicon die temperature. If the chip temperature reaches the thermal warning level, the WM8350 sets the SYS_CHIP_GT115_EINT (see Section 25) and Battery Charger operation may be paused (this is programmable in Trickle Charge mode). The charger operation will resume once the chip temperature has dropped below the thermal warning level.

If the chip temperature reaches the thermal shutdown level, the WM8350 sets the SYS_CHIP_GT140_EINT interrupt and shuts down. (Battery charging is always terminated in this case.)

Battery Voltage Detection / Defective Battery Detection

A low battery voltage is an indicator that the battery may be defective or removed.

In trickle charge mode, the battery voltage is checked after 30 minutes of charging, or after a quarter of the charging time CHG_TIME (the larger of these two times applies). If the battery voltage is less than the defective battery threshold (nominal value 2.85V) at this time, then the battery charging stops and the WM8350 sets the CHG_BATT_FAIL_EINT interrupt as defined in Table 111.

The battery failure condition is cleared if the battery voltage rises above the defective battery threshold. It is also cleared if any of the WM8350 power sources (including BATT) is removed and reapplied, or if the host processor invokes USB Suspend mode. When the failure condition is cleared, the charger then reverts back to its initial state, and may re-start if the conditions for charging are fulfilled (see Section 17.7.2).

If fast charging mode is selected, and the battery voltage is less than the defective battery threshold, then the WM8350 immediately reverts to trickle charging. If the fault persists, then trickle charging stops as described above.



17.7.8 INTERRUPTS AND FAULT PROTECTION

The battery charger can raise a first-level interrupt, CHG_INT (see Section 24) to report status and fault conditions to the host processor. The CHG_INT interrupt is the logical OR of all the second-level interrupts described in Table 111.

Note: If a battery is connected to the BATT pin, but the WM8350 is being powered from the Wall or USB supplies, then disconnection of the Wall or USB supply will cause the CHG_VBATT_LT_3P1_EINT and CHG_VBATT_LT_2P85_EINT interrupts to be set.

The CHG_VBATT_LT_3P1_EINT and CHG_VBATT_LT_2P85_EINT interrupts can be masked by setting the associated mask bits defined in Table 111.

Alternatively, the EXT_USB_FB_EINT and/or EXT_WALL_FB_EINT interrupts (see Section 17.5) can be used to validate the Battery Undervoltage interrupts - if one of the External Feedback interrupts is set at the same time as the Battery Undervoltage interrupts, then the Battery Undervoltage interrupts should be ignored.

R25 (19h) Interrupt	15	0110 BATT 110	
· ·		CHG_BATT_HOT_EINT	Battery temp too hot.
Ctatus 4			(Rising Edge triggered)
Status 1			Note: This bit is cleared once read.
	14	CHG_BATT_COLD_EINT	Battery temp too cold.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	13	CHG_BATT_FAIL_EINT	Battery fail.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	12	CHG_TO_EINT	Charger timeout.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	11	CHG_END_EINT	Charging final stage.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	10	CHG_START_EINT	Charging started.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	9	CHG_FAST_RDY_EINT	Indicates that the charger is ready to go into fast charge.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	2	CHG_VBATT_LT_3P9_EINT	Battery Voltage < 3.9 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	CHG_VBATT_LT_3P1_EINT	Battery voltage < 3.1 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	0	CHG_VBATT_LT_2P85_EIN	Battery voltage < 2.85 interrupt.
		Т	(Rising Edge triggered)
			Note: This bit is cleared once read.
R33 (21h)	15:0	"IM_" + name of respective bit	Mask bits for battery charger interrupts
Interrupt		in R25 (19h)	Each of these bits masks the respective
Status 1			bit in R25 when it is set to 1 (e.g.
mask			CHG_FAST_RDY in R25 does not trigger a CHG INT interrupt when
			IM_CHG_FAST_RDY in R33 is set).

Table 111 Battery Charger Interrupts



18 SYSTEM MONITORING AND UNDERVOLTAGE LOCKOUT (UVLO)

The WM8350 includes several mechanisms to prevent the system from starting up, or force it to shut down, when power sources are critically low.

The under-voltage lockout (UVLO) is a non-programmable voltage limit. When the available supplies are below this limit, the WM8350 enters the BACKUP state. The WM8350 can only proceed from BACKUP to the OFF state if LINE is above the UVLO level. Whenever the WM8350 is in ACTIVE, HIBERNATE or OFF state and LINE falls below the UVLO level, the WM8350 returns to the BACKUP state.

The UVLO limit threshold is equal to VRTC + 50mV. The precise value of VRTC may vary between devices, within the limits defined in the Electrical Characteristics (see Section 7.5).

The startup threshold is a programmable voltage limit. The WM8350 can only proceed from OFF to the ACTIVE state if LINE is above the startup threshold. (Note that, in the case of USB-powered operation, there are additional requirements; see Section 17.4). The startup threshold is determined by the PCCMP ON THR register field.

The shutdown threshold is determined by the PCCMP_OFF_THR register field. When LINE falls below this threshold, the WM8350 raises a SYS_HYST_COMP_FAIL_EINT interrupt. In addition, the WM8350 takes the action set by PCCOMP_ERRACT. If this bit is set, then the WM8350 will shut down in response to the LINE voltage falling below the shutdown threshold.

The startup and shutdown control register fields are described in Table 112. Note that the startup threshold should always be set higher than the shutdown threshold in order to create a hysteresis, making the system more stable.

The SYS_HYST_COMP_FAIL_EINT interrupt is one of the second-level interrupts which triggers a first-level System Interrupt, SYS_INT (see Section 24). This can be masked by setting the mask bit as described in Table 113.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R179 (B3h) Power Check Comparator	14	PCCMP_ERRA CT	0	Action to take when LINE falls below PCCMP_OFF_THR level (as well as generating an interrupt) 0 = ignore 1 = shut down system
	6:4	PCCMP_OFF_T HR [2:0]	010	Power check comparator system shutdown threshold value 000 = 2.9V 001 = 3.0V 111 = 3.6V Protected by security key.
	2:0	PCCMP_ON_TH R [2:0]	101	Power check comparator system startup threshold value 000 = 2.9V 001 = 3.0V 111 = 3.6V Protected by security key.

Table 112 Battery Monitoring and UVLO Control



ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	3	SYS_HYST_COMP_FAIL_	Hysteresis comparator indication that LINE
Interrupt		EINT	or BATT is less that shutdown threshold.
Status 2			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h)	3	IM_SYS_HYST_COMP_FAI	Mask bit for Hysteresis comparator
Interrupt		L_EINT	interrupt
Status 2			When set to 1,
Mask			IM_SYS_HYST_COMP_FAIL_EINT masks SYS_HYST_COMP_FAIL_EINT in R29
			and does not trigger an SYS_INT interrupt when SYS_HYST_COMP_FAIL_EINT is
			set).

Table 113 Battery Monitoring and UVLO Interrupts



19 AUXILIARY ADC

19.1 GENERAL DESCRIPTION

The WM8350 incorporates a low-power 12-bit Auxiliary ADC (AUXADC). This can be used to measure a number of internal or external voltages, with either VREF or VRTC as its reference. A programmable potential divider enables the AUXADC to measure voltages higher than the reference.

Note that the AUX1 pin is also the input for the battery pack temperature monitoring circuit and is therefore not freely available for other analogue inputs. The battery NTC input can still be sampled and readback via AUX1 in the same way as the other AUXADC inputs. The AUX1 pin may be used for other purposes if the NTC detection is disabled and/or the associated Battery Charger interrupts are masked. See Section 17.7 for details of the battery pack NTC functions.

The AUXADC circuit is illustrated in Figure 78.

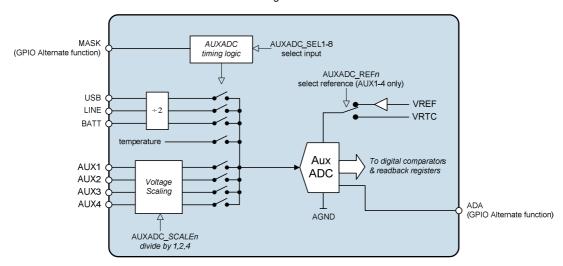


Figure 78 Auxiliary ADC

The AUXADC is enabled using the AUXADC_ENA register bit as described in Table 114.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12 (0Ch) Power Mgmt (5)	7	AUXADC_ENA	0	AUXADC control 0 = disabled
R144 (90h) Digitizer Control (1)	15			1 = enabled

Note: AUXADC_ENA can be accessed through R12 or through R144. Reading from or writing to either register location has the same effect.

Table 114 AUXADC Enable



19.2 INITIATING AUXADC MEASUREMENTS

The AUXADC can measure voltages on four external pins, AUX1, AUX2, AUX3 and AUX4. It can also measure voltages on the USB, LINE and BATT pins, and also the temperature sensor level. Each of these 8 inputs can be independently selected or deselected as an AUXADC input. Whenever the AUXADC is triggered, the AUXADC performs a measurement of each of the selected AUXADC inputs. By default, none of the AUXADC inputs is selected. Therefore, the required inputs must be enabled using the AUXADC_SELn bits prior to initiating an AUXADC measurement.

AUXADC measurements can be scheduled in a number of different ways, as determined by the AUXADC_CTC register bit. In Polling Mode, a set of measurements is initiated by writing a logic '1' to the AUXADC_POLL bit. (This bit is then automatically reset once the measurements have been completed.) In Continuous Mode, the WM8350 initiates a set of measurements at a time interval that is determined by the AUXADC_CRATE field.

Additional control can be provided using a GPIO pin configured as a 'MASK' input (see Section 20). The behaviour of the MASK input is selected using the AUXADC_MASKMODE register field - it can be used to inhibit any measurements triggered by the Polling or Continuous modes, or else it can be used as a hardware input to initiate a set of measurements.

Note that, when AUXADC_MASKMODE = 11, then AUXADC_CTC, AUXADC_POLL and AUXADC_CRATE have no effect. The polarity of the MASK input can be adjusted to be active high or active low using the GPn_CFG bits defined in Section 20, where 'n' identifies the particular GPIO pin in use.

The control fields associated with initiating AUXADC measurements are defined in Table 115.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R144 (90h)	14	AUXADC_CTC	0	Continuous conversion mode:
Digitiser Control				0 = Polling mode
(1)				1 = Continuous mode
	13	AUXADC_POLL	0	Writing "1" initiates a set of measurements in polling mode (AUXADC_CTC=0). This bit is automatically reset after the measurements are completed.
	7	AUXADC SEL8	0	AUXADC TEMP input select
		_		0 = Disable TEMP measurement
				1 = Enable TEMP measurement
	6	AUXADC_SEL7	0	AUXADC BATT input select
		_		0 = Disable BATT measurement
				1 = Enable BATT measurement
	5	AUXADC_SEL6	0	AUXADC LINE input select
				0 = Disable LINE measurement
				1 = Enable LINE measurement
	4	AUXADC_SEL5	0	AUXADC USB input select
				0 = Disable USB measurement
				1 = Enable USB measurement
	3	AUXADC_SEL4	0	AUXADC AUX4 input select
				0 = Disable AUX4 measurement
				1 = Enable AUX4 measurement
	2	AUXADC_SEL3	0	AUXADC AUX3 input select
				0 = Disable AUX3 measurement
				1 = Enable AUX3 measurement
	1	AUXADC_SEL2	0	AUXADC AUX2 input select
				0 = Disable AUX2 measurement
				1 = Enable AUX2 measurement
	0	AUXADC_SEL1	0	AUXADC AUX1 input select
				0 = Disable AUX1 measurement
				1 = Enable AUX1 measurement



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R145 (91h) Digitiser Control (2)	13:12	AUXADC_MASK MODE [1:0]	00	AUXADC MASK input control 00 = MASK is ignored 01 = When MASK is asserted, all AUXADC measurements are inhibited.
				10 = Reserved 11 = MASK input initiates AUXADC measurements. AUXADC_POLL and AUXADC_CTC have no effect. MASK polarity is controlled by GPn_CFG.
	10:8	AUXADC_CRAT E [2:0]	000	AUXADC measurement frequency in Continuous mode 000 = 1Hz 001 = 4Hz 010 = 8Hz 011 = 16Hz 100 = 32Hz 101 = 64Hz 110 = 128Hz 111 = 256Hz

Table 115 Initiating AUXADC Measurements

In Polling mode, setting AUXADC_POLL = 1 initiates one set of measurements, after which the AUXADC waits for a new trigger.

In Continuous mode, a set of measurements will be initiated at the frequency set by AUXADC_CRATE.

When using MASK to initiate measurements (AUXADC_MASKMODE=11), a rising edge (if $GPn_CFG=1$) or a falling edge (if $GPn_CFG=0$) initiates one set of AUXADC measurements. The MASK signal must be asserted for long enough for the AUXADC to perform all the selected measurements.

The AUXADC_SELn bits should not be changed until all previous measurement results stored in the AUXn readback registers have been read.



19.3 VOLTAGE SCALING AND REFERENCES

For inputs AUX1, AUX2, AUX3 and AUX4, the AUXADC measurements may be referenced to either VRTC or VREF (see Section 21). The selected reference can be selected independently for each input, using the control fields described in Table 116. In the case of USB, BATT, LINE and Temperature, the AUXADC measurements are referenced to VRTC.

In the case of AUXADC measurements which are referenced to VREF, a buffered copy of VREF is used as an input to the AUXADC. Setting the AUXADC_RBMODE field allows this buffer to be enabled at all times when the AUXADC is enabled, or else to only be enabled when a VREF-referenced measurement is made.

In order to measure voltages that may be higher than VRTC or VREF, a programmable divider is provided on each of AUX1, AUX2, AUX3 and AUX4. These are controlled using the AUXADC_SCALE*n* bits, allowing the inputs to be divided by 1, 2 or 4. In the case of USB, BATT and LINE, a fixed 'divide by 2' applies.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R152 (98h)	14:13	AUXADC_SCAL	11	AUXn input select
AUX1		En [1:0]		00 = Off
				01 = Input divided by 1
R153 (99h)				10 = Input divided by 2
AUX2				11 = Input divided by 4
D454 (0Ab)	12	AUXADC_REFn	1	AUXn reference select
R154 (9Ah) AUX3				0 = AUX <i>n</i> measured relative to
AOAO				VRTC
R155 (9Bh)				1 = AUX <i>n</i> measured relative to
AUX4				VREF
R145 (91h)	1	AUXADC_RBM	1	Enable for AUXADC bandgap
Digitizer Control		ODE		(VREF) buffer.
(2)				0 = AUXADC REFBUF is only
				enabled during conversions that use the VREF as a reference
				1 = AUXADC REFBUF is always
				enabled when the AUXADC is
				enabled

Table 116 AUXADC Reference Selection



19.4 AUXADC READBACK

Measured data from the AUXADC can be accessed by reading registers R152 through to R159, as defined in Table 117. This data may be read at any time, or may be read in response to the WM8350 indicating that new data is available.

The WM8350 indicates that new AUXADC data is available by setting the AUX_DATARDY_EINT interrupt flag as described in Section 19.7. This is one of five second-level interrupts which triggers a first-level System Interrupt, AUXADC_INT (see Section 24). This interrupt can be masked by setting the mask bit as described in Table 120. The AUX_DATARDY_EINT interrupt is set high when new data is available. It is reset when the associated interrupt register R26 is read.

The WM8350 can also indicate that new AUXADC data is available via a GPIO pin configured as ADA (Aux Data Available). This flag is set high when new data is available. It is reset when the associated data has been read from the readback registers R152 through to R159. See Section 20 for details of how to configure a GPIO pin as ADA.

To avoid losing data that has not yet been read, the WM8350 can inhibit overwriting the measurement registers with new data until the previous data has been read. When the AUXADC_WAIT bit is set, then AUXADC measurements are prevented from being overwritten until they have been read. Any Poll, Continuous or Mask-triggered AUXADC measurement will be ignored if the AUXADC_WAIT feature prevents the measurement from being overwritten.

Always specify the address of the starting register. Single data read from last register is not supported.

Reading from registers R152 to R159 returns a 12-bit code which represents the most recent AUXADC measurement on the associated channel. This code can be equated to the actual voltage (or temperature) according to the following equations:

To calculate the voltage for external measurements on the AUX input pins use the following formula:

AUXn = (Output Code / 4095) x Reference Voltage x AUX Input Scale

To calculate the voltage for internal AUXADC measurements on USB, LINE and Battery:

USB, LINE & BATT = (Output Code / 4095) x VRTC x 2

To calculate the temperature (in degrees Celsius) from AUXADC measurements on TEMP:

Temperature = 460.32 - ((Output Code / 4095) x VRTC x 614.6)

where-

Output Code = the relevant AUXADC_DATA field, decoded as an unsigned integer

Reference Voltage = VRTC voltage or VREF voltage, depending on AUXADC_REFn

AUX Input Scale = 1, 2 or 4, depending on AUXADC_SCALEn [1:0]

In a typical application, the AUX1 input is the battery pack temperature sensing (NTC) input. The voltage at this input may be used as an indicator of the battery pack temperature.

The NTC input should be measured relative to the VRTC voltage. The hot temperature threshold (CHG_BATT_HOT_EINT) corresponds to 0.33 x VRTC. This equates to approximately +45°C. The cold temperature threshold (CHG_BATT_COLD_EINT) corresponds to 0.74 x VRTC. This equates to approximately 0°C.



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R152 (98h) AUX1	11:0	AUXADC_DATA n [11:0]	000h	Measured AUXn data value relative to reference: 000 = 0V
R153 (99h) AUX2				FFF = measured voltage after divide matches reference
R154 (9Ah) AUX3				
R155 (9Bh) AUX4				
R156 (9Ch) USB Voltage Readback	11:0	AUXADC_DATA_ USB [11:0]	0h	Measured USB voltage data value.
R157 (9Dh) LINE Voltage Readback	11:0	AUXADC_DATA_ LINE [11:0]	0h	Measured LINE voltage data value
R158 (9Eh) BATT Voltage Readback	11:0	AUXADC_DATA_ BATT [11:0]	0h	Measured Battery Voltage
R159 (9Fh) Chip Temperature Readback	11:0	AUXADC_DATA_ CHIPTEMP [11:0]	0h	Measured Internal chip temperature
R145 (91h) Digitizer Control (2)	0	AUXADC_WAIT	0	Whether the old data must be read before new conversions can be made 0 = No effect (new conversions
				overwrite old) 1 = New conversions are held back (and measurements delayed) until AUX_DATAn has been read.

Table 117 Reading AUXADC Measurements

In a typical application, one of the following methods is likely to be used to control the AUXADC readback:

For interrupt-driven AUXADC readback, the host processor would read the AUXADC data registers in response to the AUXADC Interrupt or ADA output. In Continuous AUXADC mode, the processor should complete this action before the next measurement occurs, in order to avoid losing any AUXADC samples. In Polling mode, the interrupt (or ADA) signal provides confirmation that the commanded set of measurements has been completed.

For host-controlled AUXADC readback, the Continuous AUXADC mode would be used, and the AUXADC_WAIT bit would be asserted. The host processor would read the AUXADC data registers periodically, causing the next AUXADC measurement to be enabled. This limits the frequency of the AUXADC measurements to the readback frequency.

19.5 CALIBRATION

The on-chip reference VREF provides a highly accurate reference voltage to the AUXADC. For best measurement accuracy, the WM8350 provides a way to determine the voltage offset of the AUXADC's VREF buffer and the gain error introduced by scaling the AUXADC input. Measured data can then be adjusted accordingly, eliminating these errors.

To determine the buffer's offset, the AUXADC AUX3 input is disconnected from the AUX3 pin and connected to the unbuffered VREF voltage. Note that input scaling must be used, (i.e. AUXADC_SCALE3 = 10 or 11), in order to ensure that the AUXADC input is within the measurable range. Measuring this voltage using the buffered VREF as the reference (AUXADC_REF3 = 1) makes it possible to calculate the combined error.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R145 (91h) Digitizer Control (2)	2	AUXADC_CAL	0	Configure AUX3 input to be the VREF supply for AUXADC calibration. 0 = AUX3 input connected to AUX3 pin 1 = AUX3 input connected to
				1 = AUX3 input connected to unbuffered VREF

Table 118 AUXADC Calibration



19.6 DIGITAL COMPARATORS

The WM8350 has four digital comparators which may be used to compare AUXADC measurement data against programmable threshold values. Each comparator has an associated interrupt flag, as described in Section 19.7, which indicates that the associated data is beyond the threshold value.

The digital comparators are enabled using the DCMPn_ENA register bits as described in Table 119.

The source data for each comparator is selected using the DCMPn_SRCSEL register bits; this selects one of the eight AUXADC channels for each comparator. Note that, if required, the same AUXADC channel may be selected for more than one comparator; this would allow more than one threshold to be monitored on the same AUXADC channel.

The DCMP*n_*GT register bits select whether an interrupt will be indicated when the measured value is above the threshold or when the measured value is below the threshold.

The threshold $DCMPn_THR$ is a 12-bit code for each comparator. This field follows the same voltage scaling and voltage reference as the associated AUXADC channel source.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12 (0Ch)	3	DCMP4_ENA	0	Digital comparator 4 enable
Power Mgmt (5)				0 = disabled
				1 = enabled
or	2	DCMP3_ENA	0	Digital comparator 3 enable
				0 = disabled
R163 (A3h)				1 = enabled
Generic	1	DCMP2_ENA	0	Digital comparator 2 enable
Comparator Control				0 = disabled
Control				1 = enabled
	0	DCMP1_ENA	0	Digital comparator 1 enable
				0 = disabled
				1 = enabled
R164 (A4h)	15:13	DCMPn_SRCS	000	DCOMPn source select.
Generic		EL [2:0]		000 = AUX1
comparator 1				001 = AUX2
D405 (451)				010 = AUX3
R165 (A5h) Generic				011 = AUX4
Comparator 2				100 = USB
ooparator =				101 = LINE
R166 (A6h)				110 = BATT
Generic				111 = TEMP
Comparator 3	12	DCMPn_GT	0	DCOMPn interrupt control
				0 = interrupt when the source is
R167 (A7h)				less than threshold
Generic Comparator 4				1 = interrupt when the source is greater than threshold
	11:0	DCMPn_THR	000h	DCOMPn threshold
		[11:0]		(12-bit unsigned binary
				number)

Note: n is a number between 1 and 4 that identifies the individual comparator

Note: The Comparator Enable bits can each be accessed through two separate control registers. Reading from or writing to either register location has the same effect.

Table 119 AUXADC Digital Comparator Control

19.7 AUXADC INTERRUPTS

The AUXADC has five second-level interrupts which can trigger a first-level System Interrupt, AUXADC_INT (see Section 24). These are described in Table 120. Each AUXADC interrupt in Register R26 can be masked by setting the associated mask bit in Register R34.

The AUX_DATARDY_EINT interrupt indicates that new AUXADC data is ready. This bit is cleared when Register R26 is read. Note that this bit is not cleared by reading the measured AUXADC data in Registers R152 to R159.

The AUXADC_DCOMP*n_*EINT interrupts indicate that the selected AUXADC channel on Comparator 'n' is beyond the programmed threshold. The DCMP*n_*GT register bits defined in Table 119 select whether an interrupt indicates the measured value is above the threshold or indicates the measured value is below the threshold.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	8	AUXADC_DATARDY_EINT	Auxiliary data ready.
Interrupt			(Rising Edge triggered)
Status 2			Note: This bit is cleared once read.
	7	AUXADC_DCOMP4_EINT	DCOMP4 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	6	AUXADC_DCOMP3_EINT	DCOMP3 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	5	AUXADC_DCOMP2_EINT	DCOMP2 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	4	AUXADC_DCOMP1_EINT	DCOMP1 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h)	8:4	"IM_" + name of respective	Interrupt mask.
Interrupt		bit in R26	0 = Do not mask interrupt.
Status 2 Mask			1 = Mask interrupt.

Table 120 AUXADC Interrupts



20 GENERAL PURPOSE INPUTS / OUTPUTS (GPIO)

20.1 GENERAL DESCRIPTION

The WM8350 has thirteen general-purpose input/output (GPIO) pins; GPIO0 - GPIO12. These can be configured as inputs or outputs, active high or active low, with optional on-chip pull-up or pull-down resistors. Alternate functions are also available for each GPIO pin.

Note that different GPIO pins are supported on different power domains. The applicable power domain is specific to a pin, not to a particular GPIO function. The power domains are as follows:

GPIO0 to GPIO3 : VRTC
 GPIO4 to GPIO9 : DBVDD
 GPIO10 to GPIO12 : LINE

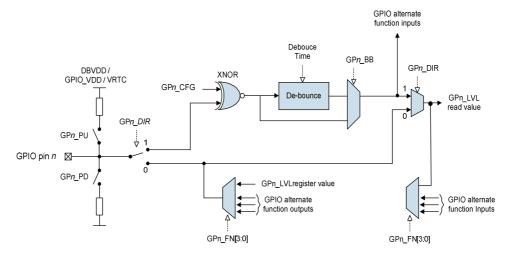


Figure 79 GPIO Equivalent Circuit

20.1.1 CONFIGURING GPIO PINS

To configure a pin as a GPIO, the corresponding GPn_FN register bits must be set to 0000 (see Table 125). Each GPIO pin can be set up as an input or as an output through the corresponding GPn_DIR register bits. Note that, when changing GPn_DIR , it is recommended to set $GPn_FN = 0000$ first. See Section 20.2.2 for the recommended sequence of commands when updating the GPIO pin function.

The state of a GPIO output is determined by writing to the corresponding GPn_LVL register bit. For GPIO inputs, reading the GPn_LVL bit returns the logic level at the GPIO pin.

The polarity of GPIO inputs can be selected through the corresponding GPn_CFG bit. For GPIO outputs, the GPn_CFG bit controls the electrical characteristics of the output pin.

GPIO inputs can also generate an interrupt (see Section 20.1.3). The GPn_INTMODE selects whether an interrupt occurs on a rising edge only, or else on both rising and falling edges. The input to this function is influenced by the polarity bit GPn_CFG described above.

ADDRESS	BIT	LABEL	DEFAULT	DESCRI	PTION		
R129 (81h)	12:0	GPn_PU [12:0]	Dependant	GPIOn pull-up			
GPIO pull-up			on CONFIG	0 = Normal			
			settings	1 = Pull-up enabled			
				Only valid when GP			
				input. Do not select			
		_		down at the same ti	me. (see note)		
R130 (82h)	12:0	GP <i>n</i> _PD [12:0]	Dependant	GPIOn pull-down			
GPIO			on CONFIG settings	0 = Normal			
pull-down			settings	1 = Pull-down enabl			
				Only valid when GP			
				input. Do not select down at the same til			
R131 (83h)	12:0	GPn_INTMODE	0	GPIOn Pin Mode:	ine. (see note)		
GPIO Interrupt		[12:0]		0 = GPIO interrupt is	s risina edae		
Mode				triggered and taken	0 0		
				of GPn_CFG registe	er bit		
				1 = GPIO interrupt is			
				falling edge triggere			
R134 (86h)	12:0	GP <i>n</i> _DIR [12:0]	Dependant on CONFIG	GPIOn pin direction			
GPIO Pin			settings	0 = Output			
Configuration			Settings	1 = Input			
R135 (87h)	12:0	GPn_CFG	Dependant	Selects input polarit	y /output type for		
GPIO Pin		[12:0]	on CONFIG	GPIOn	T -		
Polarity / Type			settings	Input	Output		
				(GPn_DIR=1)	(GPn_DIR=0)		
				0 = active low	0 = CMOS		
				1 = active high	1 = open-drain		
Door (Eal.)	40.0	OD - 1) // [40.0]	21/2	(see note)	(see note)		
R230 (E6h)	12:0	GP <i>n</i> _LVL [12:0]	N/A	Logic level of GPIO	Τ'		
GPIO pin status				Input (GPn DIR=1)	Output (GPn DIR=0)		
otatus				Read GPn_LVL to	Write to		
				check logic level.	GPn LVL to		
				Writing '0' clears	change logic		
				GPn_EINT	level.		
Note: <i>n</i> is a number between 0 and 12 that identifies the individual GPIO.							

Table 121 Configuring the GPIO Pins

Note: The GPIO input functions /MR, /WAKEUP and /LDO_ENA behave differently to other GPIO inputs. These functions are Active Low by default, when $GPn_CFG = 1$. These functions may be changed to Active High by setting $GPn_CFG = 0$.



Note: If a GPIO pin is configured as an open drain output, (ie. GP*n_*DIR=0, GP*n_*CFG=1), then the external pull-up voltage must not be greater than the supply domain for the corresponding GPIO. For example, if the GPIO supply domain is DBVDD then the external pull-up voltage must be less than or equal to DBVDD.

Note: Do not enable pull-up and pull-down resistors for the same GPIO pin.

Note: The internal pull-up and pull-down on GPIO10

, GPIO11 and GPIO12 may be too weak for many applications. If pull-up or pull-down is required on these pins, it is recommended to ensure that the pull resistance is <100k Ω . This can be achieved using an external resistor on its own or in combination with the internal resistance.

20.1.2 INPUT DE-BOUNCE

GPIO inputs have an optional de-bounce function to remove glitches from the input signal. This may be useful when the GPIO is connected to a mechanical switch. The de-bounce function can be enabled for each pin individually using GPn_DB , with a globally selectable de-bounce time set by GP_DBTIME .

GPIO alternative functions PWR_ON, PWR_OFF and /WAKEUP are special cases with regard to debouncing. PWR_ON and /WAKEUP have a debounce time of GP_DBTIME[1:0] + 40ms and PWR_OFF has a debounce time of GP_DBTIME[1:0] + 5ms.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION				
R128 (80h)	12:0	GPn_DB [12:0]	1	GPIOn debounce				
GPIO de-				0 = GPIO is not debounced.				
bounce				1 = GPIO is debounced (time from GP_DBTIME[1:0])				
R133 (85h)	7:6	GP_DBTIME	00	De-bounce time for all GPIO inputs				
GPIO Control		[1:0]		00 = 64μs				
				01 = 0.5ms				
				10 = 1ms				
				11 = 4ms				
				Note: PWR_ON, PWR_OFF and				
				/WAKEUP have additional debounce				
	times.							
Note: n is a num	ber betwe	en 0 and 12 that ide	entifies the ind	lividual GPIO.				

Table 122 Configuring GPIO De-bounce

20.1.3 GPIO INTERRUPTS

The GPIO logic can raise a first-level interrupt, GPIO_INT (see Section 24). This interrupt is the logical OR of the second-level GPIO interrupts described in Table 123.

ADDRESS	BIT	LABEL	DESCRIPTION		
R30 (1Eh)	12:0	GPn_EINT [12:0]	GPIOn interrupt.		
GPIO Interrupt			(Trigger controlled by GPn registers.)		
Status			Note: This bit is cleared once read.		
R38 (26h)	12:0	"IM_" + name of respective bit	Mask bits for GPIO interrupts		
GPIO Interrupt Mask		in R30	Each of these bits masks the respective bit in R30 when it is set to 1 (e.g. GPn_EINT in R30 does not trigger a GPIO_INT interrupt when IM_GPn_EINT in R38 is set).		
Note: n is a number between 0 and 12 that identifies the individual GPIO.					

Table 123 GPIO Interrupts



20.2 GPIO ALTERNATE FUNCTIONS

20.2.1 LIST OF ALTERNATE FUNCTIONS

The following alternate functions are available.

ALTERNATE FUNCTION NAME	INPUT / OUTPUT	DESCRIPTION
ADCLRCLK	Input	Alternate Left/Right clock for CODEC ADC digital interface. When this function is selected, the LRCLK pin supports the DAC interface only, and GPIO5 provides the ADC digital interface L/R clock. See Section 12.
ADCBCLK	Input	Alternate BCLK for CODEC ADC digital interface. When this function is selected, the BCLK pin supports the DAC interface only, and GPIO6 or GPIO8 provides the ADC digital interface BCLK signal. See Section 12.
CHIP_RESET	Input	Logic input to reset the Chip. When this input is asserted, the chip performs a full reset and re-starts in accordance with the current config mode settings. Note that CHIP_RESET_ENA in register R3 should be set
		to 1 when using CHIP_RESET as alternative GPIO function.
CSB	Input	3-/4-wire Control Interface Chip Select pin (CSB). Note that this function is selected automatically on GPIO7 when 3-/4-wire mode is selected, ie. regardless of the GP7_FN control field. See Section 11.
FLASH	Input	Hardware trigger for flash function on ISINKA or ISINKB. This function is rising edge triggered. The Current Sink must be in Flash mode, and with the trigger set to GPIO. See Section 16.
HIBERNATE (Level)	Input	Logic input to place the chip into hibernate. The behaviour of some components of the WM8350 in Hibernate mode is configurable. See Section 14.
		This "level triggered" input is deemed to be asserted for as long as it is logic 1 (or logic 0 if the polarity is inverted).
HIBERNATE (Edge)	Input	Logic input to place the chip into hibernate. The behaviour of some components of the WM8350 in Hibernate mode is configurable. See Section 14.
		When the "edge triggered" input is used, Hibernate is selected when a rising edge occurs (or a falling edge if the polarity is inverted). After Hibernate has been selected by this method, a "StartUp" event (see Section 14.3.1) is required to exit from Hibernate.
HEARTBEAT	Input	Input to Watchdog function, rising edge triggered. See Section 23.
/LDO_ENA	Input	Enable signal for LDO1. See Section 14.7.4.
L_PWR1	Input	Logic input used to place DC-DC Converters or LDOs into a Low Power state. See Section 14.
L_PWR2	Input	Logic input used to place DC-DC Converters or LDOs into a Low Power state. See Section 14.
L_PWR3	Input	Logic input used to place DC-DC Converters or LDOs into a Low Power state. See Section 14.
MASK	Input	Mask input to AUXADC. This input may be used either to block all inputs to the AUXADC, or to initiate A-D Conversions. See Section 19.
/MR	Input	Logic input used to drive the /RST pin and the /RST and /MEMRST (GPIO outputs) low. Note that this input has no other effect on internal circuits. See Section 14.
PWR_OFF	Input	Logic input signal causes a controlled shutdown of the WM8350. See Section 14.
PWR_ON	Input	Power on input signal from processor (input switching threshold 1.0V). See Section 14.



ALTERNATE FUNCTION NAME	INPUT / OUTPUT	DESCRIPTION
/WAKEUP	Input	Logic input signal causes wakeup from OFF or HIBERNATE states. Can be used for accessory detection. See Section 14.
32kHz	Input	32kHz clock input to Real Time Clock. See Section 22.
ADA	Output	Aux ADC external data available signal. See Section 19.
		0 = AUXADC external data not available
		1 = AUXADC external data available
ADCLRCLK	Output	Alternate Left/Right clock for CODEC ADC digital interface. When this function is selected, the LRCLK pin supports the DAC interface only, and GPIO5 provides the ADC digital interface L/R clock. See Section 12.
ADCLRCLKB	Output	Inverted Left/Right clock for CODEC ADC digital interface. When this function is selected, the LRCLK pin supports the DAC interface only, and GPIO6 provides the inverted ADC digital interface L/R clock. See Section 12.
ADCBCLK	Output	Alternate BCLK for CODEC ADC digital interface. When this function is selected, the BCLK pin supports the DAC interface only, and GPIO8 provides the ADC digital interface BCLK signal. See Section 12.
/BATT_FAULT	Output	Same as /UVLO signal – indicates no power present. Should be output as soon as possible after /UVLO.
CH_IND	Output	Battery Charge status indication. This output can drive an LED, which indicates battery charging status through different flash rates. See Section 17.
CODEC_OPCLK	Output	Output clock from CODEC. Frequency is determined by OPCLK_DIV. See Section 12.
DO_CONF	Output	Output used for development mode programming. Signal goes high to indicate that external programming can take place (during the Pre-Active state). Same functionality as PWR_ON (GPIO output) but with additional programmable option to prevent reset in OFF mode. See Section 14.
FLASH_OUT	Output	Logic output asserted for the duration of a Flash. Triggered by either SINKA or SINKB; Triggered by GPIO or CSn_FLASH bit. See Section 16.
FLL_CLK	Output	Output FLL clock. See Section 12.4.
ISINKC	Output	Open-drain output which can be used to drive LEDs connected to LINE via a series resistor. See Section 16.
ISINKD	Output	Open-drain output which can be used to drive LEDs connected to LINE via a series resistor. See Section 16.
ISINKE	Output	Open-drain output which can be used to drive LEDs connected to LINE via a series resistor. See Section 16.
LINE_SW	Output	Used to drive an external PFET between 'Wall' supply and LINE input, in order to prevent reverse conduction when the Wall Adapter is disconnected. See Section 17.1.
LINE_GT_BATT	Output	Output to enable external PFET to reduce IR loses when LINE is greater than BATT
MICDET	Output	Logic output indicating microphone bias current detection. 0 = Mic Bias Current not detected 1 = Mic Bias Current detected Note that an Interrupt is also generated by this event. See Section 13.12.2.
MICSHT	Output	Logic output indicating microphone bias short circuit detection. 0 = Mic Bias Short Circuit not detected 1 = Mic Bias Short Circuit detected
		Note that an Interrupt is also generated by this event. See Section 13.12.2.



ALTERNATE FUNCTION NAME	INPUT / OUTPUT	DESCRIPTION
/MEMRST	Output	Output used to control other subsystems such as external memory. Signal goes low to reset external memory. The status of this signal in the Hibernate state is configurable, allowing external memory contents to be retained in Hibernate. See Section 14.
P_CLK	Output	1MHz output clock in phase with the internal DC-DC converters. This signal can be used to sync external circuits (e.g. DC-DCs).
POR_B	Output	Output which toggles low to high during power-on reset
PWR_ON	Output	Output used to indicate that device is powered on (eg. to enable external DC-DC converters). This output is disabled in the OFF state.
/RST	Output	Output used to indicate system resets. Signal goes low during reset, same as the /RST pin. The pulse duration is programmable. See Section 14.
RTC	Output	Real Time Clock output - frequency is controlled by RTC_DSW[3:0]. See Section 22.
SDOUT	Output	4-wire Control Interface data output pin (SDOUT). Note that this function is selected automatically on GPIO6 when 4-wire mode is selected, ie. regardless of the GP6_FN control field. See Section 11.
/VCC_FAULT	Output	Indicates a fault condition on selectable DC Converters, LDO Regulators and the Limit Switch. The mask bits in Register 215 determine which supplies contribute to this status flag. See Section 14.6.5, Section 14.7.3 and Section 15.2.3.
VRTC	Output	Output from on-chip backup power source voltage regulator VRTC.
32kHz	Output	32kHz clock output from the Real Time Clock oscillator.

Table 124 List of GPIO Alternate Functions



20.2.2 SELECTING GPIO ALTERNATE FUNCTIONS

The function of each GPIO pin is programmable by writing to the respective GPn register bits. $GPn_FN = 0000$ selects the GPIO function and settings other than 0000 select various alternate functions.

The GPIO function is also determined by the value of the GPn_DIR register bit. Note that, when changing GPn_DIR , it is recommended to set $GPn_FN = 0000$ first.

When changing the function of a GPIO pin, (updating GPn_FN or GPn_DIR), it is recommended that the following sequence of actions is taken sequentially.

- Set GPn_FN = 0000
- Update the other GPIO configuration fields GPn_DB, GPn_PU, GPn_PD, GPn_CFG, GPn_DIR
- If the new function is an input, ensure that the input trigger is in the inactive state (ie. logic 0 for a function that is active High)
- Set GPn_FN according to the new GPIO function
- Read the GPIO Interrupt Status Register R30 (1Eh) to clear any GPIO Interrupt events
- If any bit in Register R30 (1Eh) was set when read, then read the System Interrupts Register R24 (18h) to clear the IRQ pin

Note that GPIO7 is automatically enabled as CSB in 3-wire and 4-wire control modes. GPIO6 is automatically enabled as SDOUT in 4-wire control mode. These automatic selections take precedence over all other GPIO6 and GPIO7 control fields.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R140 (8Ch	3:0	GP0_FN	Dependan	Selects function of GPIO0
GPIO function	7:4	GP1_FN	t on	Selects function of GPIO1
select 1	11:8	GP2_FN	CONFIG settings	Selects function of GPIO2
	15:12	GP3_FN	Settings	Selects function of GPIO3
R141 (8Dh)	3:0	GP4_FN		Selects function of GPIO4
GPIO function	7:4	GP5_FN		Selects function of GPIO5
select 2	11:8	GP6_FN		Selects function of GPIO6
	15:12	GP7_FN		Selects function of GPIO7
R142 (8Eh)	3:0	GP8_FN		Selects function of GPIO8
GPIO function	7:4	GP9_FN		Selects function of GPIO9
select 3	11:8	GP10_FN		Selects function of GPIO10
	15:12	GP11_FN		Selects function of GPIO11
R143 (8Fh)	3:0	GP12_FN		Selects function of GPIO12

Table 125 Control Registers to Select GPIO Alternate Functions

ADDRESS	BIT	LABEL	DEFAULT		DESCRIPTION		
R140 (8Ch	3:0	-	Dependant on		GPIO0 function definition		
GPIO function		[3:0]	CONFIG settings		Input (GPn_DIR=1)	Output (GP <i>n</i> _DIR=0)	
select 1				0000	GPIO	GPIO	
				0001	PWR_ON	PWR_ON	
				0010	/LDO_ENA	VRTC	
				0011	L_PWR1	POR_B	
				0100	PWR_OFF	/RST	
				0101	CHIP_RESET		
	7:4	GP1_FN	Dependant on		GPIO1 function of	definition	
		[3:0]	CONFIG		Input	Output	
			settings	0000	GPIO	GPIO	
				0001	PWR_ON	DO_CONF	
				0010	/LDO_ENA	/RST	
				0011	L_PWR2	/MEMRST	
				0100	/WAKEUP	32kHz	
	11:8	GP2_FN	Dependant on		GPIO2 function of	definition	
		[3:0]	CONFIG		Input	Output	
			settings	0000	GPIO	GPIO	
				0001	PWR_ON	PWR_ON	
				0010	/WAKEUP	VRTC	
				0011	32kHz	32kHz	
				0100	L_PWR3	/RST	
	15:1	GP3_FN	Dependant on		GPIO3 function of	definition	
	2	[3:0]	CONFIG		Input	Output	
			settings	0000	GPIO	GPIO	
				0001	PWR_ON	P_CLK	
				0010	/LDO_ENA	VRTC	
				0011	PWR_OFF	32kHz	
				0100	FLASH	/MEMRST	
Note: Undocu	mented	combination	s for GPn_FN (n	= 0 to 3) a	re reserved		

Table 126 GPIO Function Select 1



ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION			
R141(8Dh)	3:0	GP4_FN	Dependant on		GPIO4 function	definition	
GPIO function		[3:0]	CONFIG settings		Input (GPn_DIR=1)	Output (GPn_DIR=0)	
select 2				0000	GPIO	GPIO	
				0001	/MR	/MEMRST	
				0010	FLASH	ADA	
				0011	HIBERNATE (Level)	FLASH_OUT	
				0100	MASK	/VCC_FAULT	
				0101	CHIP_RESET	MICSHT	
				1010		MICDET	
	7:4	GP5_FN	Dependant on		GPIO5 function	definition	
		[3:0]	CONFIG settings		Input	Output	
			Settings	0000	GPIO	GPIO	
				0001	L_PWR1	P_CLK	
				0010	ADCLRCLK	ADCLRCLK	
				0011	HIBERNATE (Edge)	32kHz	
				0100	PWR_OFF	/BATT_FAULT	
				0101	HIBERNATE (Level)	MICSHT	
				0110	-	ADA	
				0111	-	CODEC_OPCLK	
				1010	-	MICDET	
	11:8	GP6_FN	Dependant on		GPIO6 function	definition	
		[3:0]	CONFIG settings		Input	Output	
			30ttilig3	0000	GPIO	GPIO	
				0001	L_PWR2	/MEMRST	
				0010	FLASH	ADA	
				0011	HIBERNATE (Edge)	RTC	
				0100	HIBERNATE (Level)	MICDET	
				0101	-	MICSHT	
				0110	-	ADCLRCLKB	
	15:1	GP7_FN	Dependant on		GPIO7 function		
	2	[3:0]	CONFIG		Input	Output	
			settings	0000	GPIO	GPIO	
				0001	L_PWR3	P_CLK	
				0010	MASK	/VCCFAULT	
				0011	HIBERNATE (Level)	/BATT_FAULT	
				0100	-	MICDET	
				0101	-	MICSHT	
				0110	-	ADA	
				1100	-	FLL_CLK	
Note: Undocu	Note: Undocumented combinations for GPn_FN (n = 4 to 7) are reserved						

Table 127 GPIO Function Select 2

ADDRESS	BIT	LABEL	DEFAULT		DESCRIPTION	
R142 (8Eh)	3:0	GP8_FN	Dependant on		GPIO8 function	definition
GPIO function		[3:0]	CONFIG settings		Input (GPn_DIR=1)	Output (GP <i>n</i> _DIR=0)
select 3				0000	GPIO	GPIO
				0001	/MR	/VCC_FAULT
				0010	ADCBCLK	ADCBCLK
				0011	PWR_OFF	/BATT_FAULT
				0100	HIBERNATE (Edge)	/RST
	7:4	GP9_FN	Dependant on		GPIO9 function	definition
		[3:0]	CONFIG		Input	Output
			settings	0000	GPIO	GPIO
				0001	HEARTBEAT	/VCC_FAULT
				0010	MASK	LINE_GT_BATT
				0011	PWR_OFF	/BATT_FAULT
				0100	HIBERNATE (Level)	/MEMRST
	11:8	GP10_F	Dependant on		GPIO10 function	definition
		N [3:0]	CONFIG		Input	Output
			settings	0000	GPIO	GPIO
				0001	-	ISINKC
				0010	-	LINE_GT_BATT
				0011	PWR_OFF	CH_IND
	15:1	GP11_F	Dependant on		GPIO11 function	definition
	2	N [3:0]	CONFIG		Input	Output
			settings	0000	GPIO	GPIO
			0001	-	ISINKD	
				0010	/WAKEUP	LINE_GT_BATT
				0011	-	CH_IND
Note: Undocu	ımented	combination	ns for GPn_FN (n	= 8 to 11) are reserved	

Table 128 GPIO Function Select 3

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION			
R143 (8Fh)	3:0	GP12_F	Dependant on		GPIO 12 function	definition	
GPIO function		N [3:0]	CONFIG settings		Input (GPn_DIR=1)	Output (GP <i>n</i> _DIR=0)	
select 4				0000	GPIO	GPIO	
					0001	CHIP_RESET	ISINKE
				0010	-	LINE_GT_BATT	
				0011	-	LINE_SW	
				0100	-	32kHz	
Note: Undocu	Note: Undocumented combinations are reserved						

Table 129 GPIO Function Select 4



21 VOLTAGE REFERENCES

The WM8350 generates several reference voltages used for different purposes.

The main reference voltage VREF, and additional internal references derived from it, are used in the DC-DC converters, the LDO regulators and the auxiliary ADC. VREF is highly stable, accurate, and independent of the supply voltage. It can be trimmed for improved accuracy.

The VRTC regulator (see Section 17.6) uses a separate, low-power reference at start-up.

The mid-rail reference VMID is used in the audio CODEC. It is generated from AVDD.

Each reference voltage is internally provided to those parts of the WM8350 where it is needed.

21.1 MAIN REFERENCE (VREF)

The main reference generates a highly accurate reference voltage VREF. It requires a decoupling capacitor on the CREF pin; a 2.2uF X5R capacitor is recommended, as noted in Section 29.2; and an accurate resistor on the RREF pin; a $100k\Omega$ (1%) resistor is recommended, as noted in Section 29.2.

The WM8350 will malfunction if those components are omitted.

The accuracy of supply voltages generated by the WM8350 depends on VREF, and can be improved by trimming. This scales VREF by up to +15/-16% in 1% steps, to compensate for deviations from the nominal value.

The main reference can be overdriven with an externally generated reference voltage, if desired.

21.2 LOW-POWER REFERENCE

The low-power reference determines the accuracy of VRTC on start-up. Once the main bandgap has been trimmed and has settled VRTC switches across to the main bandgap for greater accuracy.



WM8350 Production Data

22 REAL-TIME CLOCK (RTC)

22.1 GENERAL DESCRIPTION

The WM8350 contains a Real Time Clock (RTC), which maintains the current date and time, and also has the capability to generate alarms and periodic interrupt signals. The RTC is powered by the backup supply (VRTC), in order that it can keep running when the normal power sources are unavailable.

The RTC uses the 32.768kHz clock generated by the on-chip crystal oscillator. To compensate for errors in this clock frequency, the RTC includes a frequency trim option. Alternatively the RTC can be clocked from external 32.768kHz input on a GPIO pin configured as 32kHz input. See Section 12.2 for details of the 32kHz oscillator control.

22.2 RTC CONTROL

22.2.1 MODES OF OPERATION

The Real Time Clock is enabled when RTC_TICK_ENA is set to 1. (This is the default setting.) See Table 135 for the definition of this RTC_TICK_ENA.

The RTC can operate as a 24-hour clock or else as a 12-hour clock with a separate AM/PM flag bit. The RTC time register fields can be treated as BCD (binary-coded decimal) or as binary data formats. These options are selected as described in Table 130.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (17h) RTC Time	15	RTC_BCD	0	RTC Coding (applies to all time registers)
control				0 = Binary
				1 = BCD
	14	RTC_12HR	0	RTC 12/24 hours mode
				1 = 12 hours (MSB of RTC_HRS indicates AM/PM)
				0 = 24 hours (MSB of RTC_HRS is 0)

Table 130 RTC Modes of Operation

22.2.2 RTC TIME REGISTERS

The current time and date are held in registers R16 to R19, as described in Table 131.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R16 (10h)	14:8	RTC_MINS [6:0]	000 0000	RTC Minutes; 0 to 59
RTC sec / min	6:0	RTC_SECS [6:0]	000 0000	RTC Seconds; 0 to 59
R17 (11h)	10:8	RTC_DAY [2:0]	1	RTC Day of the week; 1 to 7, 1 =
RTC hour / day				Sunday
	5	RTC_HPM	0	RTC Hours AM/PM flag
				0 = AM
				1 = PM
				Only valid in 12hour mode.
	4:0	RTC_HRS [4:0]	0 0000	Hours register with 0-23 range in 24hour mode and 1-12 in 12 hour
				mode.
R18 (12h)	12:8	RTC_MTH [5:0]	0_0001	Month register with range 1-12.
RTC date	5:0	RTC_DATE [5:0]	00_0001	Date register with range 1-31.
R19 (13h)	13:8	RTC_YHUNDRED	01_0100	Year hundreds register tied to
RTC year		S [6:0]		20(dec)
-	7:0	RTC_YUNITS [7:0]	0000_0000	Year units register with range 0-99.

Table 131 RTC Time Registers



The current time can be read from the registers defined above. As the content of the time registers changes every second, a single register read, executed at an arbitrary time, does not guarantee an accurate time reading. Two possible methods are recommended for reliable reading of the time registers:

- Read after interrupt: the RTC_SEC interrupt (see Section 22.5) indicates that the seconds counter has just been incremented, and that the RTC registers will not change again within the next 999ms. A register read executed immediately after an RTC_SEC interrupt can therefore be taken as an accurate time reading.
- Two consecutive reads: if two consecutive reads within a short time (less than 1s apart)
 return the same result, this can be taken as an accurate reading. If the two results differ,
 the procedure should be repeated.

22.2.3 SETTING THE TIME

When writing to the RTC time registers, the seconds counter should first be stopped in order to prevent glitches. The following procedure should be used:

- Set the RTC_SET bit to stop seconds counter
- Read the RTC_STS bit. Repeat this step until RTC_STS=1
- Set new time in Registers R16 to R19
- Clear the RTC_SET bit to re-enable seconds counter.

The RTC_SET and RTC_STS bits are defined in Table 132.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (17h)	11	RTC_SET	0	Stops RTC seconds counter (instruction only)
RTC Time				0 = normal operation
control				1 = stop counter
	10	RTC_STS	0	Status of RTC seconds counter
				0 = normal operation
				1 = counter stopped

Table 132 Setting the RTC Time

22.2.4 RTC ALARM REGISTERS

An RTC Alarm can be set by writing to the control fields in registers R20 to R22, which are in a similar format to the RTC Time registers.

Setting any of these fields to "All 1's" results in that field being a "don't care" field. For example, setting the RTC_ALMDAY field to 0001 determines that the alarm is set for a Sunday, whilst setting RTC_ALMDAY to 1111 results in the programmed alarm occurring on every day of the week.

When the RTC Alarm time/date fields match the RTC time, the alarm event is signalled by the WM8350 raising the RTC_ALM_EINT interrupt. See Section 22.5 for further details.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R20 (14h) ALARM	14:8	RTC_ALMMINS [6:0]	000_0000	Minutes alarm register with range 0-59. All 1's sets to 'don't care' state.
sec / min				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.
	6:0	RTC_ALMSECS [6:0]	000_0000	Seconds alarm register with range 0-59. All 1's set to 'don't care' state.
				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.
R21 (15h) ALARM	11:8	RTC_ALMDAY [3:0]	0000	Day alarm register, with range 1-7, 1 = Sunday. All 1's sets to 'don't care' state.
hour / day				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.
	5	RTC_ALMHPM	0	Alarm hours AM/PM flag
				0 = AM
				1 = PM
				Only applicable in 12 hour mode. In 24 hour mode set to 1 if RTC_ALMHRS is set to all 1's 'don't care' or 0 otherwise.
	4:0	RTC_ALMHRS [4:0]	0_0000	Hours alarm register with range 0-23 in 24 hours mode and 1-12 in 12 hour. In 12 hour mode bit 5 is used as PM/not-AM flag. All 1's sets to 'don't care' state.
				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.
R22 (16h) ALARM	12:8	RTC_ALMMTH [4:0]	0_0000	Month alarm register with range 1-12. All 1's sets to 'don't care' state.
date				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.
	5:0	RTC_ALMDATE [5:0]	00_0000	Date alarm register with range 1-31. All 1's sets to 'don't care' state.
				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.

Table 133 RTC Alarm Registers

The "don't care" option (all bits set to 1) provides extra flexibility for programming ALARM duration and recurrent alarms. For example:

- Setting only RTC_ALMSEC to "don't care" produces an alarm lasting 1 minute.
- Setting only RTC_ALMDATE to "don't care" produces an alarm lasting 1 second that recurs once a week, on the day determined by RTC_ALMDAY, during the month determined by RTC_ALMMTH.
- Setting RTC_ALMSEC, RTC_ALMDATE, RTC_ALMDAY and RTC_ALMMTH to "don't care" produces a daily alarm lasting 1 minute.



22.2.5 SETTING THE ALARM

Writing to the RTC Alarm registers requires a procedure similar to that used when setting RTC time, in order to prevent accidental alarms being triggered:

- Set the RTC_ALMSET bit to disable alarms
- Read the RTC_ALMSTS bit. Repeat this step until RTC_ALMSTS=1
- Set new RTC Alarm in Registers R20 to R22
- Clear the RTC_ALMSET bit to re-enable RTC Alarm

The RTC_ALMSET and RTC_ALMSTS bits are defined in Table 134.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (17h)	9	RTC_ALMSET	1	Stops alarms (instruction only)
RTC Time				0 = normal operation
control				1 = stop alarms
				It is recommended to stop alarms when setting the RTC alarm. This avoids false alarms.
	8	RTC_ALMSTS	1	Actual status of ALARM circuitry
				0 = normal operation
				1 = alarms stopped

Table 134 Setting the RTC Alarm

22.3 TRIMMING THE RTC

The RTC has a frequency trim feature to allow compensation for known and constant errors in the crystal oscillator frequency up to ±8Hz. Programming the frequency trim requires a procedure similar to that used when setting RTC and ALARM time:

- Clear the RTC_TICK_ENA bit to disable the 1 second tick generator
- Read the RTC_TICKSTS bit. Repeat this step until RTC_TICKSTS=1
- Set new RTC frequency trim value in Register R218
- Set the RTC_TICK_ENA bit to resume normal operation

The applicable register bits are defined in Table 135.

R12 (0Ch) Power Mgmt (5)	ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
Mgmt (5) R218 (DAh) RTC Tick Control 14 RTC_TICKSTS 0 Status of tick request. This bit can be used to ensure the RTC is using the value of RTC_TICK_ENA. 0 = disabled 1 = enabled Protected by security key. 9:0 RTC_TRIM [9:0] 00_0000_ 0000 RTC_TRIM [9:0] 00_0000_ RTC_TRIM [9:0] 00_0000 RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6> 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. e.g.: Actual crystal freq: 32769.00Hz: Required trim 0xb0001_000000 (+1.000000) Actual crystal freq: 32767.00Hz: Required trim 0xb1111_000000 (-1.000000) Actual crystal freq: 32775.58Hz: Required trim 0xb0111_100101 (+7.578125)	` ,	11	RTC_TICK_ENA	1	Enable RTC counting (instruction only)
R218 (DAh) RTC Tick Control 14 RTC_TICKSTS 15 RTC_TICKSTS 16 Status of tick request. This bit can be used to ensure the RTC is using the value of RTC_TICK_ENA. 17 enabled 18 Protected by security key. 18 enabled 18 enabled 19 enabled 19 enabled 19 enabled 10000 RTC_TRIM [9:0] 100000 RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6> 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. 18 e.g.: 19 Actual crystal freq: 32769.00Hz: 19 Required trim 0xb0001_000000 (+1.000000) 20 Actual crystal freq: 32767.00Hz: 21 Required trim 0xb1111_000000 (-1.000000) 22 Required trim 0xb01111_100101 (+7.578125)					0 = disabled
RTC Tick Control 14 RTC_TICKSTS 0 Status of tick request. This bit can be used to ensure the RTC is using the value of RTC_TICK_ENA. 0 = disabled 1 = enabled Protected by security key. 9:0 RTC_TRIM [9:0] 00_0000_ 0000 RTC_TRIM [9:0] 00_0000_ 0000 RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6> 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. e.g.: Actual crystal freq: 32769.00Hz: Required trim 0xb01111_000000 (-1.00000) Actual crystal freq: 32775.58Hz: Required trim 0xb0111_100101 (+7.578125)	ivigmt (5)				1 = enabled
Control Tree Control Control	` '	15			Protected by security key.
9:0 RTC_TRIM [9:0] 00_0000 RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6> 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. e.g.: Actual crystal freq: 32769.00Hz: Required trim 0xb0001_000000 (+1.000000) Actual crystal freq: 32767.00Hz: Required trim 0xb1111_000000 (-1.000000) Actual crystal freq: 32775.58Hz: Required trim 0xb0111_100101 (+7.578125)		14	RTC_TICKSTS	0	used to ensure the RTC is using the value of RTC_TICK_ENA. 0 = disabled 1 = enabled
Required trim 0xb1011_110010 (- 4.218750) Protected by security key.		9:0	RTC_TRIM [9:0]		RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6> 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. e.g.: Actual crystal freq: 32769.00Hz: Required trim 0xb0001_000000 (+1.000000) Actual crystal freq: 32767.00Hz: Required trim 0xb1111_000000 (-1.000000) Actual crystal freq: 32775.58Hz: Required trim 0xb0111_100101 (+7.578125) Actual crystal freq: 32763.78Hz: Required trim 0xb1011_110010 (-4.218750)

Note: RTC_TICK_ENA can be accessed through R12 or through R218. Reading from or writing to either register location has the same effect.

Table 135 Controlling the RTC Frequency Trim



22.4 RTC GPIO OUTPUT

It is possible to configure GPIO6 as an RTC output, as described in Section 20. This output is a square wave that is derived from the trimmed RTC counter. The frequency can be set to values between 1Hz and 16.384kHz, as described in Table 136.

Note that, when RTC_TRIM is used to calibrate the crystal oscillator, the nominal 50% duty ratio of this output may deviate by up to 8 clock periods of the 32.768kHz oscillator on the occasions when the RTC Seconds Counter is increased (ie. once per second).

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (17h)	3:0	RTC_DSW [3:0]	0000	Divided Square wave select.
RTC Time				0000 = disabled
control				0001 = 1Hz
				0010 = 2Hz
				1011 = 1024Hz
				1100 = 2048Hz
				1101 = 4096Hz
				1110 = 8192Hz
				1111 = 16384Hz
				Note: due to trim settings for crystal
				intolerances a single square wave period during seconds rollover may be decrease
				its on time period or increase its off time
				period by up to 8 32kHz periods.

Table 136 RTC GPIO Output



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22.5 RTC INTERRUPTS

The RTC has its own first-level interrupt, RTC_INT (see Section 24). This comprises three second-level interrupts which indicate periodic events or RTC Alarm conditions.

The RTC raises an RTC_SEC_EINT interrupt on every 1 second rollover. An additional periodic interrupt, RTC_PER_EINT, is configurable with a frequency determined by the RTC_PINT field, as defined in Table 138. The RTC_ALM_EINT interrupt is triggered by the RTC Alarm function, as described in Section 22.2.4.

These interrupts can be individually masked by setting the applicable mask bit(s) as described in Table 137.

ADDRESS	BIT	LABEL	DESCRIPTION
R25 (19h)	7	RTC_PER_EINT	RTC periodic interrupt.
Interrupt Status			(Rising Edge triggered)
1			Note: This bit is cleared once read.
	6	RTC_SEC_EINT	RTC 1s rollover complete (1Hz tick).
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	5	RTC_ALM_EINT	RTC alarm etectio.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R33 (21h)	7:5	"IM_" + name of respective	Each bit in R33 enables or masks the
Interrupt Status		bit in R25	corresponding bit in R25. The default value for these bits is 0 (unmasked).
1 Mask			value for these bits is 0 (unmasked).

Table 137 RTC Interrupts

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (17h) RTC Time control	6:4	RTC_PINT [2:0]	010	Selects frequency of periodic interrupt output pulse (32kHz period duration) as shown below. When set time status is high, the periodic output is disabled. 000 = disabled 001 = 1 sec 010 = 1 min 011 = 1 hour 100 = 1 day 101 = 1 month 11x = disabled

Table 138 Configuring RTC Periodic Interrupts



23 WATCHDOG TIMER

The WM8350 includes a watchdog timer designed to detect a possible software fault condition where the host processor has locked up. The watchdog timer checks for any write operation to the watchdog control register R4 (04h) or receipt of a heartbeat signal from the host processor on GPIO9 (see Section 20). If neither event occurs within a programmable time, this is interpreted as a fault in the host processor. The watchdog timer then raises an interrupt and/or generates a system reset; the desired response to a watchdog timeout is set using the WDOG_MODE register field.

If GPIO9 is configured as HEARTBEAT input (GP9_FN = 0001, GP9_DIR = 1), then the Watchdog Timer can only be reset by a rising logic level applied to the GPIO9 pin.

If GPIO9 is not configured as HEARTBEAT input, then the Watchdog Timer can only be reset by a write operation to the watchdog control register R4 (04h).If a System reset is triggered by the watchdog timeout, the WM8350 asserts the /RST pin and the /RST and /MEMRST (GPIO) reset signals, resets the internal control registers and then initiates a start-up sequence.

The watchdog timer can be halted for debug purposes using the WDOG_DEBUG bit. The watchdog can be disabled in Hibernate mode using the WDOG_HIB_MODE bit. The watchdog timer duration is set using WDOG_TO, as described in Table 139.

The Watchdog timeout interrupt event is indicated by the SYS_WDOG_TO_EINT register field. This is one of the second-level interrupts which triggers a first-level System Interrupt, SYS_INT (see Section 24). This can be masked by setting the mask bit as described in Table 140.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h)	7	WDOG_DEBU	0	Halts watchdog timer for system debugging
System		G		0 = normal operation
control 1				1 = WDOG halt
R4 (04h)	7	WDOG_HIB_M	0	Watchdog behaviour in HIBERNATE state
System		ODE		0 = WDOG disabled in Hibernate
control 2				1 = WDOG controlled by WDOG_MODE in
				Hibernate
	5:4	WDOG_MODE	Dependan	Watchdog mode
		[2:0]	t on	00 = Disabled
			CONFIG settings	01 = SYS_WDOG_TO interrupt on time-out
			Settings	10 = WKUP_WDOG_RST interrupt and
				System reset on time-out
				11 = SYS_WDOG_TO interrupt on first time-
				out, WKUP_WDOG_RST interrupt and System reset on second time-out.
				Protected by security key.
	2:0	WDOG TO	101	Watchdog timeout (seconds)
	2.0	[2:0]	101	The timer is reset to this value when a
		[2.0]		HEARTBEAT signal edge is detected or the
				host writes to the watchdog control register.
				000 = 0.125s
				(time doubles with each step)
				101 = 4s
				11x = Reserved
				Protected by security key.
R5 (05h)	7	WDOG_HIB_M	0	Watchdog behaviour in HIBERNATE state
System		ODE		0 = WDOG disabled in Hibernate
Hibernate				1 = WDOG controlled by WDOG_MODE in
				Hibernate
Note: WDOG	HIB M	ODE can be access	sed through R	4 or through R5. Reading from or writing to

Note: WDOG_HIB_MODE can be accessed through R4 or through R5. Reading from or writing to either register location has the same effect.

Table 139 Controlling the Watchdog Timer



ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	0	SYS_WDOG_TO_EINT	Watchdog timeout has occurred.
Interrupt Status			(Rising Edge triggered)
2			Note: This bit is cleared once read.
R34 (22h)	0	IM_SYS_WDOG_TO_EINT	Mask bit for Watchdog timer interrupt
Interrupt Status 2 Mask			When set to 1, IM_SYS_WDOG_TO_EINT masks SYS_WDOG_TO_EINT in R26 and does not trigger an SYS_INT interrupt when SYS_WDOG_TO_EINT is set).

Table 140 Watchdog Timer Interrupts

Note that, if GPIO9 is configured as VCC_FAULT output (GP9_FN = 0001, GP9_DIR = 0), then the Watchdog Timer will be configured to expect a HEARTBEAT reset trigger. In this configuration, the Watchdog Reset will never occur and the system may lock up if the Watchdog Mode is enabled.

The Watchdog Timer function cannot be supported if GPIO9 is configured as VCC_FAULT output. Either the GPIO9 must be reconfigured as some other function, or the Watchdog Timer must remain disabled.

Note that Config Mode 01 selects GPIO9 = VCC_FAULT by default.



24 INTERRUPT CONTROLLER

The WM8350 can send an interrupt signal to the host processor though the IRQ pin. Interrupts can alert the host to a wide range of events and fault conditions. Each of these can be individually enabled or masked. After receiving an interrupt, the host processor can read the interrupt registers in order to determine what caused the interrupt, and take appropriate action if required.

The WM8350 interrupt controller has two levels:

Second-level interrupts indicate a single event in one of the circuit blocks. This is indicated by setting a register bit. This bit is a "sticky" bit - once it is set, it remains at logic 1 until the host processor reads the register. When the processor reads the register, the interrupt bits in that register are cleared. First-level interrupts are the logical OR of several second-level interrupts (usually all the interrupts associated with one particular circuit block). The default polarity of IRQ is active low, meaning that the IRQ signal is the logical NOR of all first-level interrupts.

Individual second-level interrupt bits can be masked, which prevents them from setting the First-level interrupt. (Note that the "sticky" bit will be set as normal, even if that interrupt is masked.)

Individual first-level interrupts can also be masked, preventing them from asserting the IRQ output.

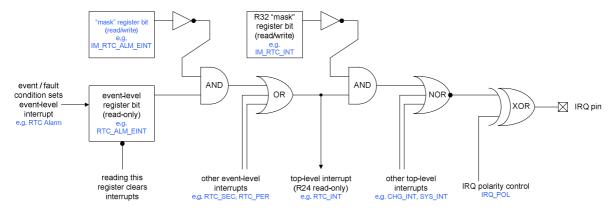


Figure 80 Interrupt Equivalent Logic

To find the cause of an interrupt signal, the host processor should first read the first-level interrupt register R24 to locate the circuit blocks(s) where the interrupt originated; after that, the precise cause(s) of the interrupt can be determined by reading the second-level interrupt register(s) as appropriate to the indicated first-level interrupt event.

24.1 CONFIGURING THE IRQ PIN

The default polarity of IRQ is active low; this can be changed to active high if desired, by writing to the IRQ_POL bit.

When the WM8350 is in the HIBERNATE state, interrupts can be disabled or can remain active. The desired behaviour can be selected using the IRQ_HIB_MODE bit.

ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3 (03h)	0	IRQ_POL	0	IRQ pin polarity
System				0 = active low (/IRQ)
Control 1				1 = active high (IRQ)
R5 (05h)	3	IRQ_HIB_MOD	0	IRQ pin state in hibernate mode
System		E		0 = Normal operation
Hibernate				1 = Forced to indicate there is no IRQ.

Table 141 Interrupts in HIBERNATE State



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24.2 FIRST-LEVEL INTERRUPTS

Each first level interrupt has a status bit in Register R24, which can be read to determine the origin of an IRQ event.

Each of these bits may be masked by setting the corresponding field in Register R32. By default, the first-level interrupts are all masked.

ADDRESS	BIT	LABEL	DESCRIPTION
R24 (18h)	13	OC_INT	First-level over-current interrupt.
System			Note: This bit is cleared once read.
Interrupts	12	UV_INT	First-level under-voltage interrupt.
			Note: This bit is cleared once read.
	9	CS_INT	First-level current sink interrupt.
			Note: This bit is cleared once read.
	8	EXT_INT	First-level external interrupt.
			Note: This bit is cleared once read.
	7	CODEC_INT	First-level codec interrupt.
			Note: This bit is cleared once read.
	6	GP_INT	First-level GPIO interrupt.
			Note: This bit is cleared once read.
	5	AUXADC_INT	First-level AUXADC comparator interrupt.
			Note: This bit is cleared once read.
	4	RTC_INT	First-level RTC interrupt.
			Note: This bit is cleared once read.
	3	SYS_INT	First-level system interrupt.
			Note: This bit is cleared once read.
	2	CHG_INT	First-level charger interrupt.
			Note: This bit is cleared once read.
	1	USB_INT	First-level USB interrupt.
			Note: This bit is cleared once read.
	0	WKUP_INT	First-level wakeup interrupt.
			Note: This bit is cleared once read.
R32 (20h)	13:0	"IM_" + name of respective	Interrupt mask.
System		bit in R25	0 = Do not mask interrupt.
Interrupt Mask			1 = Mask interrupt.
			Each bit in R32 enables or masks the
			corresponding bit in R24.
			The default value for these bits is 1 (masked)
Note: Register is	R24 is re	ad-only.	

Table 142 First Level Interrupt Status and Mask Bits



24.3 SECOND-LEVEL INTERRUPTS

The following sections define the second-level interrupt status and control bits associated with each of the first-level bits defined in Table 142.

24.3.1 OVERCURRENT INTERRUPT

The first-level OC_INT interrupt comprises one second-level interrupt for the limit switch. This status bit is in Register R29 and its mask bit is in Register R37, as defined in Table 143.

ADDRESS	BIT	LABEL	DESCRIPTION
R29 (1Dh)	15	OC_LS_EINT	Limit Switch Over-current interrupt.
Over Current			(Rising Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
R37 (25h)	15	IM_OC_LS_EINT	Interrupt mask.
Over Current			0 = Do not mask interrupt.
Interrupt Mask			1 = Mask interrupt.
			When IM_OC_LS_EINT is set to 1, then
			OC_LS_EINT in R29 does not trigger an
			OC_INT interrupt when set. The default
			value is 0 (unmasked).

Table 143 Over-Current Interrupt

24.3.2 UNDERVOLTAGE INTERRUPTS

The first-level UV_INT interrupt comprises several second-level interrupts for the DC-DCs and LDOs. Each of these has a status bit in Register R28 and a mask bit in Register R36, as defined in Table 144.

ADDRESS	BIT	LABEL	DESCRIPTION
R28 (1Ch)	11	UV_LDO4_EINT	LDO4 Under-voltage interrupt.
Under Voltage			(Rising Edge triggered)
Interrupt			Note: This bit is cleared once read.
Status	10	UV_LDO3_EINT	LDO3 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	9	UV_LDO2_EINT	LDO2 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	8	UV_LDO1_EINT	LDO1 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	5	UV_DC6_EINT	DCDC6 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	4	UV_DC5_EINT	DCDC5 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	3	UV_DC4_EINT	DCDC4 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	2	UV_DC3_EINT	DCDC3 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	UV_DC2_EINT	DCDC2 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.



ADDRESS	BIT	LABEL	DESCRIPTION
	0	UV_DC1_EINT	DCDC1 Under-voltage interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R36 (24h)	11:0	"IM_" + name of respective bit	Interrupt mask.
Under Voltage		in R28	0 = Do not mask interrupt.
Interrupt Mask			1 = Mask interrupt.
			Each bit in R36 enables or masks the corresponding bit in R28. The default value for these bits is 0 (unmasked).

Table 144 Under-Voltage Interrupts

24.3.3 CURRENT SINK (LED DRIVER) INTERRUPTS

The first-level CS_INT interrupt comprises two second-level interrupts for the Current Sink functions. Each of these has a status bit in Register R26 and a mask bit in Register R34, as defined in Table 145.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah) Interrupt Status 2	13	CS1_EINT	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.
			(Rising Edge triggered) Note: This bit is cleared once read.
	12	CS2_EINT	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.
			(Rising Edge triggered) Note: This bit is cleared once read.
R34 (22h)	13:12	"IM_" + name of respective	Interrupt mask.
Interrupt Status		bit in R26	0 = Do not mask interrupt.
2 Mask			1 = Mask interrupt.
			Each bit in R34 enables or masks the corresponding bit in R26. The default value for these bits is 0 (unmasked).

Table 145 Current Sink Interrupts



24.3.4 EXTERNAL INTERRUPTS

The first-level EXT_INT interrupt comprises three second-level interrupts for USB, Wall and Battery supply status. Each of these has a status bit in Register R31 and a mask bit in Register R37, as defined in Table 146. These flags are triggered on the rising and falling edges of the interrupt events.

ADDRESS	BIT	LABEL	DESCRIPTION
R31 (1Fh)	15	EXT_USB_FB_EINT	USB_FB changed interrupt.
Comparator			(Rising and Falling Edge triggered)
Interrupt Status			Note: This bit is cleared once read.
	14	EXT_WALL_FB_EINT	WALL_FB changed interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	13	EXT_BATT_FB_EINT	BATT_FB changed interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
R39 (27h)	15:13	"IM_" + name of respective bit	Interrupt mask.
Comparator		in R31	0 = Do not mask interrupt.
Interrupt Status			1 = Mask interrupt.
Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default value for these bits is 0 (unmasked).

Table 146 External Interrupts

24.3.5 CODEC INTERRUPTS

The first-level CODEC_INT interrupt comprises four second-level interrupts for the CODEC. Each of these has a status bit in Register R31 and a mask bit in Register R39, as defined in Table 147. These flags are triggered on the rising and falling edges of the interrupt events.

ADDRESS	BIT	LABEL	DESCRIPTION
R31 (1Fh)	11	CODEC_JCK_DET_L_EINT	Left channel Jack detection interrupt.
Comparator			(Rising and Falling Edge triggered)
Interrupt			Note: This bit is cleared once read.
Status	10	CODEC_JCK_DET_R_EINT	Right channel Jack detection interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	9	CODEC_MICSCD_EINT	Mic short-circuit detect interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
	8	CODEC_MICD_EINT	Mic detect interrupt.
			(Rising and Falling Edge triggered)
			Note: This bit is cleared once read.
R39 (27h)	11:8	"IM_" + name of respective	Interrupt mask.
Comparator		bit in R31	0 = Do not mask interrupt.
Interrupt			1 = Mask interrupt.
Status Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default value for these bits is 0 (unmasked).

Table 147 CODEC Interrupts

24.3.6 GPIO INTERRUPTS

The first-level GP_INT interrupt comprises several second-level interrupts for the 13 GPIO pins. Each of these has a status bit in Register R30 and a mask bit in Register R35, as defined in Table 148.

ADDRESS	BIT	LABEL	DESCRIPTION
R30 (1Eh)	12	GP12_EINT	GPIO12 interrupt.
GPIO Interrupt			(Trigger controlled by GP12 registers.)
Status			Note: This bit is cleared once read.
	11	GP11_EINT	GPIO11 interrupt.
			(Trigger controlled by GP11 registers.)
			Note: This bit is cleared once read.
	10	GP10_EINT	GPIO10 interrupt.
			(Trigger controlled by GP10 registers.)
			Note: This bit is cleared once read.
	9	GP9_EINT	GPIO9 interrupt.
			(Trigger controlled by GP9 registers.)
			Note: This bit is cleared once read.
	8	GP8_EINT	GPIO8 interrupt.
			(Trigger controlled by GP8 registers.)
			Note: This bit is cleared once read.
	7	GP7_EINT	GPIO7 interrupt.
			(Trigger controlled by GP7 registers.)
			Note: This bit is cleared once read.
	6	GP6_EINT	GPIO6 interrupt.
			(Trigger controlled by GP6 registers.)
			Note: This bit is cleared once read.
	5	GP5_EINT	GPIO5 interrupt.
			(Trigger controlled by GP5 registers.)
			Note: This bit is cleared once read.
	4	GP4_EINT	GPIO4 interrupt.
			(Trigger controlled by GP4 registers.)
			Note: This bit is cleared once read.
	3	GP3_EINT	GPIO3 interrupt.
			(Trigger controlled by GP3 registers.)
			Note: This bit is cleared once read.
	2	GP2_EINT	GPIO2 interrupt.
			(Trigger controlled by GP2 registers.)
			Note: This bit is cleared once read.
	1	GP1_EINT	GPIO1 interrupt.
			(Trigger controlled by GP1 registers.)
			Note: This bit is cleared once read.
	0	GP0_EINT	GPIO0 interrupt.
			(Trigger controlled by GP0 registers.)
			Note: This bit is cleared once read.
R38 (26h)	12:0	"IM_" + name of respective bit	Interrupt mask.
GPIO Interrupt		in R30	0 = Do not mask interrupt.
Mask			1 = Mask interrupt.
			Each bit in R38 enables or masks the
			corresponding bit in R30. The default
			value for these bits is 0 (unmasked).

Table 148 GPIO Interrupts



24.3.7 AUXADC AND DIGITAL COMPARATOR INTERRUPTS

The first-level AUXADC_INT interrupt comprises several second-level interrupts for the auxiliary ADC and associated digital comparators. Each of these has a status bit in Register R26 and a mask bit in Register R34, as defined in Table 149.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	8	AUXADC_DATARDY_EINT	Auxiliary data ready.
Interrupt			(Rising Edge triggered)
Status 2			Note: This bit is cleared once read.
	7	AUXADC_DCOMP4_EINT	DCOMP4 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	6	AUXADC_DCOMP3_EINT	DCOMP3 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	5	AUXADC_DCOMP2_EINT	DCOMP2 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	4	AUXADC_DCOMP1_EINT	DCOMP1 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h)	8:4	"IM_" + name of respective	Interrupt mask.
Interrupt		bit in R26	0 = Do not mask interrupt.
Status 2 Mask			1 = Mask interrupt.
			Each bit in R34 enables or masks the
			corresponding bit in R26. The default
			value for these bits is 0 (unmasked).

Table 149 AUXADC Interrupts

24.3.8 RTC INTERRUPTS

The first-level RTC_INT interrupt comprises three second-level interrupts for the Real Time Clock. Each of these has a status bit in Register R25 and a mask bit in Register R33, as defined in Table 150

ADDRESS	BIT	LABEL	DESCRIPTION
R25 (19h)	7	RTC_PER_EINT	RTC periodic interrupt.
Interrupt Status			(Rising Edge triggered)
1			Note: This bit is cleared once read.
	6	RTC_SEC_EINT	RTC 1s rollover complete (1Hz tick).
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	5	RTC_ALM_EINT	RTC alarm etectio.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R33 (21h)	7:5	"IM_" + name of respective	Interrupt mask.
Interrupt Status		bit in R25	0 = Do not mask interrupt.
1 Mask			1 = Mask interrupt.
			Each bit in R33 enables or masks the corresponding bit in R25. The default value for these bits is 0 (unmasked).

Table 150 RTC Interrupts



24.3.9 SYSTEM INTERRUPTS

The first-level SYS_INT interrupt comprises four second-level interrupts for various system events. Each of these has a status bit in Register R26 and a mask bit in Register R34, as defined in Table 151.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah) Interrupt Status 2	3	SYS_HYST_COMP_FAIL_EI NT	Hysteresis comparator indication that LINE or BATT is less that shutdown threshold.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	2	SYS_CHIP_GT115_EINT	Chip over 115°C temp limit.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	SYS_CHIP_GT140_EINT	Chip over 140°C temp limit.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	0	SYS_WDOG_TO_EINT	Watchdog timeout has occurred.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h)	3:0	"IM_" + name of respective	Interrupt mask.
Interrupt Status		bit in R26	0 = Do not mask interrupt.
2 Mask			1 = Mask interrupt.
			Each bit in R34 enables or masks the corresponding bit in R26 The default value for these bits is 0 (unmasked).

Table 151 System Interrupts

24.3.10 CHARGER INTERRUPTS

The system interrupt CHG_INT interrupt comprises several second-level interrupts for the battery charger. Each of these has a status bit in Register R25 and a mask bit in Register R33, as defined in Table 152.

ADDRESS	BIT	LABEL	DESCRIPTION
R25 (19h)	15	CHG_BATT_HOT_EINT	Battery temp too hot.
Interrupt Status			(Rising Edge triggered)
1			Note: This bit is cleared once read.
	14	CHG_BATT_COLD_EINT	Battery temp too cold.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	13	CHG_BATT_FAIL_EINT	Battery fail.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	12	CHG_TO_EINT	Charger timeout.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	11	CHG_END_EINT	Charging final stage.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	10	CHG_START_EINT	Charging started.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	9	CHG_FAST_RDY_EINT	Indicates that the charger is ready to go
			into fast charge.
			(Rising Edge triggered)
			Note: This bit is cleared once read.



ADDRESS	BIT	LABEL	DESCRIPTION
	2	CHG_VBATT_LT_3P9_EINT	Battery Voltage < 3.9 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	1	CHG_VBATT_LT_3P1_EINT	Battery voltage < 3.1 interrupt.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
	0	CHG_VBATT_LT_2P85_EIN	Battery voltage < 2.85 interrupt.
		Т	(Rising Edge triggered)
			Note: This bit is cleared once read.
R33 (21h)	15:9	"IM_" + name of respective	Interrupt mask.
Interrupt Status	2:0	bit in R25	0 = Do not mask interrupt.
1 Mask			1 = Mask interrupt.
			Each bit in R33 enables or masks the corresponding bit in R25. The default value for these bits is 0 (unmasked).

Table 152 Charger Interrupts

24.3.11 USB INTERRUPTS

The first-level USB_INT interrupt comprises one second-level interrupt for the USB limit switch. This status bit is in Register R26 and its mask bit is in Register R34, as defined in Table 153.

BIT	LABEL	DESCRIPTION
10	USB_LIMIT_EINT	USB Limit Switch interrupt.
		(Rising Edge triggered)
		Note: This bit is cleared once read.
10	IM_USB_LIMIT_EINT	Interrupt mask.
		0 = Do not mask interrupt.
		1 = Mask interrupt.
		When IM_USB_LIMIT_EINT is set to 1, then USB_LIMIT_EINT in R26 does not trigger an USB_INT interrupt when set. The default value is 0 (unmasked).
	10	10 USB_LIMIT_EINT

Table 153 USB Interrupt

24.3.12 WAKE-UP INTERRUPTS

The first-level WKUP_INT interrupt comprises several second-level interrupts. After a system reset, these indicate to the host processor why the reset occurred. Each wake-up interrupt has a status bit in Register R31 and a mask bit in Register R30, as defined in Table 154.

ADDRESS	BIT	LABEL	DESCRIPTION							
R31 (1Fh) Comparator	6	WKUP_OFF_STATE_EINT	Indicates that the chip started from the OFF state.							
Interrupt			(Rising Edge triggered)							
Status			Note: This bit is cleared once read.							
	5	WKUP_HIB_STATE_EINT	Indicated the chip started up from the hibernate state.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
	4	WKUP_CONV_FAULT_EINT	Indicates the wakeup was caused by a converter fault leading to the chip being reset.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
	3	WKUP_WDOG_RST_EINT	Indicates the wakeup was caused by a watchdog heartbeat being missed, and hence the chip being reset.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
	2	WKUP_GP_PWR_ON_EINT	PWR_ON (Alternate GPIO function) pin has been pressed for longer than specified time.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
	1	WKUP_ONKEY_EINT	ON key has been pressed for longer than specified time.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
	0	WKUP_GP_WAKEUP_EINT	WAKEUP (Alternate GPIO function) pin has been pressed for longer than specified time.							
			(Rising Edge triggered)							
			Note: This bit is cleared once read.							
R39 (27h)	6:0	"IM_" + name of respective	Interrupt mask.							
Comparator		bit in R31	0 = Do not mask interrupt.							
Interrupt			1 = Mask interrupt.							
Status Mask			Each bit in R39 enables or masks the corresponding bit in R31. The default							
			value for these bits is 0 (unmasked).							

Table 154 Wake-up Interrupts



25 TEMPERATURE SENSING

25.1 CHIP TEMPERATURE MONITORING

The WM8350 has a built-in sensor to monitor its internal temperature, with two levels of over-temperature protection.

When the device temperature exceeds the thermal warning temperature, the WM8350 raises a SYS_CHIP_GT115_EINT interrupt. If the chip temperature continues to rise, and exceeds the thermal shutdown temperature, the SYS_CHIP_GT140_EINT interrupt is set and the device shuts down. After a thermal shutdown, the WM8350 can only restart after its temperature has fallen below the restart temperature.

The associated register fields are defined in Table 155.

ADDRESS	BIT	LABEL	DESCRIPTION
R26 (1Ah)	2	SYS_CHIP_GT115_EINT	Chip over 115°C temp limit.
Interrupt			(Rising Edge triggered)
Status 2			Note: This bit is cleared once read.
	1	SYS_CHIP_GT140_EINT	Chip over 140°C temp limit.
			(Rising Edge triggered)
			Note: This bit is cleared once read.
R34 (22h)	2:1	"IM_" + name of respective bit	Each bit in R34 enables or masks the
Interrupt Status 2 Mask		in R26	corresponding bit in R26. The default value for these bits is 0 (unmasked).

Table 155 Temperature Sensing Interrupts



WM8350 Production Data

26 REGISTER MAP

26.1 OVERVIEW

The complete register map is shown below. The detailed description can be found in the relevant text of the device description. The WM8350 can be configured using the Control Interface. All registers not listed and all unused bits should be set to '0'.

Key to characters in brackets: K = protected by key, M = default in metal mask, R = read-only, W = write-only, O = read-only in ROM configs, D = protected by key in development mode, read-only otherwise, n = never reset, p = reset by POR only, s = reset by state machine, sd = reset by state machine except in dev mode, u = reset on UVLO, m = reset on /MEMRST

REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R0 (0h)	Reset/ID							S	SW_RESET/CI	HIP_ID[15:0]	(n)							6143h
R1 (1h)	ID		CHIP_F	REV[3:0]		CONF_	STS[1:0]	0 0 CUST_ID[7:0]										
R2 (2h)	Revision	0	0	0	0	0	0	0	0				MASK_I	REV[7:0]				
R3 (3h)	System Control 1	CHIP_ON (Ms)	SYS_RST (KMs)	POWERCY CLE	VCC_FAUL T_OV (Ms)	RSTB_T	O[1:0] <i>(M)</i>	BG_SLEEP (M)	0	WDOG_DE BUG (K)	CHIP_RES ET_ENA (s)	MEM_VALI D (m)	CHIP_SET_ UP	ON_DEB_T (K)	0	ON_POL (KMs)	IRQ_POL (Ms)	1C02h 1C02h 1C02h
R4 (4h)	System Control 2	USB_SUSP END_8MA (M)	USB_SUSP END (M)	USB_MSTR (Ms)	USB_MSTR _SRC (Ms)	USB_MSTR _500MA (Ms)	_	USB_SLV_ 500MA (Ms)	0	WDOG_HIB _MODE	0	WDOG_MOI	 DE[1:0] <i>(KMs)</i>	0	WI	 DOG_TO[2:0]	<u> </u> (K)	1C02h 0004h 0204h 0214h 0204h
R5 (5h)	System Hibernate	HIBERNAT E (Ms)	0	0	0	0	0	0	0	WDOG_HIB _MODE	HIB_START UP_SEQ	REG_RESE T_HIB_MO DE	RST_HIB_M ODE	IRQ_HIB_M ODE	MEMRST_H IB_MODE	PCCOMP_ HIB_MODE	TEMPMON _HIB_MOD E	0000h
R6 (6h)	Interface Control	USE_DEV_ PINS (s)	DEV_ADI	DR[1:0] <i>(s)</i>	CONFIG_D ONE (s)	RECONFIG _AT_ON	0	AUTOINC (s)	0	0	0	0	0	SPI_CFG (KM)	SPI_4WIRE (KM)	SPI_3WIRE (KM)	0	8A00h 8A00h 8A00h 8A00h
R8 (8h)	Power mgmt (1)	CODEC_	ISEL[1:0]	VBUF_ENA	0	0	OUTPUT_D RAIN_ENA	0	MIC_DET_E NA	0	0	BIAS_ENA	MICB_ENA	0	VMID_ENA	VMI	D[1:0]	8000h
R9 (9h)	Power mgmt (2)	0	0	0	0	IN3R_ENA	IN3L_ENA	INR_ENA	INL_ENA	MIXINR_EN A	MIXINL_EN A	OUT4_ENA	OUT3_ENA	0	0	MIXOUTR_ ENA	MIXOUTL_ ENA	0000h
R10 (Ah)	Power mgmt (3)	0	0	0	0	0	0	0	0	IN3R_TO_O UT2R	0	0	0	OUT2R_EN A	OUT2L_EN A	OUT1R_EN A	OUT1L_EN A	0000h
R11 (Bh)	Power mgmt (4)	0	SYSCLK_E NA	ADC_HPF_ ENA	0	0	0	0	TOCLK_EN A	0	0	DACR_ENA	DACL_ENA	ADCR_ENA	ADCL_ENA	0	0	2000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R12 (Ch)	Power mgmt (5)	0	0	0	CODEC EN	RTC TICK	OSC32K E	CHG ENA	SW VRTC	AUXADC E	0	0	0	DCMP4 EN			DCMP1 EN	0E00h
1112 (011)	owor mgmt (o)				A (s)	ENA (KMs)	NA (KMs)	(KMs)	ENA (s)	NA (s)	Ů			A (s)	A (s)	A (s)	A (s)	0E00h
					, ,	, ,		, ,							, ,	. ,	, ,	0E00h
																		0E00h
R13 (Dh)	Power mgmt (6)	LS ENA	0	0	0	LDO4 ENA	LDO3 ENA	LDO2 ENA	LDO1_ENA	0	0	DC6 ENA	DC5 ENA	DC4 ENA	DC3 ENA	DC2 ENA	DC1 ENA	0000h
(5)		(Ms)			· ·	(Ms)	(Ms)	(Ms)	(Ms)			(Ms)	(Ms)	(Ms)	(Ms)	(Ms)	(Ms)	0000
R14 (Eh)	Power mgmt (7)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CS2_ENA	CS1_ENA	0000h
																(s)	(s)	
R16 (10h)	RTC Seconds/Minutes	0			F	RTC_MINS[6:0)]			0			F	RTC_SECS[6:	0]			0000h
R17 (11h)	RTC Hours/Day	0	0	0	0	0		RTC_DAY[2:0)]	0	0	RTC_HPM			RTC_HRS[4:0)]		0100h
R18 (12h)	RTC Date/Month	0	0	0		F	RTC_MTH[4:0)]		0	0			RTC_D	ATE[5:0]			0101h
R19 (13h)	RTC Year	0	0			RTC_YHUN	DREDS[5:0]						RTC_YU	NITS[7:0]				1400h
R20 (14h)	Alarm Seconds/Minutes	0			RT	C_ALMMINS[6	6:0]			0			RT	C_ALMSECS	[6:0]			0000h
R21 (15h)	Alarm Hours/Day	0	0	0	0		RTC_ALM	MDAY[3:0]		0	0	RTC_ALMH PM		R1	C_ALMHRS[4	4:0]		0000h
R22 (16h)	Alarm Date/Month	0	0	0		RT	C_ALMMTH[4	4:0]		0	0		1	RTC_ALM	IDATE[5:0]			0000h
R23 (17h)	RTC Time Control	RTC_BCD	RTC_12HR	0	0	RTC_SET	RTC_STS	RTC_ALMS ET	RTC_ALMS TS	0	I	RTC_PINT[2:0]		RTC_D	SW[3:0]		0320h
R24 (18h)	System Interrupts	0	0	OC_INT	UV_INT	0	0	CS_INT	EXT_INT	CODEC_IN T	GP_INT	AUXADC_I NT	RTC_INT	SYS_INT	CHG_INT	USB_INT	WKUP_INT	0000h
R25 (19h)	Interrupt Status 1	CHG BATT	CHG BATT	CHG BATT	CHG TO E	CHG END	CHG STAR	CHG FAST	0	RTC PER	RTC SEC	RTC ALM	0	0	CHG_VBAT	CHG VBAT	CHG VBAT	0000h
	·	_HOT_EINT	_COLD_EIN T	_FAIL_EINT	INT	EINT	T_EINT	_RDY_EINT		EINT	EINT	EINT			T_LT_3P9_ EINT	T_LT_3P1_ EINT	T_LT_2P85 EINT	
R26 (1Ah)	Interrupt Status 2	0	0	CS1_EINT	CS2_EINT	0	USB_LIMIT	0	AUXADC_D	AUXADC_D	AUXADC_D	AUXADC_D	AUXADC_D	SYS_HYST	SYS_CHIP_	SYS_CHIP_	SYS_WDO	0000h
, ,					_		_EINT		ATARDY_EI	COMP4_EI	COMP3_EI	COMP2_EI	COMP1_EI	_COMP_FA	GT115_EIN	GT140_EIN	G_TO_EINT	
									NT	NT	NT	NT	NT	IL_EINT	T	T		
R28 (1Ch)	Under Voltage Interrupt	0	0	0	0	UV_LDO4_	UV_LDO3_	UV_LDO2_	UV_LDO1_	0	0		UV_DC5_EI		UV_DC3_EI		UV_DC1_EI	0000h
	status					EINT	EINT	EINT	EINT			NT	NT	NT	NT	NT	NT	
R29 (1Dh)	Over Current Interrupt status	OC_LS_EIN T	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R30 (1Eh)	GPIO Interrupt Status	0	0	0	GP12_EINT	GP11_EINT	GP10_EINT	GP9_EINT	GP8_EINT	GP7_EINT	GP6_EINT	GP5_EINT	GP4_EINT	GP3_EINT	GP2_EINT	GP1_EINT	GP0_EINT	0000h
R31 (1Fh)	Comparator Interrupt	EXT_USB_	EXT_WALL	EXT_BATT	0	CODEC_JC	CODEC_JC	CODEC_MI	CODEC_MI	0	WKUP_OFF	WKUP_HIB	WKUP_CO	WKUP_WD	WKUP_GP_	WKUP_ON	WKUP_GP_	0000h
	Status	FB_EINT	_FB_EINT	_FB_EINT		K_DET_L_E INT	K_DET_R_ EINT	CSCD_EIN T	CD_EINT		_STATE_EI NT	_STATE_EI NT	NV_FAULT _EINT	OG_RST_EI NT	PWR_ON_E INT	KEY_EINT	Wakeup_e Int	
R32 (20h)	System Interrupts Mask	0	0	IM_OC_INT	IM_UV_INT	0	0	IM_CS_INT	IM_EXT_IN	IM_CODEC	IM_GP_INT	IM_AUXAD	IM_RTC_IN	IM_SYS_IN	IM_CHG_IN	IM_USB_IN	IM_WKUP_I	3FFFh
				(Ms)	(Ms)			(Ms)	T (Ms)	_INT (Ms)	(Ms)	C_INT (Ms)	T (Ms)	T (Ms)	T (Ms)	T (Ms)	NT (Ms)	
R33 (21h)	Interrupt Status 1 Mask	IM_CHG_B	IM_CHG_B	IM_CHG_B	IM_CHG_T	IM_CHG_E	IM_CHG_S	IM_CHG_F	0	IM_RTC_PE			0	0	IM_CHG_V	IM_CHG_V	IM_CHG_V	0000h
		ATT_HOT_	ATT_COLD	ATT_FAIL_	O_EINT (s)	ND_EINT	TART_EINT	AST_RDY_		R_EINT (s)	C_EINT (s)	M_EINT (s)				BATT_LT_3		
		EINT (s)	_EINT (s)	EINT (s)		(s)	(s)	EINT (s)				1			P9_EINT (s)	P1_EINT (s)	P85_EINT (s)	
	l .		<u> </u>			<u> </u>		l	<u> </u>	l	l	1		l	l	l	(3)	



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R34 (22h)	Interrupt Status 2 Mask	0	0	IM_CS1_EI NT (s)	IM_CS2_EI NT (s)	0	IM_USB_LI MIT_EINT (s)	0	IM_AUXAD C_DATARD Y_EINT (s)	IM_AUXAD C_DCOMP4 _EINT (s)	IM_AUXAD C_DCOMP3 _EINT (s)	IM_AUXAD C_DCOMP2 _EINT (s)	_	IM_SYS_HY ST_COMP_ FAIL_EINT (s)	IM_SYS_C HIP_GT115 _EINT (s)		IM_SYS_W DOG_TO_E INT (s)	0000h
R36 (24h)	Under Voltage Interrupt status Mask	0	0	0	0	IM_UV_LD O4_EINT (s)	IM_UV_LD O3_EINT (s)	IM_UV_LD O2_EINT (s)	IM_UV_LD O1_EINT (s)	0	0	IM_UV_DC6 _EINT (s)	IM_UV_DC5 _EINT (s)		IM_UV_DC3 _EINT (s)	IM_UV_DC2 _EINT (s)	IM_UV_DC1 _EINT (s)	0000h
R37 (25h)	Over Current Interrupt status Mask	IM_OC_LS_ EINT (s)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R38 (26h)	GPIO Interrupt Status Mask	0	0	0	IM_GP12_E INT (s)	IM_GP11_E INT (s)	IM_GP10_E INT (s)	IM_GP9_EI NT (s)	IM_GP8_EI NT (s)	IM_GP7_EI NT (s)	IM_GP6_EI NT (s)	IM_GP5_EI NT (s)	IM_GP4_EI NT (s)	IM_GP3_EI NT (s)	IM_GP2_EI NT (s)	IM_GP1_EI NT (s)	IM_GP0_EI NT (s)	0000h
R39 (27h)	Comparator Interrupt Status Mask	IM_EXT_US B_FB_EINT (s)	IM_EXT_W ALL_FB_EI NT (s)		0	IM_CODEC _JCK_DET_ L_EINT (s)	IM_CODEC _JCK_DET_ R_EINT (s)	IM_CODEC _MICSCD_ EINT (s)	IM_CODEC _MICD_EIN T (s)	0	IM_WKUP_ OFF_STAT E_EINT (s)	IM_WKUP_ HIB_STATE _EINT (s)	IM_WKUP_ CONV_FAU LT_EINT (s)	_	IM_WKUP_ GP_PWR_ ON_EINT (s)	IM_WKUP_ ONKEY_EI NT (s)	IM_WKUP_ GP_WAKE UP_EINT (s)	0000h
R40 (28h)	Clock Control 1	TOCLK_EN A	TOCLK_RA TE	0	0	MCLK_SEL	0	0	MCLK_DIV								0040h	
R41 (29h)	Clock Control 2	LRC_ADC_ SEL	0	0	0	0	0	0	0	0	0	0	0	0	0	0	MCLK_DIR	0000h
R42 (2Ah)	FLL Control 1	FLL_ENA	FLL_OSC_ ENA	1	1	1	F	LL_OUTDIV[2	::0]	FLL_RSP_RATE[3:0] 0 FLL_RATE[2:0])]	3A00h	
R43 (2Bh)	FLL Control 2		F	LL_RATIO[4:0	0]		0			FLL_N[9:0]								7086h
R44 (2Ch)	FLL Control 3								FLL_ł	([15:0]								C226h
R45 (2Dh)	FLL Control 4	0	0	0	0	0	0	0	0	FLL_REF_F REQ	0	FLL_FRAC	0	0	0	FLL_CLK	_SRC[1:0]	0000h
R48 (30h)	DAC Control	0	0	DAC_MON O	AIF_LRCLK RATE	0	0	0	0	0	0	DEEM	MP[1:0]	DAC_SDMC LK_RATE	0	DACL_DATI NV	DACR_DAT INV	0000h
R50 (32h)	DAC Digital Volume L	DACL_ENA	0	0	0	0	0	0	DAC_VU				DACL_\	/OL[7:0]				00C0h
R51 (33h)	DAC Digital Volume R	DACR_ENA	0	0	0	0	0	0	DAC_VU				DACR_\	VOL[7:0]				00C0h
R53 (35h)	DAC LR Rate	0	0	0	0	DACLRC_E NA					DAC	CLRC_RATE[10:0]					0040h
R54 (36h)	DAC Clock Control	0	0	0	0	0	0	0	0	0 0 DACCLK_P 0 DAC_CLKDIV[2:0] OL						0000h		
R58 (3Ah)	DAC Mute	0	DAC_MUTE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	4000h
R59 (3Bh)	DAC Mute Volume	0	DAC_MUTE MODE	DAC_MUTE RATE	DAC_SB_FI LT	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R60 (3Ch)	DAC Side	0	0	ADC_TO_	DACL[1:0]	ADC_TO_	DACR[1:0]	0	0	0 0 0 0 0 0 0 0							0000h	
R64 (40h)	ADC Control	ADC_HPF_ ENA	0	0	0	0	0	ADC_HPF	_CUT[1:0]	0 0 0 0 0 ADCL_DATI ADCR_DAT NV INV						8000h		
R66 (42h)	ADC Digital Volume L	ADCL_ENA	0	0	0	0	0	0	ADC_VU				ADCL_\	/OL[7:0]				00C0h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R67 (43h)	ADC Digital Volume R	ADCR_ENA	0	0	0	0	0	0	ADC_VU			•	ADCR_	VOL[7:0]			•	00C0h
R68 (44h)	ADC Divider	0	0	0	0		ADCL_DAC	ADCL_DAC_SVOL[3:0] ADCR_DAC_SVOL[3:0] ADCCLK_P ADC_CLKDIV[2:0] OL								:0]	0000h	
R70 (46h)	ADC LR Rate	0	0	0	0	ADCLRC_E NA		ADCLRC_RATE[10:0]									0040h	
R72 (48h)	Input Control	0	0	0	0	0	IN2R_ENA	IN1RN_ENA	IN1RP_ENA	0	0	0	0	0	IN2L_ENA	IN1LN_ENA	IN1LP_ENA	0303h
R73 (49h)	IN3 Input Control	IN3R_ENA	IN3R_SHO RT	0	0	0	0	0	0	IN3L_ENA	IN3L_SHOR T	0	0	0	0	0	0	0000h
R74 (4Ah)	Mic Bias Control	MICB_ENA	MICB_SEL	0	0	0	0	0	0	MIC_DET_E NA	0	0		MCDTHR[2:0]	MCDSC	THR[1:0]	0000h
R76 (4Ch)	Output Control	0	0	0	0	OUT4_VRO I	OUT3_VRO I	OUT2_VRO	OUT1_VRO I	0	0	0	OUTPUT_D RAIN_ENA	0	OUT2_FB	0	OUT1_FB	0000h
R77 (4Dh)	Jack Detect	JDL_ENA	JDR_ENA	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R78 (4Eh)	Anti Pop Control	0	0	0	0	0	0	ANTI_F	OP[1:0]	DIS_OP_LN4[1:0]					OUT2[1:0]	DIS_OP_	OUT1[1:0]	0000h
R80 (50h)	Left Input Volume	INL_ENA	INL_MUTE	INL_ZC	0	0	0	0	IN_VU			INL_V	OL[5:0]			0	0	0040h
R81 (51h)	Right Input Volume	INR_ENA	INR_MUTE	INR_ZC	0	0	0	0	IN_VU	INR_VOL[5:0]						0	0	0040h
R88 (58h)	Left Mixer Control	MIXOUTL_ ENA	0	0	DACR_TO_ MIXOUTL	DACL_TO_ MIXOUTL	0	0	0	0	0	0	0	0	IN3L_TO_M IXOUTL	INR_TO_MI XOUTL	INL_TO_MI XOUTL	0800h
R89 (59h)	Right Mixer Control	MIXOUTR_ ENA	0	0	DACR_TO_ MIXOUTR	DACL_TO_ MIXOUTR	0	0	0	0	0	0	0	IN3R_TO_M IXOUTR	0	INR_TO_MI XOUTR	INL_TO_MI XOUTR	1000h
R92 (5Ch)	OUT3 Mixer Control	OUT3_ENA	0	0	0	DACL_TO_ OUT3	0	0	MIXINL_TO _OUT3	0	0	0	0	OUT4_TO_ OUT3	0	0	MIXOUTL_T O_OUT3	0000h
R93 (5Dh)	OUT4 Mixer Control	OUT4_ENA	0	0	DACR_TO_ OUT4	DACL_TO_ OUT4	OUT4_ATT N	MIXINR_TO _OUT4	0	0	0	0	0	0	OUT3_TO_ OUT4	MIXOUTR_ TO_OUT4	MIXOUTL_T O_OUT4	0000h
R96 (60h)	Output Left Mixer Volume	0	0	0	0	IN3L_	MIXOUTL_V	DL[2:0]	0	INR_I	MIXOUTL_VO	L[2:0]	0	INL_	MIXOUTL_VC)L[2:0]	0	0000h
R97 (61h)	Output Right Mixer	IN3R_	MIXOUTR_V	OL[2:0]	0	0	0	0	0	INR_I	MIXOUTR_VC)L[2:0]	0	INL_I	MIXOUTR_VC	DL[2:0]	0	0000h
R98 (62h)	Input Mixer Volume L	0	0	0	0	IN3L	_MIXINL_VO	L[2:0]	0	0	0	0	0	IN2L	_MIXINL_VO	L[2:0]	INL_MIXINL _VOL	0000h
R99 (63h)	Input Mixer Volume R	IN3F	R_MIXINR_VO	L[2:0]	0	0	0	0	0	IN2R_MIXINR_VOL[2:0] 0				0	0	0	INR_MIXIN R_VOL	0000h
R100 (64h)	Input Mixer Volume	OUT4_MIXI N_DST	0	0	0	0	0	0	0	0 0 0				ОИТ	4_MIXIN_VO	L[2:0]	0	0000h
R104 (68h)	OUT1L Volume	OUT1L_EN A	OUT1L_MU TE	OUT1L_ZC	0	0	0	0	OUT1_VU			OUT1L_	VOL[5:0]			0	0	00E4h
R105 (69h)	OUT1R Volume	OUT1R_EN A	OUT1R_MU TE	OUT1R_ZC	0	0	0	0	OUT1_VU	U OUT1R_VOL[5:0] 0 0					0	00E4h		
R106 (6Ah)	OUT2L Volume	OUT2L_EN A	OUT2L_MU TE	OUT2L_ZC	0	0	0	0	OUT2_VU	P_VU OUT2L_VOL[5:0] 0 0					0	00E4h		



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R107 (6Bh)	OUT2R Volume	OUT2R_EN A	OUT2R_MU TE	OUT2R_ZC	0	0	OUT2R_INV	OUT2R_INV _MUTE	OUT2_VU			OUT2R_	VOL[5:0]			0	0	02E4h
R111 (6Fh)	BEEP Volume	IN3R_TO_O UT2R	0	0	0	0	0	0	0	IN3R	_OUT2R_VO	L[2:0]	0	0	0	0	0	0000h
R112 (70h)	Al Formating	AIF_BCLK_I	0	AIF_TRI	AIF_LRCLK _INV	AIF_V	/L[1:0]	AIF_FI	MT[1:0]	0	0	0	0	0	0	0	0	0A00h
R113 (71h)	ADC DAC COMP	0	0	0	0	0	0	0	0	DAC_COM P	DAC_COM PMODE	ADC_COM P	ADC_COM PMODE	0	0	0	LOOPBACK	0000h
R114 (72h)	Al ADC Control	0	0	0	0	0	0	0	0	AIFADC_PD	AIFADCL_S RC	AIFADCR_S RC	AIFADC_TD M_CHAN	AIFADC_TD M	0	0	0	0020h
R115 (73h)	Al DAC Control	0	BCLK_MST R	0	0	0	0	0	0	AIFDAC_PD	DACL_SRC	DACR_SRC	AIFDAC_TD M_CHAN	AIFDAC_TD M	0	DAC_BC	OST[1:0]	0020h
R128 (80h)	GPIO Debounce	0	0	0	GP12_DB	GP11_DB	GP10_DB	GP9_DB (s)	GP8_DB (s)	GP7_DB (s)	GP6_DB (s)	GP5_DB (s)	GP4_DB (s)	GP3_DB (s)	GP2_DB (s)	GP1_DB (s)	GP0_DB (s)	1FFFh
R129 (81h)	GPIO Pin pull up Control	0	0	0	GP12_PU (Ms)	GP11_PU (Ms)	GP10_PU (Ms)	GP9_PU (Ms)	GP8_PU (Ms)	GP7_PU (Ms)	GP6_PU (Ms)	GP5_PU (Ms)	GP4_PU (Ms)	GP3_PU (Ms)	GP2_PU (Ms)	GP1_PU (Ms)	GP0_PU (Ms)	0000h 0000h 0000h 0010h
R130 (82h)	GPIO Pull down Control	0	0	0	GP12_PD (Ms)	GP11_PD (Ms)	GP10_PD (Ms)	GP9_PD (Ms)	GP8_PD (Ms)	GP7_PD (Ms)	GP6_PD (Ms)	GP5_PD (Ms)	GP4_PD (Ms)	GP3_PD (Ms)	GP2_PD (Ms)	GP1_PD (Ms)	GP0_PD (Ms)	0000h 0000h 0110h 0000h
R131 (83h)	GPIO Interrupt Mode	0	0	0	GP12_INTM ODE (s)	GP11_INTM ODE (s)	GP10_INTM ODE (s)	GP9_INTM ODE (s)	GP8_INTM ODE (s)	GP7_INTM ODE (s)	GP6_INTM ODE (s)	GP5_INTM ODE (s)	GP4_INTM ODE (s)	GP3_INTM ODE (s)	GP2_INTM ODE (s)	GP1_INTM ODE (s)	GP0_INTM ODE (s)	0000h
R133 (85h)	GPIO Control	0	0	0	0	0	0	0	0	GP_DBTII	ME[1:0] (s)	0	0	0	0	0	0	0000h
R134 (86h)	GPIO Configuration (i/o)	0	0	0	GP12_DIR (Ms)	GP11_DIR (Ms)	GP10_DIR (Ms)	GP9_DIR (Ms)	GP8_DIR (Ms)	GP7_DIR (Ms)	GP6_DIR (Ms)	GP5_DIR (Ms)	GP4_DIR (Ms)	GP3_DIR (Ms)	GP2_DIR (Ms)	GP1_DIR (Ms)	GP0_DIR (Ms)	0FFCh 0CFFh 09FAh 0BFBh
R135 (87h)	GPIO Pin Polarity / Type	0	0	0	GP12_CFG (Ms)	GP11_CFG (Ms)	GP10_CFG (Ms)	GP9_CFG (Ms)	GP8_CFG (Ms)	GP7_CFG (Ms)	GP6_CFG (Ms)	GP5_CFG (Ms)	GP4_CFG (Ms)	GP3_CFG (Ms)	GP2_CFG (Ms)	GP1_CFG (Ms)	GP0_CFG (Ms)	0FFCh 0C1Fh 0DF6h 0FFDh
R140 (8Ch)	GPIO Function Select 1		GP3_FN	[3:0] <i>(Ms)</i>		GP2_FN[3:0] (Ms)					GP1_FN	[3:0] <i>(Ms)</i>			0013h 0000h 1310h 0310h			



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT	
R141 (8Dh)	GPIO Function Select 2		GP7_FN	[3:0] <i>(Ms)</i>			GP6_FN	[3:0] <i>(Ms)</i>			GP5_FN	[3:0] <i>(Ms)</i>			GP4_FN	[3:0] <i>(Ms)</i>		0000h	
																		1110h	
																		0003h	
																		0001h	
R142 (8Eh)	GPIO Function Select 3		GP11_FN	N[3:0] <i>(Ms)</i>			GP10_FN	I[3:0] <i>(Ms)</i>			GP9_FN	[3:0] <i>(Ms)</i>			GP8_FN	[3:0] <i>(Ms)</i>		0000h	
																		0013h	
																		2000h	
D4.40 (0Fb)	ODIO Franctica Octobr 4	0	0	_	0	0			_	_		0	_		0040 5	I[O-O] (M-)		2300h	
H143 (8FN)	GPIO Function Select 4	0	U	0	0	0	0	0	0	0	0	0	0		GP12_F	l[3:0] <i>(Ms)</i>		0003h 0003h	
																		0003h	
																		0003h	
R144 (90h)	Digitiser Control (1)	AUXADC E	AUXADC C	AUXADC_P	AUXADC_H	0	0	0	0	AUXADC_S	AUXADC S	AUXADC S	AUXADC_S	AUXADC_S	AUXADC S	AUXADC_S	AUXADC S	0000h	
(/	, ,	NA (s)	TC (s)	OLL (s)	IB_MODE					EL8 (s)	EL7 (s)	EL6 (s)	EL5 (s)	EL4 (s)			_		
					(s)										ALIVADO O ALIVADO DE ALIVADO				
R145 (91h)	Digitiser Control (2)	0	0	AUXADC_M		0	AUXA	DC_CRATE[2	2:0] <i>(s)</i>	0	0	0	0	0					
D150 (00h)	AUX1 Readback	0	ALIVADO (-	(s)						ALIVADO E	DATA4[44.0]			AL (s) BMODE (s) WAIT (s)				
H152 (98fi)	AUX I Readback	0	AUXADC_S	SCALE1[1:0]	EF1						AUXADC_L	DATA1[11:0]						7000h	
R153 (99h)	AUX2 Readback	0	AUXADC S	SCALE2[1:0]	AUXADC_R						AUXADC [DATA2[11:0]						7000h	
, ,					EF2						_								
R154 (9Ah)	AUX3 Readback	0	AUXADC_S	SCALE3[1:0]	AUXADC_R						AUXADC_0	DATA3[11:0]						7000h	
					EF3														
R155 (9Bh)	AUX4 Readback	0	AUXADC_S	SCALE4[1:0]	AUXADC_R						AUXADC_E	DATA4[11:0]						7000h	
D156 (00h)	USB Voltage Readback	0	0	0	EF4 0						AUXADC DA	TA LICOI1110	1					0000h	
	LINE Voltage Readback	0	0	0	0						AUXADC_DA							0000h	
	BATT Voltage Readback	0	0	0	0						AUXADC_DA		•					0000h	
1	Chip Temp Readback	0	0	0	0						XADC_DATA_		•					0000h	
	Generic Comparator	0	0	0	0	0	0	0	0	0	0	0	0	DCMP4 EN	DCMP3_EN	DCMP2 EN	DCMP1 FN	0000h	
TTTOO (AOTI)	Control	•			Ů		Ů	v						A (s)	000011				
R164 (A4h)	Generic comparator 1	DCM	P1_SRCSEL[2	2:0] <i>(s)</i>	DCMP1_GT		•	-		•	DCMP1_	THR[11:0]	•	•	A (s)	A (s)	A (s)	0000h	
R165 (A5h)	Generic comparator 2	DCM	P2_SRCSEL[2	2:0] <i>(s)</i>	DCMP2_GT						DCMP2_	THR[11:0]						0000h	
R166 (A6h)	Generic comparator 3	DCM	P3_SRCSEL[2	2:0] <i>(s)</i>	DCMP3_GT						DCMP3_	THR[11:0]						0000h	
R167 (A7h)	Generic comparator 4	DCM	P4_SRCSEL[2	2:0] <i>(s)</i>	DCMP4_GT						DCMP4_	THR[11:0]						0000h	



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R168 (A8h)	Battery Charger Control 1	CHG_ENA (KMs)	0	0	CHG	_EOC_SEL[2:	0] <i>(K)</i>	CHG_TRIC KLE_TEMP _CHOKE (Ks)	CHG_TRIC KLE_USB_ CHOKE (Ks)	OVER_T	CHG_END_ ACT (Ks)	CHG_FAST (KMs)	CHG_FAST _USB_THR OTTLE (Ks)	CHG_NTC_ MON (M)	CHG_BATT _HOT_MON (M)	CHG_BATT _COLD_MO N (M)	CHG_CHIP _TEMP_MO N (KM)	A00Fh A00Fh A00Fh A00Fh
R169 (A9h)	Battery Charger Control 2	CHG_ACTI VE (M)	CHG_PAUS E (s)	CHG_S	STS[1:0]		CHG_TIM	E[3:0] <i>(KM)</i>		CHG_MASK _WALL_FB (Ks)	CHG_TRIC KLE_SEL (K)	CHG_VS	EL[1:0] <i>(K)</i>		CHG_ISE	EL[3:0] <i>(K)</i>		0B06h
R170 (AAh)	Battery Charger Control 3	0	0	0	0	0	0	0	0	CHG_FRC (Ks)	_	OTTLE_T[1:0]	0	0	0	0	0	0000h
R172 (ACh)	Current Sink Driver A	CS1_ENA	0	0	CS1_HIB_M ODE (s)	0	0	0	0	0	0			CS1_ISI	EL[5:0] (s)	•		0000h
R173 (ADh)	CSA Flash control	CS1_FLAS H_MODE (s)	CS1_TRIGS RC (s)	CS1_DRIVE (Ms)	CS1_FLAS H_RATE (s)	0	0	_	SH_DUR[1:0] (s)	0	0	CS1_OFF_F	RAMP[1:0] (s)	0	0	CS1_ON_F	AMP[1:0] (s)	0000h
R174 (AEh)	Current Sink Driver B	CS2_ENA (s)	0	0	CS2_HIB_M ODE (s)	0	0	0	0	0	0			CS2_ISI				0000h
R175 (AFh)	CSB Flash control	CS2_FLAS H_MODE (s)	CS2_TRIGS RC (s)	CS2_DRIVE (Ms)	CS2_FLAS H_RATE (s)	0	0		SH_DUR[1:0] (s)	0	0	CS2_OFF_F	RAMP[1:0] <i>(s)</i>	0	0	CS2_ON_F	AMP[1:0] (s)	0000h
R176 (B0h)	DCDC/LDO requested	LS_ENA (Ms)	0	0	0	LDO4_ENA (Ms)	LDO3_ENA (Ms)	LDO2_ENA (Ms)	LDO1_ENA (Ms)	0	0	DC6_ENA (Ms)	DC5_ENA (Ms)	DC4_ENA (Ms)	DC3_ENA (Ms)	DC2_ENA (Ms)	DC1_ENA (Ms)	0000h
R177 (B1h)	DCDC Active options	DCDC_DIS CLKS (s)	0	PUTO[1:0] <i>(s)</i>	0	0	0	0	0	0	DC6_ACTIV E (s)	0	DC4_ACTIV E (s)	DC3_ACTIV E (s)	0	DC1_ACTIV E (s)	032Dh
R178 (B2h)	DCDC Sleep options	0	0	0	0	0	0	0	0	0	0	DC6_SLEE P (s)	0	DC4_SLEE P (s)	DC3_SLEE P (s)	0	DC1_SLEE P (s)	0000h
R179 (B3h)	Power-check comparator	0	PCCMP_ER RACT (s)	0	PCCOMP_ HIB_MODE	0	0	0	0	0	PCCMF	P_OFF_THR[2	2:0] <i>(KM)</i>	0	PCCM	P_ON_THR[2	:0] <i>(KM)</i>	0025h 0025h 0025h 0025h
R180 (B4h)	DCDC1 Control	DC1_CA	.P[1:0] <i>(s)</i>	0	0	DC1_DISO VP (Ms)	DC1_OPFL T	0	0	0			DC	1_VSEL[6:0]				
R181 (B5h)	DCDC1 Timeouts	DC1_ERRA	CT[1:0] (Ms)		DC1_ENSL	OT[3:0] <i>(Ms)</i>			DC1_SD	SLOT[3:0]						0000h 1000h 0400h 0800h		
R182 (B6h)	DCDC1 Low Power	0	DC	1_HIB_MODE	[2:0]	0	0	DC1_HIB_T	RIG[1:0] (Ms)	0				OC1_VIMG[6:	0]			1006h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R183 (B7h)	DCDC2 Control	0	DC2_MODE	0	DC2_HIB_M ODE (s)	0	0	DC2_HIB_1	RIG[1:0] (s)	0	DC2_ILIM (Ms)	0	DC2_RMPH (Ms)	DC2_RMPL (Ms)	0	DC2_FBSF	RC[1:0] (Ms)	0018h
R184 (B8h)	DCDC2 Timeouts	DC2_ERR	ACT[1:0] (Ms)		DC2_ENSL	OT[3:0] (Ms)			DC2_SDS	SLOT[3:0]		0	0	0	0	0	0	0000h
																		0000h
																		0000h
					T	1	1				1							0000h
R186 (BAh)	DCDC3 Control	0	0	0	0		DC3_OPFL	0	0	0			DC	3_VSEL[6:0] ((Ms)			0000h
						VP (Ms)	Т											0026h
																		002Eh
												ı	1	1	ı		1	000Eh
R187 (BBh)	DCDC3 Timeouts	DC3_ERR	ACT[1:0] (Ms)		DC3_ENSL	OT[3:0] (Ms)			DC3_SDS	SLOT[3:0]		0	0	0	0	0	0	0000h
																		0400h
																		0000h
		_				1 -	I -				I		_					0000h
	DCDC3 Low Power	0		HIB_MODE[2		0	0	DC3_HIB_TI		0				DC3_VIMG[6:0	-			0006h
R189 (BDh)	DCDC4 Control	0	0	0	0	VP (Ms)	DC4_OPFL T	0	0	0			DC	4_VSEL[6:0] ((Ms)			0000h
						VF (IVIS)	'											0056h
																		000Eh 0006h
D100 (DEb)	DCDC4 Timeouts	DC4 EDD	L ACT[1:0] <i>(Ms)</i>		DC4_ENSL	OT[2:0] (Ma)			DC4_SDS	OTIO-01		0	0	0	0	0	0	0000h
H 190 (DEII)	DCDC4 Timeouts	DC4_ENN	AC1[1.0] (WS)		DC4_ENSL	O1[3.0] (<i>IVIS)</i>			DC4_3D3	SLUT[3.0]		0	U	U	U	U	U	0400h
																		0400H
																		0C00h
R191 (BFh)	DCDC4 Low Power	0	DC4	HIB_MODE[2	:01 (Ms)	0	0	DC4_HIB_TI	RIG[1:0] (Ms)	0				DC4_VIMG[6:0	<u> </u> 			0006h
†	DCDC5 Control	0	DC5_MODE		DC5_HIB_M		0		RIG[1:0] (s)	0	DC5_ILIM	0	DC5_RMPH		0	DC5_FBSF	RC[1:0] (Ms)	0008h
(****)			(s)		ODE (s)				[] (-)		(Ms)		(Ms)	(Ms)				
R193 (C1h)	DCDC5 Timeouts	DC5_ERR	ACT[1:0] (Ms)		DC5_ENSL	OT[3:0] (Ms)	•		DC5_SDS	SLOT[3:0]	•	0	0	0	0	0	0	0000h
																		0000h
																		0000h
																		0000h
R195 (C3h)	DCDC6 Control	DC6_	CAP[1:0]	0	0	DC6_DISO	DC6_OPFL	0	0	0			DC	6_VSEL[6:0] ((Ms)			0000h
						VP (Ms)	T											000Ah
																		0026h
															1	_		0026h
R196 (C4h)	DCDC6 Timeouts	DC6_ERR	ACT[1:0] (Ms)		DC6_ENSL	OT[3:0] (Ms)			DC6_SD5	SLOT[3:0]		0	0	0	0	0	0	0000h
								1						1			1	1000h
																		0C00h
																		0400h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R197 (C5h)	DCDC6 Low Power	0	DC6_	HIB_MODE[2:	0] <i>(Ms)</i>	0	0	DC6_HIB_TI	RIG[1:0] (Ms)	0			I	DC6_VIMG[6:	0]			0006h
R199 (C7h)	Limit Switch Control	LS_ERRA	CT[1:0] (Ms)		LS_ENSLC	OT[3:0] (Ms)			LS_SDS	LOT[3:0]		0	LS_HIB_MO DE	0	0	LS_HIB_PR OT	LS_PROT	0003h
R200 (C8h)	LDO1 Control	0	LDO1_SWI (Ms)	0	0	0	LDO1_OPF LT	0	0	0	0	0		LDO	D1_VSEL[4:0]	(Ms)		001Ch 0002h 001Ch 0002h
R201 (C9h)	LDO1 Timeouts	LDO1_ERR	ACT[1:0] <i>(Ms)</i>		LDO1_ENSL	OT[3:0] <i>(Ms)</i>			LDO1_SD	SLOT[3:0]		0	0	0	0	0	0	0000h 0C00h 0000h 0000h
R202 (CAh)	LDO1 Low Power	0	0	LDO1_HIB_ (M	_MODE[1:0] (s)	0	0		B_TRIG[1:0] <i>Ms)</i>	0	0	0		L	.DO1_VIMG[4	:0]		001Ch
R203 (CBh)	LDO2 Control	0	LDO2_SWI (Ms)	0	0	0	LDO2_OPF LT	0	0	0	0	0		LDO2_VSEL[4:0] (Ms)			001Bh 001Fh 0010h 001Ah	
R204 (CCh)	LDO2 Timeouts	LDO2_ERR	ACT[1:0] <i>(Ms)</i>		LDO2_ENSL	LOT[3:0] <i>(Ms)</i>			LDO2_SD	SLOT[3:0]		0	0	0 0 0 0 0 LDO2_VIMG[4:0]			0000h 0800h 0800h 0000h	
R205 (CDh)	LDO2 Low Power	0	0	LDO2_HIB_ (A	MODE[1:0]	0	0	_	3_TRIG[1:0] <i>l</i> (s)	0	0	0		L	.DO2_VIMG[4	:0]		001Ch
R206 (CEh)	LDO3 Control	0	LDO3_SWI (Ms)	0	0	0	LDO3_OPF LT	0	0	0	0	0		LDO	D3_VSEL[4:0]	(Ms)		001Bh 001Ch 0015h 001Fh
R207 (CFh)	LDO3 Timeouts	LDO3_ERR.	ACT[1:0] <i>(Ms)</i>		LDO3_ENSL	OT[3:0] <i>(Ms)</i>			LDO3_SD	SLOT[3:0]		0	0	0	0	0	0	0000h 0400h 0000h 0000h
R208 (D0h)	LDO3 Low Power	0	0	LDO3_HIB_ (A	MODE[1:0]	0	0		3_TRIG[1:0] Ms)	0	0	0	LDO3_VIMG[4:0]			001Ch		
R209 (D1h)	LDO4 Control	0	LDO4_SWI (Ms)	0	0	0	LDO4_OPF LT	0	0	0	0	0		LDO	O4_VSEL[4:0]	(Ms)		001Bh 0004h 001Ah 001Fh

REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R210 (D2h)	LDO4 Timeouts	LDO4_ERRA	ACT[1:0] <i>(Ms)</i>		LDO4_ENSL	OT[3:0] <i>(Ms)</i>			LDO4_SD	SLOT[3:0]		0	0	0	0	0	0	0000h 0800h 0000h 0000h
R211 (D3h)	LDO4 Low Power	0	0	LDO4_HIB_	_MODE[1:0]	0	0		3_TRIG[1:0] //s)	0	0	0		L	I DO4_VIMG[4:	<u>[</u> :0]		001Ch
R215 (D7h)	VCC_FAULT Masks	LS_FAULT	0	0	0	LDO4_FAU LT (s)	LDO3_FAU LT (s)	LDO2_FAU LT (s)	LDO1_FAU LT (s)	0	0	DC6_FAUL T (s)	DC5_FAUL T (s)	DC4_FAUL T (s)	DC3_FAUL T (s)	DC2_FAUL T (s)	DC1_FAUL T (s)	0000h
R216 (D8h)	Main Bandgap Control	MBG_LOAD _FUSES	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	001Fh
R217 (D9h)	OSC Control	OSC_LOAD _FUSES (K)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R218 (DAh)	RTC Tick Control	RTC_TICK_ ENA (KMs)	RTC_TICKS TS (K)	RTC_CLKS RC (KMs)	OSC32K_E NA (KMs)	0	0					RTC_TRI	M[9:0] <i>(K)</i>					9000h 9000h 9000h 9000h
R219 (DBh)	Security1		I					I	SECURIT	Y[15:0] (s)								0000h
R224 (E0h)	Signal overrides	0	0	0	0	WALL_FB_ GT_BATT_ OVRDE	USB_FB_G T_BATT_O VRDE	FLL_OK_O VRDE	DEB_TICK_ OVRDE	UVLO_B_O VRDE	RTC_ALAR M_OVRDE	0	0			USB_GT_LI NE_OVRDE		0000h
R225 (E1h)	DCDC/LDO status	LS_STS (s)	0	0	0	LDO4_STS (s)	LDO3_STS	LDO2_STS (s)	LDO1_STS (s)	0	0	DC6_STS (s)	DC5_STS (s)	DC4_STS (s)	DC3_STS (s)	DC2_STS (s)	DC1_STS (s)	0000h
R226 (E2h)	Charger Overides/status	CHG_BATT _HOT_OVR DE	CHG_BATT _COLD_OV RDE	0	0	CHG_END_ OVRDE	0	0	0	0	0	0	0	0	CHG_BATT _LT_3P9_O VRDE	_	_	0000h
R227 (E3h)	misc overrides	0	0	CS2_NOT_ REG_OVRD E	CS1_NOT_ REG_OVRD E	0	USB_LIMIT _OVRDE	0	0	AUX_DCO MP4_OVRD E	AUX_DCO MP3_OVRD E	AUX_DCO MP2_OVRD E		HYST_UVL O_OK_OVR DE	CHIP_GT11 5_OVRDE	CHIP_GT14 0_OVRDE	0	0000h
R228 (E4h)	Supply overrides/status 1	0	0	0	0	0	0	0	0	0	0	OVRV_DC6 _OVRDE	0	OVRV_DC4 _OVRDE	OVRV_DC3 _OVRDE	0	OVRV_DC1 _OVRDE	0000h
R229 (E5h)	Supply overrides/status 2	OVCR_LS_ OVRDE	0	0	0	UNDV_LDO 4_OVRDE	UNDV_LDO 3_OVRDE	UNDV_LDO 2_OVRDE	UNDV_LDO 1_OVRDE	0	0	UNDV_DC6 _OVRDE	UNDV_DC5 _OVRDE	UNDV_DC4 _OVRDE	UNDV_DC3 _OVRDE	UNDV_DC2 _OVRDE	UNDV_DC1 _OVRDE	0000h
R230 (E6h)	GPIO Pin Status	1 (n)	1 (n)	1 (n)	GP12_LVL	GP11_LVL	GP10_LVL	GP9_LVL	GP8_LVL	GP7_LVL	GP6_LVL	GP5_LVL	GP4_LVL	GP3_LVL	GP2_LVL	GP1_LVL	GP0_LVL	E000h
R231 (E7h)	comparotor overrides	USB_FB_O VRDE	WALL_FB_ OVRDE	BATT_FB_ OVRDE	0	CODEC_JC K_DET_L_ OVRDE	CODEC_JC K_DET_R_ OVRDE	CODEC_MI CSCD_OVR DE	CODEC_MI CD_OVRDE	0	0	0	0	0	0	0	0	0000h
R233 (E9h)	State Machine status	0	0	0	0	0		USB_SM[2:0]		0		CHG_SM[2:0			MAIN_	SM[3:0]		0000h
R248 (F8h)	DCDC1 Test Controls	0	0	0	0	0	0	0	0	0	0	0	DC1_FORC E_PWM (s)	0	0	0	0	1000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R250 (FAh)	DCDC3 Test Controls	0	0	0	0	0	0	0	0	0	0	0	DC3_FORC E_PWM (s)		0	0	0	1000h
R251 (FBh)	DCDC4 Test Controls	0	0	0	0	0	0	0	0	0	0	0	DC4_FORC E_PWM (s)		0	0	0	1000h
R253 (FDh)	DCDC6 Test Controls	0	0	0	0	0	0	0	0	0	0	0	DC6_FORC E_PWM (s)		0	0	0	1000h



27 REGISTER BITS BY ADDRESS

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R0 (00h)	15:0	SW_RESET/CHIP_ID[15:0]	0110_0001_0100_0011	Reading this register returns 6143h.	
Reset/ID				Never reset.	

Register 00h Reset/ID

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R1 (01h) ID	15:12	CHIP_REV[3:0]		The functional silicon revision - this tracks changes in functionality which are separate from ROM mask settings	
	11:10	CONF_STS[1:0]		The state of the configuration pins. This selects what register defaults should be.	
	7:0	CUST_ID[7:0]		The Chip Revision Number	

Register 01h ID

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R2 (02h) Revision	7:0	MASK_REV[7:0]		The ROM Mask ID	

Register 02h Revision

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R3 (03h) System Control 1	15	CHIP_ON	0	Indicates whether the system is on or off. Writing 0 to this bit powers down the whole chip. Registers which are affected by state machine reset will get reset. Once the system is turned OFF it can be restarted	
				by any of the valid ON event.	
				Reset by state machine. Default held in metal mask.	
	14	SYS_RST	0	Allows the processors to reboot itself	
				0 = Do nothing	
				1 = Perform a processor reset by asserting the /RST and /MEMRST (GPIO) pins for the programmed duration	
				Protected by security key. Reset by state machine. Default held in metal mask.	
	13	POWERCYCLE	0	Action to take on a fault (if response is set to shutdown system):	
				0 = Shut down	
				1 = Shutdown everything then go through startup sequence. i.e. Reboot the system.	
	12	VCC_FAULT_OV	1	Include over voltage in the /VCC_FAULT pin (Alternative GPIO function) 0 = Do not include over voltage in the /VCC_FAULT signal	
				1 = Include the over voltage in the /VCC_FAULT signal	
				Reset by state machine. Default held in metal mask.	

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	11:10	RSTB_TO[1:0]	11	Time that the /RST pin and /MEMRST output is held low after the chip reaches the active state. 00 = 15ms 01 = 30ms 10 = 60ms 11 = 120ms Default held in metal mask.	
	9	BG_SLEEP	0	Bandgap sleep mode 0 = never in sleep mode 1 = sleep mode is controlled by Main SM Default held in metal mask.	
	7	WDOG_DEBUG	0	Halts watchdog timer for system debugging 0 = normal operation 1 = WDOG halt Protected by security key.	
	6	CHIP_RESET_ENA	0	[No description available] Reset by state machine.	
	5	MEM_VALID	0	Indicates that the contents of external memory are still valid. This bit is cleared on startup and whenever /MEMRST is asserted from the main state machine. The system software should set this bit once the external memory has been set up. Controlled in hibernate mode by MEMRST_HIB_MODE 0 = External memory is not valid and needs restoring. 1 = External memory is valid. Reset when /MEMRST is asserted.	
	4	CHIP_SET_UP	0	A spare register bit that can be used by the system to say if the chip has been configured. It is reset by POR.	
	3	ON_DEB_T	0	ON pin Shutdown function debounce time 0 = 10s 1 = 5s Protected by security key.	
	1	ON_POL	1 1 1 1	ON pin polarity: 0 = Active high (ON) 1 = Active low (/ON) Protected by security key. Reset by state machine. Default held in metal mask.	
	0	IRQ_POL	0	IRQ pin polarity: 0 = Active low (/IRQ) 1 = Active high (IRQ) Reset by state machine. Default held in metal mask.	

Register 03h System Control 1



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R4 (04h) System Control 2	15	USB_SUSPEND_8MA	0	USB suspend mode with 8mA option 0 = USB is not suspended. 1 = USB is suspend with 8mA option enabled The register bit defaults to 0, when a reset happens or LINE <uvlo been="" boot="" comp="" default="" due="" fail="" held="" hysteresis="" in="" limit="" mask.<="" met.="" metal="" not="" of="" on="" or="" system="" td="" the="" to="" upper=""><td></td></uvlo>	
	14	USB_SUSPEND	0	Opens the USB switch 0 = USB enabled 1 = USB suspended The register bit defaults to 0, when a reset happens or LINE < UVLO or the system fail on boot due to the upper limit of the Hysteresis Comp not being met. Default held in metal mask.	
	13	USB_MSTR	0	Set the chip to be a USB master 0 = Slave 1 = Master The register bit defaults to 0, when a reset happens or the USB state machine moves from MASTER mode to SLAVE mode. Reset by state machine. Default held in metal mask.	
	12	USB_MSTR_SRC	0	Master mode source selector 0 = Master mode source is DCDC2/5 1 = Master mode source is LINE Reset by state machine. Default held in metal mask.	
	11	USB_MSTR_500MA	0	Set 500mA or 100mA mode when the USB switch is in master mode 0 = 100mA 1 = 500mA Reset by state machine. Default held in metal mask.	
	10	USB_NOLIM	0	USB current limiting 0 = Limit the USB current as per the settings. 1 = Don't limit USB current	
	9	USB_SLV_500MA	0 1 1 1	Set 500mA or 100mA mode when the USB switch is in slave mode 0 = 100mA 1 = 500mA The register bit defaults to 0, when a reset happens or LINE <uvlo being="" boot="" by="" comp="" default="" due="" fail="" held="" hysteresis="" in="" limit="" machine.="" mask.<="" met.="" metal="" not="" of="" on="" or="" reset="" state="" system="" td="" the="" to="" upper=""><td></td></uvlo>	
	7	WDOG_HIB_MODE	0	Watchdog state in hibernate state 0 = WDOG disabled in Hibernate 1 = WDOG controlled by WDOG_MODE in Hibernate	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
	5:4	WDOG_MODE[1:0]	00	00 = Disabled	
			00	01 = SYS_WDOG_TO interrupt on time-out	
			01 00	10 = WKUP_WDOG_RST interrupt and System reset on time-out	
			00	11 = SYS_WDOG_TO interrupt on first time-out, WKUP_WDOG_RST interrupt and System reset on second time-out	
				Protected by security key. Reset by state machine. Default held in metal mask.	
	2:0	WDOG_TO[2:0]	100	Watchdog timeout (seconds)	
				The timer is reset to this value when a HEARTBEAT signal edge is detected or the host writes to the watchdog control register.	
				000 = 0.125s	
				(time doubles with each step)	
				101 = 4s	
				11x = Reserved	
				Protected by security key.	

Register 04h System Control 2

BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
15	HIBERNATE	0	Determines what state the chip should	
			1 .	
			The register bit defaults to 0, when a reset happens	
			Reset by state machine. Default held in metal mask.	
7	WDOG_HIB_MODE	0	Watchdog behaviour in HIBERNATE state	
			0 = WDOG disabled in Hibernate	
			1 = WDOG controlled by WDOG MODE in	
			Hibernate	
6	HIB_STARTUP_SEQ	0	Direction to take when going from Hibernate state to the Active state.	
			0 = Hibernate to Active without going through startup state	
			1 = Hibernate to Active goes though startup sequence	
5	REG RESET HIB MODE	0	Action of the internal register reset signal	
			when going from Hibernate to Active.	
			0 = Do a register reset when leaving the hibernate state.	
			1 = Do not do a register reset when leaving the hibernate state	
4	RST HIB MODE	0	/RST pin state in hibernate mode:	
			` ′	
3	IRO HIB MODE	0	` • ,	
			· ·	
			· ·	
2	MEMRST HIB MODE	0		
_			state in hibernate mode	
			` '	
	7 6	To HIBERNATE To WDOG_HIB_MODE HIB_STARTUP_SEQ To REG_RESET_HIB_MODE REST_HIB_MODE To IRQ_HIB_MODE	15 HIBERNATE 0 7 WDOG_HIB_MODE 0 6 HIB_STARTUP_SEQ 0 5 REG_RESET_HIB_MODE 0 4 RST_HIB_MODE 0 3 IRQ_HIB_MODE 0	15 HIBERNATE 0 Determines what state the chip should operate in. 0 = Active state 1 = Hibernate state The register bit defaults to 0, when a reset happens Reset by state machine. Default held in metal mask. 7 WDOG_HIB_MODE 0 Watchdog behaviour in HIBERNATE state 0 = WDOG disabled in Hibernate 1 = WDOG controlled by WDOG_MODE in Hibernate 1 = WDOG controlled by WDOG_MODE in Hibernate 0 = Hibernate to Active without going through startup state 1 = Hibernate to Active without going through startup state 1 = Hibernate to Active goes though startup sequence 5 REG_RESET_HIB_MODE 0 Action of the internal register reset signal when going from Hibernate to Active. 0 = Do a register reset when leaving the hibernate state. 1 = Do not do a register reset when leaving the hibernate state. 1 = Do not do a register reset when leaving the hibernate state. 1 = Do not do a register reset when leaving the hibernate state. 1 = Not asserted (low) 1 = Not asserted (high) 1 RQ_HIB_MODE 0 IRQ pin state in hibernate mode 0 = Normal operation 1 = Forced to indicate there is no IRQ 2 MEMRST_HIB_MODE 0 /MEMRST (Alternative GPIO function) pin



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	1	PCCOMP_HIB_MODE	0	Function of the Hysteresis Comp in hibernate. 0 = Hysteresis Comp is not used in hibernate 1 = Hysteresis Comp is on in hibernate	
	0	TEMPMON_HIB_MODE	0	Function of the temp monitoring in hibernate. 0 = Temp monitoring is off in hibernate state 1 = Temp monitoring is on in the hibernate state	

Register 05h System Hibernate

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R6 (06h) Interface Control	15	USE_DEV_PINS	1	Selects which pins to use for the 2-wire control: 0 = Use 2-wire I/F pins as 2-wire interface 1 = Use GPIO 10 and 11 as 2-wire interface, e.g. to download settings from PIC. Only applies when CONFIG pins[1:0] = 00. Reset by state machine.	
	14:13	DEV_ADDR[1:0]	00	Selects device address (only valid when CONF_STS = 00) 00 = 0x34 01 = 0x36 10 = 0x3C 11 = 0x3E Reset by state machine.	
	12	CONFIG_DONE	0	Tells the system that the PIC micro has completed its programming. 0 = Programming still to be done 1 = Programming complete Only applies when CONFIG pins[1:0] = 00. Reset by state machine.	
	11	RECONFIG_AT_ON	1	Selects whether to reset the registers in the OFF state and whether to reload the device configuration from the PIC when an ON event occurs. 0 = Do not reset registers in the OFF state. Do not load configuration data when an ON event occurs. 1 = Reset registers in the OFF state. Load configuration from the PIC when an ON event occurs. Note that, in development mode, the device configuration from the PIC is always loaded when first powering up the chip. This bit must always be set to default (1) in Custom Modes 01, 10 and 11.	
	9	AUTOINC	1	Enables address auto-increment 0 = disabled 1 = enabled Reset by state machine.	
	3	SPI_CFG	0 0 0 0	Controls the SDOUT (GPIO6) pin operation in 4 wire mode 0 = SDOUT output is CMOS 1 = SDOUT output is open drain Note: SPI_4WIRE must be set for this to take effect. Protected by security key. Default held in metal	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				mask.	
	2	SPI_4WIRE	0	Selects 3-wire or 4-wire SPI mode	
			0	0 = 3-wire mode using bi-directional SDATA pin	
			0	1 = 4 wire mode using SDOUT (GPIO6)	
			0	Note: SPI_3WIRE must be set for this to take effect.	
				Protected by security key. Default held in metal mask.	
	1	SPI_3WIRE	0	Selects 2- or 3-/4-wire mode.	
			0	0 = 2-wire mode	
			0	1 = 3/4 wire mode	
			0	Protected by security key. Default held in metal mask.	

Register 06h Interface Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R8 (08h)	15:14	CODEC_ISEL[1:0]	10	CODEC Analogue current level select	
Power mgmt				00 = x 1.5	
(1)				01 = x 1.0	
				10 = x 0.75	
				11 = x 0.5	
	13	VBUF_ENA	0	Forces ON the tie-off amplifiers	
				0 = disabled	
				1 = enabled	
	10	OUTPUT_DRAIN_ENA	0	Enables a drain on the outputs allowing the	
				amplifiers to shutdown more quickly.	
				0 = Shutdown as normal	
				1 = Sink current from an external capacitor,	
				allowing faster shutdown.	
	8	MIC_DET_ENA	0	Enable MIC detect:	
				0 = disabled	
		_		1 = enabled	
	5	BIAS_ENA	0	Enables bias to analogue audio CODEC	
				circuitry 0 = disabled	
				1 = enabled	
	4	MICD ENA	0		
	4	MICB_ENA	U	Microphone bias enable	
				0 = OFF (high impedance output) 1 = ON	
	2	VMID ENA	0		
		VMID_ENA	U	Enables VMID resistor string 0 = disabled	
				1 = enabled	
	4.0	VMIDIA.01	00		
	1:0	VMID[1:0]	00	Resistor selection for VMID potential divider 00 = off	
				1 ** ***	
				01 = Vmid comes from 300kΩ R-string	
				10 = Vmid comes from 50kΩ R-string	
	l	1		11 = Vmid comes from $5k\Omega$ R-string	

Register 08h Power mgmt (1)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R9 (09h)	11	IN3R_ENA	0	IN3R Amplifier enable	
Power mgmt				0 = disabled	
(2)				1 = enabled	
	10	IN3L_ENA	0	IN3L Amplifier enable	
				0 = disabled	
				1 = enabled	
	9	INR_ENA	0	Right input PGA enable	
				0 = disabled	
				1 = enabled	
	8	INL_ENA	0	Left input PGA enable	
				0 = disabled	
				1 = enabled	
	7	MIXINR_ENA	0	Right input mixer enable	
				0 = disabled	
				1 = enabled	
	6	MIXINL_ENA	0	Left input mixer enable	
				0 = disabled	
				1 = enabled	
	5	OUT4_ENA	0	OUT4 enable	
				0 = disabled	
				1 = enabled	
	4	OUT3_ENA	0	OUT3 enable	
				0 = disabled	
				1 = enabled	
	1	MIXOUTR_ENA	0	Right Output Mixer Enable	
				0 = disabled	
				1 = enabled	
	0	MIXOUTL_ENA	0	Left Output Mixer Enable	
				0 = disabled	
				1 = enabled	

Register 09h Power mgmt (2)

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R10 (0Ah)	7	IN3R_TO_OUT2R	0	BEEP mixer enable	
Power mgmt	3	OUT2R_ENA	0	OUT2R enable	
(3)				0 = disabled	
				1 = enabled	
	2	OUT2L_ENA	0	OUT2L enable	
				0 = disabled	
				1 = enabled	
	1	OUT1R_ENA	0	OUT1R enable	
				0 = disabled	
				1 = enabled	
	0	OUT1L_ENA	0	OUT1L enable	
				0 = disabled	
				1 = enabled	

Register 0Ah Power mgmt (3)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R11 (0Bh)	14	SYSCLK_ENA	0	CODEC SYSCLK enable	
Power mgmt				0 = disabled	
(4)				1 = enabled	
	13	ADC_HPF_ENA	1	High Pass Filter enable	
				0 = disabled	
				1 = enabled	
	8	TOCLK_ENA	0	Slow clock enable. Used the zero cross timeout.	
				0 = disabled	
				1 = enabled	
	5	DACR_ENA	0	Right DAC enable	
				0 = disabled	
				1 = enabled	
	4	DACL_ENA	0	Left DAC enable	
				0 = disabled	
				1 = enabled	
	3	ADCR_ENA	0	Right ADC enable	
				0 = disabled	
				1 = enabled	
				When ADCR and ADCL are used together as a stereo pair, then both ADCs must be enabled	
				together using a single register write to Register R11 (0Bh).	
	2	ADCL_ENA	0	Left ADC enable	
		_		0 = disabled	
				1 = enabled	
				When ADCR and ADCL are used together as a	
				stereo pair, then both ADCs must be enabled	
				together using a single register write to Register R11 (0Bh).	

Register 0Bh Power mgmt (4)

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R12 (0Ch) Power mgmt	12	CODEC_ENA	0	Master codec enable bit. Until this bit is set, all codec registers are held in reset.	
(5)				0 = All codec registers held in reset	
				1 = Codec registers operate normally.	
				Reset by state machine.	
	11	RTC_TICK_ENA	1	Real Time Clock control.	
			1	0 = RTC is disabled	
			1	1 = RTC is enabled.	
			1	Protected by security key. Reset by state machine. Default held in metal mask.	
	10	OSC32K_ENA	1	32kHz crystal oscillator control	
			1	0 = 32kHz OSC is disabled	
			1	1 = 32kHz OSC is enabled	
			1	Protected by security key. Reset by state machine. Default held in metal mask.	
	9	CHG_ENA	1	Charger control	
				CHG_ENA bit selects battery charger current control	
				0 = Set battery charger current to zero	
				1 = Enable battery charge control	
				Protected by security key. Reset by state machine. Default held in metal mask.	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
	8	SW_VRTC_ENA	0	SW_VRTC control	
				0 = VRTC is not driven out on SWVRTC pin	
				1 = VRTC is driven out on SWVRTC pin	
				Reset by state machine.	
	7	AUXADC_ENA	0	AUXADC control	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	3	DCMP4_ENA	0	Digital comparator 4 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	2	DCMP3_ENA	0	Digital comparator 3 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	1	DCMP2_ENA	0	Digital comparator 2 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	0	DCMP1_ENA	0	Digital comparator 1 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	

Register 0Ch Power mgmt (5)

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R13 (0Dh)	15	LS_ENA	0	Limit Switch enable	
Power mgmt		_		0 = disabled	
(6)				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	11	LDO4_ENA	0	LDO4 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	10	LDO3_ENA	0	LDO3 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	9	LDO2_ENA	0	LDO2 enable	
		_		0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	8	LDO1_ENA	0	LDO1 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	5	DC6_ENA	0	DCDC6 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
		-		Reset by state machine. Default held in metal mask.	
	4 DC5	DC5_ENA	0	DCDC5 converter enable	
				0 = disabled	
				1 = enabled Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	3	DC4_ENA	0	DCDC4 converter enable	
		_		0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	2	DC3_ENA	0	DCDC3 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	1	DC2_ENA	0	DCDC2 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status	
				register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	0		0	DCDC1 converter enable	
		DC1_ENA		0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	

Register 0Dh Power mgmt (6)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R14 (0Eh)	1	CS2_ENA	0	Current Sink 2 enable (ISINKB pin)	
Power mgmt				0 = disabled	
(7)				1 = enabled	
				Reset by state machine.	
	0	CS1_ENA	0	Current Sink 1 enable (ISINKA pin)	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	

Register 0Eh Power mgmt (7)

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R16 (10h) RTC	14:8	RTC_MINS[6:0]	000_0000	RTC Minutes; 0 to 59	
Seconds/Minute s	6:0	RTC_SECS[6:0]	000_0000	RTC Seconds; 0 to 59	

Register 10h RTC Seconds/Minutes

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R17 (11h) RTC	10:8	RTC_DAY[2:0]	001	RTC Day of the week register with range 1-7. 1 is Sunday	
Hours/Day	5	RTC_HPM	0	RTC hours AM/PM flag	
				0 = AM	
				1 = PM	
				Only valid in 12 hour mode.	
	4:0	RTC_HRS[4:0]	0_0000	RTC Hours register with 0-23 range in 24 hour mode and 1-12 in 12 hour mode. (Bit 5 is used to indicate PM/not-AM flag in 12 hour mode.)	

Register 11h RTC Hours/Day

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R18 (12h)	12:8	RTC_MTH[4:0]	0_0001	RTC Month register with range 1-12.	
RTC Date/Month	5:0	RTC_DATE[5:0]	00_0001	RTC Date register with range 1-31	

Register 12h RTC Date/Month

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R19 (13h)	13:8	RTC_YHUNDREDS[5:0]	01_0100	RTC Year hundreds register tied to 20(dec)	
RTC Year	7:0	RTC_YUNITS[7:0]	0000_0000	RTC Year units register with range 0-99.	

Register 13h RTC Year



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R20 (14h) Alarm Seconds/Minute S	14:8	RTC_ALMMINS[6:0]	000_0000	Minutes alarm register with range 0-59. All 1's sets to 'don't care' state. Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	
	6:0	RTC_ALMSECS[6:0]	000_0000	Seconds alarm register with range 0-59. All 1's set to 'don't care' state. Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	

Register 14h Alarm Seconds/Minutes

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R21 (15h) Alarm Hours/Day	11:8	RTC_ALMDAY[3:0]	0000	Day alarm register, with range 1-7, 1 = Sunday. All 1's sets to 'don't care' state. Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	
	5	RTC_ALMHPM	0	Alarm hours AM/PM flag 0 = AM 1 = PM Only applicable in 12 hour mode. In 24 hour mode set to 1 if RTC_ALMHRS is set to all 1's 'don't care' or 0 otherwise.	
	4:0	RTC_ALMHRS[4:0]	0_0000	Hours alarm register with range 0-23 in 24 hours mode and 1-12 in 12 hour. In 12 hour mode bit 5 is used as PM/not-AM flag. All 1's sets to 'don't care' state. Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	

Register 15h Alarm Hours/Day

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDICESS					
R22 (16h) Alarm	12:8	RTC_ALMMTH[4:0]	0_0000	Month alarm register with range 1-12. All 1's sets to 'don't care' state.	
Date/Month				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	
	5:0	RTC_ALMDATE[5:0]	00_0000	Date alarm register with range 1-31. All 1's sets to 'don't care' state.	
				Note, during programming it is best to disable the Alarm Enable request bit to avoid false alarms.	

Register 16h Alarm Date/Month



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R23 (17h) RTC Time	15	RTC_BCD	0	RTC Coding (applies to all time registers) 0 = Binary	
Control				1 = BCD	
	14	RTC_12HR	0	RTC 12/24 hours mode	
				1 = 12 hours (MSB of RTC_HRS indicates AM/PM)	
				0 = 24 hours (MSB of RTC_HRS is 0)	
	11	RTC_SET	0	Stops RTC seconds counter (instruction only)	
				0 = normal operation	
				1 = stop counter	
	10	RTC_STS	0	Status of RTC seconds counter	
				0 = normal operation	
				1 = counter stopped	
	9	RTC_ALMSET	1	Stops alarms (instruction only)	
				0 = normal operation	
				1 = stop alarms	
				It is recommended to stop alarms when setting the RTC alarm. This avoids false alarms.	
	8	RTC_ALMSTS	1	Actual status of ALARM circuitry	
				0 = normal operation	
				1 = alarms stopped	
	6:4	RTC_PINT[2:0]	010	Selects frequency of periodic interrupt output pulse (32kHz period duration) as shown below. When set time status is high, the periodic output is disabled.	
				000 = disabled	
				001 = 1 sec	
				010 = 1 min	
				011 = 1 hour	
				100 = 1 day	
				101 = 1 month	
				11x = disabled	
	3:0	RTC_DSW[3:0]	0000	Divided Square wave select.	
				0000 = disabled	
				0001 = 1Hz	
				0010 = 2Hz	
				1011 = 1024Hz	
				1100 = 2048Hz	
				1101 = 4096Hz	
				1110 = 8192Hz	
				1111 = 16384Hz	
				Note: due to trim settings for crystal intolerances a single square wave period during seconds rollover may be decrease its on time period or increase its off time period by up to 8 32kHz periods.	

Register 17h RTC Time Control

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REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R24 (18h)	13 OC_INT		0	First-level over-current interrupt.	
System				Note: This bit is cleared once read.	
Interrupts	12	UV_INT	0	First-level under-voltage interrupt.	
				Note: This bit is cleared once read.	
	9	CS_INT	0	First-level current sink interrupt.	
				Note: This bit is cleared once read.	
	8	EXT_INT	0	First-level external interrupt.	
				Note: This bit is cleared once read.	
	7	CODEC_INT	0	First-level codec interrupt.	
				Note: This bit is cleared once read.	
	6	GP_INT	0	First-level GPIO interrupt.	
				Note: This bit is cleared once read.	
	5	AUXADC_INT	0	First-level AUXADC comparator interrupt.	
				Note: This bit is cleared once read.	
	4	RTC_INT	0	First-level RTC interrupt.	
				Note: This bit is cleared once read.	
	3	SYS_INT	0	First-level system interrupt.	
		_		Note: This bit is cleared once read.	
	2	CHG INT	0	First-level charger interrupt.	
		_		Note: This bit is cleared once read.	
	1	USB INT	0	First-level USB interrupt.	
		_		Note: This bit is cleared once read.	
	0	WKUP INT	0	First-level wakeup interrupt.	
		_		Note: This bit is cleared once read.	

Register 18h System Interrupts

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R25 (19h)	15	CHG_BATT_HOT_EINT	0	Battery temp too hot.	
Interrupt Status 1				(Rising Edge triggered)	
Status I				Note: This bit is cleared once read.	
	14	CHG_BATT_COLD_EINT	0	Battery temp too cold.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	13	CHG_BATT_FAIL_EINT	0	Battery fail.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	12	CHG_TO_EINT	0	Charger timeout.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	11	CHG_END_EINT	0	Charging final stage.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	10	CHG_START_EINT	0	Charging started.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	9	CHG_FAST_RDY_EINT	0	Indicates that the charger is ready to go	
				into fast charge.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
	7	RTC_PER_EINT	0	RTC periodic interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	6	RTC_SEC_EINT	0	RTC 1s rollover complete (1Hz tick).	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	5	RTC_ALM_EINT	0	RTC alarm etectio.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	2	CHG_VBATT_LT_3P9_EINT	0	Battery Voltage < 3.9 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	1	CHG_VBATT_LT_3P1_EINT	0	Battery voltage < 3.1 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	0	CHG_VBATT_LT_2P85_EINT	0	Battery voltage < 2.85 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	

Register 19h Interrupt Status 1

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R26 (1Ah) Interrupt Status 2	13	CS1_EINT	0	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	12	CS2_EINT	0	Flag to indicate drain voltage can no longer be regulated and output current may be out of spec.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	10	USB_LIMIT_EINT	0	USB limit switch interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	8	AUXADC_DATARDY_EINT	0	Auxiliary data ready.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	7	AUXADC_DCOMP4_EINT	0	DCOMP4 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	6	AUXADC_DCOMP3_EINT	0	DCOMP3 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	5	AUXADC_DCOMP2_EINT	0	DCOMP2 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	4	AUXADC_DCOMP1_EINT	0	DCOMP1 interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	3	SYS_HYST_COMP_FAIL_EINT	0	Hysteresis comparator indication that LINE or BATT is less that shutdown threshold. (Rising Edge triggered) Note: This bit is cleared once read.	
	2	SYS_CHIP_GT115_EINT	0	Chip over 115°C temp limit. (Rising Edge triggered) Note: This bit is cleared once read.	
	1	SYS_CHIP_GT140_EINT	0	Chip over 140°C temp limit. (Rising Edge triggered) Note: This bit is cleared once read.	
	0	SYS_WDOG_TO_EINT	0	Watchdog timeout has occurred. (Rising Edge triggered) Note: This bit is cleared once read.	

Register 1Ah Interrupt Status 2

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R28 (1Ch)	11	UV_LDO4_EINT	0	LDO4 Under-voltage interrupt.	
Under				(Rising Edge triggered)	
Voltage				Note: This bit is cleared once read.	
Interrupt status	10	UV_LDO3_EINT	0	LDO3 Under-voltage interrupt.	
o.a.a.a				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	9	UV_LDO2_EINT	0	LDO2 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	8	UV_LDO1_EINT	0	LDO1 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	5	UV_DC6_EINT	0	DCDC6 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	4	UV_DC5_EINT	0	DCDC5 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	3	UV_DC4_EINT	0	DCDC4 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	2	UV_DC3_EINT	0	DCDC3 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	1	UV_DC2_EINT	0	DCDC2 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	
	0	UV_DC1_EINT	0	DCDC1 Under-voltage interrupt.	
				(Rising Edge triggered)	
				Note: This bit is cleared once read.	

Register 1Ch Under Voltage Interrupt status



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R29 (1Dh) Over Current Interrupt status	15	OC_LS_EINT	0	Overcurrent interrupt. (Rising Edge triggered) Note: This bit is cleared once read.	

Register 1Dh Over Current Interrupt status

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R30 (1Eh)	12	GP12_EINT	0	GPIO12 interrupt.	
GPIO		_		(Trigger controlled by GP12 registers.)	
Interrupt				Note: This bit is cleared once read.	
Status	11	11 GP11_EINT	0	GPIO11 interrupt.	
				(Trigger controlled by GP11 registers.)	
				Note: This bit is cleared once read.	
	10	GP10_EINT	0	GPIO10 interrupt.	
				(Trigger controlled by GP10 registers.)	
				Note: This bit is cleared once read.	
	9	GP9_EINT	0	GPIO9 interrupt.	
				(Trigger controlled by GP9 registers.)	
				Note: This bit is cleared once read.	
	8	GP8_EINT	0	GPIO8 interrupt.	
				(Trigger controlled by GP8 registers.)	
				Note: This bit is cleared once read.	
	7	GP7_EINT	0	GPIO7 interrupt.	
				(Trigger controlled by GP7 registers.)	
				Note: This bit is cleared once read.	
	6	GP6_EINT	0	GPIO6 interrupt.	
				(Trigger controlled by GP6 registers.)	
				Note: This bit is cleared once read.	
	5	GP5_EINT	0	GPIO5 interrupt.	
				(Trigger controlled by GP5 registers.)	
				Note: This bit is cleared once read.	
	4	GP4_EINT	0	GPIO4 interrupt.	
				(Trigger controlled by GP4 registers.)	
				Note: This bit is cleared once read.	
	3	GP3_EINT	0	GPIO3interrupt.	
				(Trigger controlled by GP3 registers.)	
				Note: This bit is cleared once read.	
	2	GP2_EINT	0	GPIO2 interrupt.	
				(Trigger controlled by GP2 registers.)	
				Note: This bit is cleared once read.	
	1	GP1_EINT	0	GPIO1 interrupt.	
				(Trigger controlled by GP1 registers.)	
				Note: This bit is cleared once read.	
	0	GP0_EINT	0	GPIO0 interrupt.	
				(Trigger controlled by GP0 registers.)	
				Note: This bit is cleared once read.	

Register 1Eh GPIO Interrupt Status



REGISTER ADDRESS	ВІТ	LABEL	DEFAULT	DESCRIPTION	REFER TO
R31 (1Fh) Comparator Interrupt	15	EXT_USB_FB_EINT	0	USB_FB changed interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
Status	14	EXT_WALL_FB_EINT	0	WALL_FB changed interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	13	EXT_BATT_FB_EINT	0	BATT_FB changed interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	11	CODEC_JCK_DET_L_EINT	0	Left channel Jack etection interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	10	CODEC_JCK_DET_R_EINT	0	Right channel Jack etection interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	9	CODEC_MICSCD_EINT	0	Mic short-circuit detect interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	8	CODEC_MICD_EINT	0	Mic detect interrupt. (Rising and Falling Edge triggered) Note: This bit is cleared once read.	
	6	WKUP_OFF_STATE_EINT	0	Indicates that the chip started from the OFF state. (Rising Edge triggered) Note: This bit is cleared once read.	
	5	WKUP_HIB_STATE_EINT	0	Indicated the chip started up from the hibernate state. (Rising Edge triggered) Note: This bit is cleared once read.	
	4	WKUP_CONV_FAULT_EINT	0	Indicates the wakeup was caused by a converter fault leading to the chip being reset. (Rising Edge triggered) Note: This bit is cleared once read.	
	3	WKUP_WDOG_RST_EINT	0	Indicates the wakeup was caused by a watchdog heartbeat being missed, and hence the chip being reset. (Rising Edge triggered) Note: This bit is cleared once read.	
	2	WKUP_GP_PWR_ON_EINT	0	PWR_ON (Alternate GPIO function) pin has been pressed for longer than specified time. (Rising Edge triggered) Note: This bit is cleared once read.	
	1	WKUP_ONKEY_EINT	0	ON key has been pressed for longer than specified time. (Rising Edge triggered) Note: This bit is cleared once read.	
	0	WKUP_GP_WAKEUP_EINT	0	WAKEUP (Alternate GPIO function) pin has been pressed for longer than specified time. (Rising Edge triggered) Note: This bit is cleared once read.	

Register 1Fh Comparator Interrupt Status



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R32 (20h)	13	IM_OC_INT	1	Interrupt mask.	
System				0 = Do not mask interrupt.	
Interrupts				1 = Mask interrupt.	
Mask				Reset by state machine. Default held in metal mask.	
	12	IM_UV_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	9	IM_CS_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	8	IM_EXT_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	7	IM_CODEC_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	6	IM_GP_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	5	IM_AUXADC_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	4	IM_RTC_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	3	IM_SYS_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	2	IM_CHG_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	1	IM_USB_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	
	0	IM_WKUP_INT	1	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine. Default held in metal mask.	

Register 20h System Interrupts Mask



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R33 (21h)	15	IM_CHG_BATT_HOT_EINT	0	Interrupt mask.	
Interrupt				0 = Do not mask interrupt.	
Status 1				1 = Mask interrupt.	
Mask				Reset by state machine.	
	14	IM_CHG_BATT_COLD_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	13	IM_CHG_BATT_FAIL_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	12	IM_CHG_TO_EINT	0	Interrupt mask.	
		6116_16_2111		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	11	IM CHG END EINT	0		
	''	IM_CHG_END_EINT	U	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
			_	Reset by state machine.	
	10	IM_CHG_START_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	9	IM_CHG_FAST_RDY_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	7	IM_RTC_PER_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	6	IM_RTC_SEC_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	5	IM_RTC_ALM_EINT	0	Interrupt mask.	
	~	IM_ICTO_/CIM_EIIVI		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
		IM CHO VIDATT LT 2D2 FINT	0	-	
	2	IM_CHG_VBATT_LT_3P9_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	1	IM_CHG_VBATT_LT_3P1_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	0	IM_CHG_VBATT_LT_2P85_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	

Register 21h Interrupt Status 1 Mask



REGISTER ADDRESS	ВІТ	LABEL	DEFAULT	DESCRIPTION	REFER TO
R34 (22h)	13	IM_CS1_EINT	0	Interrupt mask.	
Interrupt				0 = Do not mask interrupt.	
Status 2				1 = Mask interrupt.	
Mask				Reset by state machine.	
	12	IM_CS2_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	10	IM_USB_LIMIT_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	8	IM_AUXADC_DATARDY_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	7	IM_AUXADC_DCOMP4_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	6	IM_AUXADC_DCOMP3_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	5	IM_AUXADC_DCOMP2_EINT	0	Interrupt mask.	
		, 10,0 12 0_2 0 0 1111 2_2 1111		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	4	IM_AUXADC_DCOMP1_EINT	0	Interrupt mask.	
		, 10,0 12 0_2 0 0 1111 1_2 1111		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	3	IM_SYS_HYST_COMP_FAIL_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	2	IM_SYS_CHIP_GT115_EINT	0	Interrupt mask.	
	_	0 . 0_0		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	1	IM_SYS_CHIP_GT140_EINT	0	Interrupt mask.	
	-	0 . 0_0		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	0	IM_SYS_WDOG_TO_EINT	0	Interrupt mask.	
		0.0500		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
1	1	nt Status 2 Mask	1		

Register 22h Interrupt Status 2 Mask



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R36 (24h)	11	IM_UV_LDO4_EINT	0	Interrupt mask.	
Under Voltage				0 = Do not mask interrupt.	
Interrupt				1 = Mask interrupt.	
status Mask				Reset by state machine.	
	10	IM_UV_LDO3_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	9	IM_UV_LDO2_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	8	IM_UV_LDO1_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	5	IM_UV_DC6_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	4	IM_UV_DC5_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	3	IM_UV_DC4_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	2	IM_UV_DC3_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	1	IM_UV_DC2_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	0	IM UV DC1 EINT	0	Interrupt mask.	
	_	_=		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				· ·	
				Reset by state machine.	

Register 24h Under Voltage Interrupt status Mask

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R37 (25h)	15	IM_OC_LS_EINT	0	Interrupt mask.	
Over Current				0 = Do not mask interrupt.	
Interrupt				1 = Mask interrupt.	
status Mask				Reset by state machine.	

Register 25h Over Current Interrupt status Mask



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R38 (26h)	12	IM_GP12_EINT	0	Interrupt mask.	
GPIO				0 = Do not mask interrupt.	
Interrupt				1 = Mask interrupt.	
Status Mask				Reset by state machine.	
	11	IM_GP11_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	10	IM_GP10_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	9	IM_GP9_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	8	IM_GP8_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	7	IM_GP7_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	6	IM_GP6_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	5	IM_GP5_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	4	IM_GP4_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	3	IM_GP3_EINT	0	Interrupt mask.	
	Ü	0. 0		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	2	IM_GP2_EINT	0	Interrupt mask.	
	_			0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	1	IM_GP1_EINT	0	Interrupt mask.	
		5		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	0	IM_GP0_EINT	0	Interrupt mask.	
	3	O. O_LVI		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
			1	i maon interrupt.	1

Register 26h GPIO Interrupt Status Mask



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R39 (27h)	15	IM_EXT_USB_FB_EINT	0	Interrupt mask.	
Comparator				0 = Do not mask interrupt.	
Interrupt Status Mask				1 = Mask interrupt.	
Status Mask				Reset by state machine.	
	14	IM_EXT_WALL_FB_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	13	IM_EXT_BATT_FB_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	11	IM_CODEC_JCK_DET_L_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	10	IM_CODEC_JCK_DET_R_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	9	IM CODEC MICSCD EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	8	IM_CODEC_MICD_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	6	IM_WKUP_OFF_STATE_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	5	IM WKUP HIB STATE EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	4	IM_WKUP_CONV_FAULT_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	3	IM_WKUP_WDOG_RST_EINT	0	Interrupt mask.	
		IM_WKGI _WBGG_KGI_EIIVI		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	2	IM_WKUP_GP_PWR_ON_EINT	0	Interrupt mask.	
		vvvci _ci _i vvv_civ_Eiivi		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	
	1	IM_WKUP_ONKEY_EINT	0	Interrupt mask.	
	'	INI_VITOI _OINTE I _EINI		0 = Do not mask interrupt.	
				1 = Mask interrupt.	
	l		1	i – iviask iriterrupt.	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				Reset by state machine.	
	0	IM_WKUP_GP_WAKEUP_EINT	0	Interrupt mask.	
				0 = Do not mask interrupt.	
				1 = Mask interrupt.	
				Reset by state machine.	

Register 27h Comparator Interrupt Status Mask

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R40 (28h) Clock Control 1	15	TOCLK_ENA	0	Slow clock enable. Used for both the jack insert detect debounce circuit and the zero cross timeout. 0 = slow clock disabled 1 = slow clock enabled	
	14	TOCLK_RATE	0	Slow Clock Selection (Used for volume update timeouts and for jack detect debounce) 0 = SYSCLK / 2^21 (Slower Response) 1 = SYSCLK / 2^19 (Faster Response)	
	11	MCLK_SEL	0	Selects source for SYSCLK to CODEC 0 = MCLK pin 1 = FLL	
	8	MCLK_DIV	0	Selects MCLK division in slave (MCLK input) mode: 0 = divide MCLK by 1 1 = divide MCLK by 2	
	7:4	BCLK_DIV[3:0]	0100	Sets BCLK rate for Master mode 0000 = SYSCLK 0001 = SYSCLK / 1.5 0010 = SYSCLK / 2 0011 = SYSCLK / 3 0100 = SYSCLK / 4 0101 = SYSCLK / 5.5 0101 = SYSCLK / 6 0111 = SYSCLK / 8 1000 = SYSCLK / 11 1001 = SYSCLK / 12 1010 = SYSCLK / 12 1010 = SYSCLK / 22 1100 = SYSCLK / 24 1101 = SYSCLK / 32 1111 = SYSCLK / 32	
	2:0	OPCLK_DIV[2:0]	000	OPCLK Frequency (GPIO function) 000 = SYSCLK 001 = SYSCLK / 2 010 = SYSCLK / 3 011 = SYSCLK / 4 100 = SYSCLK / 5.5 101 = SYSCLK / 6 110 = Reserved 111 = Reserved	

Register 28h Clock Control 1



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R41 (29h) Clock Control 2	15	LRC_ADC_SEL	0	Selects either ADCLRCLK or DACLRCLK to drive LRCLK pin in Master mode 0 = DACLRCLK	
	0	MCLK DIR	0	1 = ADCLRCLK Whether MCLK is an input or an output.	
		oz.k_birk		0 = MCLK is an input	
				1 = MCLK is an output	

Register 29h Clock Control 2

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS R42 (2Ah)	15	FLL_ENA	0	Digital Enable for FLL	
FLL Control	10	I LL_EINA		0 = disabled	
1				1 = enabled	
				Note that FLL_OSC_ENA must be enabled before	
				enabling FLL_ENA.	
	14	FLL_OSC_ENA	0	Analogue Enable for FLL	
				0 = FLL disabled	
				1 = FLL enabled	
				Note that FLL_OSC_ENA must be enabled before enabling FLL_ENA.	
	10:8	FLL_OUTDIV	010	F _{OUT} clock divider	
		[2:0]		000 = F _{VCO} / 2	
				001 = F _{VCO} / 4	
				010 = F _{VCO} / 8	
				011 = F _{VCO} / 16	
				100 = F _{VCO} / 32	
				101 = Reserved	
				110 = Reserved	
				111 = Reserved	
	7:4	FLL_RSP_RATE	0000	FLL Loop Gain	
				0000 = x 1 (Recommended value)	
				0001 = x 2	
				0010 = x 4	
				0011 = x 8	
				0100 = x 16	
				0101 = x 32	
				0110 = x 64	
				0111 = x 128	
				1000 = x 256	
				Recommended that these are not changed from default.	
	2:0	FLL_RATE [2:0]	000	Frequency of the FLL control block	
				000 = F _{VCO} / 1 (Recommended value)	
				001 = F _{VCO} / 2	
				010 = F _{VCO} / 4	
				011 = F _{VCO} / 8	
				100 = F _{VCO} / 16	
				101 = F _{VCO} / 32	
				Recommended that these are not changed from default.	

Register 2Ah FLL Control 1



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R43 (2Bh)	15:11	FLL_RATIO [4:0]	14	CLK_VCO is divided by this integer, valid from 1	
FLL Control			(0Eh)	31.	
2			, ,	1 recommended for high freq reference	
				8 recommended for low freq reference	
	9:0	FLL_N [9:0]	086h	FLL integer multiplier N for CLK_REF	

Register 2Bh FLL Control 2

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R44 (2Ch) FLL Control 3	15:0	FLL_K [15:0]	C226h	FLL fractional multiplier K for CLK_REF. This is only used if FLL_FRAC is set.	

Register 2Ch FLL Control 3

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R45 (2Dh)	7	FLL_REF_FREQ	0	Low frequency reference locking	
Clock Control 1				0 = High frequency reference locking (recommended for reference clock > 48kHz)	
				1 = Lock frequency reference locking (recommended for reference clock <= 48kHz)	
	5	FLL_FRAC	0	Fractional enable	
				0 = Integer Mode	
				1 = Fractional Mode	
				1 recommended in all cases	
	1:0	FLL_CLK_SRC	00	Select FLL input clock Source	
		[1:0]		00 = MCLK	
				01 = DACLRCLK	
				10 = ADCLRCLK	
				11 = CLK_32K_REF	

Register 2Dh FLL Control 4

WM8350

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R48 (30h) DAC Control	13	DAC_MONO	0	Adds left and right channel and halves the resulting output to create a mono output	
	12	AIF_LRCLKRATE	0	Mode Select 1 = USB mode (272 * Fs) 0 = Normal mode (256 * Fs)	
	5:4	DEEMP[1:0]	00	DAC De-emphasis filter control 00 = No de-emphasis 01 = 32kHz sample rate 10 = 44.1kHz sample rate 11 = 48kHz sample rate	
	3	DAC_SDMCLK_RATE	0	DAC_SDMCLK_RATE allows the DAC SDM to be run at a speed higher than 64*fs. This is used for low sample rate modes to allow the SDM to run fast enough to shape the noise so that none of it appears in the audio band. On the previous version, at 8k sample rate you could hear some high frequency noise when playing back through a decent system.	
	1	DACL_DATINV	0	DAC data left channel polarity 0 = Normal 1 = Inverted	
	0	DACR_DATINV	0	DAC data right channel polarity 0 = Normal 1 = Inverted	

Register 30h DAC Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R50 (32h)	15	DACL_ENA	0	Left DAC enable	
DAC Digital				0 = disabled	
Volume L				1 = enabled	
	8	DAC_VU	0	DAC left and DAC right volume do not update until a	
				1 is written to either DAC_VU register bit.	
	7:0	DACL_VOL[7:0]	1100_0000	Left DAC digital volume control:	
				0000_0000 = Digital mute	
				0000_0001 = -71.625dB	
				0000_0010 = -71.25dB	
				(0.375dB steps)	
				1100_000 = 0dB	

Register 32h DAC Digital Volume L

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R51 (33h)	15	DACR_ENA	0	Right DAC enable	
DAC Digital				0 = disabled	
Volume R				1 = enabled	
	8	DAC_VU	0	DAC left and DAC right volume do not update until a	
				1 is written to either DAC_VU register bit.	
	7:0	DACR_VOL[7:0]	1100_0000	Right DAC digital volume control:	
				0000_0000 = Digital mute	
				0000_0001 = -71.625dB	
				0000_0010 = -71.25dB	
				(0.375dB steps)	
				1100_000 = 0dB	

Register 33h DAC Digital Volume R

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R53 (35h) DAC LR Rate	11	DACLRC_ENA	0	Enables DAC LRC generation in Master mode 0 = disabled 1 = enabled	
	10:0	DACLRC_RATE[10:0]	000_0100_0000	Determines the number of bit clocks per LRC phase (when enabled) 00000000000 = invalid 00000000111 = invalid 00000001000 = 8 BCPS 11111111111 = 2047 BCPS	

Register 35h DAC LR Rate

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R54 (36h) DAC Clock	4	DACCLK_POL	0	DAC Clock Polarity 0 = Normal	
Control				1 = Inverted	
	2:0	DAC_CLKDIV[2:0]	000	DAC Sample rate divider	
				000 = SYSCLK / 1.0	
				001 = SYSCLK / 1.5	
				010 = SYSCLK / 2	
				011 = SYSCLK / 3	
				100 = SYSCLK / 4	
				101 = SYSCLK / 5.5	
				110 = SYSCLK / 6	
				111 = Reserved	

Register 36h DAC Clock Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R58 (3Ah) DAC Mute	14	DAC_MUTE	1	DAC Mute 0 = disabled	
DAO Mate				1 = enabled	

Register 3Ah DAC Mute

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R59 (3Bh) DAC Mute Volume	14	DAC_MUTEMODE	0	DAC Soft Mute Mode 0 = Disabling soft-mute (DAC_MUTE=0) will cause the volume to change immediately to the DACL_VOL / DACR_VOL settings 1 = Disabling soft-mute (DAC_MUTE=0) will cause	
				the volume to ramp up gradually to the DACL_VOL / DACR_VOL settings	
	13	DAC_MUTERATE	0	DAC Soft Mute Ramp Rate	
				0 = Fast ramp (24kHz at fs=48k, providing maximum delay of 10.7ms)	
				1 = Slow ramp (1.5kHz at fs=48k, providing maximum delay of 171ms)	
	12	DAC_SB_FILT	0	Selects DAC filter characteristics	
				0 = Normal mode	
				1 = Sloping stopband mode	

Register 3Bh DAC Mute Volume

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R60 (3Ch)	13:12	ADC_TO_DACL[1:0]	00	DAC Left Side-tone Control	
DAC Side				11 = Unused	
				10 = Mix ADCR into DACL	
				01 = Mix ADCL into DACL	
				00 = No Side-tone mix into DACL	
	11:10	ADC_TO_DACR[1:0]	00	DAC Right Side-tone Control	
				11 = Unused	
				10 = Mix ADCR into DACR	
				01 = Mix ADCL into DACR	
				00 = No Side-tone mix into DACR	

Register 3Ch DAC Side



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R64 (40h)	15	ADC_HPF_ENA	1	High Pass Filter enable	
ADC Control				0 = disabled	
				1 = enabled	
	9:8	ADC_HPF_CUT[1:0]	00	Select cut-off frequency for high-pass filter	
				00 = 2^-11 (first order) = 3.7Hz @44.1kHz	
				$01 = 2^{-5}$ (2nd order) = ~250Hz @8kHz	
				$10 = 2^{-4}$ (2nd order) = ~250Hz @16kHz	
				$11 = 2^{-3}$ (2nd order) = ~250Hz @32kHz	
	1	ADCL_DATINV	0	ADC Left channel polarity:	
				0 = Normal	
				1 = Inverted	
	0	ADCR_DATINV	0	ADC Right Channel Polarity	
				0 = Normal	
				1 = Inverted	

Register 40h ADC Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R66 (42h) ADC Digital Volume L	15	ADCL_ENA	0	Left ADC enable 0 = disabled 1 = enabled	
	8	ADC_VU	0	ADC left and ADC right volume do not update until a 1 is written to either ADC_VU register bit.	
	7:0	ADCL_VOL[7:0]	1100_0000	Left ADC Digital Volume Control 0000 0000 = Digital Mute 0000 0001 = -71.625dB 0000 0010 = -71.25dB 0.375dB steps up to 1110 1111 = +17.625dB	

Register 42h ADC Digital Volume L

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R67 (43h)	15	ADCR_ENA	0	Right ADC enable	
ADC Digital				0 = disabled	
Volume R				1 = enabled	
	8	ADC_VU	0	ADC left and ADC right volume do not update until a	
				1 is written to either ADC_VU register bit.	
	7:0	ADCR_VOL[7:0]	1100_0000	Right ADC Digital Volume Control	
				0000 0000 = Digital Mute	
				0000 0001 = -71.625dB	
				0000 0010 = -71.25dB	
				0.375dB steps up to	
				1110 1111 = +17.625dB	

Register 43h ADC Digital Volume R

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R68 (44h) ADC Divider	11:8	ADCL_DAC_SVOL[3:0]	0000	Controls left digital side tone volume from - 36dB to 0dB in 3dB steps.	
	7:4	ADCR_DAC_SVOL[3:0]	0000	Controls right digital side tone volume from - 36dB to 0dB in 3dB steps.	
	3	ADCCLK_POL	0	ADC Clock Polarity	
				0 = Normal	
				1 = Inverted	
	2:0	ADC_CLKDIV[2:0]	000	ADC Sample rate divider	
				000 = SYSCLK / 1.0	
				001 = SYSCLK / 1.5	
				010 = SYSCLK / 2	
				011 = SYSCLK / 3	
				100 = SYSCLK / 4	
				101 = SYSCLK / 5.5	
				110 = SYSCLK / 6	
				111 = Reserved	

Register 44h ADC Divider

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R70 (46h) ADC LR Rate	11	ADCLRC_ENA	0	Enables the LRC generation for the ADC 0 = disabled 1 = enabled	
	10:0	ADCLRC_RATE[10:0]	000_0100_0000	Determines the number of bit clocks per LRC phase (when enabled) 000000000000 = invalid 00000000111 = invalid 00000001000 = 8 BCPS 11111111111 = 2047 BCPS	

Register 46h ADC LR Rate

	N2R_ENA	0	Connect IN2R pin to right channel input PGA 0 = IN2R not connected to input PGA amplifier 1 = IN2R connected to input PGA amplifier	
	_	-	0 = IN2R not connected to input PGA amplifier 1 = IN2R connected to input PGA amplifier	
9 IN	I1RN_ENA	1	1 = IN2R connected to input PGA amplifier	
9 IN	I1RN_ENA	1	· · · ·	
9 IN	I1RN_ENA	1		
			Connect IN1RN pin to right channel input PGA negative terminal.	
			0 = IN1RN not connected to input PGA	
			1 = IN1RN connected to right channel input PGA amplifier negative terminal.	
8 IN	I1RP_ENA	1	Connect IN1RP pin to right channel input PGA amplifier positive terminal.	
			0 = IN1RP not connected to input PGA	
			1 = right channel input PGA amplifier positive terminal connected to IN1RP (constant input impedance)	
2 1	N2L_ENA	0	Connect IN2L pin to left channel input PGA amplifier	
			0 = IN2L not connected to input PGA amplifier	
			1 = IN2L connected to input PGA amplifier	
_				amplifier negative terminal. IN1RP_ENA 1 Connect IN1RP pin to right channel input PGA amplifier positive terminal. 0 = IN1RP not connected to input PGA 1 = right channel input PGA amplifier positive terminal connected to IN1RP (constant input impedance) IN2L_ENA 0 Connect IN2L pin to left channel input PGA amplifier 0 = IN2L not connected to input PGA amplifier



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	1	IN1LN_ENA	1	Connect IN1LN pin to left channel input PGA negative terminal. 0 = IN1LN not connected to input PGA 1 = IN1LN connected to input PGA amplifier negative terminal.	
	0	IN1LP_ENA	1	Connect IN1LP pin to left channel input PGA amplifier positive terminal. 0 = IN1LP not connected to input PGA 1 = input PGA amplifier positive terminal connected to IN1LP (constant input impedance)	

Register 48h Input Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R73 (49h)	15	IN3R_ENA	0	IN3R Amplifier enable	
IN3 Input				0 = disabled	
Control				1 = enabled	
	14	IN3R_SHORT	0	Short circuit internal input resistor for IN3R amplifier.	
				0 = Internal resistor in circuit.	
				1 = Internal resistor shorted.	
	7	IN3L_ENA	0	IN3L Amplifier enable	
				0 = disabled	
				1 = enabled	
	6	IN3L_SHORT	0	Short circuit internal input resistor for IN3L amplifier.	
				0 = Internal resistor in circuit.	
				1 = Internal resistor shorted.	

Register 49h IN3 Input Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R74 (4Ah) Mic Bias Control	15	MICB_ENA	0	Microphone bias enable 0 = OFF (high impedance output) 1 = ON	
	14	MICB_SEL	0	Microphone bias voltage cont rol: 0 = 0.9 * AVDD 1 = 0.75 * AVDD	
	7	MIC_DET_ENA	0	Enable MIC detect: 0 = Disabled 1 = Enabled	
	4:2	MCDTHR[2:0]	000	Threshold for bias current detection 000 = 160μA 001 = 330μA 010 = 500μA 011 = 680μA 100 = 850μA 101 = 1000μA 111 = 1200μA 111 = 1400μA These threshold currents scale proportionally with AVDD. The values given are for AVDD=3.3V.	
	1:0	MCDSCTHR[1:0]	00	Threshold for microphone short-circuit detection	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				00 = 400μΑ	
				01 = 900μA	
				10 = 1350μA	
				11 = 1800μA	
				These threshold currents scale proportionally with AVDD. The values given are for AVDD=3.3V.	

Register 4Ah Mic Bias Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R76 (4Ch)	11	OUT4_VROI	0	VREF (AVDD/2) to OUT4 resistance	
Output				0 = approx 500 ohms	
Control				1 = approx 30 kOhms	
	10	OUT3_VROI	0	VREF (AVDD/2) to OUT3 resistance	
				0 = approx 500 ohms	
				1 = approx 30 kOhms	
	9	OUT2_VROI	0	VREF (AVDD/2) to OUT2L and OUT2R	
				resistance	
				0 = approx 500 ohms	
				1 = approx 30 kOhms	
	8	OUT1_VROI	0	VREF (AVDD/2) to OUT1L and OUT1R	
				resistance	
				0 = approx 500 ohms	
				1 = approx 30 kOhms	
	4	OUTPUT_DRAIN_ENA	0	Enables a drain on the outputs allowing the amplifiers to shutdown more quickly.	
				0 = Shutdown as normal	
				1 = Sink current from an external capacitor,	
				allowing faster shutdown.	
	2	OUT2_FB	0	Enable Headphone common mode ground	
				feedback for OUT2	
				0 = disabled (HPCOM unused)	
				1 = enabled (common mode feedback through HPCOM)	
	0	OUT1_FB	0	Enable Headphone common mode ground feedback for OUT1	
				0 = disabled (HPCOM unused)	
				1 = enabled (common mode feedback through HPCOM)	

Register 4Ch Output Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R77 (4Dh)	15	JDL_ENA	0	Jack Detect Enable for inputs connected to IN2L	
Jack Detect				0 = disabled	
				1 = enabled	
	14	JDR_ENA	0	Jack Detect Enable for input connected to IN2R	
				0 = disabled	
				1 = enabled	

Register 4Dh Jack Detect



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R78 (4Eh) Anti Pop Control	9:8	ANTI_POP[1:0]	00	Reduces pop when VMID is enabled by setting the speed of the S-ramp for VMID. 00 = no S-ramp (will pop) 01 = Fastest S-curve 10 = Medium S-curve	
	7:6	DIS_OP_LN4[1:0]	00	11 = Slowest S-curve Sets the Discharge rate for OUT4 00 = discharge path OFF 01 = fastest discharge 10 = medium discharge 11 = slowest discharge	
	5:4	DIS_OP_LN3[1:0]	00	Sets the Discharge rate for OUT3 00 = discharge path OFF 01 = fastest discharge 10 = medium discharge 11 = slowest discharge	
	3:2	DIS_OP_OUT2[1:0]	00	Sets the discharge rate for OUT2L and OUT2R 00 = discharge path OFF 01 = fastest discharge 10 = medium discharge 11 = slowest discharge	
	1:0	DIS_OP_OUT1[1:0]	00	Sets the discharge rate for OUT1L and OUT1R 00 = discharge path OFF 01 = fastest discharge 10 = medium discharge 11 = slowest discharge	

Register 4Eh Anti Pop Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R80 (50h)	15	INL_ENA	0	Left input PGA enable	
Left Input		_		0 = disabled	
Volume				1 = enabled	
	14	INL_MUTE	0	Mute control for left channel input PGA:	
				0 = Input PGA not muted, normal operation	
				1 = Input PGA muted (and disconnected from the following input record mixer).	
	13	INL_ZC	0	Left channel input PGA zero cross enable:	
				0 = Update gain when gain register changes	
				1 = Update gain o ⁿ 1st zero cross after gain register write.	
	8	IN_VU	0	Input left PGA and input right PGA volume do not update until a 1 is written to either IN_VU register bit.	
	7:2	INL_VOL[5:0]	01_0000	Left channel input PGA volume	
				000000 = -12dB	
				000001 = -11.25dB	
				010000 = 0dB	
				111111 = 35.25dB	

Register 50h Left Input Volume



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R81 (51h)	15	INR_ENA	0	Right input PGA enable	
Right Input				0 = disabled	
Volume				1 = enabled	
	14	INR_MUTE	0	Mute control for right channel input PGA:	
				0 = Input PGA not muted, normal operation	
				1 = Input PGA muted (and disconnected from the following input record mixer).	
	13	INR_ZC	0	Right channel input PGA zero cross enable:	
				0 = Update gain when gain register changes	
				1 = Update gain o ⁿ 1st zero cross after gain register write.	
	8	IN_VU	0	Input left PGA and input right PGA volume do not update until a 1 is written to either IN_VU register bit.	
	7:2	INR_VOL[5:0]	01_0000	Right channel input PGA volume	
				000000 = -12dB	
				000001 = -11.25dB	
				010000 = 0dB	
				111111 = 35.25dB	

Register 51h Right Input Volume

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R88 (58h)	15	MIXOUTL_ENA	0	Left output mixer enable.	
Left Mixer				0 = disabled	
Control				1 = enabled	
	12	DACR_TO_MIXOUTL	0	Right DAC output to left output mixer	
				0 = not selected	
				1 = selected	
	11	DACL_TO_MIXOUTL	1	Left DAC output to left output mixer	
				0 = not selected	
				1 = selected	
	2	IN3L_TO_MIXOUTL	0	IN3L amplifier output to left output mixer:	
				0 = not selected	
				1 = selected	
	1	INR_TO_MIXOUTL	0	Right input PGA output to left output mixer	
				0 = not selected	
				1 = selected	
	0	INL_TO_MIXOUTL	0	Left input PGA output to left output mixer	
				0 = not selected	
				1 = selected	

Register 58h Left Mixer Control



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R89 (59h)	15	MIXOUTR_ENA	0	Right output mixer enable.	
Right Mixer				0 = disabled	
Control				1 = enabled	
	12	DACR_TO_MIXOUTR	1	Right DAC output to right output mixer	
				0 = not selected	
				1 = selected	
	11	DACL_TO_MIXOUTR	0	Left DAC output to right output mixer	
				0 = not selected	
				1 = selected	
	3	IN3R_TO_MIXOUTR	0	IN3R amplifier output to right output mixer:	
				0 = not selected	
				1 = selected	
	1	INR_TO_MIXOUTR	0	Right input PGA output to right output mixer	
				0 = not selected	
				1 = selected	
	0	INL_TO_MIXOUTR	0	Left input PGA output to right output mixer	
				0 = not selected	
				1 = selected	

Register 59h Right Mixer Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R92 (5Ch)	15	OUT3_ENA	0	OUT3 enable	
OUT3 Mixer				0 = disabled	
Control				1 = enabled	
	11	DACL_TO_OUT3	0	Left DAC output to OUT3	
				0 = disabled	
				1 = enabled	
	8	MIXINL_TO_OUT3	0	Left input mixer to OUT3	
				0 = disabled	
				1 = enabled	
	3	OUT4_TO_OUT3	0	OUT4 mixer to OUT3	
				0 = disabled	
				1 = enabled	
	0	MIXOUTL_TO_OUT3	0	Left output mixer to OUT3	
				0 = disabled	
				1 = enabled	

Register 5Ch OUT3 Mixer Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R93 (5Dh)	15	OUT4_ENA	0	Enable OUT4 mixer	
OUT4 Mixer				0 = disabled	
Control				1 = enabled	
	12	DACR_TO_OUT4	0	Right DAC output to OUT4	
				0 = disabled	
				1 = enabled	
	11	DACL_TO_OUT4	0	Left DAC output to OUT4	
				0 = Disabled	
				1 = Enabled	
	10	OUT4_ATTN	0	Reduce OUT4 output by 6dB	
		_		0 = Output at normal level	
				1 = Output reduced by 6dB	
	9	MIXINR_TO_OUT4	0	Right input mixer to OUT4	
				0 = disabled	
				1 = enabled	
	2	OUT3_TO_OUT4	0	OUT3 mixer to OUT4	
				This function is not supported	
	1	MIXOUTR TO OUT4	0	Right output mixer to OUT4	
				0 = disabled	
				1 = enabled	
	0	MIXOUTL TO OUT4	0	Left output mixer to OUT4	
				0 = disabled	
				1 = enabled	

Register 5Dh OUT4 Mixer Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R96 (60h)	11:9	IN3L_MIXOUTL_VOL[2:0]	000	IN3L amplifier volume control to left output	
Output Left Mixer				mixer	
Volume				000 = Path disabled (disconnected)	
Volumo				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	7:5	INR_MIXOUTL_VOL[2:0]	000	Right input PGA volume control to left output	
				mixer.	
				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	3:1	INL_MIXOUTL_VOL[2:0]	000	Left input PGA volume control to left output	
				mixer.	
				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	

Register 60h Output Left Mixer Volume



BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
15:13	IN3R_MIXOUTR_VOL[2:0]	000	IN3R amplifier volume control to right output mixer.	
			000 = Path disabled (disconnected)	
			001 = -12dB gain through mixer	
			010 = -9dB gain through mixer	
			111 = +6dB gain through mixer	
7:5	INR_MIXOUTR_VOL[2:0]	000	Right input PGA volume control to right output mixer.	
			000 = Path disabled (disconnected)	
			001 = -12dB gain through mixer	
			010 = -9dB gain through mixer	
			111 = +6dB gain through mixer	
3:1	INL_MIXOUTR_VOL[2:0]	000	Left input PGA volume control to right output	
			,	
			oro – -oub gain unough mixel	
			111 = +6dB gain through mixer	
	15:13 7:5	15:13 IN3R_MIXOUTR_VOL[2:0] 7:5 INR_MIXOUTR_VOL[2:0]	15:13 IN3R_MIXOUTR_VOL[2:0] 000 7:5 INR_MIXOUTR_VOL[2:0] 000	15:13 IN3R_MIXOUTR_VOL[2:0] 000 IN3R amplifier volume control to right output mixer. 000 = Path disabled (disconnected) 001 = -12dB gain through mixer 010 = -9dB gain through mixer 111 = +6dB gain through mixer 7:5 INR_MIXOUTR_VOL[2:0] 000 Right input PGA volume control to right output mixer. 000 = Path disabled (disconnected) 001 = -12dB gain through mixer 010 = -9dB gain through mixer 111 = +6dB gain through mixer

Register 61h Output Right Mixer Volume

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R98 (62h)	11:9	IN3L_MIXINL_VOL[2:0]	000	IN3L amplifier volume control to right input	
Input Mixer				mixer.	
Volume L				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	3:1	IN2L MIXINL VOL[2:0]	000	IN2L amplifier volume control to right input	
	· · ·			mixer.	
				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	0	INL_MIXINL_VOL	0	Boost enable for left channel input PGA:	
				0 = PGA output has +0dB gain through input	
				record mixer.	
				1 = PGA output has +20dB gain through input record mixer.	

Register 62h Input Mixer Volume L

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R99 (63h)	15:13	IN3R_MIXINR_VOL[2:0]	000	IN3R amplifier volume control to right input	
Input Mixer				mixer.	
Volume R				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	7:5	IN2R_MIXINR_VOL[2:0]	000	IN2R amplifier volume control to right input	
				mixer.	
				000 = Path disabled (disconnected)	
				001 = -12dB gain through mixer	
				010 = -9dB gain through mixer	
				111 = +6dB gain through mixer	
	0	INR_MIXINR_VOL	0	Boost enable for right channel input PGA:	
				0 = PGA output has +0dB gain through input	
				record mixer.	
				1 = PGA output has +20dB gain through input	
				record mixer.	

Register 63h Input Mixer Volume R

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R100 (64h)	15	OUT4_MIXIN_DST	0	Select routing of OUT4 to input mixers.	
Input Mixer				0 = OUT4 to left input mixer.	
Volume				1 = OUT4 to right input mixer.	
	3:1	OUT4_MIXIN_VOL[2:0]	000	Controls the gain of OUT4 to left and right input mixers:	
				000 = Path disabled (left and right mute)	
				001 = -12dB gain through boost stages	
				010 = -9dB gain through boost stages	
				111 = +6dB gain through boost stages	

Register 64h Input Mixer Volume



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS	45	OUTAL ENA	0	OUT4L analys	
R104 (68h) OUT1L	15	OUT1L_ENA	0	OUT1L enable	
Volume				0 = disabled	
Volumo				1 = enabled	
	14	OUT1L_MUTE	0	OUT1L mute:	
				0 = normal operation	
				1 = mute	
	13	OUT1L_ZC	0	OUT1L volume zero cross enable	
				0 = Change gain immediately	
				1 = Change gain on zero cross only	
	8	OUT1_VU	0	OUT1L and OUT1R volumes do not update until a 1	
				is written to either OUT1_VU.	
	7:2	OUT1L_VOL[5:0]	11_1001	OUT1L volume:	
				000000 = -57dB	
				111001 = 0dB	
				111111 = +6dB	

Register 68h OUT1L Volume

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R105 (69h)	15	OUT1R_ENA	0	OUT1R enable	
OUT1R				0 = disabled	
Volume				1 = enabled	
	14	OUT1R_MUTE	0	OUT1R mute:	
				0 = normal operation	
				1 = mute	
	13	OUT1R_ZC	0	OUT1R volume zero cross enable	
				0 = Change gain immediately	
				1 = Change gain on zero cross only	
	8	OUT1_VU	0	OUT1L and OUT1R volumes do not update until a 1 is written to either OUT1_VU register bits.	
	7:2	OUT1R_VOL[5:0]	11_1001	OUT1R volume:	
				000000 = -57dB	
				111001 = 0dB	
				111111 = +6dB	

Register 69h OUT1R Volume

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R106 (6Ah)	15	OUT2L_ENA	0	OUT2L enable	
OUT2L				0 = disabled	
Volume				1 = enabled	
	14	OUT2L_MUTE	0	OUT2L mute:	
				0 = normal operation	
				1 = mute	
	13	OUT2L_ZC	0	OUT2L volume zero cross enable	
				0 = Change gain immediately	
				1 = Change gain on zero cross only	
	8	OUT2_VU	0	OUT2L and OUT2R volumes do not update until a 1 is written to either OUT2_VU register bits.	
	7:2	OUT2L_VOL[5:0]	11_1001	OUT2L volume:	
				000000 = -57dB	
				111001 = 0dB	
				111111 = +6dB	

Register 6Ah OUT2L Volume

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R107 (6Bh)	15	OUT2R_ENA	0	OUT2R enable	
OUT2R				0 = disabled	
Volume				1 = enabled	
	14	OUT2R_MUTE	0	OUT2R mute:	
				0 = normal operation	
				1 = mute	
	13	OUT2R_ZC	0	OUT2R volume zero cross enable	
				0 = Change gain immediately	
				1 = Change gain on zero cross only	
	10	OUT2R_INV	0	Enable OUT2R inverting amplifier	
				0 = disabled	
				1 = enabled	
				This register must be set to 0 when using the non-inverting MIXOUT2R to OUT2R path.	
				This register must be set to 1 when using the inverting MIXOUT2R to OUT2R path.	
	9	OUT2R_INV_MUTE	1	Mute output of PGA to inverting amplifier.	
				0 = PGA output goes to inverting amplifier	
				1 = PGA output goes to output driver	
				This register must be set to 0 when using the inverting MIXOUT2R to OUT2R path.	
				This register must be set to 1 when using the non-inverting MIXOUT2R to OUT2R path.	
	8	OUT2_VU	0	OUT2L and OUT2R volumes do not update until a 1 is written to either OUT2_VU register bits.	
	7:2	OUT2R_VOL[5:0]	11_1001	OUT2R volume:	
				000000 = -57dB	
				111001 = 0dB	
				111111 = +6dB	

Register 6Bh OUT2R Volume



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REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R111 (6Fh)	15	IN3R_TO_OUT2R	0	Beep mixer enable	
BEEP				0 = disabled	
Volume				1 = enabled	
	7:5	IN3R_OUT2R_VOL[2:0]	000	Beep mixer volume:	
				000 = -15dB	
				in +3dB steps	
				111 = +6dB	

Register 6Fh BEEP Volume

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R112 (70h)	15	AIF_BCLK_INV	0	0 = normal	
Al Formating				1 = inverted	
	13	AIF_TRI	0	Sets Output enables for LRCLK and BCLK and ADCDAT to inactive state	
				0 = normal	
				1 = forces pins to Hi-Z	
	12	AIF_LRCLK_INV	0	LRCLK clock polarity	
				0 = normal	
				1 = inverted	
				DSP Mode – mode A/B select 0 = MSB is available o ⁿ 2nd BCLK rising edge after LRCLK rising edge (mode A) 1 = MSB is available o ⁿ 1st BCLK rising edge after LRCLK rising edge (mode B)	
	11:10	AIF_WL[1:0]	10	Data word length 11 = 32 bits 10 = 24 bits 01 = 20 bits 00 = 16 bits Note: When using the Right-Justified data format (FMT=00), the maximum word length is 24 bits.	
	9:8	AIF_FMT[1:0]	10	00 = Right-justified 01 = Left justified 10 = I2S 11 = DSP / PCM mode	

Register 70h Al Formating

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R113 (71h)	7	DAC_COMP	0	DAC Companding enable	
ADC DAC				0 = disabled	
COMP				1 = enabled	
	6	DAC_COMPMODE	0	DAC Companding mode select:	
				$0 = \mu$ -law	
				1 = A-law	
				(Note: Setting DAC_COMPMODE=1 selects 8-bit	
				mode when DAC_COMP=0 and ADC_COMP=0)	
	5	ADC_COMP	0	ADC Companding enable	
				0 = disabled	
				1 = enabled	
	4	ADC_COMPMODE	0	ADC Companding mode select:	
				$0 = \mu$ -law	
				1 = A-law	
				(Note: Setting ADC_COMPMODE=1 selects 8-bit	
				mode when DAC_COMP=0 and ADC_COMP=0)	
	0	LOOPBACK	0	Digital Loopback Function	
				0 = No loopback.	
				1 = Loopback enabled, ADC data output is fed	
				directly into DAC data input.	

Register 71h ADC DAC COMP

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R114 (72h)	7	AIFADC_PD	0	Enables a pull down on ADC data pin	
AI ADC				0 = disabled	
Control				1 = enabled	
	6	AIFADCL_SRC	0	Selects Left channel ADC output.	
				0 = ADC Left channel	
				1 = ADC Right channel	
	5	AIFADCR_SRC	1	Selects Right channel ADC output.	
				0 = ADC Left channel	
				1 = ADC Right channel	
	4	AIFADC_TDM_CHAN	0	ADCDAT TDM Channel Select	
				0 = ADCDAT outputs data on slot 0	
				1 = ADCDAT outputs data on slot 1	
	3	AIFADC_TDM	0	ADC TDM Enable	
				0 = Normal ADCDAT operation	
				1 = TDM enabled on ADCDAT	

Register 72h Al ADC Control



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R115 (73h) AI DAC Control	14	BCLK_MSTR	0	Enables the Audio Interface BCLK generation and enables the BCLK pin for Master mode 0 = BCLK Slave mode 1 = BCLK Master mode	
	7	AIFDAC_PD	0	Enables a pull down on DAC data pin 0 = disabled 1 = enabled	
	6	DACL_SRC	0	Selects Left channel DAC input. 0 = DAC Left channel 1 = DAC Right channel	
	5	DACR_SRC	1	Selects Right channel DAC input. 0 = DAC Left channel 1 = DAC Right channel	
	4	AIFDAC_TDM_CHAN	0	DACDAT TDM Channel Select 0 = DACDAT outputs data on slot 0 1 = DACDAT outputs data on slot 1	
	3	AIFDAC_TDM	0	DAC TDM Enable 0 = Normal DACDAT operation 1 = TDM enabled on DACDAT	
	1:0	DAC_BOOST[1:0]	00	Provides a limited set of gains to be applied to the signal 00 = 0dB 01 = +6dB 10 = +12dB 11 = Reserved (+18dB)	

Register 73h Al DAC Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R128 (80h)	12	GP12_DB	1	GPIO12 debounce	
GPIO				0 = GPIO is not debounced.	
Debounce				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	11	GP11_DB	1	GPIO11 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	10	GP10_DB	1	GPIO10 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	9	GP9_DB	1	GPIO9 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	8	GP8_DB	1	GPIO8 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	7	GP7_DB	1	GPIO7 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	6	GP6_DB	1	GPIO6 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	5	GP5_DB	1	GPIO5 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	4	GP4_DB	1	GPIO4 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	3	GP3_DB	1	GPIO3 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	2	GP2_DB	1	GPIO2 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	1	GP1_DB	1	GPIO1 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	
	0	GP0_DB	1	GPIO0 debounce	
				0 = GPIO is not debounced.	
				1 = GPIO is debounced (time from GP_DBTIME[1:0])	
				Reset by state machine.	

Register 80h GPIO Debounce

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R129 (81h)	12	GP12_PU	0	GPIO12 pull-up	
GPIO Pin			0	0 = Normal	
pull up Control			0	1 = Pull-up enabled	
Control			0	(Only valid when GPIO12 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	11	GP11_PU	0	GPIO11 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO11 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	10	GP10_PU	0	GPIO10 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO10 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	9	GP9_PU	0	GPIO9 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
				(Only valid when GPIO9 is set to input. Do not select	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
			0	pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	8	GP8_PU	0	GPIO8 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO8 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
		_		Reset by state machine. Default held in metal mask.	
	7	GP7_PU	0	GPIO7 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO7 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	6	GP6_PU	0	GPIO6 pull-up	
	0	GF0_F0	0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO6 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	5	GP5_PU	0	GPIO5 pull-up	
		_	0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO5 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	4	GP4_PU	0	GPIO4 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			1	(Only valid when GPIO4 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
		OD2 DII	0	Reset by state machine. Default held in metal mask.	
	3	GP3_PU	0	GPIO3 pull-up 0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO3 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	2	GP2_PU	0	GPIO2 pull-up	
		_	0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO2 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	1	GP1_PU	0	GPIO1 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO1 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	0	GP0_PU	0	GPIO0 pull-up	
			0	0 = Normal	
			0	1 = Pull-up enabled	
			0	(Only valid when GPIO0 is set to input. Do not select	
		<u> </u>		pull-up and pull-down at the same time.)	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				Reset by state machine. Default held in metal mask.	

Register 81h GPIO Pin pull up Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R130 (82h)	12	GP12_PD	0	GPIO12 pull-down	
GPIO Pull		_	0	0 = Normal	
down Control			0	1 = Pull-down enabled	
			0	(Only valid when GPIO12 is set to input. Do not select	
				pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	11	GP11_PD	0	GPIO11 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO11 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	10	GP10_PD	0	GPIO10 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO10 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	9	GP9 PD	0	GPIO9 pull-down	
		_	0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO9 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	8	GP8_PD	0	GPIO8 pull-down	
			0	0 = Normal	
			1	1 = Pull-down enabled	
			0	(Only valid when GPIO8 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	7	GP7_PD	0	GPIO7 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO7 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	6	GP6_PD	0	GPIO6 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO6 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	5	GP5_PD	0	GPIO5 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO5 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	4	GP4_PD	0	GPIO4 pull-down	
			0	0 = Normal	
			1	1 = Pull-down enabled	
			0	(Only valid when GPIO4 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	3	GP3_PD	0	GPIO3 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO3 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	2	GP2_PD	0	GPIO2 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO2 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	1	GP1_PD	0	GPIO1 pull-down	
			0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO1 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	
	0	GP0_PD	0	GPIO0 pull-down	
		_	0	0 = Normal	
			0	1 = Pull-down enabled	
			0	(Only valid when GPIO0 is set to input. Do not select pull-up and pull-down at the same time.)	
				Reset by state machine. Default held in metal mask.	

Register 82h GPIO Pull down Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R131 (83h) GPIO Interrupt Mode	12	GP12_INTMODE	0	GPIO12 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP12_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	11	GP11_INTMODE	0	GPIO11 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP11_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	10	GP10_INTMODE	0	GPIO10 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP10_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	9	GP9_INTMODE	0	GPIO9 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP9_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	8	GP8_INTMODE	0	GPIO8 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP8_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	7	GP7_INTMODE	0	GPIO7 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP7_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	6	GP6_INTMODE	0	GPIO6 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP6_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	5	GP5_INTMODE	0	GPIO5 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP5_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	4	GP4_INTMODE	0	GPIO4 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP4_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	3	GP3_INTMODE	0	GPIO3 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP3_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	2	GP2_INTMODE	0	GPIO2 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP2_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	
	1	GP1_INTMODE	0	GPIO1 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GP1_CFG register bit. 1 = GPIO interrupt is both rising and falling edge triggered. Reset by state machine.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	0	GP0_INTMODE	0	GPIO0 Pin Mode 0 = GPIO interrupt is rising edge triggered, and is taken after the effect of the GPO_CFG register bit. 1 = GPIO interrupt is both rising and falling edge	
				triggered. Reset by state machine.	

Register 83h GPIO Interrupt Mode

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R133 (85h) GPIO Control	7:6	GP_DBTIME[1:0]		Debounce time for all GPIO inputs 00 = 64us 01 = 0.5ms 10 = 1ms 11 = 4ms Note: PWR_ON, PWR_OFF and /WAKEUP have additional debounce times. Reset by state machine.	

Register 85h GPIO Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R134 (86h)	12	GP12_DIR	0	GPIO12 pin direction	
GPIO			0	0 = Output	
Configuration			0	1 = Input	
(i/o)			0	Reset by state machine. Default held in metal mask.	
	11	GP11_DIR	1	GPIO11 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	10	GP10_DIR	1	GPIO10 pin direction	
			1	0 = Output	
			0	1 = Input	
			0	Reset by state machine. Default held in metal mask.	
	9	GP9_DIR	1	GPIO9 pin direction	
			0	0 = Output	
			0	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	8	GP8_DIR	1	GPIO8 pin direction	
			0	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	7	GP7_DIR	1	GPIO7 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	6	GP6_DIR	1	GPIO6 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
	5	GP5_DIR	1	GPIO5 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	4	GP4_DIR	1	GPIO4 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	3	GP3_DIR	1	GPIO3 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	2	GP2_DIR	1	GPIO2 pin direction	
			1	0 = Output	
			0	1 = Input	
			0	Reset by state machine. Default held in metal mask.	
	1	GP1_DIR	0	GPIO1 pin direction	
			1	0 = Output	
			1	1 = Input	
			1	Reset by state machine. Default held in metal mask.	
	0	GP0_DIR	0	GPIO0 pin direction	
			1	0 = Output	
			0	1 = Input	
			1	Reset by state machine. Default held in metal mask.	

Register 86h GPIO Configuration (i/o)

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R135 (87h)	12	GP12_CFG	0	GPIO12 pin polarity/type:	
GPIO Pin			0	Input:	
Polarity / Type			0	0 = Active low	
Туре			0	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	11	GP11_CFG	1	GPIO11 pin polarity/type:	
			1	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	10	GP10_CFG	1	GPIO10 pin polarity/type:	
			1	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	9	GP9_CFG	1	GPIO9 pin polarity/type:	
			0	Input:	
			0	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	8	GP8_CFG	1	GPIO8 pin polarity/type:	
			0	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
	_	007.050		Reset by state machine. Default held in metal mask.	
	7	GP7_CFG	1	GPIO7 pin polarity/type:	
			0	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output: 0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	6	GP6_CFG	1	GPIO6 pin polarity/type:	
	0	GF0_CFG	0	Input:	
			1	0 = Active low	
			1	1 = Active high	
			'	Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	5	GP5_CFG	1	GPIO5 pin polarity/type:	
		_	0	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	4	GP4_CFG	1	GPIO4 pin polarity/type:	
			1	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
		000 000	4	Reset by state machine. Default held in metal mask.	
	3	GP3_CFG	1	GPIO3 pin polarity/type:	
			1	Input:	
			0	0 = Active low	
1			1	1 = Active high	
				Output: 0 = CMOS	
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REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	2	GP2_CFG	1	GPIO2 pin polarity/type:	
			1	Input:	
			1	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	1	GP1_CFG	0	GPIO1 pin polarity/type:	
			1	Input:	
			1	0 = Active low	
			0	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	
	0	GP0_CFG	0	GPIO0 pin polarity/type:	
			1	Input:	
			0	0 = Active low	
			1	1 = Active high	
				Output:	
				0 = CMOS	
				1 = Open drain	
				Reset by state machine. Default held in metal mask.	

Register 87h GPIO Pin Polarity / Type

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R140 (8Ch)	15:12	GP3_FN[3:0]	0000	GPIO3 alternate function:	
GPIO			0000	Input:	
Function Select 1			0001	0000 = GPIO	
Select			0000	0001 = PWR_ON	
				0010 = LDO_ENA	
				0011 = PWR_OFF	
				0100 = FLASH	
				Output:	
				0000 = GPIO	
				0001 = P_CLK	
				0010 = VRTC	
				0011 = 32kHz	
				0100 = /MEMRST	
				Reset by state machine. Default held in metal mask.	
	11:8	GP2_FN[3:0]	0000	GPIO2 alternate function:	
			0000	Input:	
			0011	0000 = GPIO	
			0011	0001 = PWR_ON	
				0010 = /WAKEUP	
				0011 = 32KHZ	
				0100 = L_PWR3	
				Output:	
				0000 = GPIO	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				0001 = PWR_ON	
				0010 = VRTC	
				0011 = 32KHZ	
				0100 = /RST	
				Reset by state machine. Default held in metal mask.	
	7:4	GP1_FN[3:0]	0001	GPIO1 alternate function:	
			0000	Input:	
			0001	0000 = GPIO	
			0001	0001 = PWR_ON	
				0010 = /LDO_ENA	
				0011 = L_PWR2	
				0100 = /WAKEUP	
				Output:	
				0000 = GPIO	
				0001 = DO_CONF	
				0010 = /RST	
				0011 = /MEMRST	
				0100 = 32KHz	
				Reset by state machine. Default held in metal mask.	
	3:0	GP0_FN[3:0]	0011	GPIO0 alternate function:	
			0000	Input-	
			0000	0000 = GPIO	
			0000	0001 = PWR_ON	
				0010 = /LDO_ENA	
				0011 = L_PWR1	
				0100 = PWR_OFF	
				0101 = CHIP_RESET	
				Output:	
				0000 = GPIO	
				0001 = PWR_ON	
				0010 = VRTC	
				0011 = POR_B	
				0100 = /RST	
				Reset by state machine. Default held in metal mask.	

Register 8Ch GPIO Function Select 1

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R141 (8Dh)	15:12	GP7_FN[3:0]	0000	GPIO7 alternate function:	
GPIO			0001	Input:	
Function			0000	0000 = GPIO	
Select 2			0000	0001 = L_PWR3	
				0010 = MASK	
				0011 = Hibernate (level)	
				Output:	
				0000 = GPIO	
				0001 = P_CLK (1MHz)	
				0010 = /VCC_FAULT	
				0011 = /BATT_FAULT	
				0100 = MICDET	
				0101 = MICSHT	
				0110 = ADA	
				1100 = FLL_CLK	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
7.551.200				Reset by state machine. Default held in metal mask.	
	11:8	GP6_FN[3:0]	0000	GPIO6 alternate function:	
			0001	Input:	
			0000	0000 = GPIO	
			0000	0001 = L_PWR2	
				0010 = FLASH	
				0011 = Hibernate (Edge)	
				0100 = Hibernate (Level)	
				Output:	
				0000 = GPIO	
				0001 = /MEMRST	
				0010 = ADA	
				0011 = RTC	
				0100 = MICDET	
				0101 = MICSHT	
				0110 = ADCLRCLKB	
				Reset by state machine. Default held in metal mask.	
	7:4	GP5_FN[3:0]	0000	GPIO5 alternate function:	
			0001	Input:	
			0000	0000 = GPIO	
			0000	0001 = L_PWR1	
				0010 = ADCLRCLK	
				0011 = Hibernate (Edge)	
				0100 = PWR_OFF	
				0101 = Hibernate (Level)	
				Output: 0000 = GPIO	
				0000 = GFIO 0001 = P_CLK	
				0010 = ADCLRCLK	
				0010 = ABOLINOLIN	
				0100 = /BATT_FAULT	
				0101 = MICSHT	
				0110 = ADA	
				0111 = CODEC_OPCLK	
				1010 = MICDET	
				Reset by state machine. Default held in metal mask.	
	3:0	GP4_FN[3:0]	0000	GPIO4 alternate function:	
			0000	Input:	
			0011	0000 = GPIO	
			0001	0001 = /MR	
				0010 = FLASH	
				0011 = Hibernate (level)	
				0100 = MASK	
				0101 = CHIP_RESET	
				Output:	
				0000 = GPIO	
				0001 = /MEMRST	
				0010 = ADA	
				0011 = FLASH_OUT	
				0100 = /VCC_FAULT	
				0101 = MICSHT	
				1010 = MICDET	
				Reset by state machine. Default held in metal mask.	

Register 8Dh GPIO Function Select 2



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R142 (8Eh)	15:12	GP11_FN[3:0]	0000	GPIO11 alternate function:	
GPIO			0000	Input:	
Function Select 3			0010	0000 = GPIO	
Select 5			0010	0010 = /WAKEUP	
				Output:	
				0000 = GPIO	
				0001 = ISINKD	
				0010 = LINE_GT_BATT	
				0011 = CH_IND	
				Reset by state machine. Default held in metal mask.	
	11:8	GP10_FN[3:0]	0000	GPIO10 alternate function:	
			0000	Input:	
			0000	0000 = GPIO	
			0011	0011 = PWR_OFF	
				Output:	
				0000 = GPIO	
				0001 = ISINKC	
				0010 = LINE_GT_BATT	
				0011 = CH_IND	
				Reset by state machine. Default held in metal mask.	
	7:4	GP9_FN[3:0]	0000	GPIO9 alternate function:	
			0001	Input:	
			0000	0000 = GPIO	
			0000	0001 = HEARTBEAT	
				0010 = MASK	
				0011 = PWR_OFF	
				0100 = HIBERNATE (Level)	
				Output:	
				0000 = GPIO	
				0001 = /VCC_FAULT	
				0010 = LINE_GT_BATT	
				0011 = /BATT_FAULT	
				0100 = /MEMRST	
	0.0	000 5150 01	2222	Reset by state machine. Default held in metal mask.	
	3:0	GP8_FN[3:0]	0000	GPIO8 alternate function:	
			0011	Input:	
			0000	0000 = GPIO	
			0000	0001 = /MR	
				0010 = ADCBCLK	
				0011 = PWR_OFF	
				0100 = HIBERNATE (edge)	
				Output: 0000 = GPIO	
				0000 = GPIO 0001 = /VCC_FAULT	
				<u> </u>	
				0010 = ADCBCLK	
				0011 = /BATT_FAULT	
				0100 = /RST	
			1	Reset by state machine. Default held in metal mask.	<u> </u>

Register 8Eh GPIO Function Select 3



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R143 (8Fh) GPIO	3:0	GP12_FN[3:0]	0011 0011	GPIO12 alternate function:	
Function Select 4			0000	0000 = GPIO	
OCICCI 4			0011	0001 = CHIP_RESET Output:	
				0000 = GPIO	
				0001 = ISINKE 0010 = LINE GT BATT	
				0011 = LINE_SW	
				0100 = 32kHz Reset by state machine. Default held in metal mask.	

Register 8Fh GPIO Function Select 4

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R144 (90h)	15	AUXADC_ENA	0	AUXADC control	
Digitiser				0 = disabled	
Control (1)				1 = enabled	
				Reset by state machine.	
	14	AUXADC_CTC	0	Continuous conversion m ode:	
				0 = Polling mode	
				1 = Continuous mode	
				Reset by state machine.	
	13	AUXADC_POLL	0	Writing "1" initiates a set of measurements in polling mode (AUXADC_CTC=0). This bit is automatically reset after the measurements are completed.	
				Reset by state machine.	
	12	AUXADC_HIB_MODE	0	AUXADC state in hibernate mode:	
				0 = Leave AUXADC as in Active	
				1 = Disable AUXADC.	
				Reset by state machine.	
	7	AUXADC_SEL8	0	AUXADC TEMP input select	
				0 = Disable TEMP measurement	
				1 = Enable TEMP measurement	
				Reset by state machine.	
	6	AUXADC_SEL7	0	AUXADC BATT input select	
				0 = Disable BATT measurement	
				1 = Enable BATT measurement	
				Reset by state machine.	
	5	AUXADC_SEL6	0	AUXADC LINE input select	
				0 = Disable LINE measurement	
				1 = Enable LINE measurement	
				Reset by state machine.	
	4	AUXADC_SEL5	0	AUXADC USB input select	
				0 = Disable USB measurement	
				1 = Enable USB measurement	
				Reset by state machine.	
	3	AUXADC_SEL4	0	AUXADC AUX4 input select	
				0 = Disable AUX4 measurement	
				1 = Enable AUX4 measurement	
				Reset by state machine.	



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDICESS	2	AUXADC SEL3	0	AUXADC AUX3 input select	
				0 = Disable AUX3 measurement	
				1 = Enable AUX3 measurement	
				Reset by state machine.	
	1	AUXADC_SEL2	0	AUXADC AUX2 input select	
				0 = Disable AUX2 measurement	
				1 = Enable AUX2 measurement	
				Reset by state machine.	
	0	AUXADC_SEL1	0	AUXADC AUX1 input select	
				0 = Disable AUX1 measurement	
				1 = Enable AUX1 measurement	
				Reset by state machine.	

Register 90h Digitiser Control (1)

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R145 (91h)	13:12	AUXADC_MASKMODE[1:0]	00	AUXADC MASK input control	
Digitiser				00 = MASK is ignored	
Control (2)				01 = When MASK is asserted, all AUXADC	
				measurements are inhibited.	
				10 = Reserved	
				11 = MASK input initiates AUXADC	
				measurements. AUXADC_POLL and AUXADC_CTC have no effect. MASK	
				polarity is controlled by GPn_CFG.	
				Reset by state machine.	
	10:8	AUXADC CRATE[2:0]	000	AUXADC measurement frequency in	
				Continuous mode	
				000 = 1Hz	
				001 = 4Hz	
				010 = 8Hz	
				011 = 16Hz	
				100 = 32Hz	
				101 = 64Hz	
				110 = 128Hz	
				111 = 256Hz	
				Reset by state machine.	
	2	AUXADC_CAL	0	Configure AUX3 input to be the VREF	
				supply for AUXADC calibration.	
				0 = AUX3 input connected to AUX3 pin	
				1 = AUX3 input connected to unbuffered	
				VREF	
	1	AUXADC_RBMODE	1	Reset by state machine. Enable for AUXADC bandgap (VREF) buffer.	
	'	AOXADC_RBMODE	'	0 = AUXADC REFBUF is only enabled	
				during conversions that use the VREF as a	
				reference	
				1 = AUXADC REFBUF is always enabled	
				when the AUXADC is enabled	
				Reset by state machine.	
	0	AUXADC_WAIT	0	Whether the old data must be read before	
				new conversions can be made	
				0 = No effect (new conversions overwrite old)	
				1 = New conversions are held back (and	
		<u> </u>		1 14644 CONVENSIONS are neid back (and	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				measurements delayed) until AUX_DATAn has been read.	
				Reset by state machine.	

Register 91h Digitiser Control (2)

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R152 (98h) AUX1 Readback	14:13	AUXADC_SCALE1[1:0]	11	AUX1 input select: 00 = Off 01 = Input divided by 1 10 = Input divided by 2 11 = Input divided by 4	
	12	AUXADC_REF1	1	AUX1 reference select 0 = AUX1 measured relative to VRTC 1 = AUX1 measured relative to VREF	
	11:0	AUXADC_DATA1[11:0]	0000_0000_0000	Measured AUX1 data value relative to reference: 000 = 0V FFF = measured voltage after divide matches reference	

Register 98h AUX1 Readback

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R153 (99h)	14:13	AUXADC_SCALE2[1:0]	11	AUX2 input select:	
AUX2				00 = Off	
Readback				01 = Input divided by 1	
				10 = Input divided by 2	
				11 = Input divided by 4	
	12	AUXADC_REF2	1	AUX2 reference select	
				0 = AUX2 measured relative to VRTC	
				1 = AUX2 measured relative to VREF	
	11:0	AUXADC_DATA2[11:0]	0000_0000_0000	Measured AUX2 data value relative to	
				reference:	
				000 = 0V	
				FFF = measured voltage after divide	
				matches reference	

Register 99h AUX2 Readback

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R154 (9Ah) AUX3 Readback	14:13	AUXADC_SCALE3[1:0]	11	AUX3 input select: 00 = Off 01 = Input divided by 1 10 = Input divided by 2 11 = Input divided by 4	
	12	AUXADC_REF3	1	AUX3 reference select 0 = AUX3 measured relative to VRTC 1 = AUX3 measured relative to VREF	
	11:0	AUXADC_DATA3[11:0]	0000_0000_0000	Measured AUX3 data value relative to reference: 000 = 0V FFF = measured voltage after divide matches reference	

Register 9Ah AUX3 Readback

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R155 (9Bh) AUX4 Readback	14:13	AUXADC_SCALE4[1:0]	11	AUX4 input select: 00 = Off 01 = Input divided by 1 10 = Input divided by 2 11 = Input divided by 4	
	12	AUXADC_REF4	1	AUX4 reference select 0 = AUX4 measured relative to VRTC 1 = AUX4 measured relative to VREF	
	11:0	AUXADC_DATA4[11:0]	0000_0000_0000	Measured AUX4 data value relative to reference: 000 = 0V FFF = measured voltage after divide matches reference	

Register 9Bh AUX4 Readback

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R156 (9Ch) USB Voltage Readback	11:0	AUXADC_DATA_USB[11:0]	0000_0000_0000	Measured USB voltage data value.	

Register 9Ch USB Voltage Readback

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R157 (9Dh) LINE Voltage Readback	11:0	AUXADC_DATA_LINE[11:0]	0000_0000_0000	Measured LINE voltage data value.	

Register 9Dh LINE Voltage Readback



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R158 (9Eh)	11:0	AUXADC_DATA_BATT[11:0]	0000_0000_0000	Measured Battery voltage.	
BATT					
Voltage					
Readback					

Register 9Eh BATT Voltage Readback

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R159 (9Fh)	11:0	AUXADC_DATA_CHIPTEMP[11:0]	0000_0000_0000	Measured internal chip	
Chip Temp				temperature	
Readback					

Register 9Fh Chip Temp Readback

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R163 (A3h)	3	DCMP4_ENA	0	Digital comparator 4 enable	
Generic				0 = disabled	
Comparator Control				1 = enabled	
Control				Reset by state machine.	
	2	DCMP3_ENA	0	Digital comparator 3 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	1	DCMP2_ENA	0	Digital comparator 2 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	
	0	DCMP1_ENA	0	Digital comparator 1 enable	
				0 = disabled	
				1 = enabled	
				Reset by state machine.	

Register A3h Generic Comparator Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R164 (A4h)	15:13	DCMP1_SRCSEL[2:0]	000	DCOMP1 source select.	
Generic				000 = AUX1	
comparator				001 = AUX2	
•				010 = AUX3	
				011 = AUX4	
				100 = USB	
				101 = LINE	
				110 = BATT	
				111 = TEMP	
				Reset by state machine.	
	12	DCMP1_GT	0	DCOMP1 interrupt control	
				0 = interrupt when the source is less than threshold	
				1 = interrupt when the source is greater than threshold	
	11:0	DCMP1_THR[11:0]	0000_0000_0000	DCOMP1 threshold	
				(12-bit unsigned binary number)	

Register A4h Generic comparator 1



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R165 (A5h)	15:13	DCMP2_SRCSEL[2:0]	000	DCOMP2 source select.	
Generic				000 = AUX1	
comparator				001 = AUX2	
2				010 = AUX3	
				011 = AUX4	
				100 = USB	
				101 = LINE	
				110 = BATT	
				111 = TEMP	
				Reset by state machine.	
	12	DCMP2_GT	0	DCOMP2 interrupt control	
				0 = interrupt when the source is less than threshold	
				1 = interrupt when the source is greater than threshold	
	11:0	DCMP2_THR[11:0]	0000_0000_0000	DCOMP2 threshold	
1				(12-bit unsigned binary number)	

Register A5h Generic comparator 2

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R166 (A6h)	15:13	DCMP3_SRCSEL[2:0]	000	DCOMP3 source select.	
Generic				000 = AUX1	
comparator				001 = AUX2	
3				010 = AUX3	
				011 = AUX4	
				100 = USB	
				101 = LINE	
				110 = BATT	
				111 = TEMP	
				Reset by state machine.	
	12	DCMP3_GT	0	DCOMP3 interrupt control	
				0 = interrupt when the source is less than threshold	
				1 = interrupt when the source is greater than threshold	
	11:0	DCMP3_THR[11:0]	0000_0000_0000	DCOMP3 threshold	
				(12-bit unsigned binary number)	

Register A6h Generic comparator 3

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R167 (A7h)	15:13	DCMP4_SRCSEL[2:0]	000	DCOMP4 source select.	
Generic				000 = AUX1	
comparator				001 = AUX2	
4				010 = AUX3	
				011 = AUX4	
				100 = USB	
				101 = LINE	
				110 = BATT	
				111 = TEMP	
				Reset by state machine.	
	12	DCMP4_GT	0	DCOMP4 interrupt control	
				0 = interrupt when the source is less than threshold	
				1 = interrupt when the source is greater	
				than threshold	
	11:0	DCMP4_THR[11:0]	0000_0000_0000	DCOMP4 threshold	1
				(12-bit unsigned binary number)	

Register A7h Generic comparator 4

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R168 (A8h) Battery	15	CHG_ENA	1	CHG_ENA bit selects battery charger current control	
Charger				0 = Set battery charger current to zero	
Control 1				1 = Enable battery charge control	
				Protected by security key. Reset by state machine. Default held in metal mask.	
	12:10	CHG_EOC_SEL[2:0]	000	Selects what the end of charge current should be set to	
				000 = 20mA	
				001 = 30mA	
				(10mA steps)	
				111 = 90mA	
				Protected by security key.	
	9	CHG_TRICKLE_TEMP_CHOKE	0	Enable trickle charge temperature choking	
				0 = disable	
				1 = enable	
				Protected by security key. Reset by state machine.	
	8	CHG_TRICKLE_USB_CHOKE	0	Enable USB current choking in trickle charge	
				0 = disable	
				1 = enable	
				Protected by security key. Reset by state machine.	
	7	CHG_RECOVER_T	0	Time constant adjust for charger choke recovery (step-up): 0 = Step-up time constant is 180us	
				(allows faster recovery between processor wakeups)	
				1 = Step-up time constant is >20ms (outside audio band)	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS				Protected by security key. Reset by state machine.	
	6	CHG_END_ACT	0	Action to take when charging ends: 0 = Set charge current to 0 1 = Do nothing (leave charger on till timeout) Protected by security key. Reset by state machine.	
	5	CHG_FAST	0	Enable fast charging. 0 = Fast charging cannot take place. 1 = Enable fast charging (will not start until valid charging conditions are met). Note: This register is held low and can only be written to once the fast charge ready signal has gone high. Protected by security key. Reset by state machine. Default held in metal mask.	
	4	CHG_FAST_USB_THROTTLE	0	Enable USB current throttling in fast charge: 0 = 'on't do any current throttling when fast charging. 1 = Do current throttle while fast charging. Protected by security key. Reset by state machine.	
	3	CHG_NTC_MON	1 1 1 1	Enable charger battery NTC detection (some batteries may not need this - turn off with caution) 0 = Charger ignores NO_NTC detection. 1 = Charger monitors NO_NTC detection. Default held in metal mask.	
	2	CHG_BATT_HOT_MON	1 1 1 1	Enable charger battery temperature high detection (some batteries may not need this - turn off with caution) 0 = Charger ignores battery temperature too high. 1 = Charger monitors battery temperature too high. Default held in metal mask.	
	1	CHG_BATT_COLD_MON	1 1 1 1	Enable charger battery temperature low detection (some batteries may not need this - turn off with caution) 0 = Charger ignores battery temperature low. 1 = Charger monitors battery temperature low. Default held in metal mask.	
	0	CHG_CHIP_TEMP_MON	1	Enable charger chip temperature detection (some batteries may not need this - turn off with caution) 0 = Charger ignores chip temperature 1 = Charger monitors chip temperature Protected by security key. Default held in metal mask.	

Register A8h Battery Charger Control 1



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS	45	OLIO ACTIVE		Charger Status	
R169 (A9h) Battery Charger Control 2	15	CHG_ACTIVE	0	Charger Status. 0 = Battery Charging is inactive 1 = Battery Charging is active (Note CHG_ENA is just a request; the WM8350 determines if the conditions are satisfied for Battery Charging). Default held in metal mask.	
	14	CHG_PAUSE	0	0 = 'on't pause the charger	
	14	CHG_PAUSE		1 = Pause charging	
				Reset by state machine.	
	13:12	CHG_STS[1:0]	00	00 = Charger off, current set to 0.	
		5.75_5.5[5]		01 = In trickle charge mode.	
				10 = In fast charge mode.	
				11 = Reserved	
	11:8	CHG_TIME[3:0]	1011	Writing to his field set the charge timeout duration: 0000 = 60min 0001 = 90min 0010 = 120min 0011 = 150min 0100 = 180min 0101 = 210min 0110 = 240min 0111 = 270min 1000 = 300min 1001 = 330min 1001 = 360min 1011 = 390min 1100 = 420min 1110 = 450min 1110 = 480min 1111 = 510min Reading from this field indicates the charge time remaining: Time remaining = CHG_TIME * 2048s Protected by security key. Default held in metal mask.	
	7	CHG_MASK_WALL_FB	0	Selects whether to ignore the WALL_FB signal when charging from LINE. 0 = Does not mask the WALL_FB signal 1 = Mask the WALL_FB signal. Note: Care needs to be taken when using this bit. Protected by security key. Reset by state machine.	
	6	CHG_TRICKLE_SEL	0	Selects the trickle charge current. 0 = Set the trickle charge current to 50mA. 1 = Set the trickle charge current to 100mA. Protected by security key.	
	5:4	CHG_VSEL[1:0]	00	Battery charge voltage: $00 = 4.05V$ $01 = 4.1V$ $10 = 4.15V$ $11 = 4.2V$ Protected by security key.	
	3:0	CHG_ISEL[3:0]	0110	Fast charge current limit setting.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				0000 = off	
				0001 = 50mA	
				0010 = 100mA	
				(50mA steps)	
				1111 = 750mA	
				Note: Do not set the charger to be more than 400mA when USB powered.	
				Protected by security key.	

Register A9h Battery Charger Control 2

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R170 (AAh) Battery	7	CHG_FRC	0	Allows trickle-charging to be forced even if the battery voltage is above the default threshold	
Charger Control 3				0 = only trickle-charge if the battery voltage is below CHG_VSEL-100mV	
				1 = always trickle-charge	
				Protected by security key. Reset by state machine.	
	6:5	CHG_THROTTLE_T[1:0]	00	Time between steps when the charger throttles back due to USB current limit.	
				00 = 8us	
				01 = 16us	
				10 = 32us	
				11 = 128us	
				Protected by security key.	

Register AAh Battery Charger Control 3

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R172 (ACh)	15	CS1_ENA	0	Current Sink 1 enable (ISINKA pin)	
Current Sink				0 = disabled	
Driver A				1 = enabled	
				Reset by state machine.	
	12	CS1_HIB_MODE	0	Current Sink 1 behaviour in Hibernate mode	
				0 = disable current sink in Hibernate	
				1 = leave current sink as in Active	
				Reset by state machine.	
	5:0	CS1_ISEL[5:0]	00_0000	ISINKA current	
				00_0000 = 4.05uA	
				00_0001 = 4.85uA	
				00_0010 = 5.64uA	
				00_0011 = 6.83uA	
				00_0100 = 8.02uA	
				00_0101 = 9.6uA	
				00_0110 = 11.2uA	
				00_0111 = 13.5uA	
				00_1000 = 16.1uA	
				00_1001 = 19.3uA	
				00_1010 = 22.4uA	
				00_1011 = 27.2uA	
				00_1100 = 32uA	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				00_1101 = 38.3uA	
				00_1110 = 44.7uA	
				00_1111 = 54.1uA	
				01_0000 = 64.1uA	
				01_0001 = 76.8uA	
				01_0010 = 89.5uA	
				01_0011 = 109uA	
				01_0100 = 128uA	
				01_0101 = 153uA	
				01_0110 = 178uA	
				01_0111 = 216uA	
				01_1000 = 256uA	
				01_1001 = 307uA	
				01_1010 = 358uA	
				01_1011 = 434uA	
				01_1100 = 510uA	
				01_1101 = 612uA	
				01_1110 = 713uA	
				01_1111 = 865uA	
				10_0000 = 1.02mA	
				10_0001 = 1.22mA	
				10_0010 = 1.42mA	
				10_0011 = 1.73mA	
				10_0100 = 2.03mA	
				10_0101 = 2.43mA	
				10_0110 = 2.83mA	
				10_0111 = 3.43mA	
				10_1000 = 4.08mA	
				10_1001 = 4.89mA	
				10_1010 = 5.7mA	
				10_1011 = 6.91mA	
				10_1100 = 8.13mA	
				10_1101 = 9.74mA	
				10_1110 = 11.3mA	
				10_1111 = 13.7mA	
				11_0000 = 16.3mA	
				11_0001 = 19.6mA 11_0010 = 22.8mA	
				11_0010 = 22.8MA 11_0011 = 27.6mA	
				11_0100 = 32.5mA	
				11_0101 = 39mA 11_0110 = 45.4mA	
				11_0110 = 45.4mA 11_0111 = 54.9mA	
				11_1000 = 65.3mA	
				11_1000 = 65.3ffA 11_1001 = 78.2mA	
				11_1010 = 76.2mA 11_1010 = 91.2mA	
				11_1010 = 91.2111A	
				11_1100 = 130mA	
				11_1101 = 156mA	
				11_110 = 181mA	
				11_1111 = 220mA	
				Reset by state machine.	
				neset by state machine.	l

Register ACh Current Sink Driver A



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R173 (ADh) CSA Flash control	15	CS1_FLASH_MODE	0	Determines the function of the current sink 0 = LED mode 1 = Flash mode Reset by state machine.	
	14	CS1_TRIGSRC	0	Selects the trigger for the flash 0 = Flash is triggered by CS1_DRIVE bit 1 = Flash is triggered from GPIO pin configured as FLASH This bit has no effect when CS1_FLASH_MODE=0 Reset by state machine.	
	13	CS1_DRIVE	0	Enables the current sink ISINKA LED mode- 0 = disable LED 1 = enabled LED FLASH mode- Register bit used to trigger the flash, if CS1_TRIGSRC is set to 0. Flash is started when the bit goes high, it is then reset at the end of the flash duration. Duration is determined by CS1_FLASH_DUR. This bit has no effect if CS1_TRIGSRC is set to 1. Reset by state machine. Default held in metal mask.	
	12	CS1_FLASH_RATE	0	Determines the Flash rate 0 = Normal Operation. Once per trigger (Either register bit or GPIO) 1 = Flash will be internally triggered every 4 seconds Reset by state machine.	
	9:8	CS1_FLASH_DUR[1:0]	00	Sets duration of flash 00 = 32ms 01 = 64ms 10 = 96ms 11 = 1024ms Reset by state machine.	
	5:4	CS1_OFF_RAMP[1:0]	00	Switch-off ramp duration LED mode- 00 = instant (no ramp) 01 = 0.25s 10 = 0.5s 11 = 1s Flash mode- 00 = instant (no ramp) 01 = 1.95ms 10 = 3.91ms 11 = 7.8ms Reset by state machine.	
	1:0	CS1_ON_RAMP[1:0]	00	Switch-on ramp duration	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				LED mode-	
				00 = instant (no ramp)	
				01 = 0.25s	
				10 = 0.5s	
				11 = 1s	
				Flash mode-	
				00 = instant (no ramp)	
				01 = 1.95ms	
				10 = 3.91ms	
				11 = 7.8ms	
				Reset by state machine.	

Register ADh CSA Flash control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R174 (AEh)	15	CS2_ENA	0	Current Sink 2 enable (ISINKB pin)	
Current Sink		_		0 = disabled	
Driver B				1 = enabled	
				Reset by state machine.	
	12	CS2_HIB_MODE	0	Current Sink 2 behaviour in Hibernate mode	
				0 = disable current sink in Hibernate	
				1 = leave current sink as in Active	
				Reset by state machine.	
	5:0	CS2_ISEL[5:0]	00_0000	ISINK2 current	
				00_0000 = 4.05uA	
				00_0001 = 4.85uA	
				00_0010 = 5.64uA	
				00_0011 = 6.83uA	
				00_0100 = 8.02uA	
				00_0101 = 9.6uA	
				00_0110 = 11.2uA	
				00_0111 = 13.5uA	
				00_1000 = 16.1uA	
				00_1001 = 19.3uA	
				00_1010 = 22.4uA	
				00_1011 = 27.2uA	
				00_1100 = 32uA	
				00_1101 = 38.3uA	
				00_1110 = 44.7uA	
				00_1111 = 54.1uA	
				01_0000 = 64.1uA	
				01_0001 = 76.8uA	
				01_0010 = 89.5uA	
				01_0011 = 109uA	
				01_0100 = 128uA	
				01_0101 = 153uA	
				01_0110 = 178uA	
				01_0111 = 216uA	
				01_1000 = 256uA	
				01_1001 = 307uA	
				01_1010 = 358uA	
				01_1011 = 434uA	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				01_1100 = 510uA	
				01_1101 = 612uA	
				01_1110 = 713uA	
				01_1111 = 865uA	
				10_0000 = 1.02mA	
				10_0001 = 1.22mA	
				10_0010 = 1.42mA	
				10_0011 = 1.73mA	
				10_0100 = 2.03mA	
				10_0101 = 2.43mA	
				10_0110 = 2.83mA	
				10_0111 = 3.43mA	
				10_1000 = 4.08mA	
				10_1001 = 4.89mA	
				10_1010 = 5.7mA	
				10_1011 = 6.91mA	
				10_1100 = 8.13mA	
				10_1101 = 9.74mA	
				10_1110 = 11.3mA	
				10_1111 = 13.7mA	
				11_0000 = 16.3mA	
				11_0001 = 19.6mA	
				11_0010 = 22.8mA	
				11_0011 = 27.6mA	
				11_0100 = 32.5mA	
				11_0101 = 39mA	
				11_0110 = 45.4mA	
				11_0111 = 54.9mA	
				11_1000 = 65.3mA	
				11_1001 = 78.2mA	
				11_1010 = 91.2mA	
				11_1011 = 111mA	
				11_1100 = 130mA	
				11_1101 = 156mA	
				11_1110 = 181mA	
				11_1111 = 220mA	
				Reset by state machine.	

Register AEh Current Sink Driver B

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R175 (AFh)	15	CS2_FLASH_MODE	0	Determines the function of the current sink	
CSB Flash control				0 = LED mode 1 = Flash mode	
				Reset by state machine.	
	14	CS2_TRIGSRC	0	Selects the trigger in Flash mode.	
				0 = Flash triggered by CS2_DRIVE bit	
				1 = Flash triggered from GPIO pin configured as FLASH	
				This bit has no effect when CS2_FLASH_MODE=0	
				Reset by state machine.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	13	CS2_DRIVE	0	Enables the current sink ISINKB	
				LED mode-	
				0 = disable LED 1 = enabled LED	
				T = enabled LED	
				FLASH mode-	
				Register bit used to trigger the flash, if CS2 TRIGSRC is set to 0. Flash is started when	
				the bit goes high, it is then reset at the end of the	
				flash duration. Duration is determined by	
				CS2_FLASH_DUR. This bit has no effect if CS2_TRIGSRC is set to 1.	
				Reset by state machine. Default held in metal mask.	
	12	CS2_FLASH_RATE	0	Determines the Flash rate	
				0 = Normal Operation. Once per trigger (Either	
				register bit or GPIO)	
				1 = Flash will be internally triggered every 4 seconds	
				Reset by state machine.	
	9:8	CS2_FLASH_DUR[1:0]	00	Sets duration of flash	
				00 = 32ms	
				01 = 64ms	
				10 = 96ms	
				11 = 1024ms	
	5:4	CS2_OFF_RAMP[1:0]	00	Reset by state machine. Switch-off ramp duration	
	5.4	C32_OFF_KAWF[1.0]	00	Switch-on famp duration	
				LED mode-	
				00 = instant (no ramp)	
				01 = 0.25s	
				10 = 0.5s	
				11 = 1s	
				Flash mode-	
				00 = instant (no ramp)	
				01 = 1.95ms	
				10 = 3.91ms	
				11 = 7.8ms	
				Reset by state machine.	
	1:0	CS2_ON_RAMP[1:0]	00	Switch-on ramp duration	
				LED mode-	
				00 = instant (no ramp)	
				01 = 0.25s 10 = 0.5s	
				10 = 0.5s 11 = 1s	
				Flash mode-	
				00 = instant (no ramp)	
				01 = 1.95ms	
				10 = 3.91ms	
				11 = 7.8ms	
				Reset by state machine.	

Register AFh CSB Flash control



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R176 (B0h) DCDC/LDO requested	15	LS_ENA	0	Limit Switch enable 0 = disabled 1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	11	LDO4_ENA	0	LDO4 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status. Reset by state machine. Default held in metal mask.	
	10	I DO2 ENA	0	LDO3 enable	+
	10	LDO3_ENA	U	0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	9	LDO2_ENA	0	LDO2 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	8	LDO1_ENA	0	LDO1 enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	5	DC6_ENA	0	DCDC6 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
		DOE ENA		Reset by state machine. Default held in metal mask.	+
	4	DC5_ENA	0	DCDC5 converter enable 0 = disabled	
				1 = enabled Note: internal conditions may prevent the converter	
				from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	3	DC4_ENA	0	DCDC4 converter enable	
		_		0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter	
				from actually switching on - see DCDC/LDO Status register for actual converter status.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
7.551.200				Reset by state machine. Default held in metal mask.	
	2	DC3_ENA	0	DCDC3 converter enable	
		_		0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	1	DC2_ENA	0	DCDC2 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	
	0	DC1_ENA	0	DCDC1 converter enable	
				0 = disabled	
				1 = enabled	
				Note: internal conditions may prevent the converter from actually switching on - see DCDC/LDO Status register for actual converter status.	
				Reset by state machine. Default held in metal mask.	

Register B0h DCDC/LDO requested

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R177 (B1h) DCDC Active options	15	DCDC_DISCLKS	0	DCDC clock enable 0 = DCDC Clocks enabled 1 = DCDC1, 3, 4 and 6 clocks disabled. Note: This feature is useful in reducing the current consumption if all 4 DCDCs are in LDO mode. The requirement is to put them in LDO mode and then at least 100us is required before clocks are disabled. Again while coming out of LDO mode first enable the clocks and then at least 100us wait and then come out of LDO mode. This can only be used if the	
				processor is alive to set and unset this bit. Reset by state machine.	
	13:12	PUTO[1:0]	00	Power up time out value for all converters 00 = 0.5ms 01 = 2ms 10 = 32ms 11 = 256ms Reset by state machine.	
	5	DC6_ACTIVE	1	DC-DC 6 Active mode 0 = Select Standby mode 1 = Select Active mode Reset by state machine.	
	3	DC4_ACTIVE	1	DC-DC 4 Active mode 0 = Select Standby mode 1 = Select Active mode Reset by state machine.	
	2	DC3_ACTIVE	1	DC-DC 3 Active mode 0 = Select Standby mode 1 = Select Active mode	



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				Reset by state machine.	
	0	DC1_ACTIVE	1	DC-DC 1 Active mode	
		_		0 = Select Standby mode	
				1 = Select Active mode	
				Reset by state machine.	

Register B1h DCDC Active options

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R178 (B2h)	5	DC6_SLEEP	0	DC-DC 6 Sleep mode	
DCDC Sleep				0 = Normal DC-DC operation	
options				1 = Select LDO mode	
				Reset by state machine.	
	3	DC4_SLEEP	0	DC-DC 4 Sleep mode	
				0 = Normal DC-DC operation	
				1 = Select LDO mode	
				Reset by state machine.	
	2	DC3_SLEEP	0	DC-DC 3 Sleep mode	
				0 = Normal DC-DC operation	
				1 = Select LDO mode	
				Reset by state machine.	
	0	DC1_SLEEP	0	DC-DC 1 Sleep mode	
				0 = Normal DC-DC operation	
				1 = Select LDO mode	
				Reset by state machine.	

Register B2h DCDC Sleep options

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R179 (B3h) Power-check	14	PCCMP_ERRACT	0	Action when supply falls below PCCMP_OFF_THR level	
comparator				0 = Generate critical supply interrupt only	
				1 = Generate interrupt and trigger hard shut down	
				Reset by state machine.	
	12	PCCOMP_HIB_MODE	0	Function of Hyst Comp in the hibernate state	
				0 = Hyst Comp is not used in hibernate state	
				1 = Hyst comp is on in the hibernate state	
	6:4	PCCMP_OFF_THR[2:0]	010	Power check comparator critical batter" ("system turn "ff") threshold value	
				000 = 2.9V	
				001 = 3.0V	
				111 = 3.6V	
				Protected by security key. Default held in metal mask.	
	2:0	PCCMP_ON_THR[2:0]	101	Power check comparato" ("system turn"on") threshold value	
				000 = 2.9V	
				001 = 3.0V	
				111 = 3.6V	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				Protected by security key. Default held in metal	
				mask.	

Register B3h Power-check comparator

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS	45.44	DO1 01 D11 01		DO DOMO, to at Occasion	
R180 (B4h) DCDC1	15:14	DC1_CAP[1:0]	00	DC-DC1 Output Capacitor	
Control				00 = 10uF, 30uF, 45uF	
				01 = 60uF, 85uF	
				10 = Not used	
				11 = 100uF	
				Reset by state machine.	
	11	DC1_DISOVP	0	Over voltage Protection	
				0 = enabled	
				1 = disabled	
				Reset by state machine. Default held in metal mask.	
	10	DC1_OPFLT	0	Enable discharge of DC-DC1 outputs when DC-DC1	
				is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
	6:0	DC1_VSEL[6:0]	000_1110	DC-DC1 Converter output voltage settings in 25mV	
			000_0110	steps.	
			001_0010	Maximum output = 3.4V.	
			110_0010		
				110 0110 = 3.4V	
				110 0010 = 3.3V	
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	
				Reset by state machine. Default held in metal mask.	

Register B4h DCDC1 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R181 (B5h) DCDC1	15:14	DC1_ERRACT[1:0]	00	Action to take on DC-DC1 fault (as well as generating an interrupt):	
Timeouts				00 = ignore	
				01 = shut down converter	
				10 = shut down system	
				11 = reserved (shut down system)	
				Reset by state machine. Default held in metal mask.	
	13:10	DC1_ENSLOT[3:0]	0000	Time slot for DC-DC1 start-up	
			0100	0000 = Disabled (do not start up)	
			0001	0001 = Start-up in time slot 1	
			0010	(total 14 slots available)	
				1110 = Start-up in time slot 14	
				1111 = Start-up on entering ACTIVE	
				Reset by state machine. Default held in metal	



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				mask.	
	9:6	DC1_SDSLOT[3:0]	0000	Time slot for DC-DC1 shutdown.	
				0000 = Shut down on entering OFF	
				0001 = Shutdown in time slot 1	
				(total 14 slots available)	
				1110 = Shutdown in time slot 14	
				1111 = Shut down on entering OFF	

Register B5h DCDC1 Timeouts

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R182 (B6h)	14:12	DC1_HIB_MODE[2:0]	001	DC-DC1 Hibernate behaviour:	
DCDC1 Low				000 = Use current settings (no change)	
Power				001 = Select voltage image settings	
				010 = Force standby mode	
				011 = Force standby mode and voltage image	
				settings.	
				100 = Force LDO mode	
				101 = Force LDO mode and voltage image	
				settings.	
				110 = Reserved.	
				111 = Disable output	
	9:8	DC1_HIB_TRIG[1:0]	00	DC-DC1 Hibernate signal select	
				00 = HIBERNATE register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Note that Hibernate is also selected when a GPIO Hibernate input is asserted.	
				Reset by state machine. Default held in metal mask.	
	6:0	DC1_VIMG[6:0]	000_0110	DC-DC1 Converter output image voltage settings in 25mv steps.	
				Maximum output = 3.4V.	
				110 0110 = 3.4V	
				110 0010 = 3.3V	
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	

Register B6h DCDC1 Low Power

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R183 (B7h)	14	DC2_MODE	0	DC-DC2 Converter Mode	
DCDC2				0 = Boost mode	
Control				1 = Switch mode	
				Reset by state machine.	
	12	DC2_HIB_MODE	0	DC-DC2 Hibernate behaviour:	
				0 = Continue as in Active state	
				1 = Disable converter output	
				Reset by state machine.	
	9:8	DC2_HIB_TRIG[1:0]	00	DC-DC2 Hibernate signal select	
				00 = HIBERNATE register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Note that Hibernate is also selected when a GPIO	
				Hibernate input is asserted.	
		_		Reset by state machine.	
	6	DC2_ILIM	0	DC-DC2 peak current limit select	
				0 = Higher peak current	
				1 = Lower peak current	
				Reset by state machine. Default held in metal mask.	
	4	DC2_RMPH	1	DC-DC2 compensation ramp	
				{DC2_RMPH, DC2_RMPL}	
				00 = 20V < VOUT ≤ 30V	
				01 = 10V < VOUT ≤ 20V	
				10 = 5V < VOUT ≤ 10V	
				11 = VOUT ≤ 5V (will be chosen automatically if DC2_FBSRC=11)	
				Reset by state machine. Default held in metal mask.	
	3	DC2_RMPL	1	DC-DC2 compensation ramp	
				{DC2_RMPH, DC2_RMPL}	
				00 = 20V < VOUT ≤ 30V	
				01 = 10V < VOUT ≤ 20V	
				10 = 5V < VOUT ≤ 10V	
				11 = VOUT ≤ 5V (will be chosen automatically if DC2_FBSRC=11)	
				Reset by state machine. Default held in metal mask.	
	1:0	DC2_FBSRC[1:0]	00	DC-DC2 voltage feedback selection	
				00 = voltage feedback (using external resistor divider on pin FB2)	
				01 = current sink ISINKA used as feedback	
				10 = current sink ISINKB used as feedback	
				11 = voltage feedback (using internal resistor divider on pin USB)	
				Reset by state machine. Default held in metal mask.	

Register B7h DCDC2 Control



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R184 (B8h) DCDC2 Timeouts	15:14	DC2_ERRACT[1:0]	00	Action to take on DC-DC2 fault (as well as generating an interrupt): 00 = ignore 01 = shut down converter 10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	DC2_ENSLOT[3:0]	0000 0000 0000 0000	Time slot for DC-DC2 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start-up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	DC2_SDSLOT[3:0]	0000	Time slot for DC-DC2 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register B8h DCDC2 Timeouts

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R186 (BAh)	11	DC3_DISOVP	0	Over voltage Protection	
DCDC3				0 = enabled	
Control				1 = disabled	
				Reset by state machine. Default held in metal mask.	
	10	DC3_OPFLT	0	Enable discharge of DC-DC3 outputs when DC-DC3 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
	6:0	DC3_VSEL[6:0]	000_0000	DC-DC3 Converter output voltage settings in 25mV	
			010_0110	steps.	
			010_1110	Maximum output = 3.4V.	
			000_1110		
				110 0110 = 3.4V	
				110 0010 = 3.3V	
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	
				Reset by state machine. Default held in metal mask.	

Register BAh DCDC3 Control



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R187 (BBh) DCDC3 Timeouts	15:14	DC3_ERRACT[1:0]	00	Action to take on DC-DC3 fault (as well as generating an interrupt): 00 = ignore 01 = shut down converter	
				10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	DC3_ENSLOT[3:0]	0000 0001 0000 0000	Time slot for DC-DC3 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start-up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	DC3_SDSLOT[3:0]	0000	Time slot for DC-DC3 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register BBh DCDC3 Timeouts

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R188 (BCh) DCDC3 Low Power	14:12	DC3_HIB_MODE[2:0]	000	DC-DC3 Hibernate behaviour: 000 = Use current settings (no change) 001 = Select voltage image settings 010 = Force standby mode	
				011 = Force standby mode and voltage image settings.	
				100 = Force LDO mode 101 = Force LDO mode and voltage image settings.	
				110 = Reserved. 111 = Disable output Reset by state machine. Default held in metal	
	9:8	DC3_HIB_TRIG[1:0]	00	mask. DC-DC3 Hibernate signal select 00 = HIBERNATE register bit 01 = L_PWR1 10 = L_PWR2 11 = L_PWR3 Note that Hibernate is also selected when a GPIO Hibernate input is asserted. Reset by state machine. Default held in metal mask.	
	6:0	DC3_VIMG[6:0]	000_0110	DC-DC3 Converter output image voltage settings in 25mv steps. Maximum output = 3.4V. 110 0110 = 3.4V 110 0010 = 3.3V 101 0110 = 3.0V	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	

Register BCh DCDC3 Low Power

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R189 (BDh)	11	DC4_DISOVP	0	Over voltage Protection	
DCDC4				0 = enabled	
Control				1 = disabled	
				Reset by state machine. Default held in metal mask.	
	10	DC4_OPFLT	0	Enable discharge of DC-DC4 outputs when DC-DC4 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
	6:0	DC4_VSEL[6:0]	000_0000	DC-DC4 Converter output voltage settings in 25mV	
			101_0110	steps.	
			000_1110	Maximum output = 3.4V.	
			000_0110		
				110 0110 = 3.4V	
				110 0010 = 3.3V	
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	
				Reset by state machine. Default held in metal mask.	

Register BDh DCDC4 Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R190 (BEh) DCDC4 Timeouts	15:14	DC4_ERRACT[1:0]	00	Action to take on DC-DC4 fault (as well as generating an interrupt): 00 = ignore 01 = shut down converter 10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	DC4_ENSLOT[3:0]	0000 0001 0000 0011	Time slot for DC-DC4 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start-up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	DC4_SDSLOT[3:0]	0000	Time slot for DC-DC4 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register BEh DCDC4 Timeouts

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R191 (BFh)	14:12	DC4_HIB_MODE[2:0]	000	DC-DC4 Hibernate behaviour:	
DCDC4 Low				000 = Use current settings (no change)	
Power				001 = Select voltage image settings	
				010 = Force standby mode	
				011 = Force standby mode and voltage image settings.	
				100 = Force LDO mode	
				101 = Force LDO mode and voltage image settings.	
				110 = Reserved.	
				111 = Disable output	
				Reset by state machine. Default held in metal mask.	
	9:8	DC4_HIB_TRIG[1:0]	00	DC-DC4 Hibernate signal select	
				00 = HIBERNATE register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Note that Hibernate is also selected when a GPIO Hibernate input is asserted.	
				Reset by state machine. Default held in metal mask.	
	6:0	DC4_VIMG[6:0]	000_0110	DC-DC4 Converter output image voltage settings in 25mv steps.	
				Maximum output = 3.4V.	
				110 0110 = 3.4V	
				110 0010 = 3.3V	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	

Register BFh DCDC4 Low Power

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R192 (C0h)	14	DC5_MODE	0	DC-DC5 Converter Mode	
DCDC5				0 = Boost mode	
Control	DC5_MODE				
				Reset by state machine.	
	12	DC5_HIB_MODE	0	DC-DC5 Hibernate behaviour:	
				0 = Continue as in Active state	
				1 = Disable converter output	
				Reset by state machine.	
	9:8	DC5_HIB_TRIG[1:0]	00	DC-DC5 Hibernate signal select	
				00 = HIBERNATE register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Reset by state machine.	
	6	DC5_ILIM	0	DC-DC5 peak current limit select	
				0 = Higher peak current	
				1 = Lower peak current	
				· · · · · · · · · · · · · · · · · · ·	
	4	DC5_RMPH	0	DC-DC5 compensation ramp	
				{DC5_RMPH, DC5_RMPL}	
				00 = 20V < VOUT ≤ 30V	
				01 = 10V < VOUT ≤ 20V	
				10 = 5V < VOUT ≤ 10V	
				,	
	3	DC5_RMPL	1	DC-DC5 compensation ramp	
				{DC5_RMPH, DC5_RMPL}	
				00 = 20V < VOUT ≤ 30V	
				01 = 10V < VOUT ≤ 20V	
				10 = 5V < VOUT ≤ 10V	
				11 = VOUT ≤ 5V (will be chosen automatically if DC5_FBSRC=11)	
				Reset by state machine. Default held in metal mask.	
	1:0	DC5_FBSRC[1:0]	00	DC-DC5 voltage feedback selection	
				00 = voltage feedback (using external resistor divider on pin FB5)	
				01 = current sink ISINKA used as feedback	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				10 = current sink ISINKB used as feedback 11 = voltage feedback (using internal resistor divider on pin USB) Reset by state machine. Default held in metal mask.	

Register C0h DCDC5 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R193 (C1h) DCDC5 Timeouts	15:14	DC5_ERRACT[1:0]	00	Action to take on DC-DC5 fault (as well as generating an interrupt): 00 = ignore 01 = shut down converter 10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	DC5_ENSLOT[3:0]	0000 0000 0000 0000	Time slot for DC-DC5 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start-up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	DC5_SDSLOT[3:0]	0000	Time slot for DC-DC5 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register C1h DCDC5 Timeouts



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R195 (C3h)	15:14	DC6_CAP[1:0]	00	DC-DC6 Output Capacitor	
DCDC6				00 = 10uF, 30uF, 45uF	
Control				01 = 60uF, 85uF	
				10 = Not used	
				11 = 100uF	
	11	DC6_DISOVP	0	Over voltage Protection	
				0 = enabled	
				1 = disabled	
				Reset by state machine. Default held in metal mask.	
	10	DC6_OPFLT	0	Enable discharge of DC-DC6 outputs when DC-DC6	
				is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
	6:0	DC6_VSEL[6:0]	000_0000	DC-DC6 Converter output voltage settings in 25mV	
			000_1010	steps.	
			010_0110	Maximum output = 3.4V.	
			010_0110		
				110 0110 = 3.4V	
				110 0010 = 3.3V	
				101 0110 = 3.0V	
				100 1110 = 2.8V	
				010 0110 = 1.8V	
				000 1110 = 1.2V	
				000 0110 = 1.0V	
				000 0000 = 0.85V	
				Reset by state machine. Default held in metal mask.	

Register C3h DCDC6 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R196 (C4h)	15:14	DC6_ERRACT[1:0]	00	Action to take on DC-DC6 fault (as well as	
DCDC6				generating an interrupt):	
Timeouts				00 = ignore	
				01 = shut down converter	
				10 = shut down system	
				11 = reserved (shut down system)	
				Reset by state machine. Default held in metal	
				mask.	
	13:10	DC6_ENSLOT[3:0]	0000	Time slot for DC-DC6 start-up	
			0100	0000 = Disabled (do not start up)	
			0011	0001 = Start-up in time slot 1	
			0001	(total 14 slots available)	
				1110 = Start-up in time slot 14	
				1111 = Start-up on entering ACTIVE	
				Reset by state machine. Default held in metal	
				mask.	
	9:6	DC6_SDSLOT[3:0]	0000	Time slot for DC-DC6 shutdown.	
				0000 = Shut down on entering OFF	
				0001 = Shutdown in time slot 1	
				(total 14 slots available)	
				1110 = Shutdown in time slot 14	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				1111 = Shut down on entering OFF	

Register C4h DCDC6 Timeouts

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R197 (C5h) DCDC6 Low Power	14:12	DC6_HIB_MODE[2:0]	000	DC-DC6 Hibernate behaviour: 000 = Use current settings (no change) 001 = Select voltage image settings 010 = Force standby mode 011 = Force standby mode and voltage image settings. 100 = Force LDO mode 101 = Force LDO mode and voltage image settings. 110 = Reserved. 111 = Disable output Reset by state machine. Default held in metal mask.	
	9:8	DC6_HIB_TRIG[1:0]	00	DC-DC6 Hibernate signal select 00 = HIBERNATE register bit 01 = L_PWR1 10 = L_PWR2 11 = L_PWR3 Note that Hibernate is also selected when a GPIO Hibernate input is asserted. Reset by state machine. Default held in metal mask.	
	6:0	DC6_VIMG[6:0]	000_0110	DC-DC6 Converter output image voltage settings in 25mv steps. Maximum output = 3.4V. 110 0110 = 3.4V 110 0010 = 3.3V 101 0110 = 3.0V 100 1110 = 2.8V 010 0110 = 1.8V 000 1110 = 1.2V 000 0110 = 1.0V 000 0000 = 0.85V	

Register C5h DCDC6 Low Power



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R199 (C7h)	15:14	LS_ERRACT[1:0]	00	Current limit detection behaviour	
Limit Switch				00 = ignore	
Control				01 = disable switch	
				10 = shut down system	
				11 = shut down system	
				Reset by state machine. Default held in metal mask.	
	13:10	LS_ENSLOT[3:0]	0000	Time slot for Limit Switch start-up	
				0000 = Disabled (do not start up)	
				0001 = Start-up in time slot 1	
				(total 14 slots available)	
				1110 = Start-up in time slot 14	
				1111 = Start-up on entering ACTIVE	
				Reset by state machine. Default held in metal mask.	
	9:6	LS_SDSLOT[3:0]	0000	Time slot for Limit Switch shutdown.	
				0000 = Shut down on entering OFF	
				0001 = Shutdown in time slot 1	
				(total 14 slots available)	
				1110 = Shutdown in time slot 14	
				1111 = Shut down on entering OFF	
	4	LS_HIB_MODE	0	Limit switch hibernate mode setting	
				0 = disabled	
				1 = leave setting as in Active mode	
	1	LS_HIB_PROT	1	Controls the bulk detection circuit when Limit Switch	
				is disabled in Hibernate mode.	
				0 = bulk detection disabled	
				1 = bulk detection enabled	
	0	LS_PROT	1	Controls the bulk detection circuit when Limit Switch	
				is disabled in Active mode.	
				0 = bulk detection disabled	
				1 = bulk detection enabled	

Register C7h Limit Switch Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R200 (C8h)	14	LDO1 SWI	0	LDO1 Regulator mode	
LDO1				0 = LDO voltage regulator	
Control				1 = Current-limited switch (no voltage regulation, LDO1_VSEL has no effect)	
				Reset by state machine. Default held in metal mask.	
	10	LDO1_OPFLT	0	Enable discharge of LDO1 outputs when LDO1 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
				Note - if LDO Regulators 1, 2, 3 and 4 are all disabled, then the outputs will all be discharged,	
				regardless of the LDOn_OPFLT bit.	
	4:0	LDO1_VSEL[4:0]	1_1100	LDO1 Regulator output voltage (when LDO1_SWI=0)	
			0_0010		
			1_1100	1 1111 = 3.3V	
			0_0010	(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				0 0000 = 0.9V Reset by state machine. Default held in metal mask.	

Register C8h LDO1 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R201 (C9h)	15:14	LDO1_ERRACT[1:0]	00	Action to take on LDO1 fault (as well as	
LDO1				generating an interrupt):	
Timeouts				00 = ignore	
				01 = shut down regulator	
				10 = shut down system	
				11 = reserved (shut down system)	
				Reset by state machine. Default held in metal mask.	
	13:10	LDO1_ENSLOT[3:0]	0000	Time slot for LDO1 start-up	
			0011	0000 = Disabled (do not start up)	
			0000	0001 = Start-up in time slot 1	
			0000	(total 14 slots available)	
				1110 = Start-up in time slot 14	
				1111 = Start up on entering ACTIVE	
				Reset by state machine. Default held in metal mask.	
	9:6	LDO1_SDSLOT[3:0]	0000	Time slot for LDO1 shutdown.	
				0000 = Shut down on entering OFF	
				0001 = Shutdown in time slot 1	
				(total 14 slots available)	
				1110 = Shutdown in time slot 14	
				1111 = Shut down on entering OFF	

Register C9h LDO1 Timeouts

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R202 (CAh)	13:12	LDO1_HIB_MODE[1:0]	00	LDO1 Hibernate behaviour:	
LDO1 Low				00 = Select voltage image settings	
Power				01 = disable output	
				10 = reserved	
				11 = reserved	
				Reset by state machine. Default held in metal mask.	
	9:8	LDO1_HIB_TRIG[1:0]	00	LDO1 Hibernate signal select	
				00 = Hibernate register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Reset by state machine. Default held in metal mask.	
	4:0	LDO1_VIMG[4:0]	1_1100	LDO1 Regulator output image voltage	
				1 1111 = 3.3V	
				(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				0 0000 = 0.9V	

Register CAh LDO1 Low Power

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R203 (CBh)	14	LDO2 SWI	0	LDO2 Regulator mode	
LDO2		LDOZ_GWI		0 = LDO voltage regulator	
Control				1 = Current-limited switch (no voltage regulation, LDO2_VSEL has no effect)	
				Reset by state machine. Default held in metal mask.	
	10	LDO2_OPFLT	0	Enable discharge of LDO2 outputs when LDO2 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
				Note - if LDO Regulators 1, 2, 3 and 4 are all disabled, then the outputs will all be discharged, regardless of the LDO <i>n_OPFLT</i> bit.	
	4:0	LDO2_VSEL[4:0]	1_1011	LDO2 Regulator output voltage (when LDO2_SWI=0)	
			1_1111		
			1_0000	1 1111 = 3.3V	
			1_1010	(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	
				0 0000 = 0.9V	
				Reset by state machine. Default held in metal mask.	

Register CBh LDO2 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R204 (CCh) LDO2	15:14	LDO2_ERRACT[1:0]	00	Action to take on LDO2 fault (as well as generating an interrupt):	
Timeouts				00 = ignore	
				01 = shut down regulator	
				10 = shut down system	
				11 = reserved (shut down system)	
				Reset by state machine. Default held in metal mask.	
	13:10	LDO2_ENSLOT[3:0]	0000	Time slot for LDO2 start-up	
			0010	0000 = Disabled (do not start up)	
			0010	0001 = Start-up in time slot 1	
			0000	(total 14 slots available)	
				1110 = Start-up in time slot 14	
				1111 = Start up on entering ACTIVE	
				Reset by state machine. Default held in metal mask.	
	9:6	LDO2_SDSLOT[3:0]	0000	Time slot for LDO2 shutdown.	
				0000 = Shut down on entering OFF	
				0001 = Shutdown in time slot 1	
				(total 14 slots available)	
				1110 = Shutdown in time slot 14	
				1111 = Shut down on entering OFF	

Register CCh LDO2 Timeouts



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS R205 (CDh)	13:12	LDO2_HIB_MODE[1:0]	00	LDO2 Hibernate behaviour:	
LDO2 Low	13.12	LDO2_IIIB_WODE[1.0]	00	00 = Select voltage image settings	
Power				01 = disable output	
				10 = reserved	
				11 = reserved	
				Reset by state machine. Default held in metal	
				mask.	
	9:8	LDO2_HIB_TRIG[1:0]	00	LDO2 Hibernate signal select	
				00 = Hibernate register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Reset by state machine. Default held in metal mask.	
	4:0	LDO2_VIMG[4:0]	1_1100	LDO2 Regulator output image voltage	
				1 1111 = 3.3V	
				(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	
				0 0000 = 0.9V	

Register CDh LDO2 Low Power

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R206 (CEh)	14	LDO3_SWI	0	LDO3 Regulator mode	
LDO3				0 = LDO voltage regulator	
Control				1 = Current-limited switch (no voltage regulation, LDO3_VSEL has no effect)	
				Reset by state machine. Default held in metal mask.	
	10	LDO3_OPFLT	0	Enable discharge of LDO3 outputs when LDO3 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
				Note - if LDO Regulators 1, 2, 3 and 4 are all disabled, then the outputs will all be discharged, regardless of the LDO <i>n_OPFLT</i> bit.	
	4:0	LDO3_VSEL[4:0]	1_1011	LDO3 Regulator output voltage (when LDO3_SWI=0)	
			1_1100		
			1_0101	1 1111 = 3.3V	
			1_1111	(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	
				0 0000 = 0.9V	
				Reset by state machine. Default held in metal mask.	

Register CEh LDO3 Control



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R207 (CFh) LDO3 Timeouts	15:14	LDO3_ERRACT[1:0]	00	Action to take on LDO3 fault (as well as generating an interrupt): 00 = ignore 01 = shut down regulator 10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	LDO3_ENSLOT[3:0]	0000 0001 0000 0000	Time slot for LDO3 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	LDO3_SDSLOT[3:0]	0000	Time slot for LDO3 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register CFh LDO3 Timeouts

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R208 (D0h)	13:12	LDO3_HIB_MODE[1:0]	00	LDO3 Hibernate behaviour:	
LDO3 Low				00 = Select voltage image settings	
Power				01 = disable output	
				10 = reserved	
				11 = reserved	
				Reset by state machine. Default held in metal mask.	
	9:8	LDO3_HIB_TRIG[1:0]	00	LDO3 Hibernate signal select	
				00 = Hibernate register bit	
				01 = L_PWR1	
				10 = L_PWR2	
				11 = L_PWR3	
				Reset by state machine. Default held in metal mask.	
	4:0	LDO3_VIMG[4:0]	1_1100	LDO3 Regulator output image voltage	
				1 1111 = 3.3V	
				(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	
				0 0000 = 0.9V	

Register D0h LDO3 Low Power



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R209 (D1h)	14	LDO4 SWI	0	LDO4 Regulator mode	
LDO4				0 = LDO voltage regulator	
Control				1 = Current-limited switch (no voltage regulation, LDO4_VSEL has no effect)	
				Reset by state machine. Default held in metal mask.	
	10	LDO4_OPFLT	0	Enable discharge of LDO4 outputs when LDO4 is disabled	
				0 = Enabled - Output to be discharged	
				1 = Disabled - Output is left floating	
				Note - if LDO Regulators 1, 2, 3 and 4 are all disabled, then the outputs will all be discharged, regardless of the LDOn_OPFLT bit.	
	4:0	LDO4_VSEL[4:0]	1_1011	LDO4 Regulator output voltage (when LDO4_SWI=0)	
			0_0100		
			1_1010	1 1111 = 3.3V	
			1_1111	(100mV steps)	
				1 0000 = 1.8V	
				0 1111 = 1.65V	
				(50mV steps)	
				0 0000 = 0.9V	
				Reset by state machine. Default held in metal mask.	

Register D1h LDO4 Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R210 (D2h) LDO4 Timeouts	15:14	LDO4_ERRACT[1:0]	00	Action to take on LDO4 fault (as well as generating an interrupt): 00 = ignore 01 = shut down regulator 10 = shut down system 11 = reserved (shut down system) Reset by state machine. Default held in metal mask.	
	13:10	LDO4_ENSLOT[3:0]	0000 0010 0000 0000	Time slot for LDO4 start-up 0000 = Disabled (do not start up) 0001 = Start-up in time slot 1 (total 14 slots available) 1110 = Start-up in time slot 14 1111 = Start up on entering ACTIVE Reset by state machine. Default held in metal mask.	
	9:6	LDO4_SDSLOT[3:0]	0000	Time slot for LDO4 shutdown. 0000 = Shut down on entering OFF 0001 = Shutdown in time slot 1 (total 14 slots available) 1110 = Shutdown in time slot 14 1111 = Shut down on entering OFF	

Register D2h LDO4 Timeouts



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R211 (D3h) LDO4 Low Power	13:12	LDO4_HIB_MODE[1:0]	00	LDO4 Hibernate behaviour: 00 = Select voltage image settings 01 = disable output	
				10 = reserved 11 = reserved Reset by state machine. Default held in metal mask.	
	9:8	LDO4_HIB_TRIG[1:0]	00	LDO4 Hibernate signal select 00 = Hibernate register bit 01 = L_PWR1 10 = L_PWR2 11 = L_PWR3 Reset by state machine. Default held in metal mask.	
	4:0	LDO4_VIMG[4:0]	1_1100	LDO4 Regulator output image voltage 1 1111 = 3.3V (100mV steps) 1 0000 = 1.8V 0 1111 = 1.65V (50mV steps) 0 0000 = 0.9V	

Register D3h LDO4 Low Power

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R215 (D7h)	15	LS_FAULT	0	Limit Switch fault mask for the /VCC_FAULT	
VCC_FAULT				0 = 'on't mask converter fault	
Masks				1 = mask converter fault	
				Reset by state machine.	
	11	LDO4_FAULT	0	LDO4 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	10	LDO3_FAULT	0	LDO3 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	9	LDO2_FAULT	0	LDO2 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	8	LDO1_FAULT	0	LDO1 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	5	DC6_FAULT	0	DCDC6 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	4	DC5_FAULT	0	DCDC5 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
				1 = mask converter fault	
				Reset by state machine.	
	3	DC4_FAULT	0	DCDC4 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	2	DC3_FAULT	0	DCDC3 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	1	DC2_FAULT	0	DCDC2 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	
	0	DC1_FAULT	0	DCDC1 fault mask for the /VCC_FAULT	
				0 = 'on't mask converter fault	
				1 = mask converter fault	
				Reset by state machine.	

Register D7h VCC_FAULT Masks

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R216 (D8h) Main Bandgap Control	15	MBG_LOAD_FUSES	0	Enables the current to the bandgap trim fuses. This must be set to 1 when writing the fuses. To read the trim value held in the fuse, this bit must be set and then reset.	

Register D8h Main Bandgap Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R217 (D9h) OSC Control	15	OSC_LOAD_FUSES	0	Enables the current to the bandgap trim fuses. This must be set to 1 when writing the fuses. To read the trim value, this bit must be set and then reset. Protected by security key.	

Register D9h OSC Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R218 (DAh)	15	RTC_TICK_ENA	1	Enable RTC counting (instruction only)	
RTC Tick Control			1	0 = disabled	
Control			1	1 = enabled	
			1	Protected by security key. Reset by state machine. Default held in metal mask.	
	14	RTC_TICKSTS	0	Status of tick request. This bit can be used to ensure the RTC is using the value of RTC_TICK_ENA. 0 = disabled 1 = enabled	
				Protected by security key.	
	13	RTC_CLKSRC	0	RTC 32Khz clock source.	
			0	0 = take 32Khz from 32K OSC	
			0	1 = take 32Khz from GPIOx (Alternative GPIO	
			0	function)	
				Protected by security key. Reset by state machine. Default held in metal mask.	
	12	OSC32K_ENA	1	On chip 32Khz OSC enable	
			1	0 = disable	
			1	1 = enable	
			1	Protected by security key. Reset by state machine. Default held in metal mask.	
	9:0	RTC_TRIM[9:0]	00_0000_0000	RTC frequency trim. Used to adjust the count value of the Tick Gen block to compensate for crystal inaccuracies. RTC frequency trim is a 10bit fixed point <4,6' 2's complement number. MSB Scaling = -8Hz. The register indicates the error (in Hz) with respect to the ideal 32768Hz) of the input crystal frequency. e.g.:	
				Actual crystal freq: 32769.00Hz: Required trim 0xb0001_000000 (+1.000000)	
				Actual crystal freq: 32767.00Hz: Required trim 0xb1111_000000 (-1.000000)	
				Actual crystal freq: 32775.58Hz: Required trim 0xb0111_100101 (+7.578125)	
				Actual crystal freq: 32763.78Hz: Required trim 0xb1011_110010 (-4.218750)	
				Protected by security key.	

Register DAh RTC Tick Control

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R219 (DBh) Security1	15:0	SECURITY[15:0]	0000_0000_0000_0000	The value 0013h needs to be set in this register to allow write access to the security locked registers. Reset by state machine.	

Register DBh Security1



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R224 (E0h) Signal overrides	11	WALL_FB_GT_BATT_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	10	USB_FB_GT_BATT_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	9	FLL_OK_OVRDE	0	0 = normal operation 1 = Overrides the FLL OK	
	8	DEB_TICK_OVRDE	0	Overrides the ticks in the debounce block 0 = normal 1 = All ticks are overwritten with 16KHz ticks	
	7	UVLO_B_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	6	RTC_ALARM_OVRDE	0	Override for RTC_ALARM signal 0 = normal 1 = Alarm = 1	
	3	LINE_GT_BATT_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	2	LINE_GT_VRTC_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	1	USB_GT_LINE_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	0	BATT_GT_USB_OVRDE	0	[No description available]	

Register E0h Signal overrides



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R225 (E1h) DCDC/LDO status	15	LS_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
				Reset by state machine.	
	11	LDO4_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	10	LDO3_STS	0	Readback of the raw signal value.	
				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	9	LDO2_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	8	LDO1_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	5	DC6_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	4	DC5_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	3	DC4_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	2	DC3_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	1	DC2_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	
	0	DC1_STS	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1. Reset by state machine.	

Register E1h DCDC/LDO status



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R226 (E2h)	15	CHG_BATT_HOT_OVRDE	0	Readback of the raw signal value.	
Charger Overides/statu s				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	14	CHG_BATT_COLD_OVRDE	0	Readback of the raw signal value.	
				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	11	CHG_END_OVRDE	0	Readback of the raw signal value.	
				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	2	CHG_BATT_LT_3P9_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	1	CHG_BATT_LT_3P1_OVRDE	0	Readback of the raw signal value.	
				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	0	CHG_BATT_LT_2P85_OVRDE	0	Readback of the raw signal value.	
				Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	

Register E2h Charger Overides/status

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R227 (E3h) misc overrides	13	CS2_NOT_REG_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	12	CS1_NOT_REG_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	10	USB_LIMIT_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	7	AUX_DCOMP4_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	6	AUX_DCOMP3_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	5	AUX_DCOMP2_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	4	AUX_DCOMP1_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
	3	HYST_UVLO_OK_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	2	CHIP_GT115_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	1	CHIP_GT140_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	

Register E3h misc overrides

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R228 (E4h) Supply overrides/statu s 1	5	OVRV_DC6_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_OV_OVRDE bit is set to 1.	
	3	OVRV_DC4_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_OV_OVRDE bit is set to 1.	
	2	OVRV_DC3_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_OV_OVRDE bit is set to 1.	
	0	OVRV_DC1_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_OV_OVRDE bit is set to 1.	

Register E4h Supply overrides/status 1

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R229 (E5h) Supply overrides/statu s 2	15	OVCR_LS_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_OC_OVRDE bit is set to 1.	
	11	UNDV_LDO4_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	10	UNDV_LDO3_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	9	UNDV_LDO2_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	8	UNDV_LDO1_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	5	UNDV_DC6_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	4	UNDV_DC5_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	3	UNDV_DC4_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	2	UNDV_DC3_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	1	UNDV_DC2_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	
	0	UNDV_DC1_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the CONVERTER_UV_OVRDE bit is set to 1.	

Register E5h Supply overrides/status 2



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R230 (E6h) GPIO Pin	15	1	1	Unused Never reset.	
Status	14	1	1	Unused Never reset.	
	13	1	1	Unused Never reset.	
	12	GP12_LVL	0	Logic level of GPIO12 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP12_EINT	
				Output- Write sets the value to drive the GPIO pin	
	11	GP11_LVL	0	Logic level of GPIO11 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP11_EINT Output-	
	10	GP10_LVL	0	Write sets the value to drive the GPIO pin Logic level of GPIO10 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP10_EINT	
	9	GP9_LVL	0	Output- Write sets the value to drive the GPIO pin Logic level of GPIO9 pin Input- Reads the logic level of GPIO pin	
		000 11/1		Writing '0' clears GP9_EINT Output- Write sets the value to drive the GPIO pin	
	8	GP8_LVL	0	Logic level of GPIO8 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP8_EINT Output- Write sets the value to drive the GPIO pin	
	7	GP7_LVL	0	Logic level of GPIO7 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP7_EINT Output-	
	6	GP6_LVL	0	Write sets the value to drive the GPIO pin Logic level of GPIO6 pin Input- Reads the logic level of GPIO pin Writing '0' clears GP6_EINT	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
				Output-	
				Write sets the value to drive the GPIO pin	
	5	GP5_LVL	0	Logic level of GPIO5 pin	
				Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP5_EINT	
				Output-	
				Write sets the value to drive the GPIO pin	
	4	GP4_LVL	0	Logic level of GPIO4 pin	
				Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP4_EINT	
				Output-	
				Write sets the value to drive the GPIO pin	
	3	GP3_LVL	0	Logic level of GPIO3 pin	
				Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP3_EINT	
				Output	
				Output- Write sets the value to drive the GPIO pin	
	2	GP2_LVL	0	Logic level of GPIO2 pin	
	_	01 2_212		Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP2_EINT	
				Output-	
	4	OD4 11//	0	Write sets the value to drive the GPIO pin	
	1	GP1_LVL	0	Logic level of GPIO1 pin Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP1_EINT	
				Timing of distance of I	
				Output-	
				Write sets the value to drive the GPIO pin	
	0	GP0_LVL	0	Logic level of GPIO0 pin	
				Input-	
				Reads the logic level of GPIO pin	
				Writing '0' clears GP0_EINT	
				Output	
				Output-	
				Write sets the value to drive the GPIO pin	

Register E6h GPIO Pin Status



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
R231 (E7h) 15 comparotor overrides		USB_FB_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	14	WALL_FB_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	13	BATT_FB_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	11	CODEC_JCK_DET_L_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	10	CODEC_JCK_DET_R_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	9	CODEC_MICSCD_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	
	8	CODEC_MICD_OVRDE	0	Readback of the raw signal value. Allow direct control of this sig'al's input to the debounce logic when the ANALOG_OVRDE bit is set to 1.	

Register E7h comparotor overrides

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R233 (E9h) State Machine status	10:8	USB_SM[2:0]	000	Readback tell you what state the USB state machine is in. This is useful for debugging your setup. 0001 = 100mA Slave 0101 = 500mA Slave 0100 = Suspend 0010 = Master Line 0110 = Master DCDC	
	6:4	CHG_SM[2:0]	000	Readback tell you what state the Charger state machine is in. This is useful for debugging your setup. 0000 = OFF 0001 = TRICKLE 0010 = TRICKLE_CHOKE 0011 = TRICKLE_OVERTEMP 0100 = FAST 0110 = FAST_CHOKE 0101 = FAST_OVERTEMP	
	3:0	MAIN_SM[3:0]	0000	Readback tell you what state the MAIN state machine is in. This is useful for debugging your setup. 0010 = OFF 1101 = PRE-ACTIVE 1100 = HIBERNATE 1111 = ACTIVE	

Register E9h State Machine status



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R248 (F8h)	4	DC1_FORCE_PWM	0	Force DC-DC1 PWM mode	
DCDC1 Test				0 = Normal DC-DC operation	
Controls				1 = Force DC-DC PWM mode	
				Reset by state machine.	

Register F8h DCDC1 Test Controls

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R250 (FAh)	4	DC3_FORCE_PWM	0	Force DC-DC3 PWM mode	
DCDC3 Test				0 = Normal DC-DC operation	
Controls				1 = Force DC-DC PWM mode	
				Reset by state machine.	

Register FAh DCDC3 Test Controls

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R251 (FBh)	4	DC4_FORCE_PWM	0	Force DC-DC4 PWM mode	
DCDC4 Test				0 = Normal DC-DC operation	
Controls				1 = Force DC-DC PWM mode	
				Reset by state machine.	

Register FBh DCDC4 Test Controls

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION	REFER TO
ADDRESS					
R253 (FDh)	4	DC6_FORCE_PWM	0	Force DC-DC6 PWM mode	
DCDC6 Test				0 = Normal DC-DC operation	
Controls				1 = Force DC-DC PWM mode	
				Reset by state machine.	ļ

Register FDh DCDC6 Test Controls

28 DIGITAL FILTER CHARACTERISTICS

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADC Filter		-	•		•
Passband	+/- 0.025dB	0		0.454fs	
	-6dB		0.5fs		
Passband Ripple			+/- 0.025		dB
Stopband		0.546fs			
Stopband Attenuation	f > 0.546fs		-60		dB
Group Delay			21/fs		
ADC High Pass Filter					
High Pass Filter Corner	-3dB		3.7		Hz
Frequency	-0.5dB		10.4		1
	-0.1dB		21.6		1
DAC Filter					
Passband	+/- 0.035dB	0		0.454fs	
	-6dB		0.5fs		
Passband Ripple			+/-0.035		dB
Stopband		0.546fs			
Stopband Attenuation	f > 0.546fs		-55		dB
Group Delay			29/fs		

Terminology

- 1. Stop Band Attenuation (dB) the degree to which the frequency spectrum is attenuated (outside audio band)
- 2. Pass-band Ripple any variation of the frequency response in the pass-band region

28.1 DAC FILTER RESPONSES

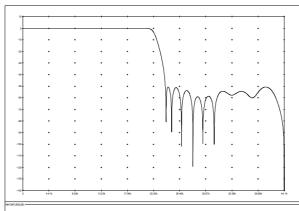


Figure 81 DAC Digital Filter Frequency Response (Normal Mode)

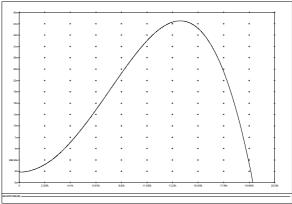
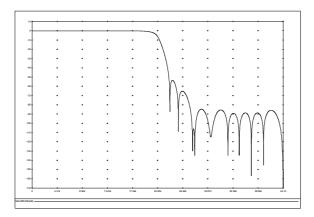
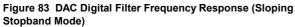


Figure 82 DAC Digital Filter Ripple (Normal Mode)





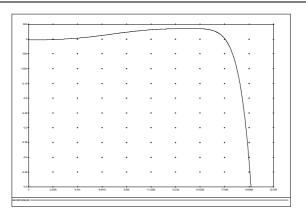


Figure 84 DAC Digital Filter Ripple (Sloping Stopband Mode)

28.2 ADC FILTER RESPONSES

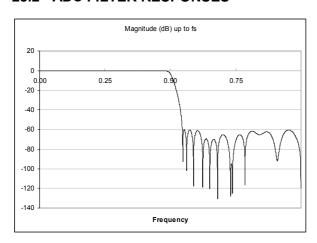


Figure 85 ADC Digital Filter Frequency Response

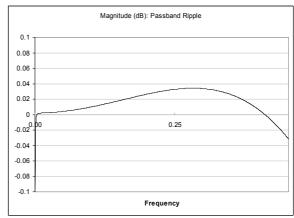


Figure 86 ADC Digital Filter Ripple

9 APPLICATIONS INFORMATION

9.1 TYPICAL CONNECTIONS

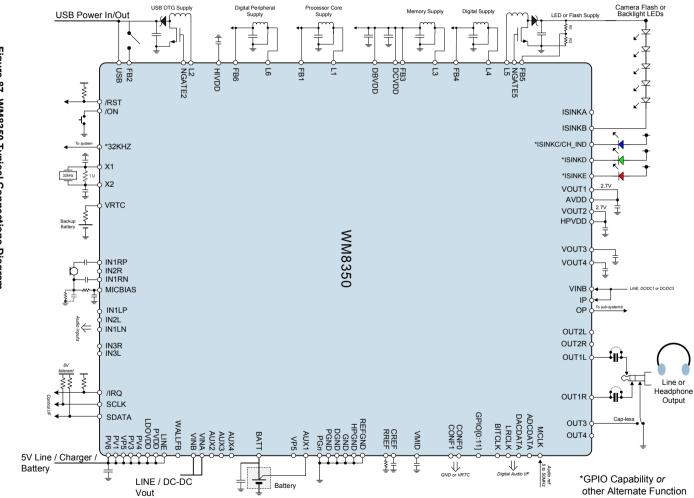


Figure 87 WM8350 Typical Connections Diagram

For detailed schematics, bill of materials WM8350 evaluation board users manual. and recommended external components refer ಠ the



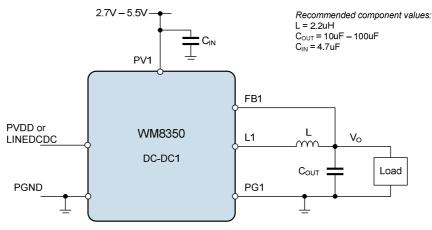
29.2 VOLTAGE REFERENCE (VREF) COMPONENTS

A decoupling capacitor is required between CREF and REFGND; a 2.2uF X5R capacitor is recommended

A reference resistor is required between RREF and REFGND; a 100k Ω (1%) resistor is recommended.

29.3 DC-DC (STEP-DOWN) CONVERTER EXTERNAL COMPONENTS

The recommended connections to the DC-DC (Step-Down) Converters are illustrated in Figure 88.



Note: Equivalent circuit applies for DC-DC 3, 4 and 6.

Figure 88 DC-DC (Step-Down) Converters External Components

When selecting suitable capacitors, is it imperative that the effective capacitance is within the required limits at the applicable input/output voltage of the converter. It should be noted that some components' capacitance changes significantly depending on the DC voltage applied. Ceramic X7R or X5R types are recommended.

The choice of output capacitor for DC-DC1 and DC-DC6 varies depending on the required transient response. A value of $30\mu F$ is recommended in the first instance. Larger values (up to $100\mu F$) may be required for optimum performance under large load transient conditions. Smaller values (down to $10\mu F$) may be sufficient for a steady load in some applications.

For layout and size reasons, users may choose to implement large values of output capacitance by connecting two or more capacitors in parallel.

To ensure stable operation, the register fields DC1_CAP and DC6_CAP must be set according to the output capacitance, as detailed in Table 156.

		T	T	
ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R180 (B4h)	15:1	DC1_CAP	00	DC-DC1 Output Capacitor
	4			00 = 10uF, 30uF, 45uF
				01 = 60uF, 85uF
				10 = Not used
				11 = 100uF
R195 (C3h)	15:1	DC6_CAP	00	DC-DC6 Output Capacitor
	4			00 = 10uF, 30uF, 45uF
				01 = 60uF, 85uF
				10 = Not used
				11 = 100uF

Table 156 Register Control for DC-DC1 and DC-DC6 Output Capacitor



> When selecting a suitable output inductor, the inductance value and the saturation current must be compatible with the operating conditions of the converter.

> The magnitude of the inductor current ripple is dependant on the inductor value and can be determined by the following equation:

$$\triangle I_L = \frac{V_{OUT} \cdot (1 - (V_{OUT} / V_{IN}))}{L \cdot F_{SW}}$$

 $\triangle I_L$ = Inductor ripple current

 V_{OUT} = Output voltage V_{IN} = Input voltage L = Inductance

 F_{SW} = Switching frequency (2MHz)

As a minimum requirement, the DC current rating should be equal to the maximum load current plus one half of the inductor current ripple:

$$I_{Lpeak} = I_{OUTmax} + (\triangle I_L / 2)$$

$$I_{Lpeak} = I_{OUTmax} = Maximum load current$$

$$\triangle I_L = Inductor ripple current$$

To be suitable for the application, the chosen inductor must have a saturation current that is higher than the peak inductor current given by the above equation. To maximise the converter efficiency, the inductor should also have a low DC Resistance (DCR), resulting in minimum conduction losses. Care should also be taken to ensure that the inductor is effective at the applicable operating temperature.

Wolfson recommends the following external components for use with DC-DC Converters 1 and 6. Note that the choice of output capacitor should be determined as described above.

COMPONENT	VALUE	PART NUMBER	SIZE
L	2.2μΗ	Coilcraft LPS3010-222ML (1.4A)	
C _{OUT}	10μF	Murata GRM219R60J106KE19B	0805
	22μF	Murata GRM21BR60J226M	0805
	47μF	Murata GRM31CR60J476M	1206
	100μF	Murata GRM31CR60J107M	1206
C _{IN}	4.7μF	Murata GRM188R60J475KE19D	0603

Table 157 Recommended External Components - DC-DC1 and DC-DC6

Wolfson recommends the following external components for use with DC-DC Converters 3 and 4.

COMPONENT	VALUE	PART NUMBER	SIZE
L	2.2μΗ	Murata LQM31PN2R2M00 (0.9A)	1206
C _{OUT}	10μF	Murata GRM219R60J106KE19B	0805
Cini	4.7uF	Murata GRM188R60J475KE19D	0603

Table 158 Recommended External Components - DC-DC3 and DC-DC4

29.4 DC-DC (STEP-UP) CONVERTER EXTERNAL COMPONENTS

The DC-DC (Step-Up) Converters can operate as Switches or as Boost Converters. In Boost mode, they operate in one of three different modes, set by the DC2_FBSRC and DC5_FBSRC register fields. The following subsections describe each of these modes in turn.

29.4.1 DC-DC (STEP-UP) CONVERTERS - CONSTANT VOLTAGE MODE

Constant voltage mode is selected by setting DCn_FBSRC[1:0] = 00, as described in Section 14.6.4. The recommended connections to the DC-DC (Step-Up) Converters in this mode are illustrated in Figure 89.

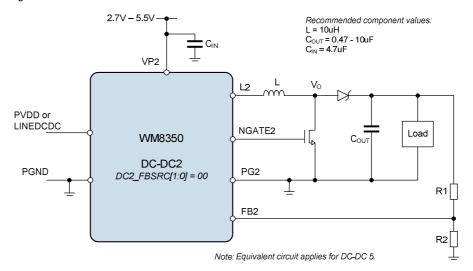


Figure 89 DC-DC (Step-Up) Converters External Components - Constant Voltage Mode

The DC-DC (Step-Up) Converters are capable of generating output voltages of up to 30V. The output voltage is determined by the two external resistors R1 and R2, which form a resistive divider between load connection and the voltage feedback pin FB2 or FB5. The output voltage is set as described in the following equation:

$$V_{OUT} = \frac{(R1/R2) + 1}{2}$$

Setting R2 to $47k\Omega$ is recommended for most applications; R1 can be calculated using the following equation, given the required output voltage:

$$R1 = R2 \cdot (2V_{OUT} - 1)$$

When selecting suitable capacitors, is it imperative that the effective capacitance is within the required limits at the applicable input/output voltage of the converter. Ceramic X7R or X5R types are recommended.

The choice of output capacitor for DC-DC2 and DC-DC varies depending on the required output voltage. For a 20V output, $0.47\mu F$ is recommended. For a 5V output, $10\mu F$ is recommended.



When selecting a suitable output inductor, the inductance value and the saturation current must be compatible with the operating conditions of the converter.

The magnitude of the inductor current ripple is dependent on the inductor value and can be determined by the following equation:

 F_{SW} = Switching frequency (1MHz)

The inductor current is also a function of the DC-DC Converter maximum input current, which can be determined by the following equation:

$$I_{\text{INmax}} = \begin{array}{c} I_{\text{OUTmax}} \\ \hline efficiency \end{array} \times \begin{array}{c} V_{\text{OUT}} \\ \hline V_{\text{IN}} \\ \hline \end{array} \qquad \begin{array}{c} I_{\text{OUTmax}} \\ \hline V_{\text{INmax}} \\ \hline V_{\text{OUT}} \\ \hline V_{\text{OUT}} \\ \hline \end{array} = \begin{array}{c} \text{Maximum load current} \\ \hline = \text{Maximum input current} \\ \hline V_{\text{OUT}} \\ \hline = \text{Output voltage} \\ \hline = \text{Input voltage} \\ \hline \end{array}$$

As a minimum requirement, the DC current rating should be equal to the maximum input current plus one half of the inductor current ripple.

$$I_{Lpeak} = I_{OUTmax} + (\triangle I_L / 2)$$

$$I_{Lpeak} = I_{OUTmax} = Maximum load current$$

$$\triangle I_L = Inductor ripple current$$

To be suitable for the application, the chosen inductor must have a saturation current that is higher than the peak inductor current given by the above equation. To maximise the converter efficiency, the inductor should also have a low DC Resistance (DCR), resulting in minimum conduction losses. Care should also be taken to ensure that the inductor is effective at the applicable operating temperature.

See Section 29.4.4 for recommended inductor, capacitor and FET component details.

29.4.2 DC-DC (STEP-UP) CONVERTERS - CONSTANT CURRENT MODE

Constant current mode is selected by setting DCn_FBSRC[1:0] as described in Section 14.6.4. Setting DCn_FBSRC[1:0] = 01 results in the DC Converter controlling the current at ISINKA, whilst setting DCn_FBSRC[1:0] = 10 controls the current at ISINKB. The recommended connections to the DC-DC (Step-Up) Converters in this mode are illustrated in Figure 90.

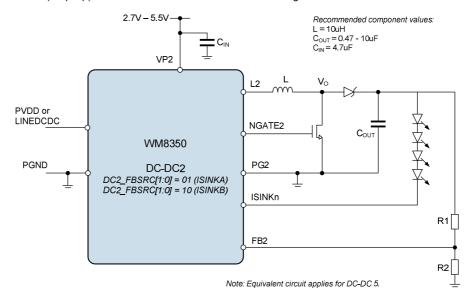


Figure 90 DC-DC (Step-Up) Converters External Components - Constant Current Mode

In the constant current mode, the DC-DC Converter output voltage is controlled by the WM8350 in order to achieve the required current in ISINKA or ISINKB. The required current is set by the CSn_ISEL register fields, as described in Section 16.2.2. A typical application for this mode would be a white LED driver, where several LEDs are connected in series to achieve uniform brightness.

The DC-DC (Step-Up) Converters are capable of generating output voltages of up to 30V. The maximum output voltage is determined by the two external resistors R1 and R2, which form a resistive divider between load connection and the voltage feedback pin FB2 or FB5.

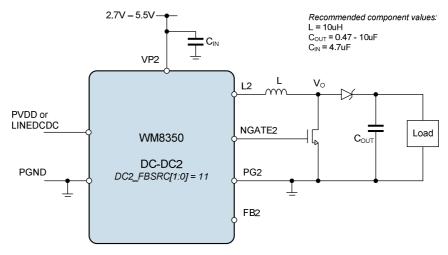
The choice of resistors R1 and R2 follows the same equations as for the constant voltage mode (see Section 29.4.1). Note that, in constant current mode, the resistors determine the maximum output voltage. The actual voltage will be determined by the selected ISINK current, subject to the device limits.

The choice of Capacitors, Inductor and FET in constant current mode is the same as for the constant voltage mode; see Section 29.4.4 for specific recommended component details.

When ISINKA or ISINKB is used in conjunction with DC-DC Converter 2 or 5, the ISINK should always be switched on before the DC-DC Converter is switched on. Conversely, the DC-DC Converter should always be switched off before the ISINK is switched off.

29.4.3 DC-DC (STEP-UP) CONVERTERS - USB MODE

USB mode is selected by setting DCn_FBSRC[1:0] = 11 as described in Section 14.6.4. This mode generates a 5V output, suitable for USB interfaces. The recommended connections to the DC-DC (Step-Up) Converters in this mode are illustrated in Figure 91.



Note: Equivalent circuit applies for DC-DC 5.

Figure 91 DC-DC (Step-Up) Converters External Components - USB Mode

In the USB mode, the DC-DC (Step-Up) Converters use an internal resistor chain to control the output voltage. This results in a fixed 5V output, suitable for USB interfaces.

The DC-DC (Step-Up) Converters may be configured as USB OTG supplement by setting USB_MSTR = 1 as described in Section 17.4. (The DC-DC Converters USB mode must also be selected by setting DCn_FBSRC[1:0] = 11). The output of the applicable DC-DC Converter should be connected to the USB pin in order to provide voltage feedback.

The choice of Capacitors, Inductor and FET in constant current mode is the same as for the constant voltage mode; see Section 29.4.4 for specific recommended component details.

29.4.4 DC-DC (STEP-UP) CONVERTERS RECOMMENDED COMPONENTS

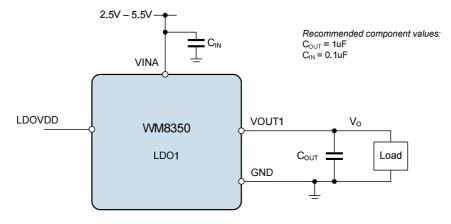
Wolfson recommends the following external components for use with DC-DC Converters 2 and 5. Note that the choice of output capacitor should be determined as described in Section 29.4.1.

COMPONENT	VALUE	PART NUMBER	SIZE
L	10μΗ	Taiyo Yuden NR4012T100M (0.7A)	
C _{OUT}	0.47μF	Murata GRM21BR71E474KC01L	0805
	4.7μF	Murata GRM188R60J475KE19D	0603
	10μF	Murata GRM219R60J106KE19B	0805
C _{IN}	4.7μF	Murata GRM188R60J475KE19D	0603
FET		On Semiconductor NTHD4N02F N-Channel FETKY	

Table 159 Recommended External Components - DC-DC2 and DC-DC5

29.5 LDO REGULATOR EXTERNAL COMPONENTS

The recommended connections to the LDO Regulators are illustrated in Figure 92.



Note: Equivalent circuit applies for LDO2, LDO3 and LDO4.
Input pin VINA supplies LDO1 and LDO2; Input pin VINB supplies LDO3 and LDO4.

Figure 92 LDO Regulators External Components

When selecting suitable capacitors, is it imperative that the effective capacitance is within the required limits at the applicable input/output voltage of the converter. Ceramic X7R or X5R types are recommended.

Wolfson recommends the following external components for use with LDO Regulators 1, 2, 3 and 4. Note that larger capacitors will improve load transient response and power supply rejection. A maximum of $10\mu F$ is possible at the output; a maximum of $1\mu F$ is possible at the input.

COMPONENT	VALUE	PART NUMBER	SIZE
C _{OUT}	1μF	Murata GRM155R60J105KE19D	0402
C _{IN}	0.1μF	Phycomp 06032R104K7B2	0603

Table 160 Recommended External Components - LDO1, LDO2, LDO3 and LDO4

29.6 PCB LAYOUT

Poor PCB layout will degrade the performance and be a contributory factor in EMI, ground bounce and resistive voltage losses. Poor regulation and instability can result.

Simple design rules can be implemented to negate these effects:

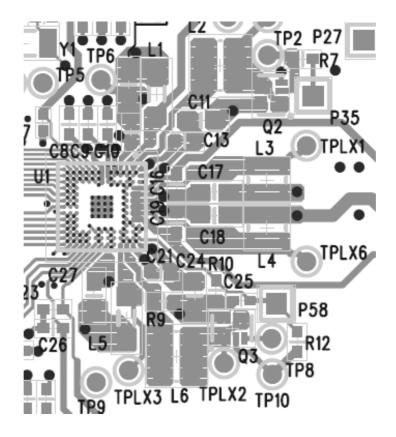
External input and output capacitors should be placed as close to the device as possible using short wide traces between the external power components.

Route output voltage feedback on an inner plane away from inductor and LX nodes to minimise noise and magnetic interference.

Use a local ground island for each individual converter connected at a single point onto a fully flooded ground plane.

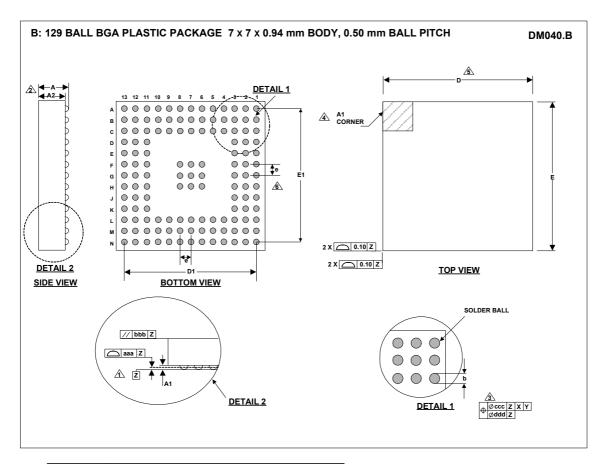
Current loop areas should be kept as small as possible with loop areas changing little during alternating switching cycles.

Studying the layout below shows, for example, DCDC1 layout with external components C16, L3, C17. The input capacitor, C16, is close into the IC and shares a small ground island with C17 the output capacitor. The inductor, L3, is then situated in close proximity to C17 to keep loop area small and current flowing in the same direction during alternating switching cycles. Note also the use of short wide traces with all power tracking on a single (top) layer.





30 PACKAGE DIAGRAM



Symbols	Dimensions (mm)				
	MIN	NOM	MAX	NOTE	
Α	0.83	0.94	1.05		
A1	0.2	0.24	0.28		
A2	0.63	0.70	0.77		
b	0.25	0.30	0.35		
D		7.00 BSC			
D1		6.00 BSC			
E		7.00 BSC			
E1		6.00 BSC			
е		0.50 BSC		6	
Tolerances of Form and Position					
aaa	0.08				
bbb	0.10				
ССС	0.15				
ddd	0.05				
REF:	JEDEC, MO-195				

- NOTES:

 1. PRIMARY DATUM -Z- AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

 2. THIS DIMENSION INCLUDES STAND-OFF HEIGHT 'A1'.

 3. DIMENSION 'b' IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM -Z
 4. A1 CORNER IS IDENTIFIED BY INKILASER MARK ON TOP PACKAGE.

 5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

 6. 'e' REPRESENTS THE BASIC SOLDER BALL GRID PITCH.

 7. THIS DRAWING IS SUBJECT TO CHANGE WITHOUT NOTICE.

 8. FALLS WITHIN JEDEC, MO-195



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32 REVISION HISTORY

DATE	REV	ORIGINATOR	CHANGES
01/02/11	4.4	PH	REG_RESET_HIB_MODE description corrected, p111, 226

